
CMOS single-chip 8-bit MCU with EEPROM and 12-bit A/D converter



Main features

- **8-bit Microcontroller with high speed 8051 CPU**
- **Basic MCU Function**
 - 8Kbytes Flash Code Memory
 - 512bytes EEPROM Backup Memory
 - 512bytes SRAM Data Memory
- **Built-in Analog Function**
 - Power-On Reset and Brown Out Detect Reset
 - Internal 8MHz RC Oscillator ($\pm 3\%$, $T_A = -40 \sim +85^\circ\text{C}$)
 - Internal 1MHz RING Oscillator
- **Peripheral features**
 - 12-bit Analog to Digital Converter (15inputs)
 - Serial Interface (USART + SPI + I2C)
 - 6-channel 10-bit PWM for Motor Control
- **I/O and packages**
 - Up to 30 programmable I/O lines with 32SOP
 - 32/28/20/16 SOP
- **Operating conditions**
 - 1.8V to 5.5V wide voltage range
 - -40°C to 85°C temperature range
- **Application**
 - Small Home Appliance
 - BLDC Motor Controller
 - LED Lighting with High speed PWM
 - (7-bit duty 500kHz period ~ 10-bit duty 62.5kHz period)

MC95FG308

MC95FG208

User's manual

V 3.3

Revision history

Version	Date	Revision list
0.0	2010.01.15	Initial version
0.1	2010.02.25	Update 15.7 Security and 16.1 Configuration
0.2	2010.03.29	Update Figure 1.3 gang 4→gang 8
1.0	2010.06.18	Release version
1.1	2010.07.02	Update endurance spec
1.2	2010.10.30	Update 11.1.5 register description for clock generator
1.3	2010.11.23	TxDR register increment range modification
1.4	2010.11.30	ADCM2 and Figure 11-67 modification
1.5	2011.01.22	Electrical Characteristics description modification
1.6	2011.02.10	Correct Interrupt, Port selection register
1.7	2011.03.03	Correct A/D Converter Characteristics and OCD emulator description
1.8	2011.03.10	Add package diagram(28TSSOP)
1.9	2011.03.21	Add Internal RC Oscillator Range, Figure1.1 8MHz Internal OSC Freq. (SOC_HOT: 85℃)
2.0	2011.03.24	Correct register T1ISR
2.1	2011.05.05	Add PWM description
2.2	2011.06.10	Correct Analog Comparator Block Diagram
2.3	2011.06.28	Add Port RESET N/C
2.4	2011.08.17	Add DC Characteristics
2.5	2011.11.24	Add Appendix B (Instructions on how to use the input port)
2.6	2011.11.28	Correct 28SOP package diagram
2.7	2011.12.21	Correct TMISR, ACCSR address
2.8	2012.01.31	Correct 32QFN Package Diagram
2.9	2012.05.21	Correct Ordering Information
3.0	2012.10.04	Add Main and sub clock oscillator characteristics
3.1	2012.12.14	Correct Figure 3.2, Figure 3.3
3.2	2013.06.05	Renewal version
3.3	2015.04.30	Change Configure Option naming. Bit test & branch instruction caution

Version 3.3

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1 Overview

1.1. Description

The MC95FG308 is an advanced CMOS 8-bit microcontroller with 8Kbytes of FLASH. This is powerful microcontroller which provides a highly flexible and cost effective solution to many embedded control applications. This provides the following features: 8Kbytes of FLASH, 256bytes of internal SRAM, 256bytes of external SRAM, 512bytes of Data EEPROM, general purpose I/O, 8/16-bit timer/counter, watchdog timer, watch timer, SPI, USART, I2C, on-chip POR, BOD, 12-bit A/D converter, analog comparator, buzzer driving port, 10-bit high speed PWM output, on-chip oscillator and clock circuitry. The MC95FG308 also supports power saving modes to reduce power consumption.

Device Name	FLASH	IRAM	XRAM	EEPROM	ADC	I/O PORT	Package
MC95FG308D	8Kbytes	256bytes	256bytes	512bytes	15inputs	30	32SOP
MC95FG308U							32QFN
MC95FG308L							32LQFP
MC95FG308M					12inputs	26	28SOP
MC95FG208D					10inputs	18	20SOP
MC95FG208R							20TSSOP
MC95FG208M					8inputs	14	16SOP
MC95FG208H							16TSSOP

Table 1.1 Ordering Information of MC95FG308

1.2 Features

- **CPU**
 - 8-bit CISC core (8051 Compatible, 2 clock per cycle)
- **8Kbytes On-Chip FLASH**
 - Optional boot code section with protection
 - Endurance : 10,000 times at room temperature
 - Retention : 10 years
- **256bytes SRAM**
- **256bytes XRAM**
- **512bytes Data EEPROM**
 - Endurance : 300,000 times at room temperature
 - Retention : 10 years
- **General Purpose I/O (GPIO)**
 - 30Ports (P0[7:0], P1[6:0], P2[6:0], P3[7:0]): 32-Pin
 - 26Ports (P0[7:0], P1[6:0], P2[2:0], P3[7:0]): 28-Pin
 - 18Ports (P0[7:0], P1[6:0], P2[2:0]): 20-Pin
 - 14Ports (P0[7:0], P1[2:0], P2[2:0]): 16-Pin
- **One Basic Interval Timer**
- **Timer/Counter**
 - 8-bit × 4-ch (16-bit × 2-ch) + 16-bit × 1-ch
- **3 High Frequency 10-bit PWM (Using Timer1)**
- **10-bit PWM (Using Timer3)**
- **Watch Dog Timer**
- **Watch Timer**
- **SPI**
- **USART (2-ch)**
- **I2C**
- **Buzzer Driving Port**
- **12-bit A/D Converter**
 - 15-Input channels : 32-Pin
- **Analog Comparator**
 - On Chip Analog Comparator
- **Interrupt Sources**
 - External Interrupts (8)
 - Pin Change Interrupt(P0) (1)
 - USART0,1 (4)
 - SPI (1)
 - Timer (5)
 - I2C (1)
 - Data EEPROM (1)
 - ADC (1)
 - Analog Comparator (1)
 - WDT (1)
 - WT (1)
 - BIT (1)
- **On-Chip RC-Oscillator**
 - 8MHz(±3%)
- **Power On Reset**
- **Programmable Brown-Out Detector**
- **Minimum Instruction Execution Time**
 - 200ns (@10MHz, NOP Instruction)
- **Power Down Mode**
 - IDLE, STOP1, STOP2 mode
- **Sub-Active mode**
 - System used external 32.768kHz crystal or system used internal 125kHz Ring oscillator
- **Operating Frequency**
 - 1MHz ~ 12MHz
- **Operating Voltage**
 - 1.8V ~ 5.5V
- **Operating Temperature : -40 ~ +85℃**
- **Package Type**
 - 32SOP/QFN/LQFP
 - 28SOP
 - 20SOP/TSSOP
 - 16SOP/TSSOP
 - Pb free package

1.3 Development tools

1.3.1 Compiler

ABOV Semiconductor does not provide compiler. It is recommended that you consult a compiler provider.

The MC95FG308 core is Mentor 8051, and the ROM size is smaller than 64Kbytes. Therefore, developer can use the standard 8051 compiler from other providers.

1.3.2 OCD(On-chip debugger) emulator and debugger

The OCD (On Chip Debug) emulator supports ABOV Semiconductor's 8051 series MCU emulation. The OCD interface uses two-wire connection between PC and MCU which is attached to user's system. The OCD can read or change the value of MCU internal memory and I/O peripherals. And the OCD also controls MCU internal debugging logic, it means OCD controls emulation, step run, monitoring, etc.

The OCD debugger program works on Microsoft-Windows NT, 2000, XP, Vista (32-bit) operating system. If you want to see more details, please refer to OCD debugger manual. You can download debugger S/W and manual from our web-site (<http://www.abov.co.kr>).

Connection:

- DSCL (MC95FG308 P06 port)
- DSDA (MC95FG308 P07 port)

OCD connector diagram: Connect OCD with user system

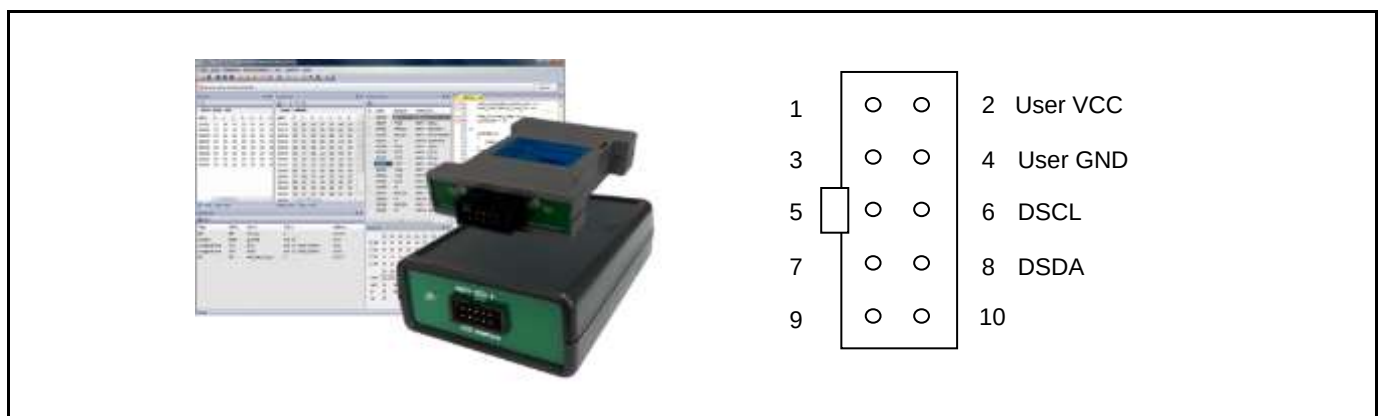


Figure 1.1 debugger and pin description

OCD emulator:

It can write code to MCU device too, because OCD debugger supports ISP (In System Programming). It does not require additional H/W, except developer's target system.

1.3.3 Programmer

Single programmer:

PGMplus USB: It programs MCU device directly.



Figure 1.2 PGMplusUSB(Single writer)

Standalone PGMplus:

It programs MCU device directly.



Figure 1.3 Standalone PGMplus(Single writer)

Gang programmer:

It programs 8 MCU devices at once. So, it is mainly used in mass production factory.

Gang programmer is standalone type, it means it does not require host PC, after a program is downloaded from host PC to Gang programmer.



Figure 1.4 StandAlone Gang8 (for Mass Production)

On-Board programming :

The program memory of MC95FG308 is FLASH Memory Type. This flash is accessed by serial data format. There are four pins (DSCL, DSDA, VDD, and VSS) for programming/reading the flash. The MC95FG308 needs only four signal lines including VDD and VSS pins for programming FLASH with serial protocol. Therefore the on-board programming is possible if the programming signal lines are considered when the PCB of application board is designed.

Pin name	Main chip pin name	During programming	
		I/O	Description
DSCL	P06	I	Serial clock pin. Input only pin.
DSDA	P07	I/O	Serial data pin. Output port when reading and input port when programming. Can be assigned as input/push-pull output port.
VDD, VSS	VDD, VSS	-	Logic power supply pin.

Table 1.2 Descriptions of pins used to programming/reading the Flash

2 Block diagram

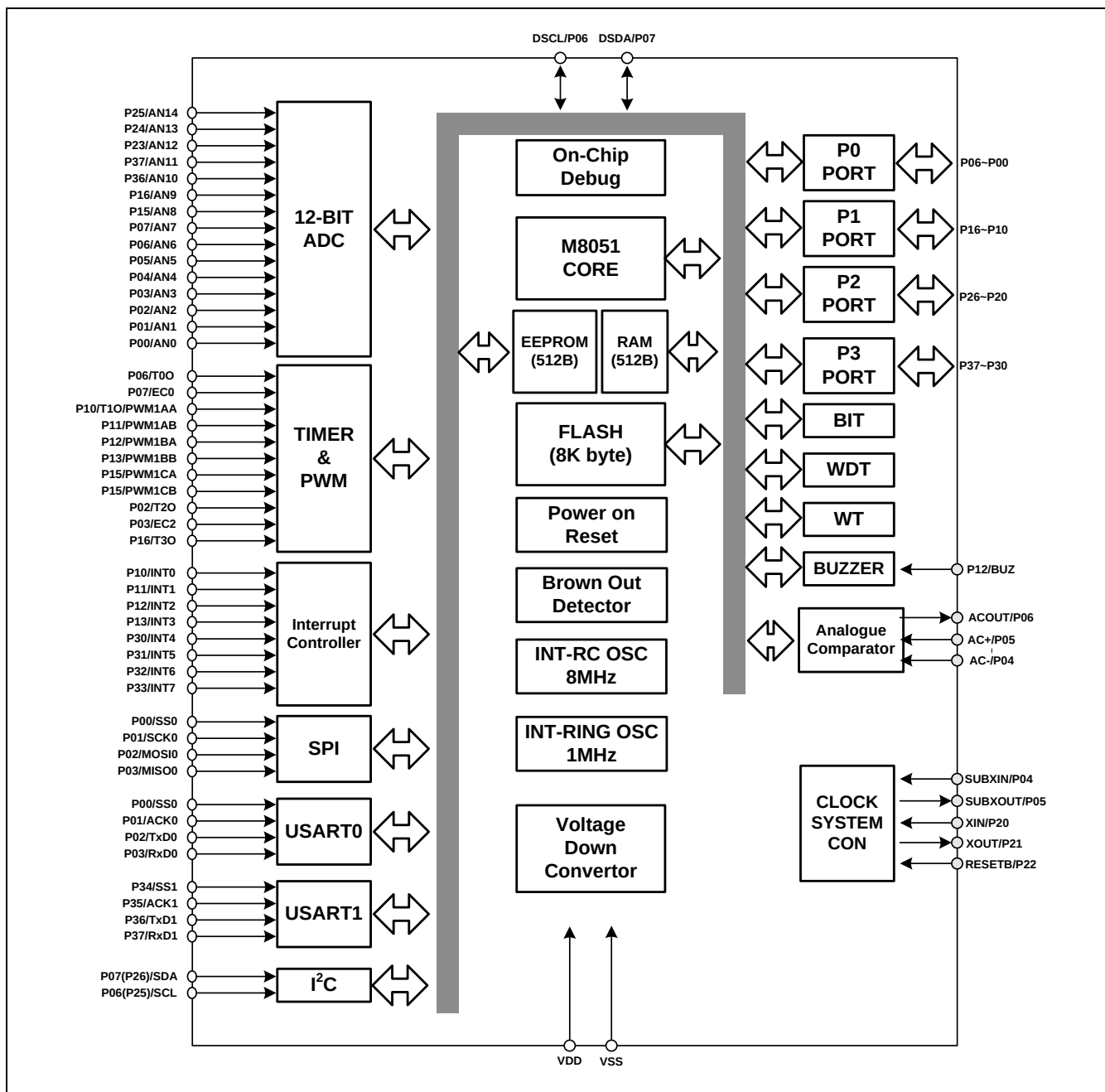
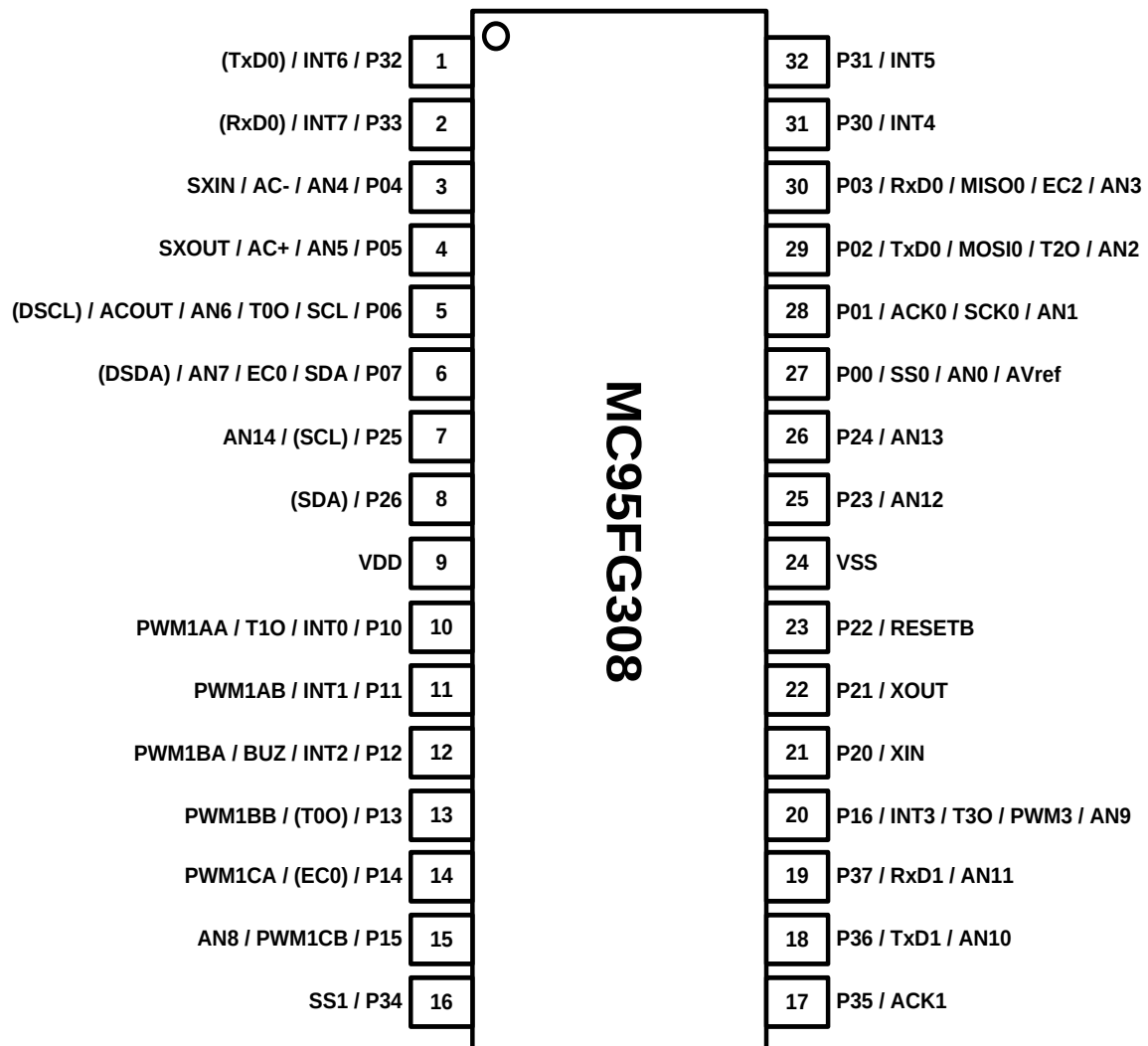


Figure 2.1 Block diagram of MC95FG308

3 Pin assignment



NOTE)

1. If 28PKG, Pin 7, 8, 25 and 26 in 32-pin package are removed and their function can't operate.
2. If 20PKG, Pin 1, 2, 31, 32, 15, 16, 17, 18, 7, 8, 25 and 26 in 32-pin package are removed and their function can't operate.
3. If 16PKG, Pin 13, 14, 19, 20, 1, 2, 31, 32, 15, 16, 17, 18, 7, 8, 25 and 26 in 32-pin package are removed and their function can't operate.
4. On On-Chip Debugging, ISP uses P0[7:6] pin as DSCL, DSDA.
5. The outside pin operation has higher priority than the inside pin operation. Ex) In pin32, if P03, RxD0, MISO0, EC2 and AN3 are set, AN3 will be operated.

Figure 3.1 MC95FG308 32SOP pin assignment

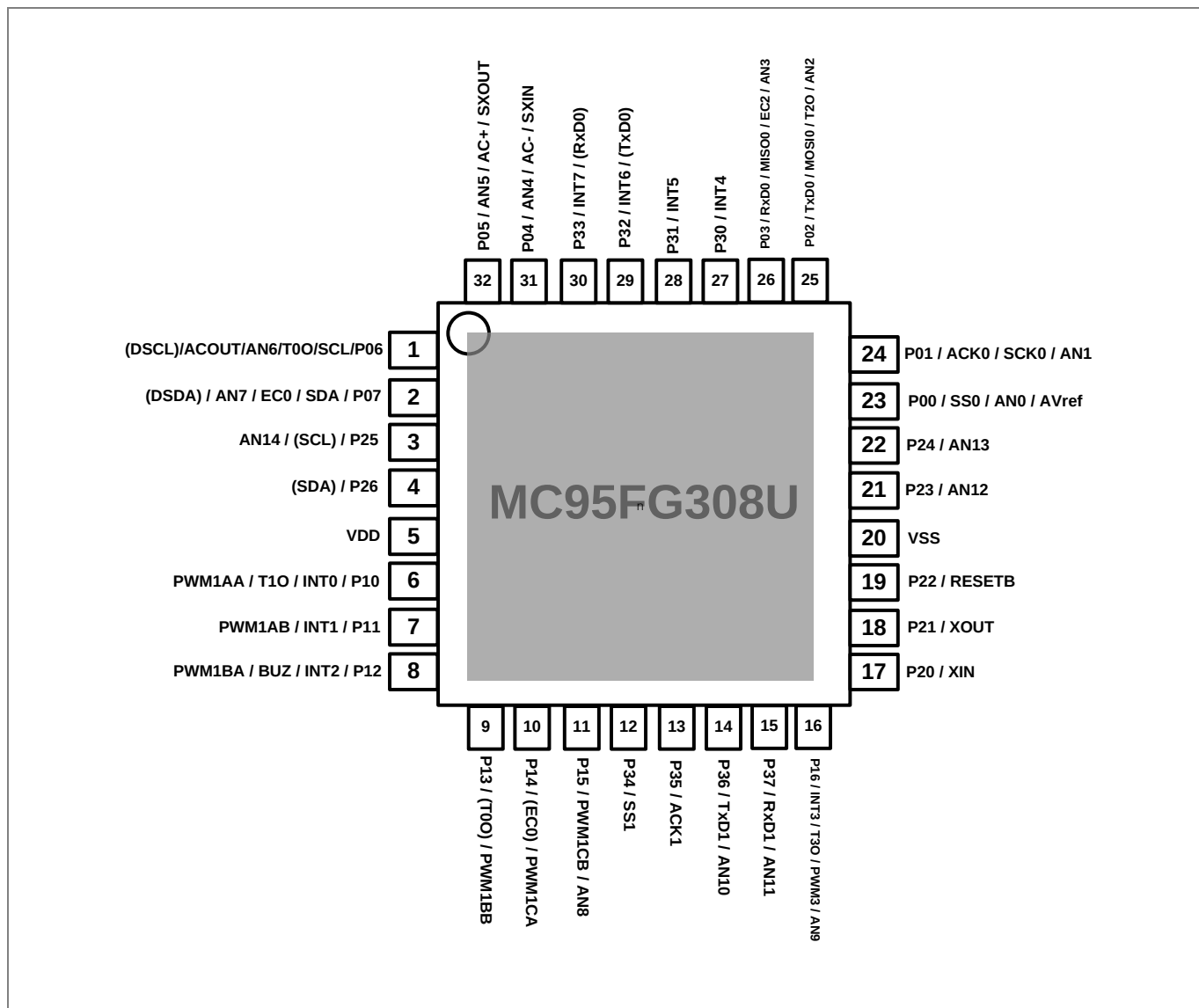


Figure 3.2 MC95FG308 32QFN pin assignment

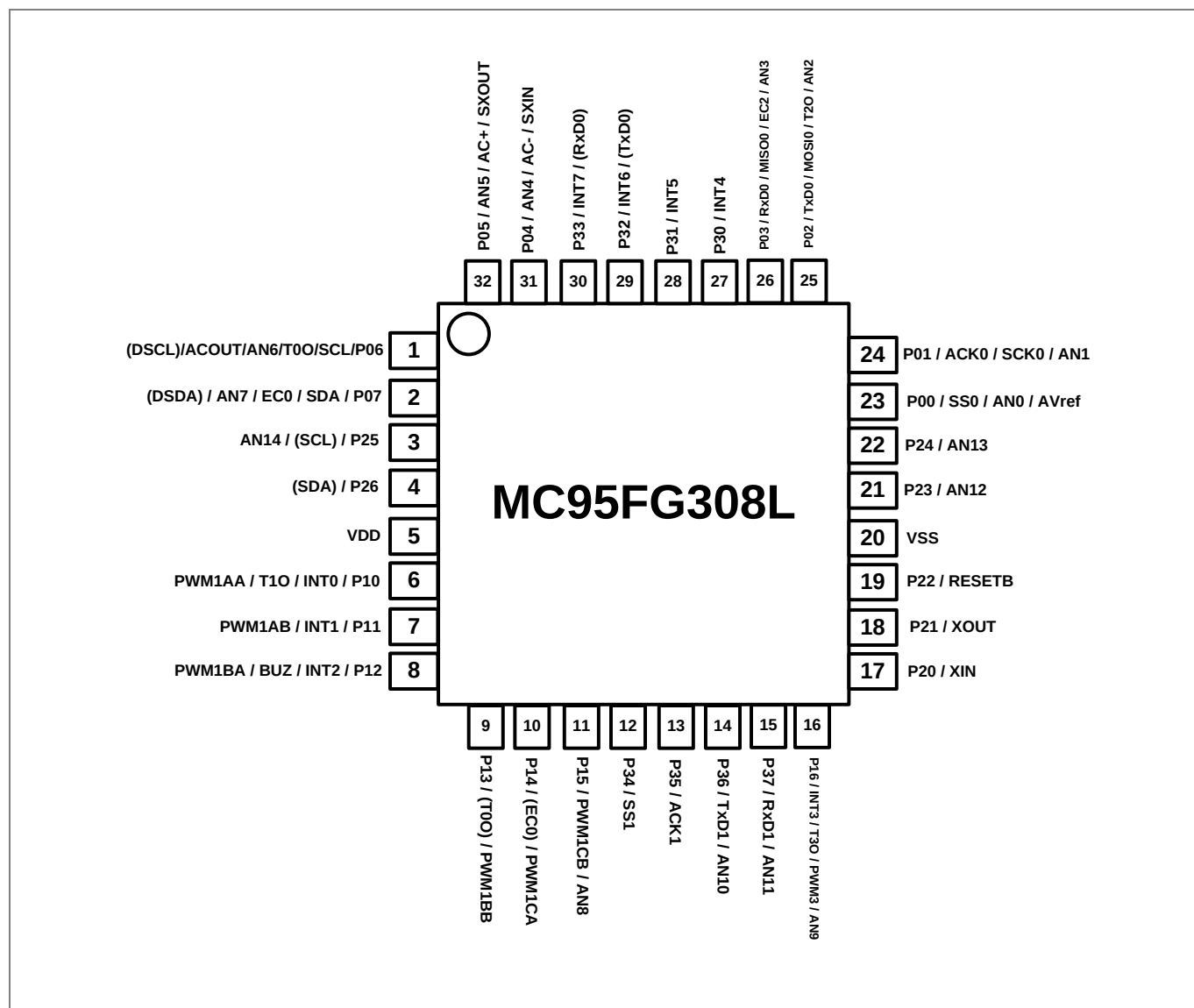


Figure 3.3 MC95FG308 32LQFP pin assignment

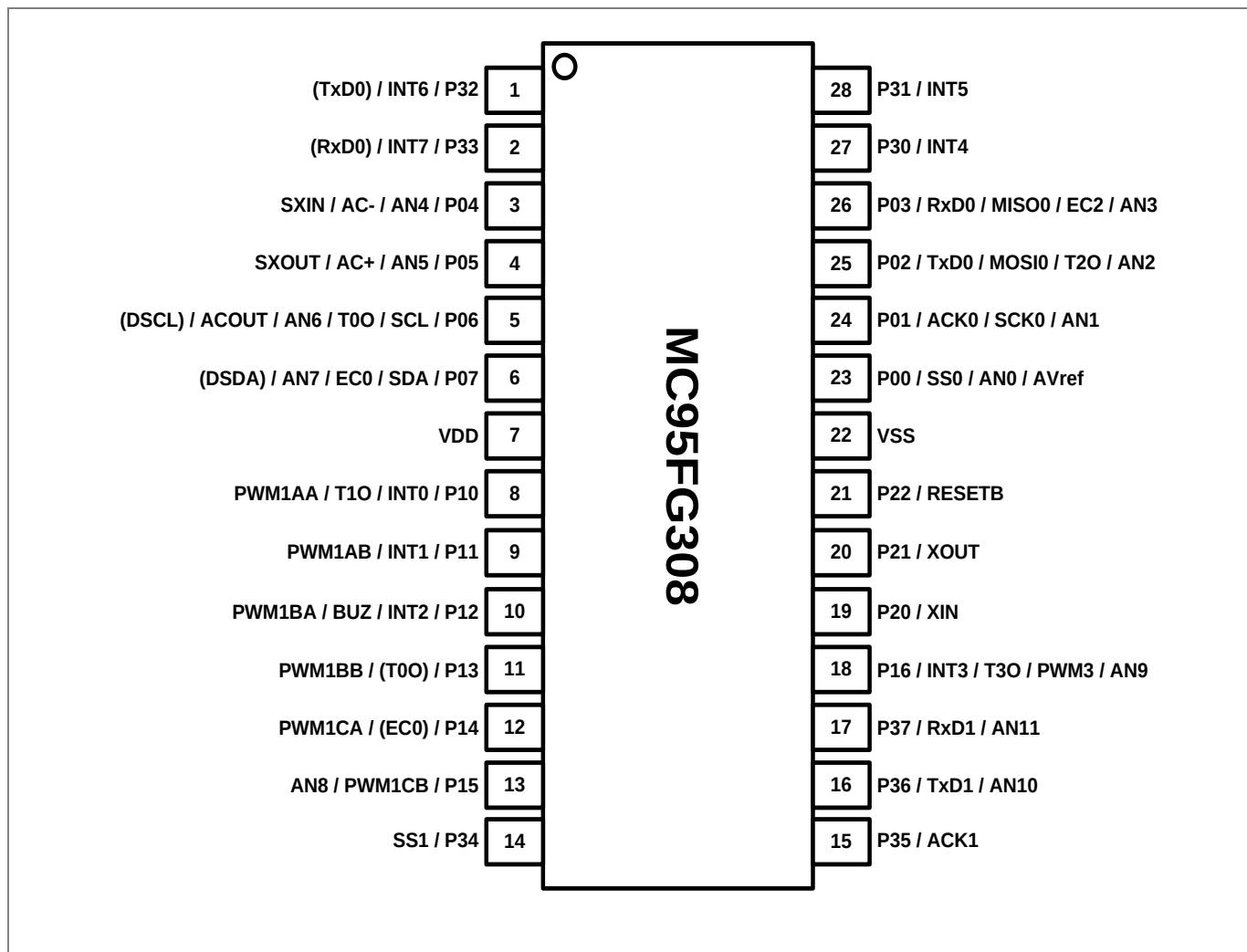


Figure 3.4 MC95FG308 28SOP pin assignment

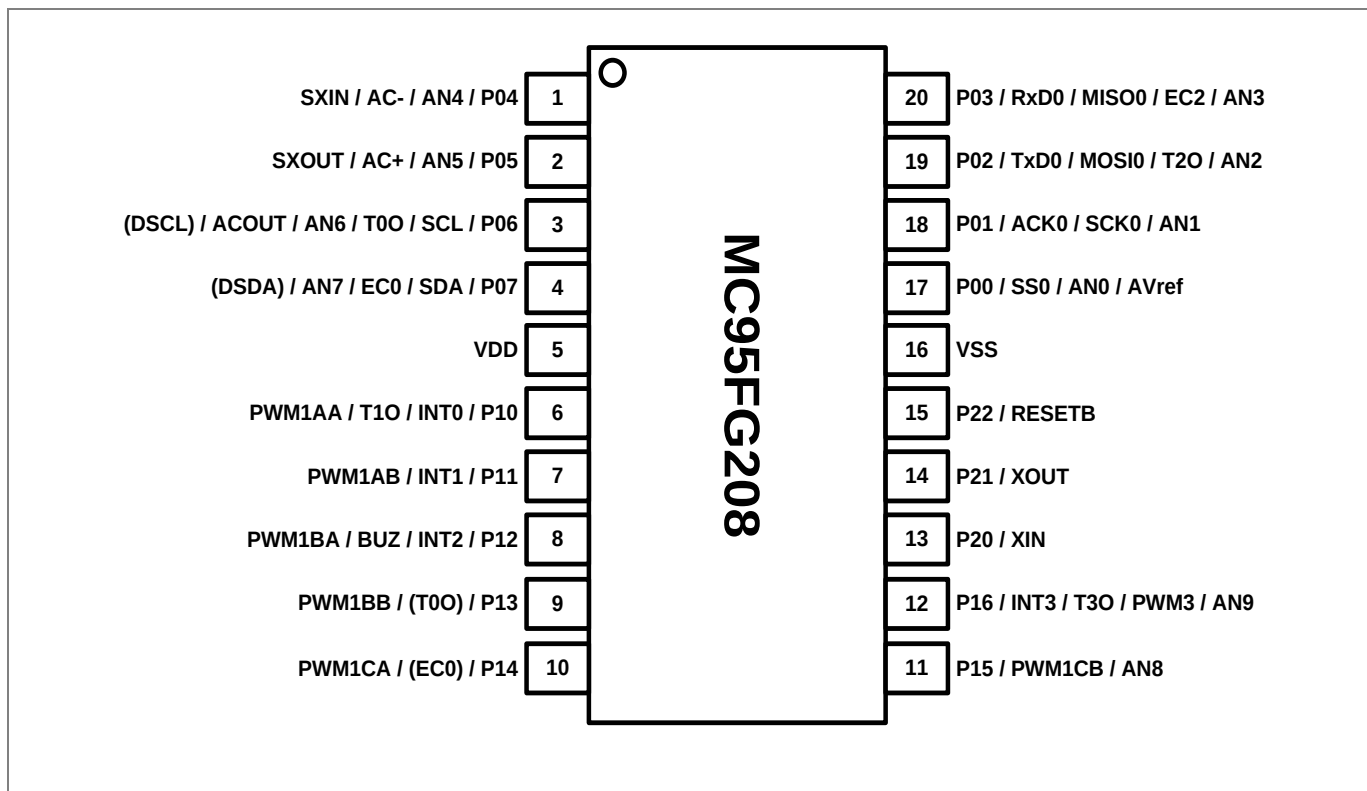


Figure 3.5 MC95FG208 20SOP/TSSOP pin assignment

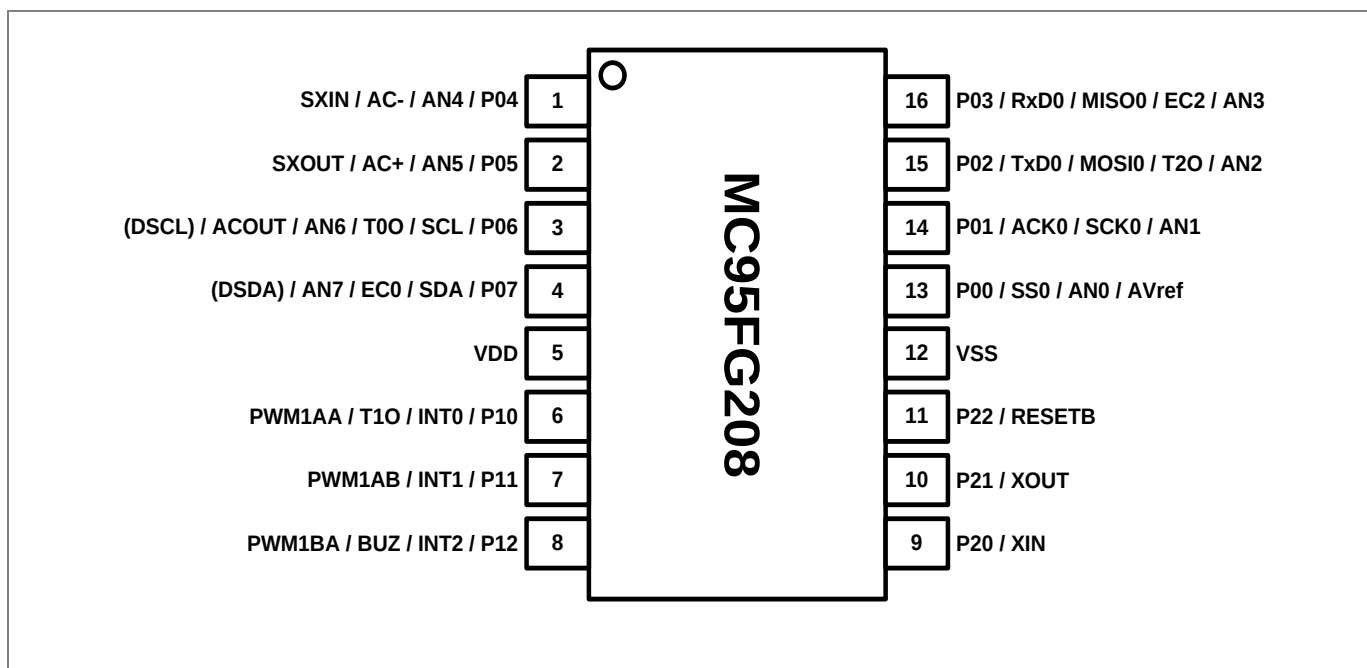


Figure 3.6 MC95FG208 16SOP/TSSOP pin assignment

4 Package Diagram

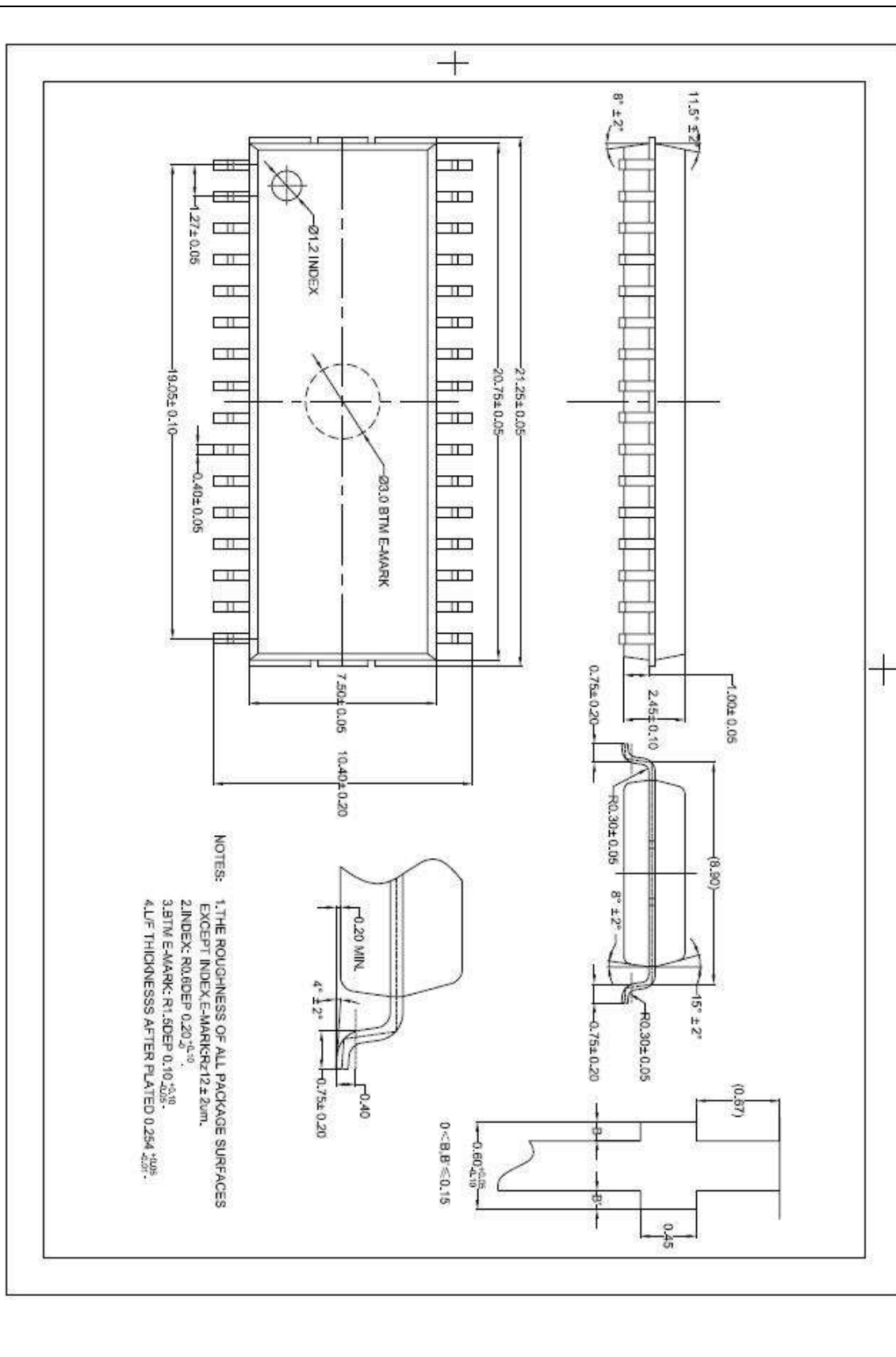


Figure 4.1 32-Pin SOP Package

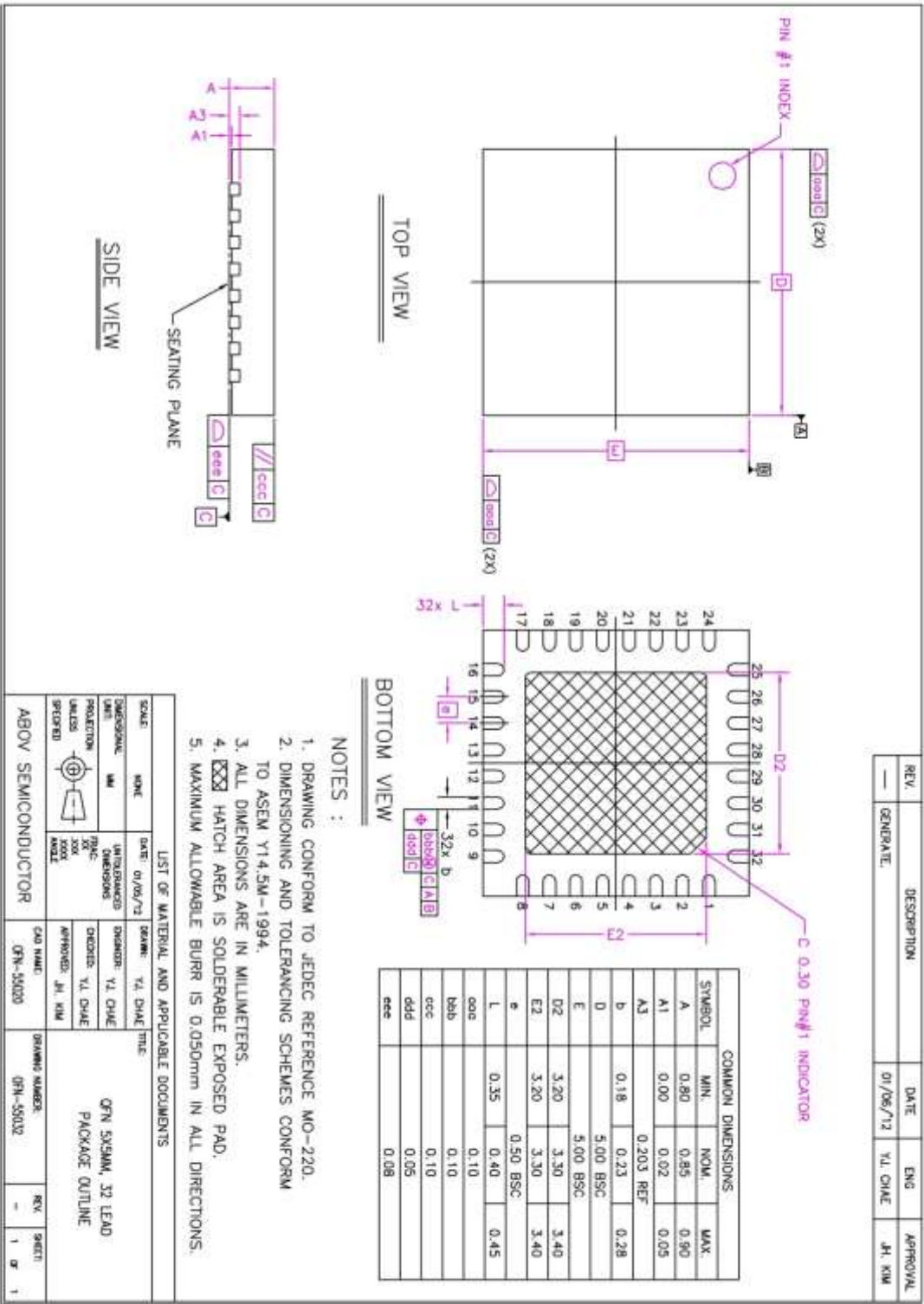


Figure 4.2 32-Pin QFN Package

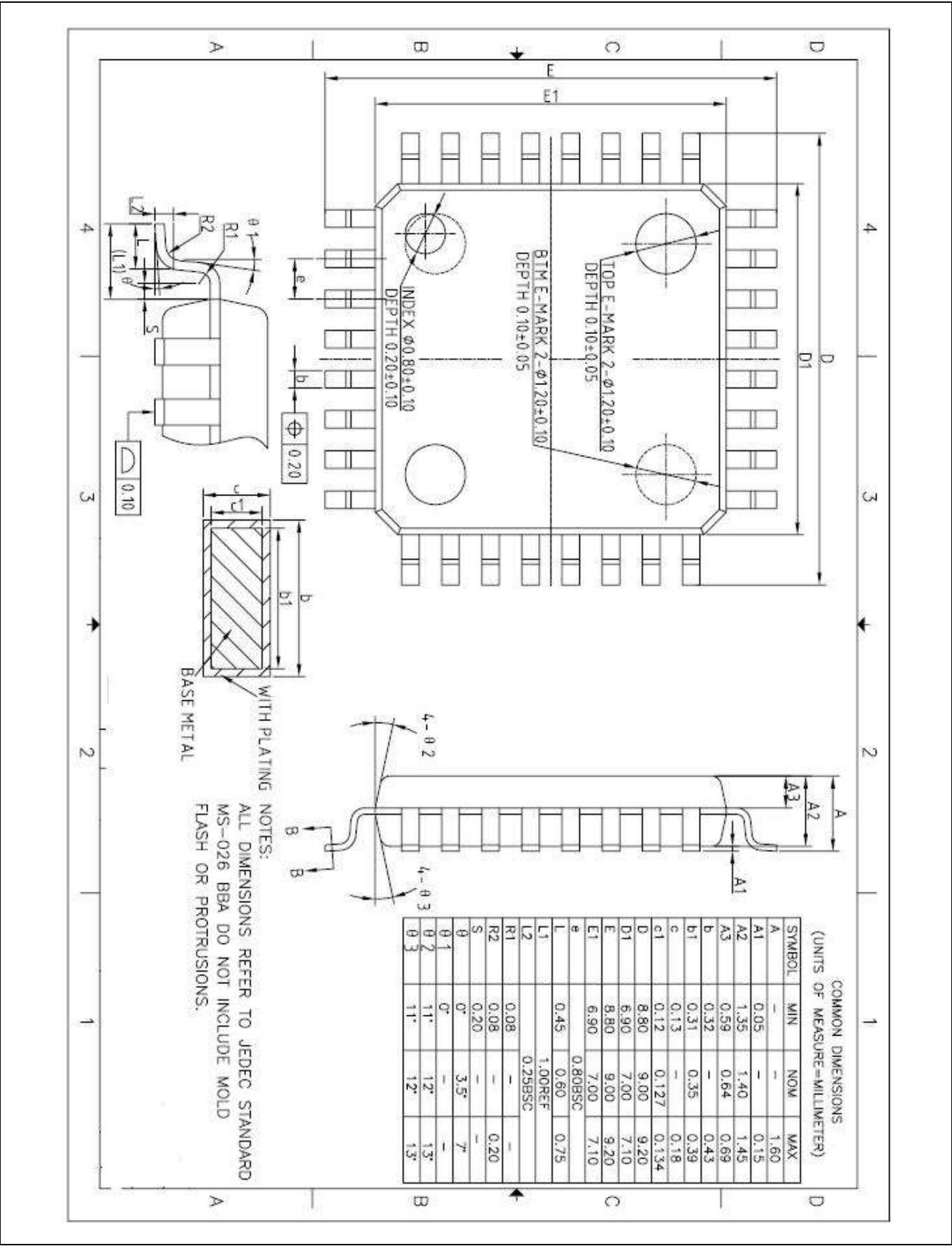


Figure 4.3 32-Pin LQFP Package

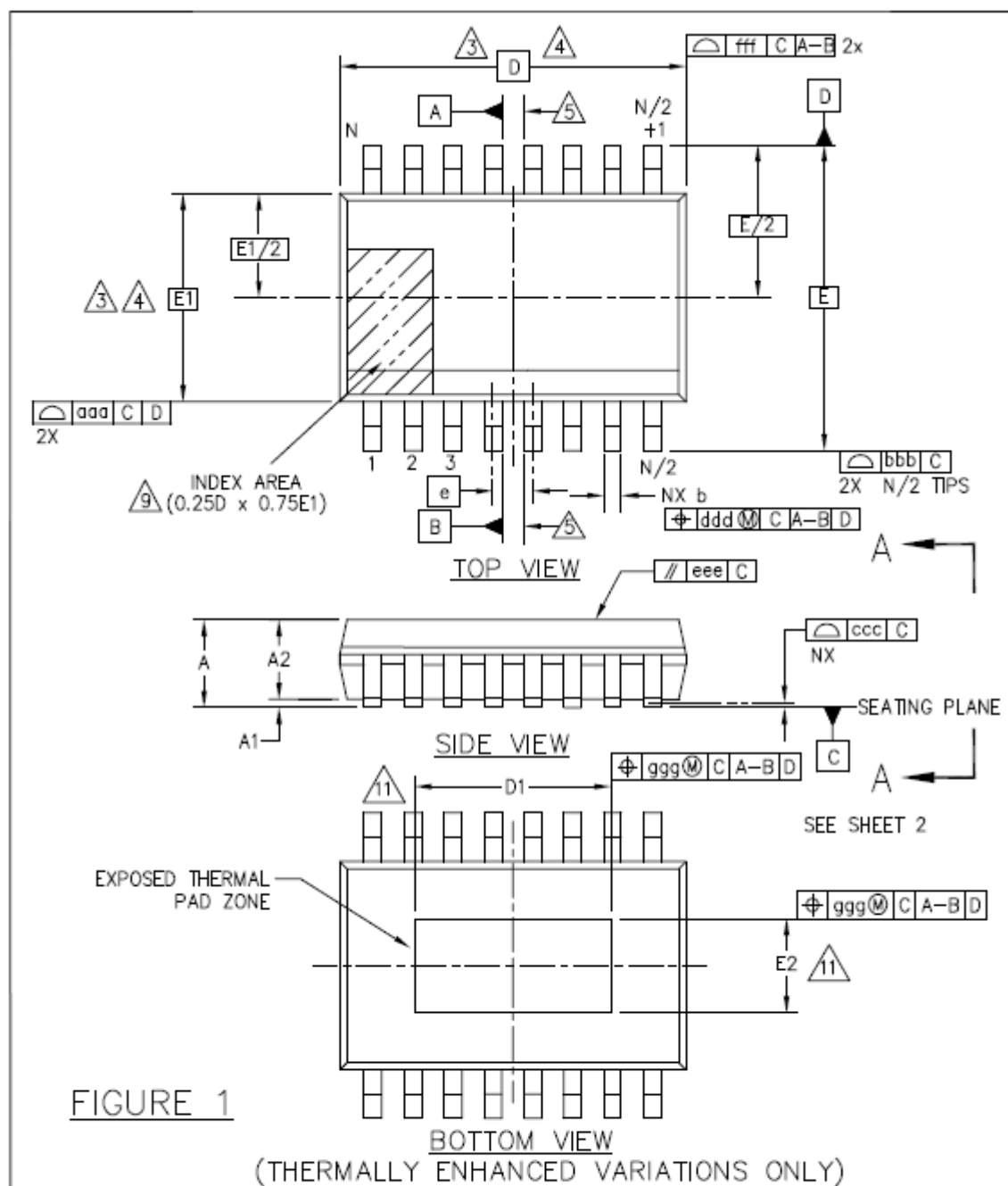


Figure 4.4 28-Pin SOP Package

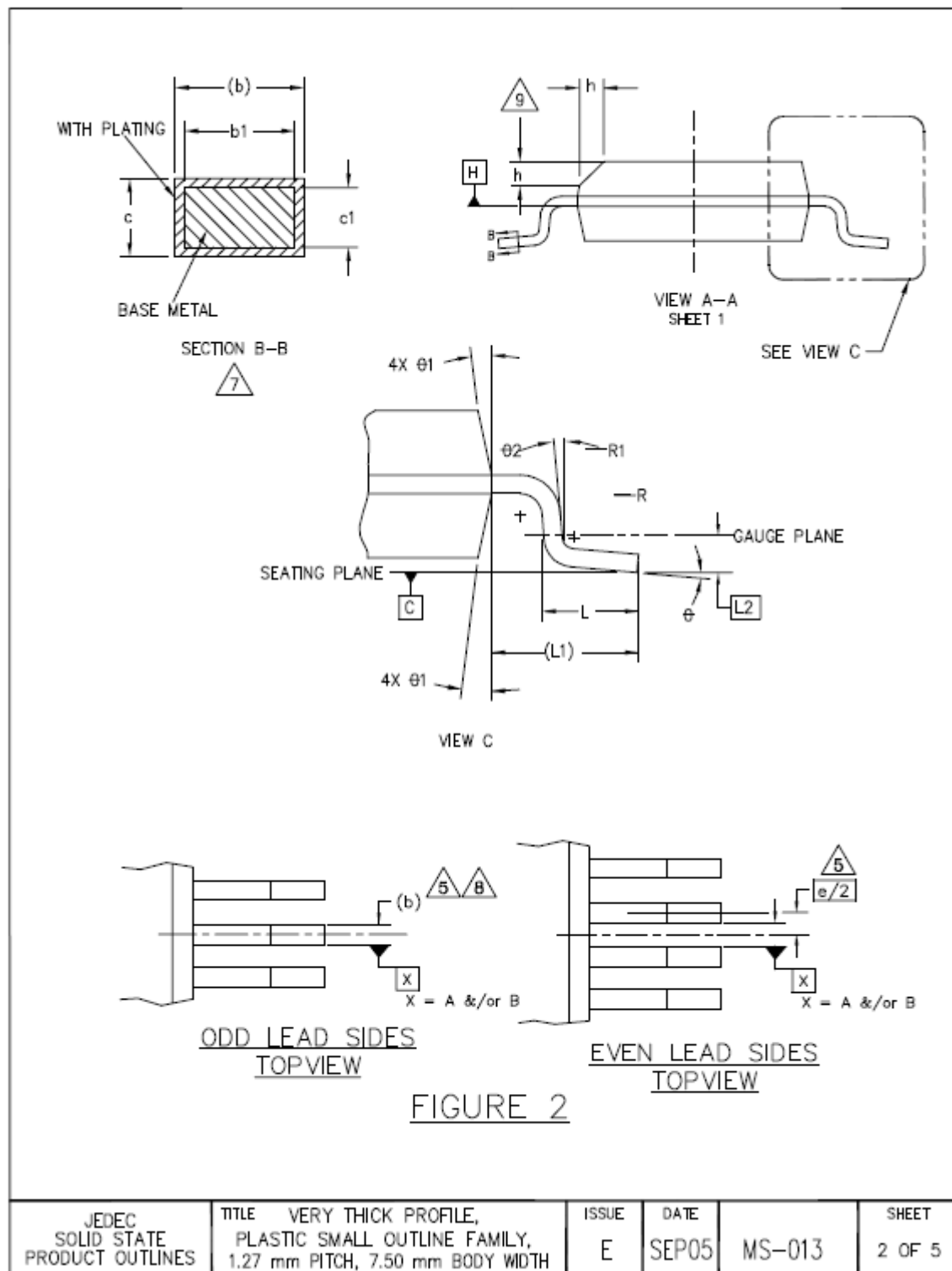


Figure 4.5 28-Pin SOP Package (continue)

SYMBOL	COMMON DIMENSIONS			NOTE
	MIN	NOM	MAX	
A2	2.05	—	—	
b	0.31	—	0.51	7,8
b1	0.27	—	0.48	7,8
c	0.20	—	0.33	7
c1	0.20	—	0.30	7
E	10.30 BSC			
E1	7.50 BSC			3,4
e	1.27 BSC			
L	0.40	—	1.27	
L1	1.40 REF			
L2	0.25 BSC			
R	0.07	—	—	
R1	0.07	—	—	
h	0.25	—	0.75	9
θ	0°	—	8°	
θ1	5°	—	15°	
θ2	0°	—	—	
NOTE	1,2			
REF	11-720S			
ISSUE	E			

SYMBOL	TOLERANCES OF FORM AND POSITION		NOTE
aaa	0.10		
bbb	0.33		
ccc	0.10		
ddd	0.25		
eee	0.10		
fff	0.20		
ggg	0.15		
NOTE	1,2		
REF	11-720S		
ISSUE	E		

VARIATION TABLES

STANDARD

VARIATION SYMBOL ▼		AA	AB	AC	AD	AE	AF	NOTE
A	MIN	---						
	NOM	---						
	MAX	2.65						
A1	MIN	0.10						10
	NOM	---						
	MAX	0.30						
D BSC		10.30	11.55	12.80	15.40	17.90	9.00	3,4
N		16	18	20	24	28	14	6
NOTE								
REF		11-720S						
ISSUE		E						

THERMAL

VARIATION SYMBOL ▼		BA	BB	BC	BD	BE	BF	NOTE
A	MIN	---						
	NOM	---						
	MAX	2.50						
A1	MIN	0.00						10
	NOM	---						
	MAX	0.15						
D BSC		10.30	11.55	12.80	15.40	17.90	9.00	3,4
D1	MIN	3.00	3.00	3.00	3.00	3.00	3.00	11
	NOM	---	---	---	---	---	---	
	MAX	---	---	---	---	---	---	
E2	MIN	2.00	2.00	2.00	2.00	2.00	2.00	11
	NOM	---	---	---	---	---	---	
	MAX	---	---	---	---	---	---	
N		16	18	20	24	28	14	6
NOTE								
REF		11-720S						
ISSUE		E						

JEDEC SOLID STATE PRODUCT OUTLINES	TITLE VERY THICK PROFILE, PLASTIC SMALL OUTLINE FAMILY, 1.27 mm PITCH, 7.50 mm BODY WIDTH	ISSUE E	DATE SEP05	MS-013	SHEET 3 OF 5
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Figure 4.6 28-Pin SOP Package (continue)

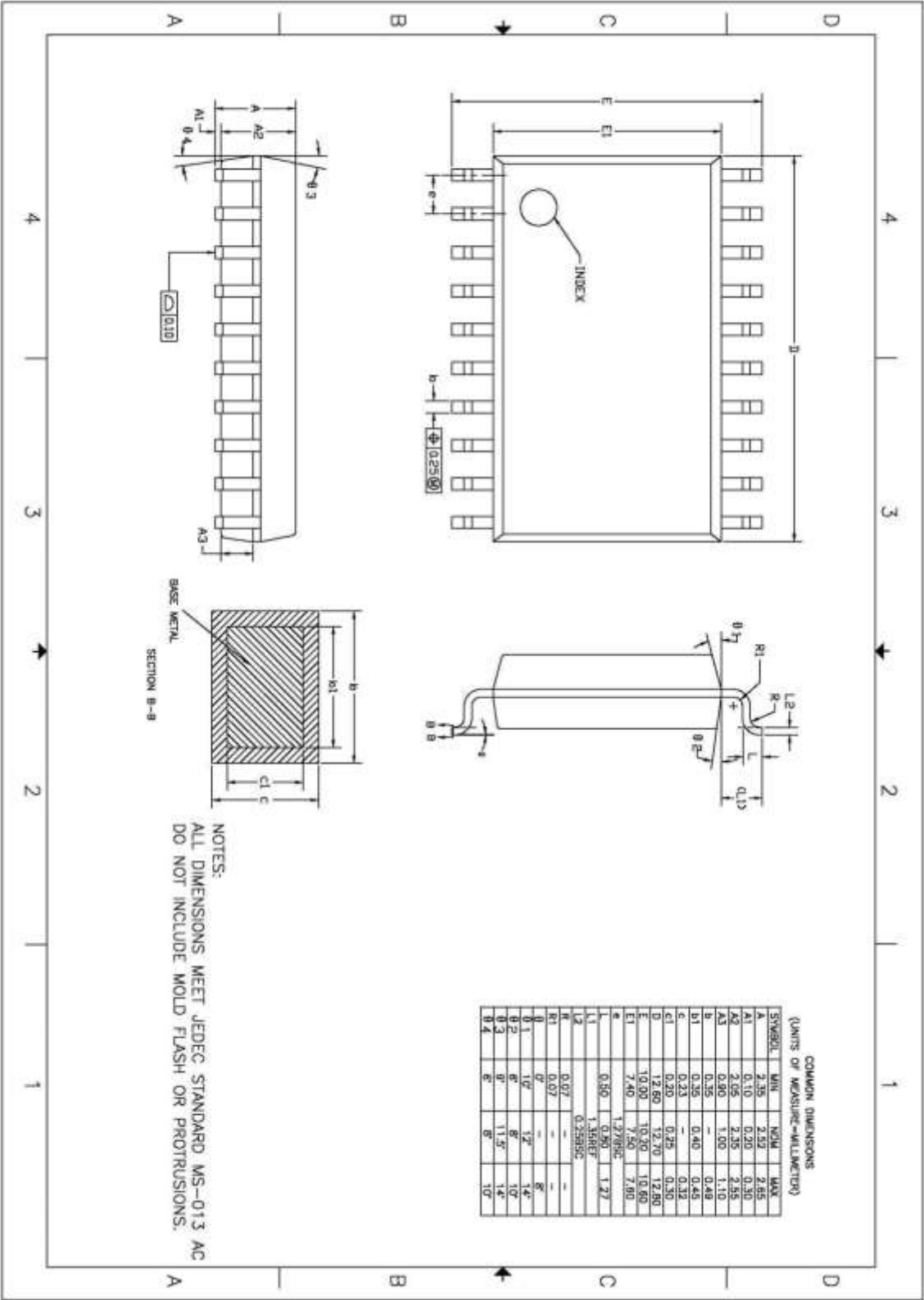


Figure 4.7 20-Pin SOP Package

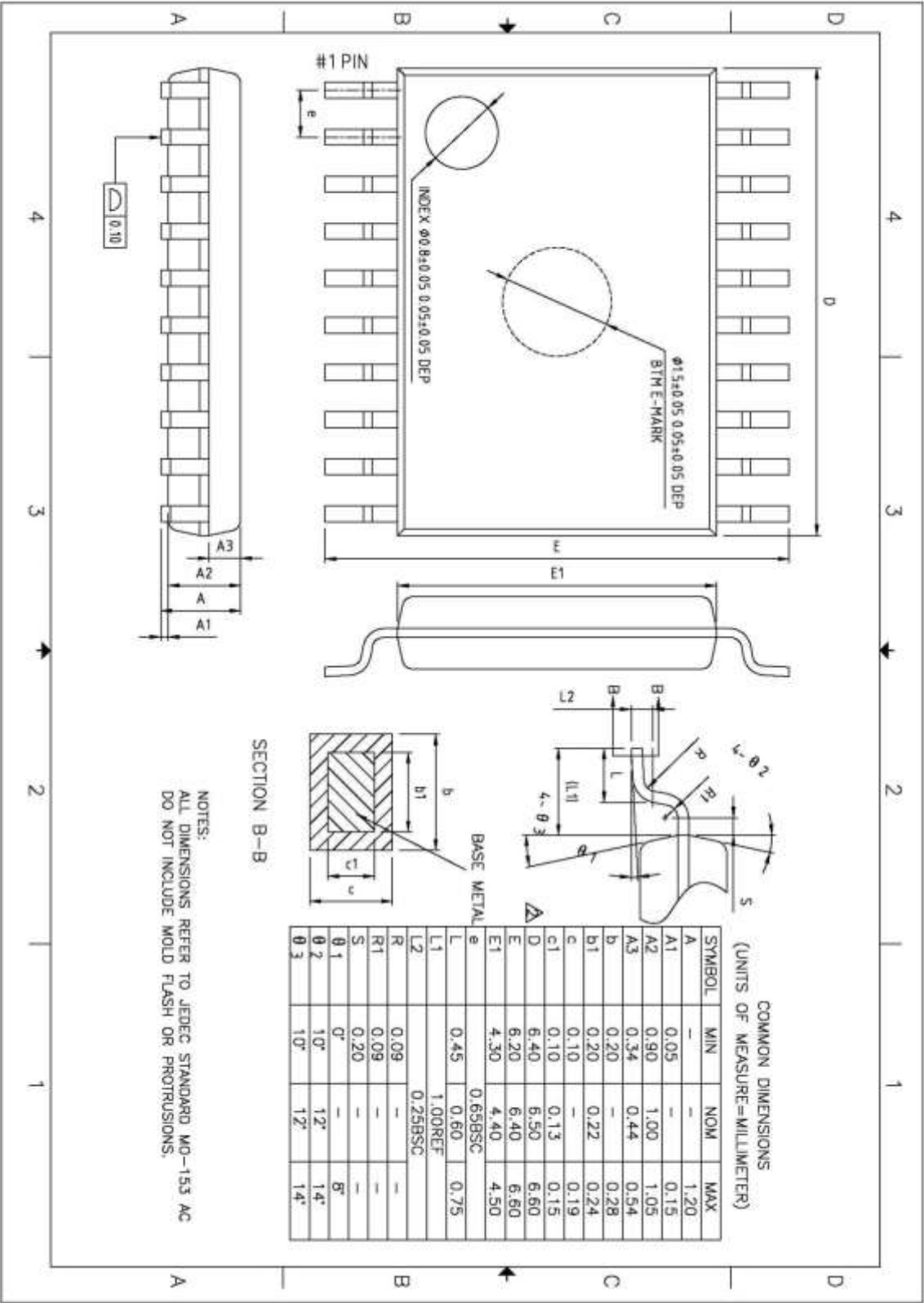


Figure 4.8 20-Pin TSSOP Package

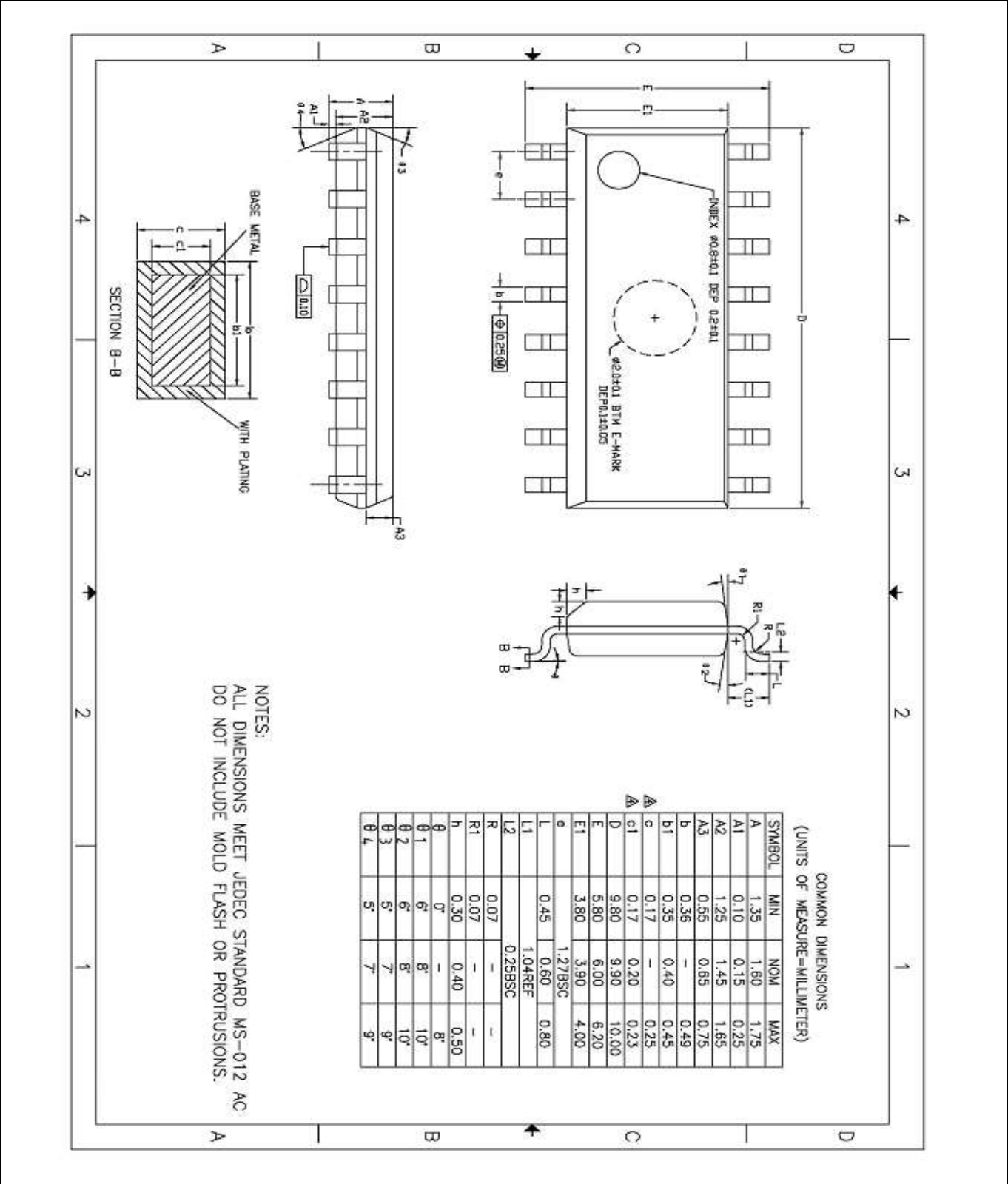


Figure 4.9 16-Pin SOP Package

Figure 4.10 16-Pin TSSOP Package

5 Pin Description

PIN Name	I/O	Function	@RESET	Shared with
P00	I/O	Port P0 8-bit I/O Port Can be set in input or output mode in 1-bit units Internal pull-up register can be used via software when this port is used as input port Open Drain enable register can be used via software when this port is used as output port AN0~AN7 can be selected by ADCM register	Input	Avref / AN0 / SS0
P01				AN1 / SCK0 / ACK0
P02				AN2 / T2O / MOSI0 / TxD0
P03				AN3 / EC2 / MISO0 / RxD0
P04				SXIN / AC- / AN4
P05				SXOUT / AC+ / AN5
P06				DSCL / ACOUT/ AN6/ T0O / SCL
P07				DSDA / AN7/ EC0 / SDA
P10	I/O	Port P1 7-bit I/O Port Can be set in input or output mode in 1-bit units Internal pull-up register can be used via software when this port is used as input port Open Drain enable register can be used via software when this port is used as output port AN8, AN9 can be selected by ADCM register	Input	PWM1AA / T1O / INT0
P11				PWM1AB / INT1
P12				PWM1BA / BUZ / INT2
P13				PWM1BB
P14				PWM1CA
P15				AN8 / PWM1CB
P16				AN9 / PWM3 / T3O / INT3
P20	I/O	Port P2 7-bit I/O Port Can be set in input or output mode in 1-bit units Internal pull-up register can be used via software when this port is used as input port Open Drain enable register can be used via software when this port is used as output port AN12, AN13, AN14 can be selected by ADCM register	Input	XIN
P21				XOUT
P22				RESETB
P23				AN12
P24				AN13
P25				AN14 / (SCL)
P26				(SDA)
P30	I/O	Port P3 8-bit I/O Port Can be set in input or output mode in 1-bit units Internal pull-up register can be used via software when this port is used as input port Open Drain enable register can be used via software when this port is used as output port AN10, AN11 can be selected by ADCM register	Input	INT4
P31				INT5
P32				INT6
P33				INT7
P34				SS1
P35				ACK1
P36				AN10 / TxD1
P37				AN11 / RxD1

Table 5.1 Normal Pin Description

6 Port Structures

6.1 General Purpose I/O Port

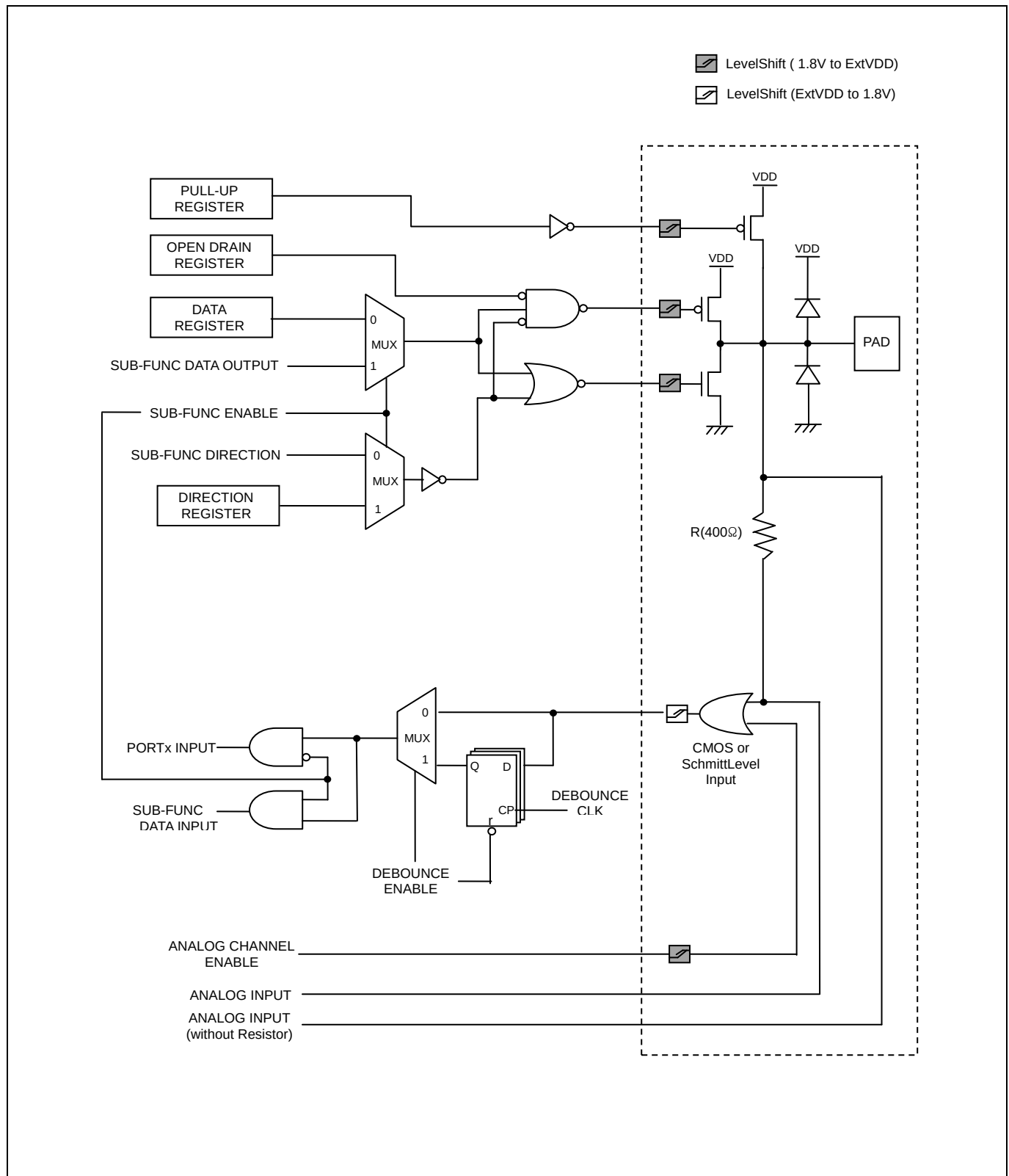


Figure 6.1 General Purpose I/O Port

6.2 External Interrupt I/O Port

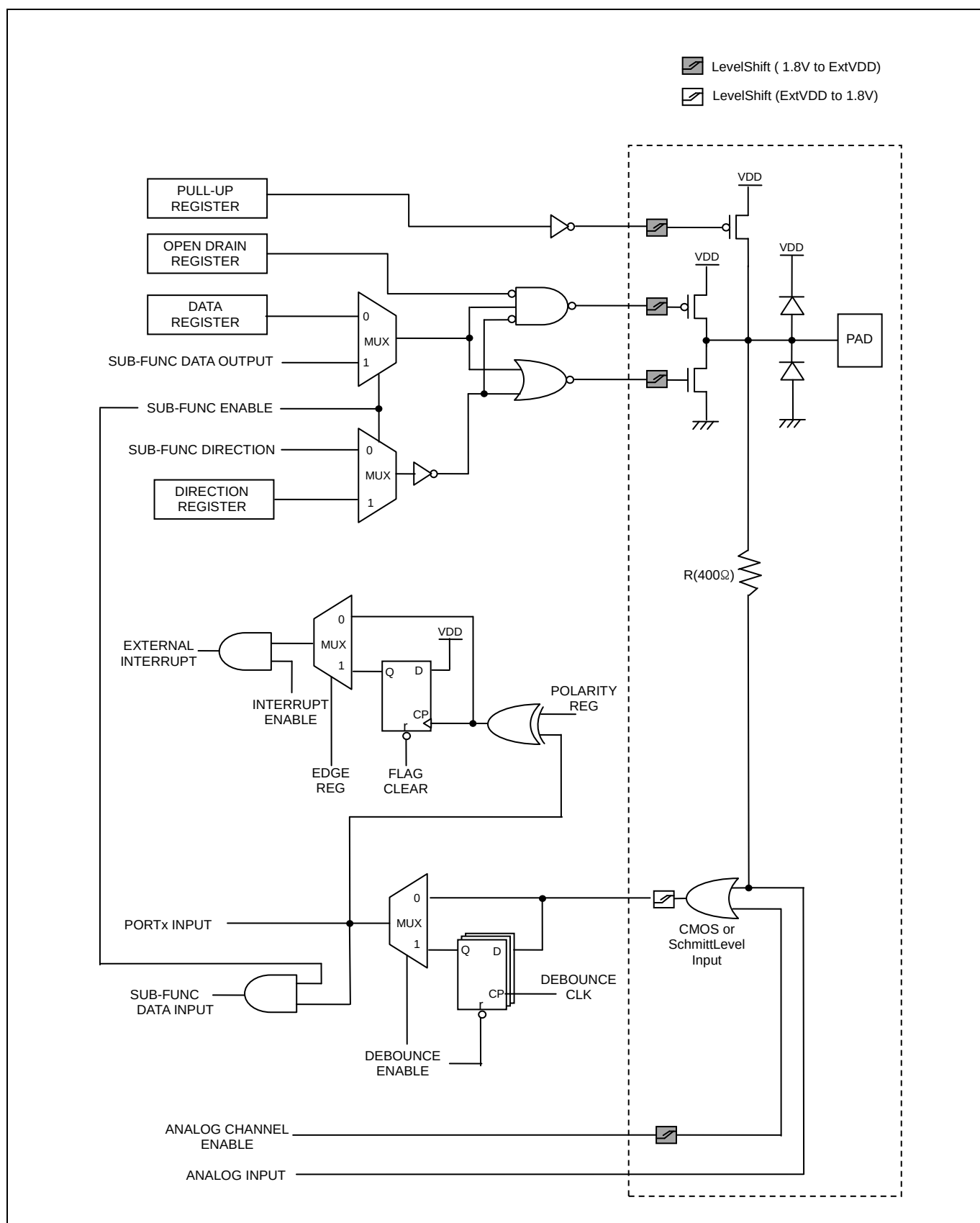


Figure 6.2 External Interrupt I/O Port

7 Electrical Characteristics

7.1 Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply Voltage	VDD	-0.3~+6.5	V
	VSS	-0.3~+0.3	V
Normal Voltage Pin	VI	-0.3~VDD+0.3	V
	VO	-0.3~VDD+0.3	V
	IOH	10	mA
	Σ IOH	80	mA
	IOL	20	mA
	Σ IOL	160	mA
Total Power Dissipation	PT	600	mW
Storage Temperature	TSTG	-65~+150	°C

Table 7.1 Absolute Maximum Ratings

NOTE)

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

7.2 Recommended Operating Conditions

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Supply Voltage	VDD	fXIN=1~12MHz	4.5	-	5.5	V
		fXIN=1~8MHz	1.8			
		fSUB=32.768kHz				
Operating Temperature	TOPR	VDD=1.8~5.5V	-40	-	85	℃
Operating Frequency	FOPR	fXIN	1	-	12	MHz
		fSUB	-	32.768	-	kHz
		Internal RC-OSC	7.76	8	8.24	MHz
		Internal Ring-OSC	-	1		MHz

Table 7.2 Recommended Operating Conditions

7.3 A/D Converter Characteristics

(TA=-40℃ ~ +85℃, VDD=AVDD=2.7V ~ 5.5V, VSS=0V)

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
A/D converting Resolution	-	-	-	12	-	bits
Integral Linearity Error	ILE	Vref=5.12V, Vss=0V, TA=+25℃	-	-	±3	LSB
Differential Linearity Error	DLE		-	-	±2	
Offset Error of Top	EOT		-	-±1	±3	
Zero Offset Error	EOB		-	±1	±3	
Overall Accuracy	-		-	±3	-	
Conversion Time	tCONV	-	-	60	-	Cycle
Analog Input Voltage	VAIN	-	VSS	-	Vref	V
Analog Reference Voltage	Vref	(note)	1.8	-	5.5	V
Analog Input Current	IAIN	VDD=Vref=5V	-	-	10	uA
Analog Block Current	IAVDD	VDD=Vref=5V	-	1	3	mA
		VDD=Vref=3V	-	0.5	1.5	
		VDD=Vref=5V Power down mode	-	100	500	nA
BGR	-	VDD=5V, TA=+25℃	-	1.67	-	V
		VDD=4V, TA=+25℃	-	1.63	-	
		VDD=3V, TA=+25℃	-	1.62	-	

Table 7.3 A/D Converter Characteristics

(note) When AVREF is lower than 2.7V, the ADC resolution is worse

7.4 Analog Comparator Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Input Leakage Current	IL	VDDEXT=5V, Vin=1/2VDDEXT	-50	-	50	nA
Input Offset Voltage	Voffset	VDDEXT=5V, Vin=1/2VDD	10	-	40	±mV
Operating Current	IOP	COMP_EN=H	-	1	-	mA
Power Down Current	IPD	COMP_EN=L	-	1	-	uA
Response Time	VRT	CL= 50pF, VDDEXT=5V	-	-	500	ns

Table 7.4 Analog Comparator Characteristics

7.5 Voltage Dropout Converter Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Operating Voltage		-	1.8	-	5.5	V
Operating Temperature		-	-40	-	+85	°C
Regulation Voltage		-	1.62	1.8	1.98	V
Drop-out Voltage		-	-	-	0.02	V
Current Drivability		RUN/IDLE	-	20	-	mA
		SUB-ACTIVE	-	1	-	mA
		STOP1	-	50	-	uA
		STOP2	-	10	-	uA
Operating Current	IDD1	RUN/IDLE	-	-	1	mA
	IDD2	SUB-ACTIVE	-	-	0.1	mA
	SIDD1	STOP1	-	-	5	uA
	SIDD2	STOP2	-	-	0.1	uA
Drivability Transition Time	TRAN1	SUB to RUN	-	-	1	us
	TRAN2	STOP to RUN	-	-	200	us

Table 7.5 Voltage Dropout Converter Characteristics

NOTE)

1. -STOP1: WDT running - STOP2: WDT disable

7.6 Power-On Reset Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Operating Voltage		-	VSS	-	5.5	V
Operating Temperature		-	-40	-	+85	°C
RESET Release Level		-	1.3	1.4	1.5	V
Operating Current	IDD	-	-	-	10	uA
	SIDD	-	-	-	1	uA

Table 7.6 Power-On Reset Characteristics

7.7 Brown Out Detector Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Operating Voltage		-	VSS	-	5.5	V
Operating Temperature		-	-40	-	+85	°C
Detection Level	4.2V	-	4.0	-	4.4	V
	3.6V	-	3.4	-	3.8	V
	2.5V	-	2.3	-	2.7	V
	1.6V	-	1.4	-	1.8	V
Hysteresis		-	-	-	-	mV
Operating Current	IDD	-	-	-	50	uA
	SIDD	-	-	-	1	uA

Table 7.7 Brown Out Detector Characteristics

7.8 Internal RC Oscillator Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Operating Voltage		-	1.8	-	5.5	V
Operating Temperature		-	-40	-	+85	°C
Frequency		-	7.76		8.24	MHz
Stabilization Time		-	-	-	10	ms
Operating Current	IDD	-	-	-	-	uA
	SIDD	-	-	-	1	uA

Table 7.8 Internal RC Oscillator Characteristics

7.9 Ring-Oscillator Characteristics

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Operating Voltage		-	1.8	-	5.5	V
Operating Temperature		-	-40	-	+85	°C
Frequency		-	-	1	-	MHz
Stabilization Time		-	-	-	-	ms
Operating Current	IDD	-	-	-	-	uA
	SIDD	-	-	-	1	uA

Table 7.9 Ring-Oscillator Characteristics

7.10 PLL Characteristics

(TA = 0°C ~ +70°C, VDD18 = 1.6V ~ 2.0V, VSS = 0V)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
PLL current	IPLL	-	-	1.5	TBD	mA
Input clock frequency	fxin	-	2	-	16	MHz
Output clock frequency	fout	-	6.25	-	128	MHz
Output clock duty	-	-	40	-	60	%
Setting time	tD	-	-	1	-	ms
Accuracy	-	-	-	2	-	%

Table 7.10 PLL Characteristics

7.11 DC Characteristics

(VDD =2.7~5.5V, VSS =0V, fXIN=10.0MHz, TA=-40~+85℃)

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Input Low Voltage	VIL1	P2[2]	-0.5	-	0.2VDD	V
	VIL2	All others PAD	-0.5	-	0.2VDD	V
Input High Voltage	VIH1	P2[2]	0.8VDD	-	VDD	V
	VIH2	All others PAD	0.7VDD	-	VDD	V
Output Low Voltage	VOL1	ALL I/O (IOL=20mA, VDD=4.5V)	-	-	1	V
Output High Voltage	VOH1	ALL I/O (IOH=-8.57mA, VDD=4.5V)	3.5	-	-	V
Input High Leakage Current	IIH	ALL PAD	-	-	1	uA
Input Low Leakage Current	IIL	ALL PAD	-1	-	-	uA
Pull-Up Resister	RPU	ALL PAD	20	-	50	kΩ
Power Supply Current	IDD1	Run Mode, fXIN=12MHz @5V	-	*2.6	10	mA
	IDD2	Sleep Mode, fXIN=12MHz @5V	-	*1.5	5	mA
	IDD3	Sub Active Mode, fSUBXIN=32.768kHz @5V	-	*71	500	uA
	IDD4	STOP1 Mode, WDT Active @5V (BOD enable)	-	*45	200	uA
	IDD5	STOP1 Mode, WDT Active @5V (BOD disable)	-	*20	100	uA
	IDD6	STOP2 Mode, WDT Disable @5V (BOD enable)	-	*27	100	uA
	IDD7	STOP2 Mode, WDT Disable @5V (BOD disable)	-	*1	7 (room temp)	uA

Table 7.11 DC Characteristics

NOTE)

1. STOP1: WDT running, STOP2: WDT disable.
2. (*) typical test condition : VDD=5V, Internal RC-OSC=8MHz, ROOM TEMP, all PORT output LOW, Timer0 Active, 1PORT toggling

7.12 AC Characteristics

(VDD=5.0V±10%, VSS=0V, TA=-40~+85℃)

Parameter	Symbol	PIN	MIN	TYP	MAX	Unit
Operating Frequency	fMCP	XIN	1	-	10	MHz
System Clock Cycle Time	tSYS	-	100	-	1000	ns
Oscillation Stabilization Time (8MHz)	tMST1	XIN, XOUT	-	-	10	ms
External Clock "H" or "L" Pulse Width	tCPW	XIN	90	-	-	ns
External Clock Transition Time	tRCP,tFCP	XIN	-	-	10	ns
External Interrupt Input Width	tIW	INT0~INTx	2	-	-	tSYS
External Interrupt Transition Time	tFI,tRI	INT0~INTx	-	-	1	us
nRESET Input Pulse "L" Width	tRST	nRESET	8	-	-	tSYS
External Counter Input "H" or "L" Pulse Width	tECW	EC0~ECx	2	-	-	tSYS
Event Counter Transition Time	tREC,tFEC	EC0~ECx	-	-	20	ns

Table 7.12 AC Characteristics

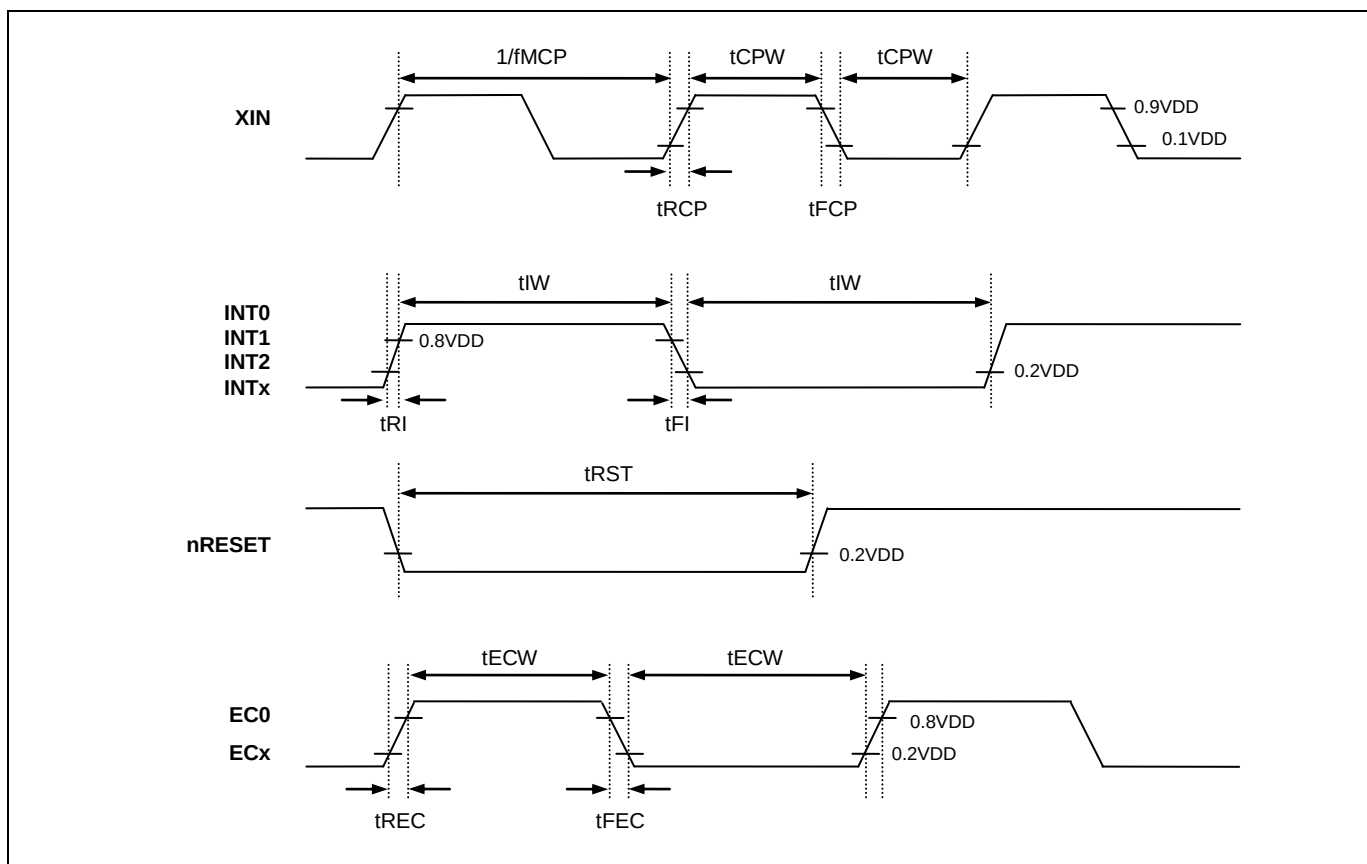


Figure 7.1 AC Timing

7.13 SPI Characteristics

(VDD=5.0V±10%, VSS=0V, TA=-40~+85℃)

Parameter	Symbol	PIN	MIN	TYP	MAX	Unit
Output Clock Pulse Period	tSCK	SCK	-	SPI clock mode	-	ns
Input Clock Pulse Period	tSCK	SCK	2• tSYS	-	-	ns
Input Clock "H" or "L" Pulse Width	tSCKL, tSCKH	SCK		50% duty	-	ns
Input Clock Pulse Transition Time	tFSCK, tRSCK	SCK	-	-	30	ns
Output Clock "H" or "L" Pulse Width	tSCKL, tSCKH	SCK	tSYS-30	-	-	ns
Output Clock Pulse Transition Time	tFSCK, tRSCK	SCK	-	-	30	ns
First Output Clock Delays Time	tFOD	OUTPUT				
Output Clock Delay Time	tDS	OUTPUT	-	-	100	ns
Input Pulse Transition Time	tFSIN, tRSIN	INPUT	-	-	30	ns
Input Setup Time	tDIS	INPUT	100		-	ns
Input Hold Time	tDIH	INPUT	tSYS+70	-	-	ns

Table 7.13 SPI Characteristics

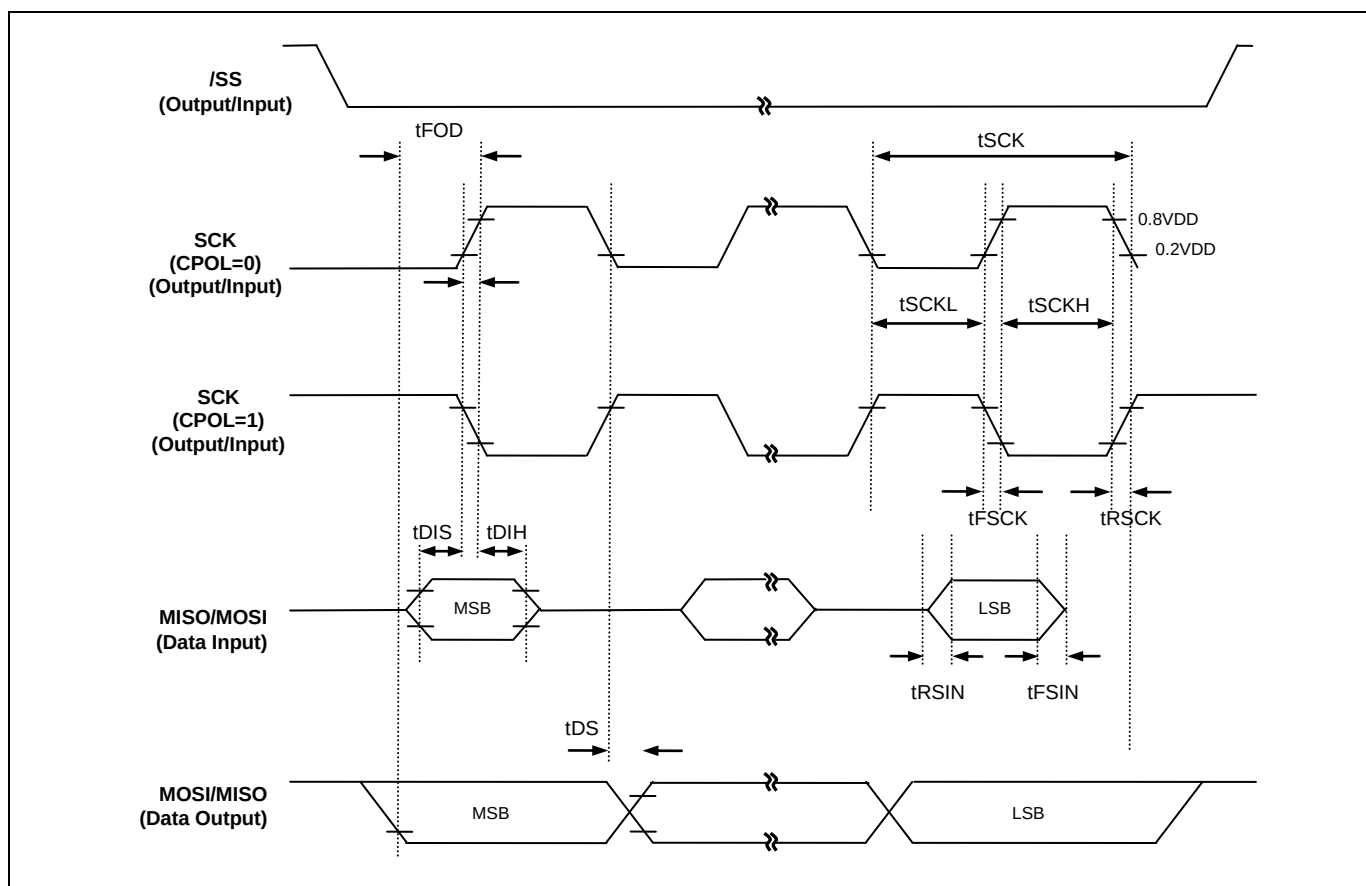


Figure 7.2 SPI Timing

7.14 Main Clock Oscillator Characteristics

(VDD=5.0V±10%, VSS=0V, TA=-40~+85℃)

Parameter	MIN	TYP	MAX	ETC
Operating Voltage (VDDEXT)	1.5V		5.5V	
TEMP	-40℃		85℃	
IDD	-	660uA	-	@4Mhz, VDDEXT(+5V)
Operating Frequency	-		12Mhz	
Ext. Load Cap	5pF	22pF	35pF	C1,C2

Table 7.14 Main Clock Oscillator Characteristics

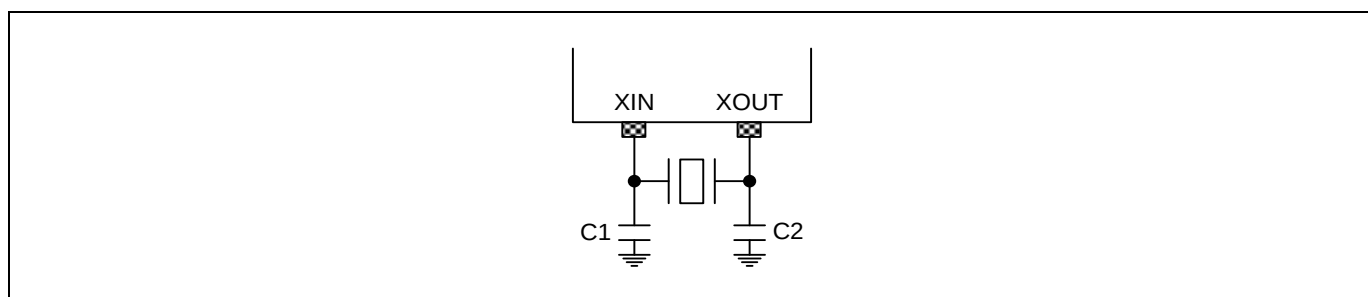


Figure 7.3 Crystal Oscillator

7.15 Sub Clock Oscillator Characteristics

(VDD=5.0V±10%, VSS=0V, TA=-40~+85℃)

Parameter	MIN	TYP	MAX	ETC
Operating Voltage	-	1.8V	-	
TEMP	-40℃	-	85℃	
IDD	-	3uA	-	
Operating Frequency	-	32.768kHz	-	
Ext. Load Cap	5pF	15pF	20pF	C1,C2

Table 7.15 Sub Clock Oscillator Characteristics

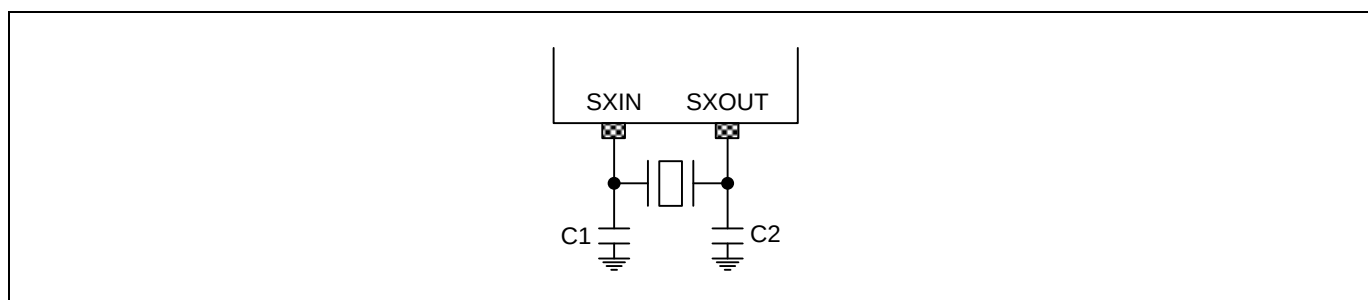


Figure 7.4 Sub-Crystal Oscillator

7.16 Typical Characteristics

These graphs and tables provided in this section are for design guidance only and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g. outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3σ) and (mean - 3σ) respectively where σ is standard deviation.

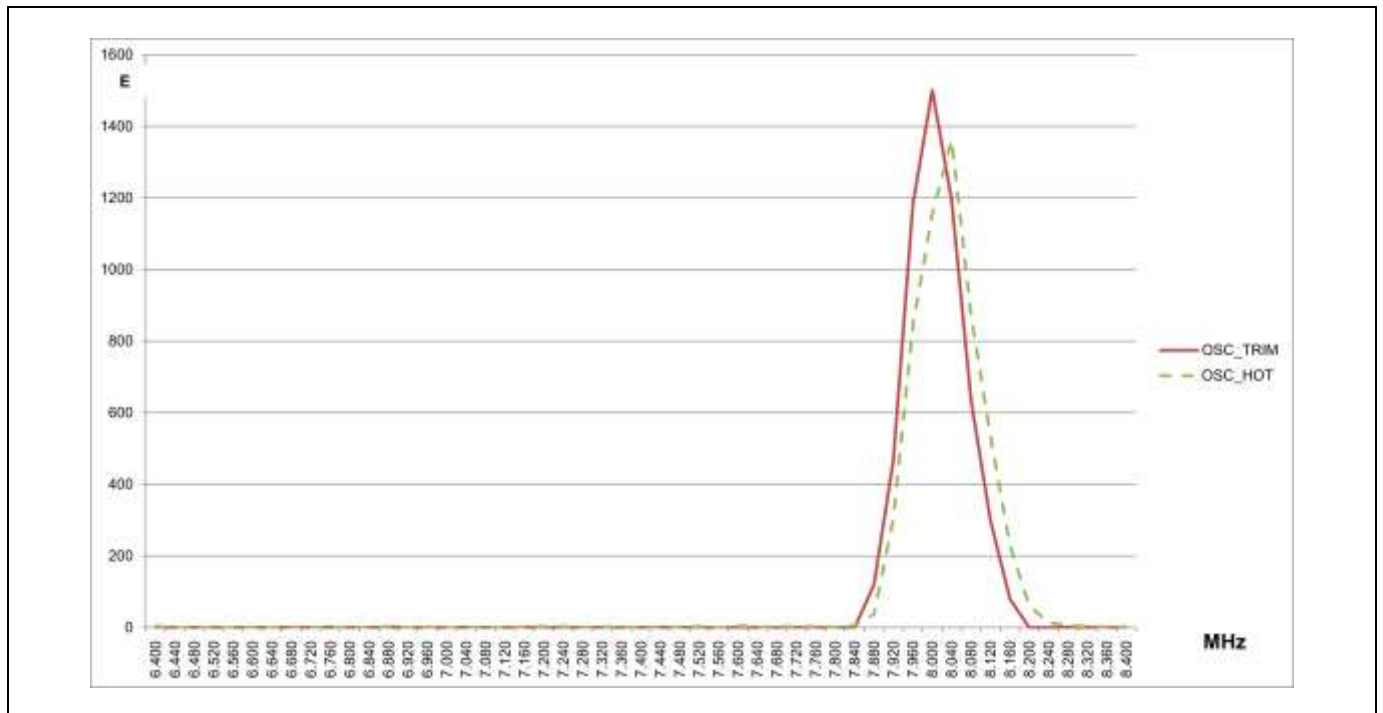


Figure 7.5 8MHz Internal OSC Freq.(OSC_HOT: 85°C)

8 Memory

The MC95FG308 addresses two separate address memory stores: Program memory and Data memory. The logical separation of Program and Data memory allows Data memory to be assessed by 8-bit addresses, which can be more quickly stored and manipulated by 8-bit CPU. Nevertheless, 16-bit Data memory addresses can also be generated through the DPTR register.

Program memory can only be read, not written to. There can be up to 64Kbytes of Program memory. In the MC95FG308 FLASH version of these devices the 8Kbytes of Program memory are provided on-chip. Data memory can be read and written to up to 256bytes internal memory (DATA) including the stack area.

8.1 Program Memory

A 16-bit program counter is capable of addressing up to 64Kbytes, but this device has just 8Kbytes program memory space.

Figure 8.1 shows a map of the lower part of the program memory. After reset, the CPU begins execution from location 0000H. Each interrupt is assigned a fixed location in program memory. The interrupt causes the CPU to jump to that location, where it commences execution of the service routine. External interrupt 0, for example, is assigned to location 0003H. If external interrupt 0 is going to be used, its service routine must begin at location 0003H. If the interrupt is not going to be used, its service location is available as general purpose program memory. If an interrupt service routine is short enough (as is often the case in control applications), it can reside entirely within that 8-byte interval. Longer service routines can use a jump instruction to skip over subsequent interrupt locations, if other interrupts are in use.

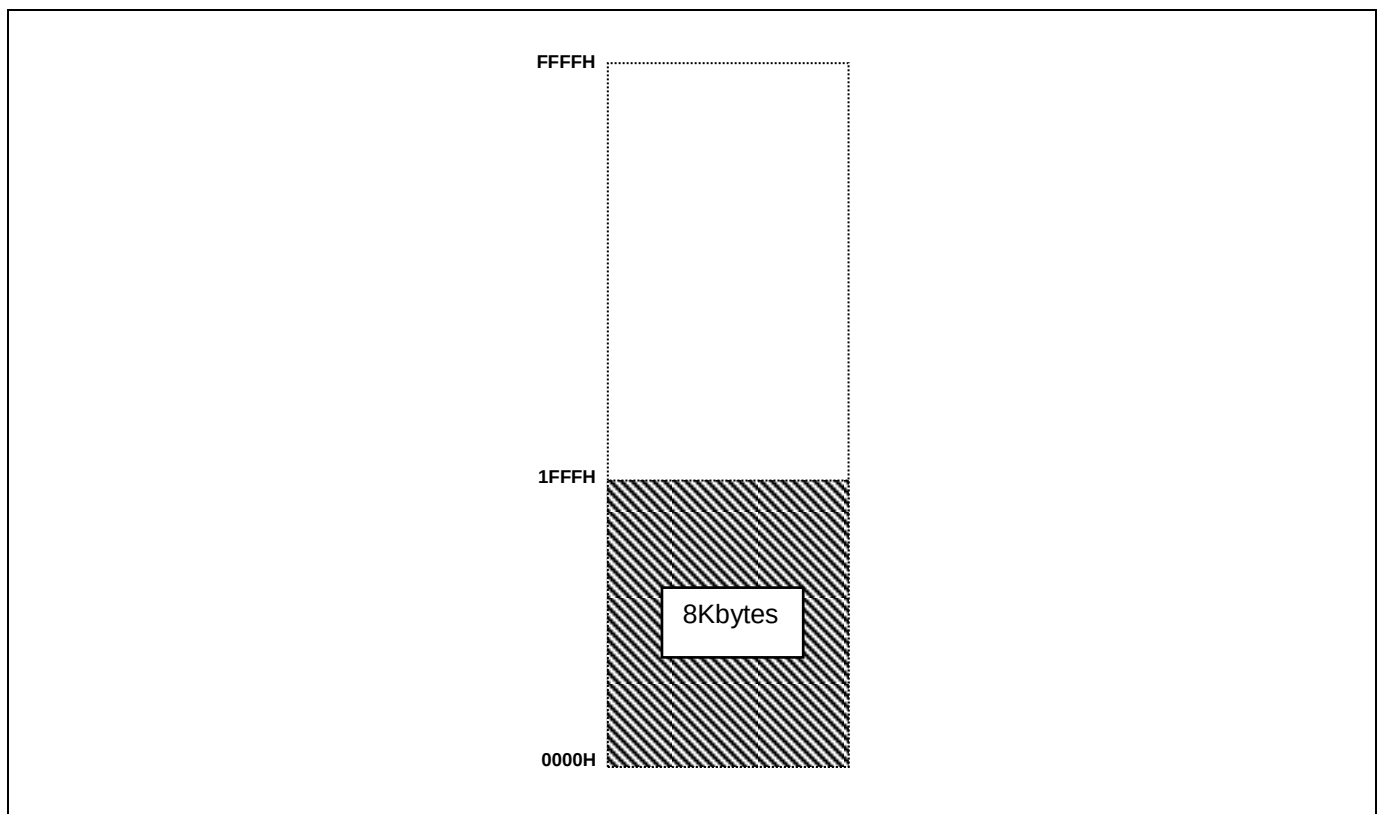


Figure 8.1 Program Memory

- User Function Mode: 8Kbytes Included Interrupt Vector Region
- Non-volatile and reprogramming memory: Flash memory based on EEPROM cell

8.2 Data Memory

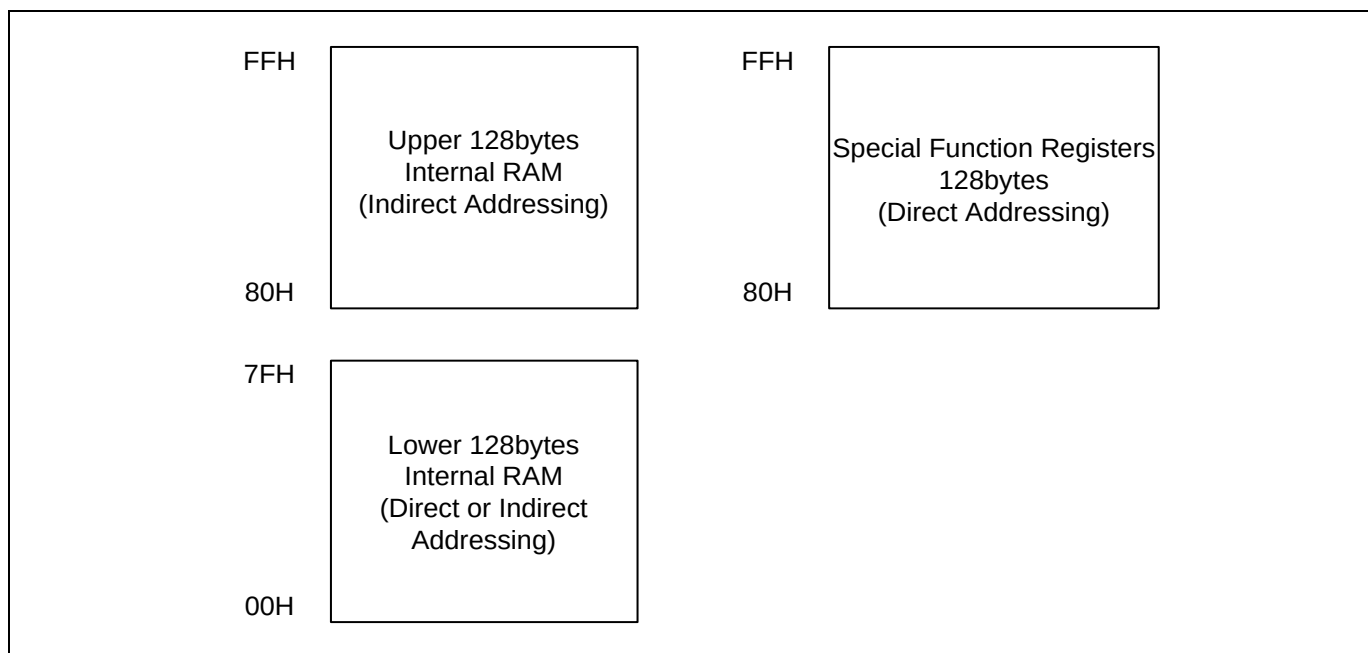


Figure 8.2 Data Memory Map

The internal data memory space is divided into three blocks, which are generally referred to as the lower 128bytes, upper 128bytes, and SFR space.

Internal data memory addresses are always one byte wide, which implies an address space of only 256bytes. However, in fact the addressing modes for internal RAM can accommodate up to 384bytes by using a simple trick. Direct addresses higher than 7FH access one memory space and indirect addresses higher than 7FH access a different memory space. Thus Figure 8.2 shows the upper 128bytes and SFR space occupying the same block of addresses, 80H through FFH, although they are physically separate entities.

The lower 128bytes of RAM are present in all 8051 devices as mapped in Figure 8.3. The lowest 32bytes are grouped into 4 banks of 8 registers. Program instructions call out these registers as R0 through R7. Two bits in the Program Status Word select which register bank is in use. This allows more efficient use of code space, since register instructions are shorter than instructions that use direct addressing.

The next 16bytes above the register banks form a block of bit-addressable memory space. The 8051 instruction set includes a wide selection of single-bit instructions, and the 128 bits in this area can be directly addressed by these instructions. The bit addresses in this area are 00H through 7FH.

All of the bytes in the lower 128bytes can be accessed by either direct or indirect addressing. The upper 128bytes RAM can only be accessed by indirect addressing. These spaces are used for data RAM and stack.

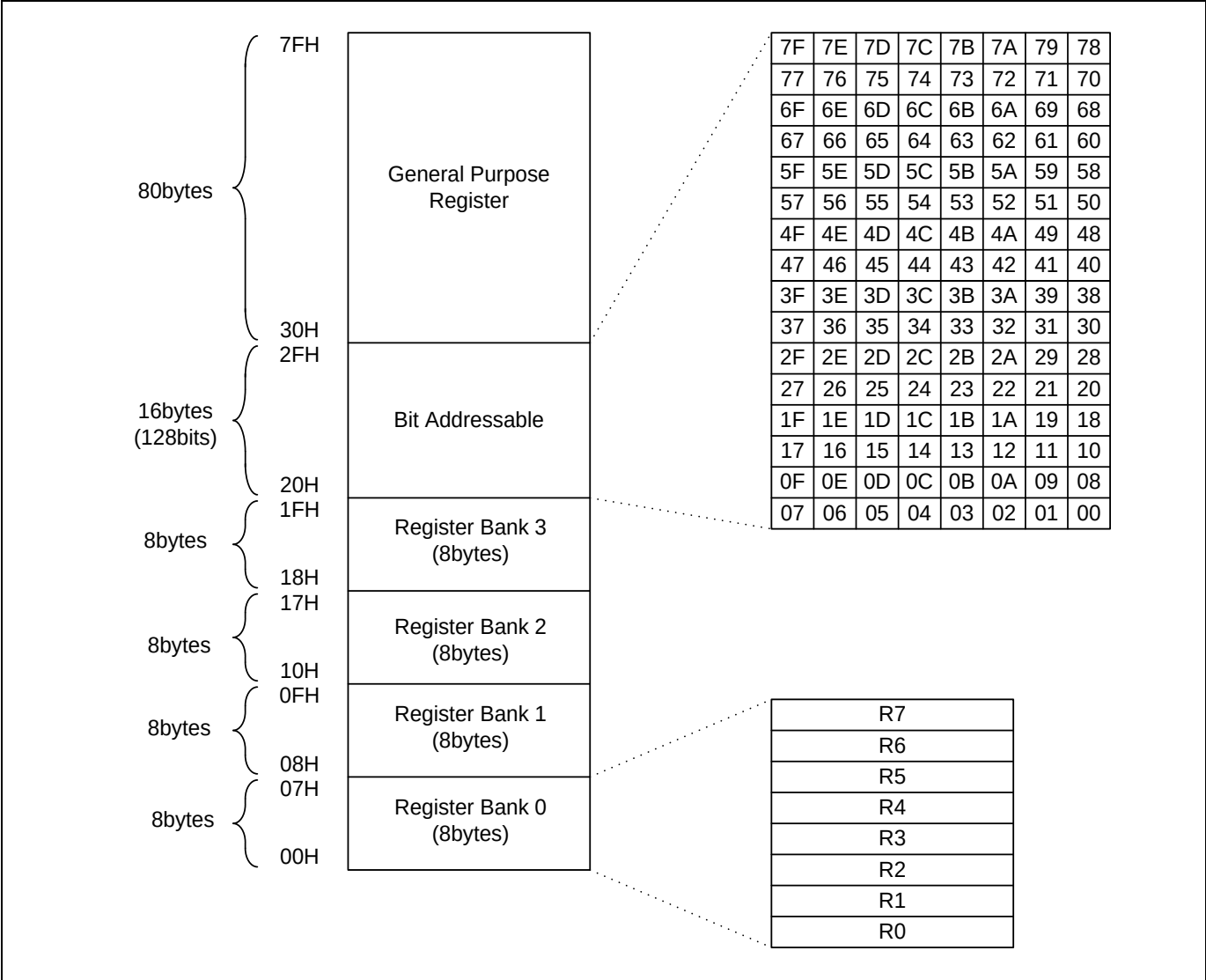


Figure 8.3 Lower 128bytes RAM

8.3 EEPROM Data Memory and XSRAM

MC95FG308 has 512bytes EEPROM Data memory. This area has no relation with RAM/FLASH. It can read and write through SFR with 8-bit unit.

For more information about EEPROM Data memory, see chapter 15.

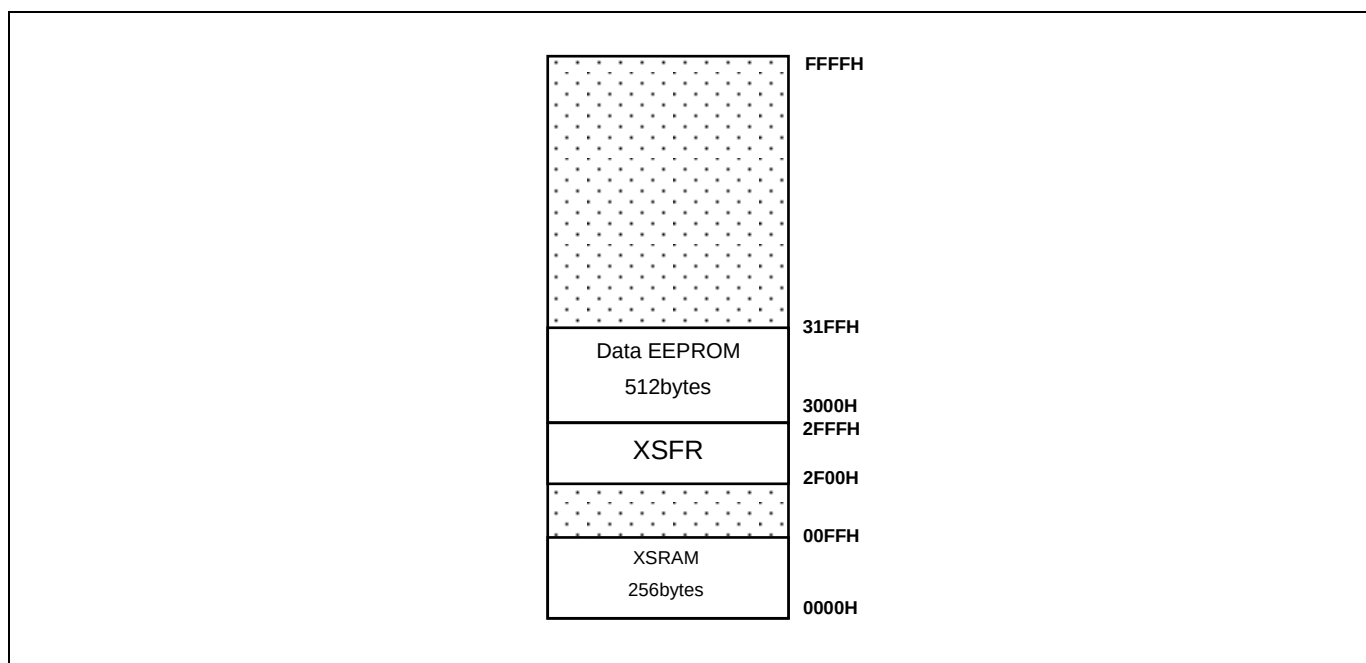


Figure 8.4 XDATA Memory Area

8.4 SFR Map

8.4.1 SFR Map Summary

	0H/8H	1H/9H	2H/AH	3H/BH	4H/CH	5H/DH	6H/EH	7H/FH
2F58H	-	FUSE_PKG	FUSE_CAL2	FUSE_CAL1	FUSE_CAL0	FUSE_CONF	TEST_REGB	TEST_REGA
2F50H	PSR0	PSR1	PSR2	-	-	-	-	-
2F48H	-	-	-	-	-	-	-	-
2F40H	-	-	-	-	-	-	-	-
2F38H	-	-	-	-	-	-	-	-
2F30H	-	-	-	-	-	-	-	-
2F28H	-	-	-	-	-	-	-	-
2F20H	-	-	-	-	-	-	-	-
2F18H	P0DB	P1DB	P2DB	P3DB	-	-	-	-
2F10H	-	-	-	-	-	-	-	-
2F08H	-	-	-	-	P00D	P10D	P20D	P30D
2F00H	P0PU	P1PU	P2PU	P3PU	-	-	-	-
F8H	IP1	ACCSR	UCTRL11	UCTRL12	UCTRL13	USTAT1	UBAUD1	UDATA1
F0H	B	-	FEARL	FEARM	FEARH	FEDR	FETR	-
E8H	-	-	FEMR	FECR	FESR	FETCR	-	-
E0H	ACC	-	UCTRL1	UCTRL2	UCTRL3	USTAT	UBAUD	UDATA
D8H	-	-	I2CMR	I2CSR	I2CSCLLR	I2CSCLHR	I2CSDHR	I2CDR
D0H	PSW	-	SPICR	SPIDR	SPISR	T4H	I2CSAR1	I2CSAR
C8H	-	-	T3CR	T3DR / PWM3PR	T3 / PWM3DR / CDR3	PWM3HR	T4CR	T4L
C0H	-	-	T2DLYB	T1DLYC	T1ISR	T1IMSK	T2CR	T2 / T2DR / CDR2
B8H	IP	-	T1BDR	T1CDR	T1PHR	T1PCR2	T1PCR3	T1DLYA
B0H	-	-	T0CR	T0 / T0DR / CDR0	T1CR	T1DR / T1PPR	T1 / T1ADR / CDR1	T1PCR
A8H	IE	IE1	IE2	IE3	IE4	IE5	PCIO	TMISR
A0H	-	P3IO	EO	EIENAB	EIFLAG	EIEDGE	EIPOLA	EIBOTH
98H	P3	P2IO	ADCM	ADCM2 / ADCRH	ADCRL	WTMR	WTR / WTCR	BUZCR
90H	P2	P1IO	-	-	-	-	-	-
88H	P1	P0IO	SCCR	BCCR	BITR	WDTMR	WDTR / WDTCR	BUZDR
80H	P0	SP	DPL	DPH	-	PLLRCR	BODR	PCON

Table 8.1 SFR Map Summary

NOTE)

- The registers of which lower 3-bit address are 000 are bit-addressable (except for XSFR)

8.4.2 8051 Compiler Compatible SFR

ACC (Accumulator) : E0H

7	6	5	4	3	2	1	0
ACC							
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

ACC Accumulator

B (B Register) : F0H

7	6	5	4	3	2	1	0
B							
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

B B Register

SP (Stack Pointer) : 81H

7	6	5	4	3	2	1	0
SP							
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 07H

SP Stack Pointer

DPL (Data Pointer Low Byte) : 82H

7	6	5	4	3	2	1	0
DPL							
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

DPL Data Pointer Low Byte

DPH (Data Pointer High Byte) : 83H

7	6	5	4	3	2	1	0
DPH							
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

DPH Data Pointer High Byte

PSW (Program Status Word) : D0H

7	6	5	4	3	2	1	0
CY	AC	F0	RS1	RS0	OV	F1	P
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

CY Carry Flag**AC** Auxiliary Carry Flag**F0** General Purpose User-Definable Flag**RS1** Register Bank Select bit 1**RS0** Register Bank Select bit 0**OV** Overflow Flag**F1** User-Definable Flag**P** Parity Flag. Set/cleared by hardware each instruction cycle to indicate an odd/even number of '1' bits in the accumulator**EO (Extended Operation Register) : A2H**

7	6	5	4	3	2	1	0
-	-	-	TRAP_EN	-	DPSEL2	DPSEL1	DPSEL0
R	R	R	RW	R	RW	RW	RW

Initial value : 00H

TRAP_EN Select the instruction

0 Select MOVC @(DPTR++), A

1 Select Software TRAP instruction

DPSEL[2:0] Select Banked Data Point Register

DPSEL2 DPSEL1 DPSEL0

0 0 0 DPTR0

0 0 1 DPTR1

0 1 0 DPTR2

0 1 1 DPTR3

1 0 0 DPTR4

1 0 1 DPTR5

1 1 0 DPTR6

1 1 1 DPTR7

9 I/O Ports

9.1 I/O Ports

The MC95FG308 has four I/O ports (P0, P1, P2 and P3). Each port can be easily configured by software as I/O pin, internal pull up and open drain pin to meet various system configurations and design requirements. Also P0 includes function that can generate interrupt according to change of state of the pin.

9.2 Port Register

9.2.1 Data Register (Px)

Data Register is a bidirectional I/O port. If ports are configured as output ports, data can be written to the corresponding bit of the Px. If ports are configured as input ports, the data can be read from the corresponding bit of the Px.

Note) Do not use the “direct bit test and branch” instruction for input port, more detail information is at Appendix B.

(example) avoid direct input port bit test and branch condition as below
If(P00) → if(P0 & 0x01)

9.2.2 Direction Register (PxIO)

Each I/O pin can independently used as an input or an output through the PxIO register. Bits cleared in this read/write register will select the corresponding pin in Px to become an input, setting a bit sets the pin to output. All bits are cleared by a system reset.

9.2.3 Pull-up Resistor Selection Register (PxPU)

The on-chip pull-up resistor can be connected to them in 1-bit units with a pull-up resistor selection register (PxPU). The pull-up register selection controls the pull-up resistor enable/disable of each port. When the corresponding bit is 1, the pull-up resistor of the pin is enabled. When 0, the pull-up resistor is disabled. All bits are cleared by a system reset. (Only port pull-up resistor selection have default ON state for unused pins in 32-pin package for 16, 20, 28-pin package).

9.2.4 Open-drain Selection Register (PxOD)

There is internally open-drain selection register (PxOD) in P0, P1, P2 and P3. The open-drain selection register controls the open-drain enable/disable of each port. Ports become push-pull by a system reset.

9.2.5 De-bounce Enable Register (PxDB)

There is internally open-drain selection register (PxOD) in P0, P1, P2 and P3. The open-drain selection register controls the open-drain enable/disable of each port. Ports become push-pull by a system reset.

9.2.6 Port Selection Register (PSRx)

PSRx registers prevent the input leakage current when ports are connected to analog inputs. If the bit of PSRx is '1', the dynamic current path of the schmitt OR gate of the port is cut off and the digital input of the corresponding port is always '1'.

9.2.7 Pin Change Interrupt Enable Register (PCI0)

The P0 can support Pin Change Interrupt function. Pin Change Interrupts PCI will trigger if any enabled P0[7:0] pin toggles. The PCI0 Register control which pins contribute to the pin change interrupts.

9.2.8 Register Map

Name	Address	Dir	Default	Description
P0	80H	R/W	00H	P0 Data Register
P0IO	89H	R/W	00H	P0 Direction Register
P0PU	2F00H	R/W	00H	P0 Pull-up Resistor Selection Register
P0OD	2F0CH	R/W	00H	P0 Open-drain Selection Register
P0DB	2F18H	R/W	00H	P0 Debounce Enable Register
PCI0	AEH	R/W	00H	P0 Pin Change Interrupt Enable Register
P1	88H	R/W	00H	P1 Data Register
P1IO	91H	R/W	00H	P1 Direction Register
P1PU	2F01H	R/W	00H	P1 Pull-up Resistor Selection Register
P1OD	2F0DH	R/W	00H	P1 Open-drain Selection Register
P1DB	2F19H	R/W	00H	P1 Debounce Enable Register
P2	90H	R/W	00H	P2 Data Register
P2IO	99H	R/W	00H	P2 Direction Register
P2PU	2F02H	R/W	00H	P2 Pull-up Resistor Selection Register
P2OD	2F0EH	R/W	00H	P2 Open-drain Selection Register
P2DB	2F1AH	R/W	00H	P2 Debounce Enable Register
P3	98H	R/W	00H	P3 Data Register
P3IO	A1H	R/W	00H	P3 Direction Register
P3PU	2F03H	R/W	00H	P3 Pull-up Resistor Selection Register
P3OD	2F0FH	R/W	00H	P3 Open-drain Selection Register
P3DB	2F1BH	R/W	00H	P3 Debounce Enable Register
PSR0	2F50H	R/W	00H	Port Selection Register 0
PSR1	2F51H	R/W	00H	P1,P2,P3 Port Selection Register
PSR2	2F52H	R/W	00H	Special Port Selection Register

Table 9.1 Register Map

9.3 Px Port

9.3.1 Px Port Description

Px is 8-bit I/O port. Px control registers consist of Data register (Px), direction register (PxIO), debounce enable register (PxDB), pull-up register selection register (PxPU), open-drain selection register (PxOD), pin change interrupt register (PCIO).

9.3.2 Register description for Px

Px (Px Data Register) : 80H, 88H, 90H, 98H

7	6	5	4	3	2	1	0
Px7	Px6	Px5	Px4	Px3	Px2	Px1	Px0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

Px[7:0] I/O Data

PxIO (Px Direction Register) : 89H, 91H, 99H, A1H

7	6	5	4	3	2	1	0
Px7IO	Px6IO	Px5IO	Px4IO	Px3IO	Px2IO	Px1IO	Px0IO
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PxIO[7:0] Px data I/O direction.
 0 Input
 1 Output

PxPU (Px Pull-up Resistor Selection Register) : 2F00H ~ 2F03H

7	6	5	4	3	2	1	0
Px7PU	Px6PU	Px5PU	Px4PU	Px3PU	Px2PU	Px1PU	Px0PU
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PxPU[7:0] Configure pull-up resistor of Px port
 0 Disable
 1 Enable

PxOD (Px Open-drain Selection Register) : 2F0CH ~ 2F0FH

7	6	5	4	3	2	1	0
Px7OD	Px6OD	Px5OD	Px4OD	Px3OD	Px2OD	Px1OD	Px0OD
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PxOD[7:0] Configure open-drain of Px port
 0 Disable
 1 Enable

PxDB (Px Debounce Enable Register) : 2F18H ~ 2F1BH

7	6	5	4	3	2	1	0
Px7DB	Px6DB	Px5DB	Px4DB	Px3DB	Px2DB	Px1DB	Px0DB
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PxDB[7:0] Configure debounce of Px port

0 Disable

1 Enable

PCI0 (P0 Pin Change Interrupt Enable Register) : AEH

7	6	5	4	3	2	1	0
PCI07	PCI06	PCI05	PCI04	PCI03	PCI02	PCI01	PCI00
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PCI0[7:0] Configure Pin Change Interrupt of P0 port

0 Disable

1 Enable

PSR0 (Port Selection Register) : 2F50H

7	6	5	4	3	2	1	0
PSR07	PSR06	PSR05	PSR04	PSR03	PSR02	PSR01	PSR00
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PSR0[7:0] P07~P00 port selection register

0 Disable analog channel AN[7:0] (default)

1 Enable analog channel AN[7:0]

PSR1 (P1,2,3 Port Selection Register) : 2F51H

7	6	5	4	3	2	1	0
PSR17	PSR16	PSR15	PSR14	PSR13	PSR12	PSR11	PSR10
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PSR1[7] I2C ports selection register

0 P0[7:6] for I2C (default)

1 P2[6:5] for I2C

PSR1[6:0] P25,P24,P23,P37,P36,P16,P15 port selection register

0 Disable analog channel AN[14:8] (default)

1 Enable analog channel AN[14:8]

PSR2 (USART0, TIMER0 Port Selection Register) : 2F52H

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	PSR20
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

PSR2[0]	RxD0, TxD0, EC0, T0O ports selection register
0	P0[3:2] for RxD0, TxD0 (default) P0[7:6] for EC0, T0O
1	P3[3:2] for RxD0, TxD0 P1[4:3] for EC0, T0O

9.4 Port RESET Noise Canceller

The Figure 9.1 is the Noise canceller diagram for Noise cancel of Pore RESET. It has the Noise cancel value of about 5us (@VDD=5V) to input of Port Reset.

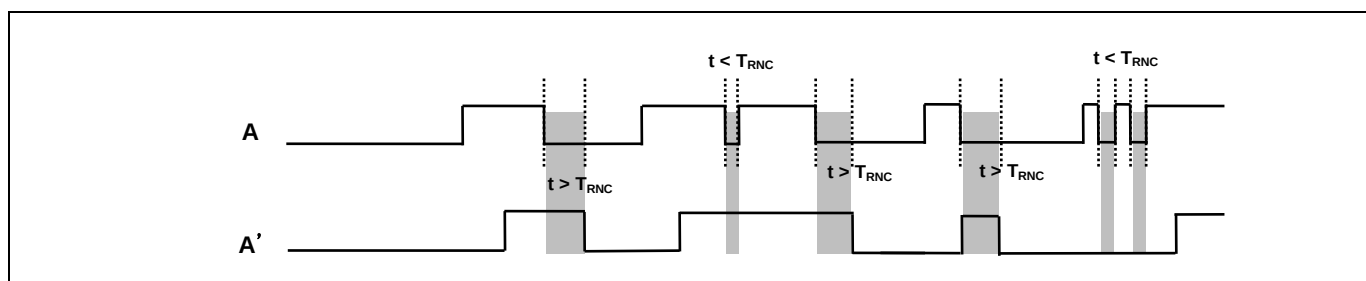


Figure 9.1 Port Reset noise canceller time diagram

10 Interrupt Controller

10.1 Overview

The MC95FG308 supports up to 32 interrupt sources. The interrupts have separate enable register bits associated with them, allowing software control. They can also have four levels of priority assigned to them. The interrupt controller has following features:

- receive the request from 32 interrupt sources
- 8 group priority
- 4 priority levels
- Multi Interrupt possibility
- If the requests of different priority levels are received simultaneously, the request of higher priority level is serviced
- Each interrupt source can control by EA bit and each IEx bit
- Interrupt latency: 5–8 machine cycles in single interrupt system

The maskable interrupts are enabled through six of interrupt enable registers (IE, IE1, IE2, IE3, IE4, IE5). Bits of IE, IE1, IE2, IE3, IE4, IE5 register each individually enable/disable a particular interrupt source. Overall control is provided by bit 7 of IE (EA). When EA is set to '0', all interrupts are disabled; when EA is set to '1', interrupts are individually enabled or disabled through the other bits of the interrupt enable registers. The MC95FG308 supports a four-level priority scheme. Each maskable interrupt is individually assigned to one of four priority levels by writing to IP or IP1.

Interrupt default mode is level-trigger basically but if needed, it is able to change edge-trigger mode. Table 10.1 shows the Interrupt Group Priority Level that is available for sharing interrupt priority. Priority sets two bit which is to IP and IP1 register about group. Interrupt service routine services higher priority. If two requests of different priority levels are received simultaneously, the request of higher priority level is serviced. If the request of same or lower priority level is received, that request is not serviced.

Interrupt Group	Highest Lowest				
	Interrupt0	Interrupt8	Interrupt16	Interrupt24	
0 (Bit0)	Interrupt0	Interrupt8	Interrupt16	Interrupt24	Highest ↓ Lowest
1 (Bit1)	Interrupt1	Interrupt9	Interrupt17	Interrupt25	
2 (Bit2)	Interrupt2	Interrupt10	Interrupt18	Interrupt26	
3 (Bit3)	Interrupt3	Interrupt11	Interrupt19	Interrupt27	
4 (Bit4)	Interrupt4	Interrupt12	Interrupt20	Interrupt28	
5 (Bit5)	Interrupt5	Interrupt13	Interrupt21	Interrupt29	
6 (Bit6)	Interrupt6	Interrupt14	Interrupt22	Interrupt30	
7 (Bit7)	Interrupt7	Interrupt15	Interrupt23	Interrupt31	

Table 10.1 Interrupt Group Priority Level

10.2 External Interrupt

The external interrupt on INT0, INT1, INT2, INT3, INT4, INT5, INT6 and INT7 pins receive various interrupt request depending on the EIEDGE (External Interrupt Edge register) and EIPOLA (External Interrupt Polarity register) and EIBOTH (External Interrupt Both Edge register) as shown in Figure 10.1. Also each external interrupt source has control setting bits. The EIFLAG (External interrupt flag register) register provides the status of external interrupts.

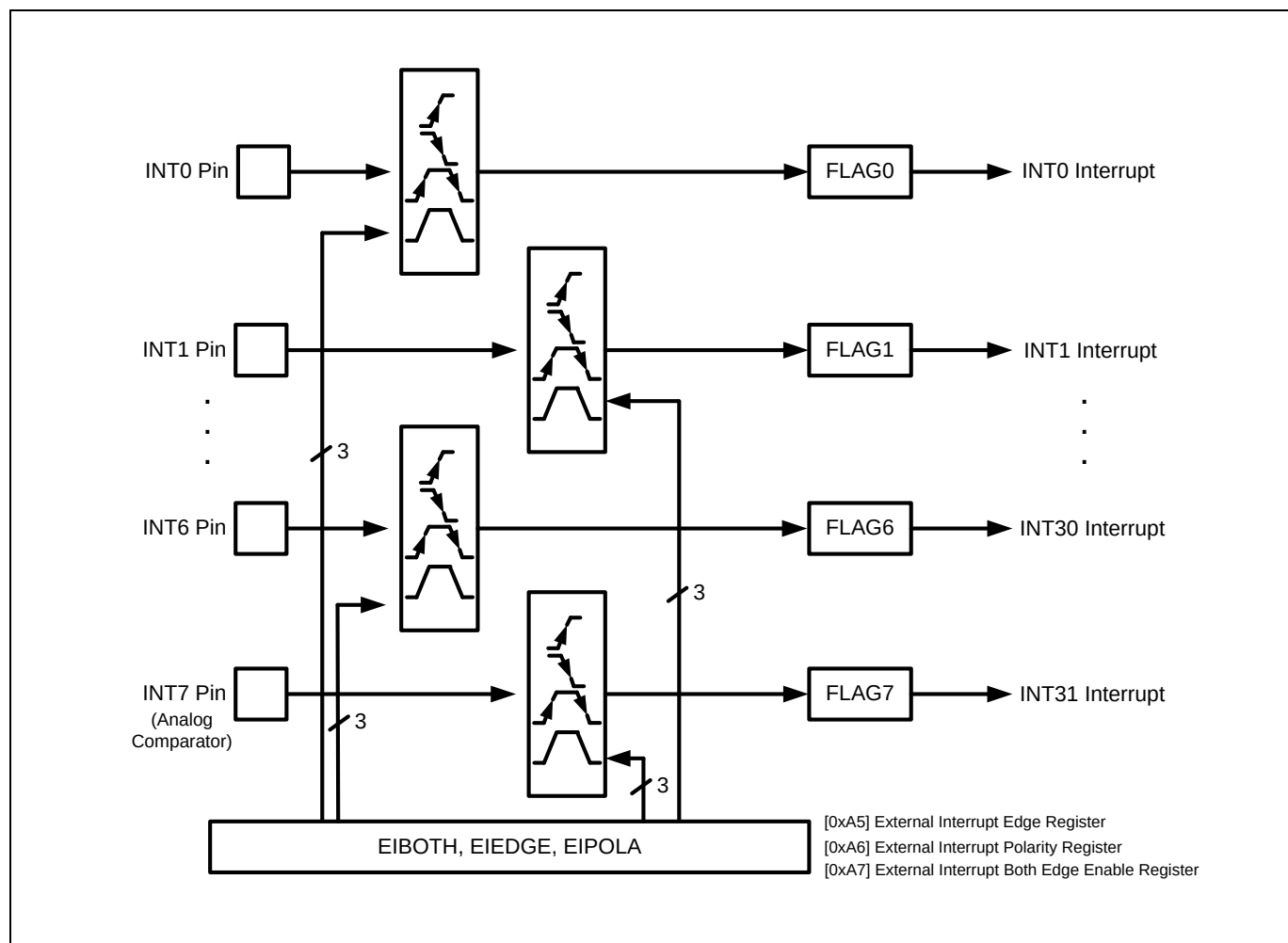


Figure 10.1 External Interrupt Description

10.3 Block Diagram

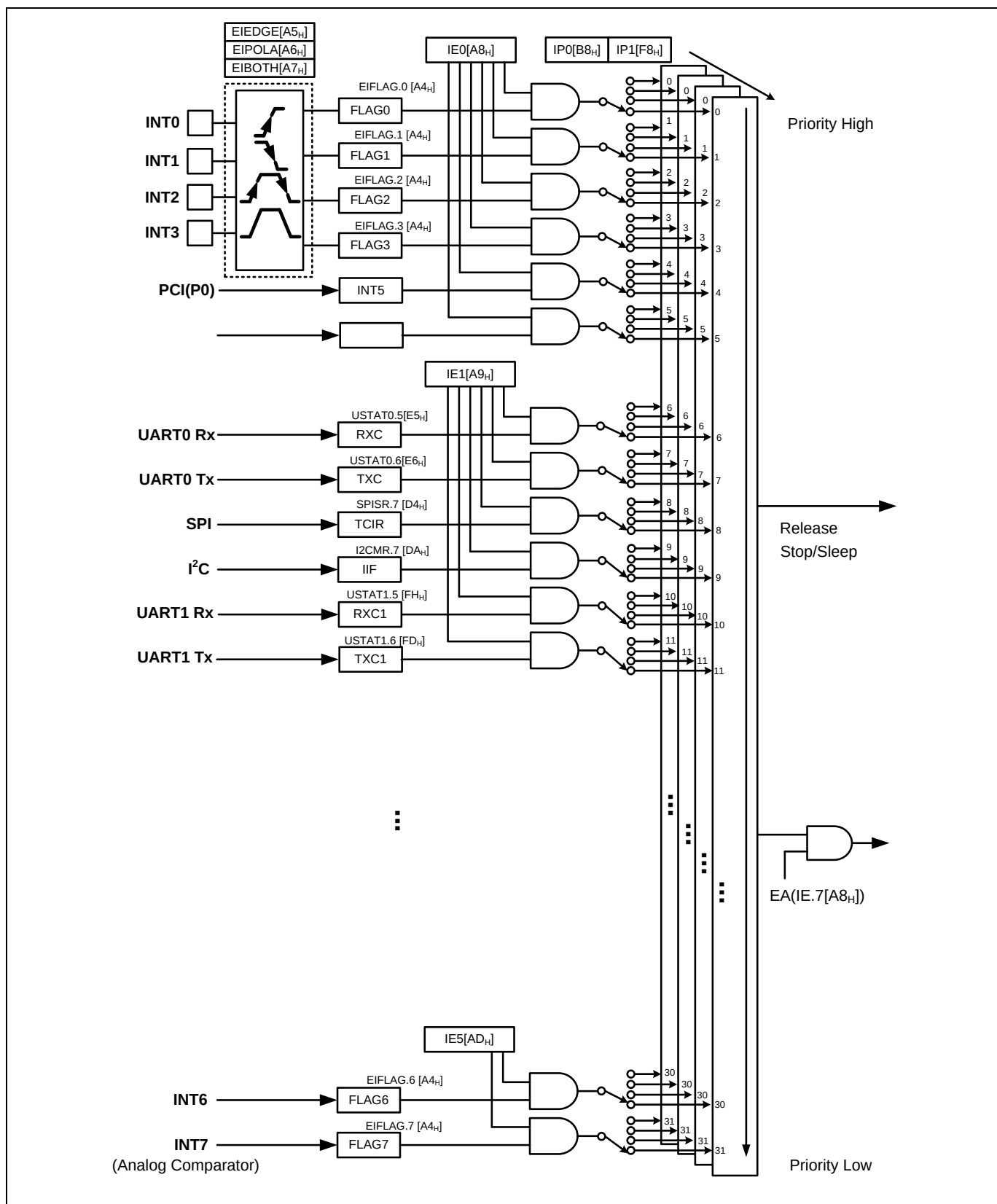


Figure 10.2 Block Diagram of Interrupt

10.4 Interrupt Vector Table

The interrupt controller supports 32 interrupt sources as shown in the Table 10.2 below. When interrupt becomes service, long call instruction (LCALL) is executed in the vector address. Interrupt request 32 has a decided priority order.

Interrupt Source	Symbol	Interrupt Enable bit	Priority	Mask	Vector Address
Hardware Reset	RESETB	0	0	Non-Maskable	0000H
External Interrupt 0	INT0	IE0.0	1	Maskable	0003H
External Interrupt 1	INT1	IE0.1	2	Maskable	000BH
External Interrupt 2	INT2	IE0.2	3	Maskable	0013H
External Interrupt 3	INT3	IE0.3	4	Maskable	001BH
Pin Change Interrupt (P0)	INT4	IE0.4	5	Maskable	0023H
Reserved	INT5	-	6	-	002BH
USART0 Rx	INT6	IE1.0	7	Maskable	0033H
USART0Tx	INT7	IE1.1	8	Maskable	003BH
SPI0	INT8	IE1.2	9	Maskable	0043H
I2C	INT9	IE1.3	10	Maskable	004BH
USART1 Rx	INT10	IE1.4	11	Maskable	0053H
USART1 Tx	INT11	IE1.5	12	Maskable	005BH
T0	INT12	IE2.0	13	Maskable	0063H
T1	INT13	IE2.1	14	Maskable	006BH
T2	INT14	IE2.2	15	Maskable	0073H
T3	INT15	IE2.3	16	Maskable	007BH
T4	INT16	IE2.4	17	Maskable	0083H
EEPROM	INT17	IE2.5	18	Maskable	008BH
ADC	INT18	IE3.0	19	Maskable	0093H
Comparator	INT19	IE3.1	20	Maskable	009BH
WT	INT20	IE3.2	21	Maskable	00A3H
WDT	INT21	IE3.3	22	Maskable	00ABH
BIT	INT22	IE3.4	23	Maskable	00B3H
Reserved	INT23	-	24	-	00BBH
Reserved	INT24	-	25	-	00C3H
Reserved	INT25	-	26	-	00CBH
Reserved	INT26	-	27	-	00D3H
Reserved	INT27	-	28	-	00DBH
External Interrupt 4	INT28	IE4.4	29	Maskable	00E3H
External Interrupt 5	INT29	IE4.5	30	Maskable	00EBH
External Interrupt 6	INT30	IE5.0	31	Maskable	00F3H
External Interrupt 7	INT31	IE5.1	32	Maskable	00FBH

Table 10.2 Interrupt Vector Address Table

For maskable interrupt execution, first EA bit must set '1' and specific interrupt source must set '1' by writing a '1' to associated bit in the IEx. If interrupt request is received, specific interrupt request flag set '1'. And it remains '1' until CPU accepts interrupt. After that, interrupt request flag will be cleared automatically.

10.5 Interrupt Sequence

An interrupt request is held until the interrupt is accepted or the interrupt latch is cleared to '0' by a reset or an instruction. Interrupt acceptance always generates at last cycle of the instruction. So instead of fetching the current instruction, CPU executes internally LCALL instruction and saves the PC stack. For the interrupt service routine, the interrupt controller gives the address of LJMP instruction to CPU. After finishing the current instruction, at the next instruction to go interrupt service routine needs 5~8 machine cycle and the interrupt service task is terminated upon execution of an interrupt return instruction [RETI]. After generating interrupt, to go to interrupt service routine, the following process is progressed.

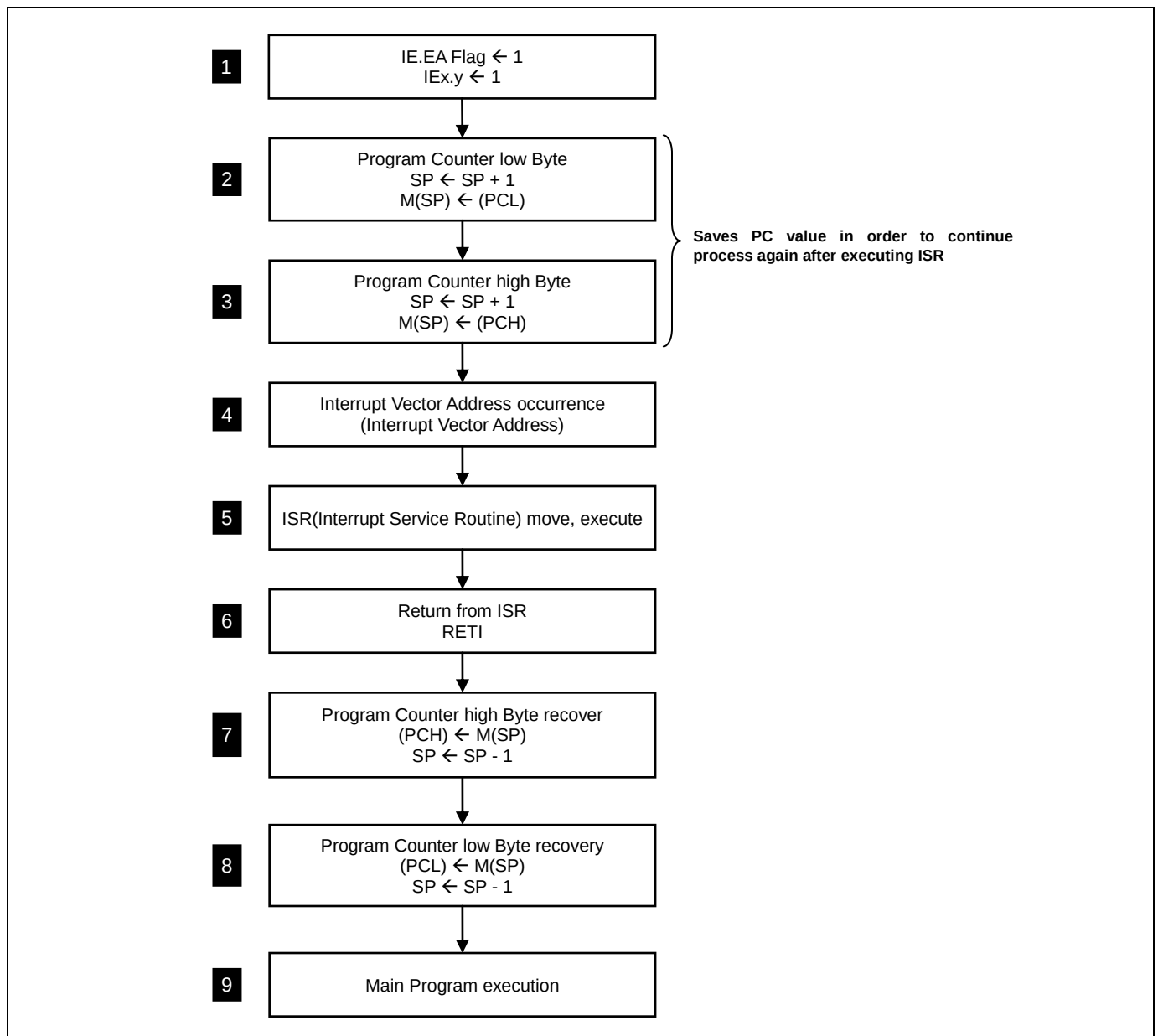


Figure 10.3 Interrupt Sequence Flow

10.6 Effective Timing after Controlling Interrupt bit

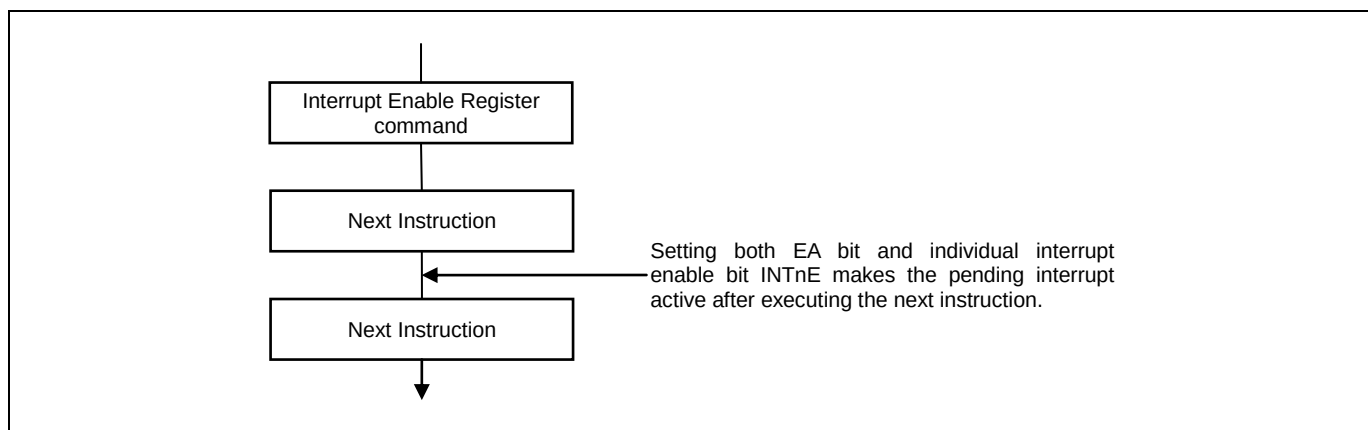


Figure 10.4 Interrupt Enable Register effective Timing

10.7 Multi Interrupt

If two requests of different priority levels are received simultaneously, the request of higher priority level is serviced. If requests of the interrupt are received at the same time simultaneously, an interrupt polling sequence determines by hardware which request is serviced. However, multiple processing through software for special features is possible.

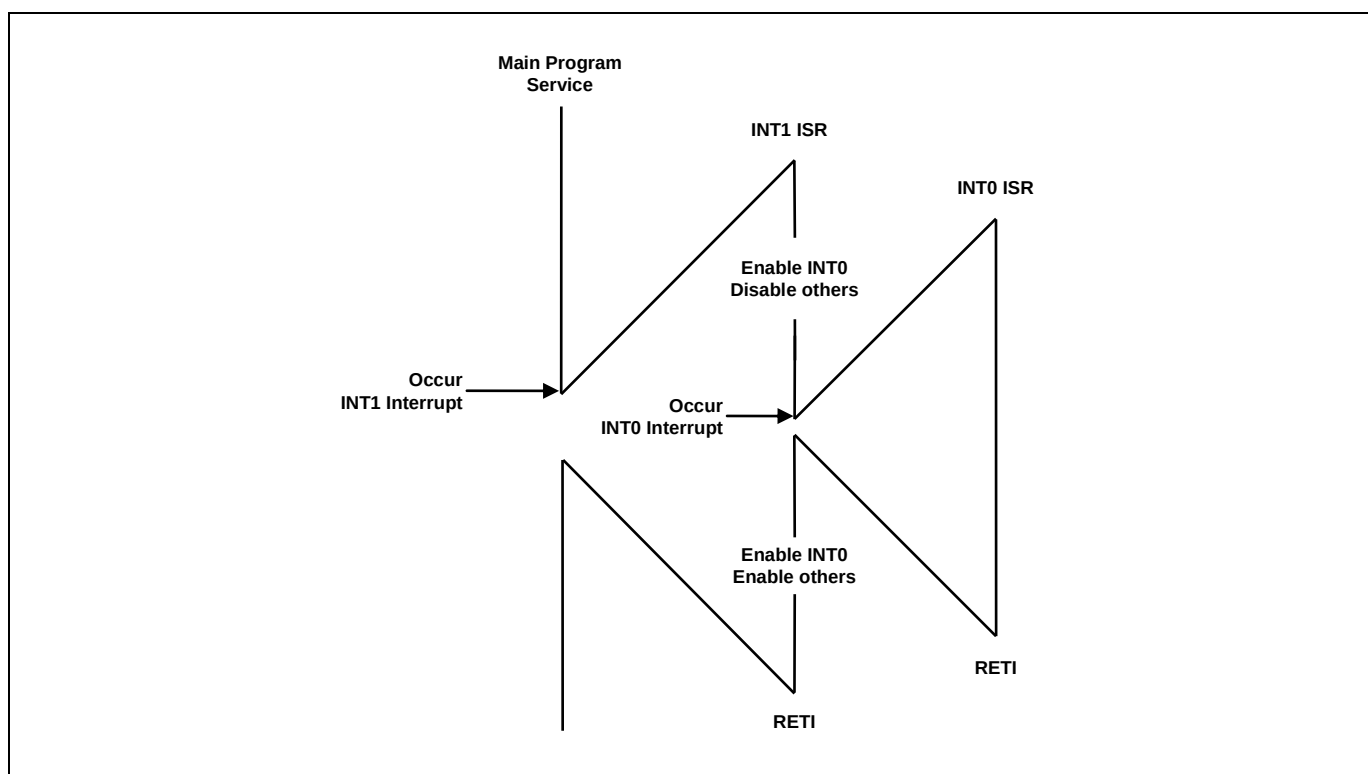


Figure 10.5 Execution of Multi Interrupt

Following example is shown to service INT0 routine during INT1 routine in Figure 10.6. In this example, INT0 interrupt priority is higher than INT1 interrupt priority. If some interrupt is lower than INT1 priority, it can't service its interrupt routine.

Example) Software Multi Interrupt:

```

INT1:  MOV    IE, #01H    ; Enable INT0 only
        MOV    IE1, #00H  ; Disable others
        SETB   EA         ; Enable global interrupt (necessary for multi interrupt)
        :
        MOV    IE, #0FFH  ; Enable all Interrupts
        MOV    IE1, #0FFH
        RETI

```

10.8 Interrupt Enable Accept Timing

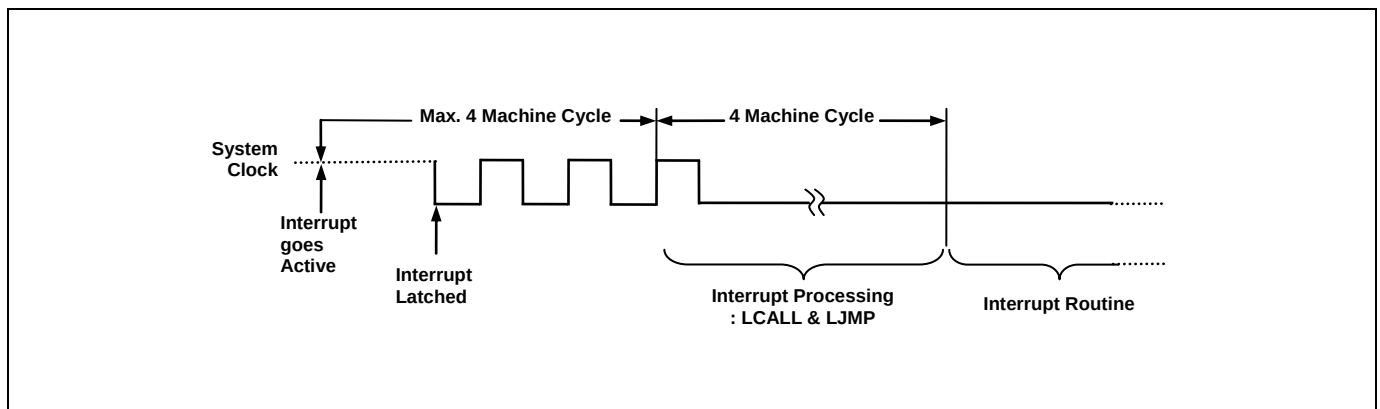


Figure 10.6 Interrupt Response Timing Diagram

10.9 Interrupt Service Routine Address

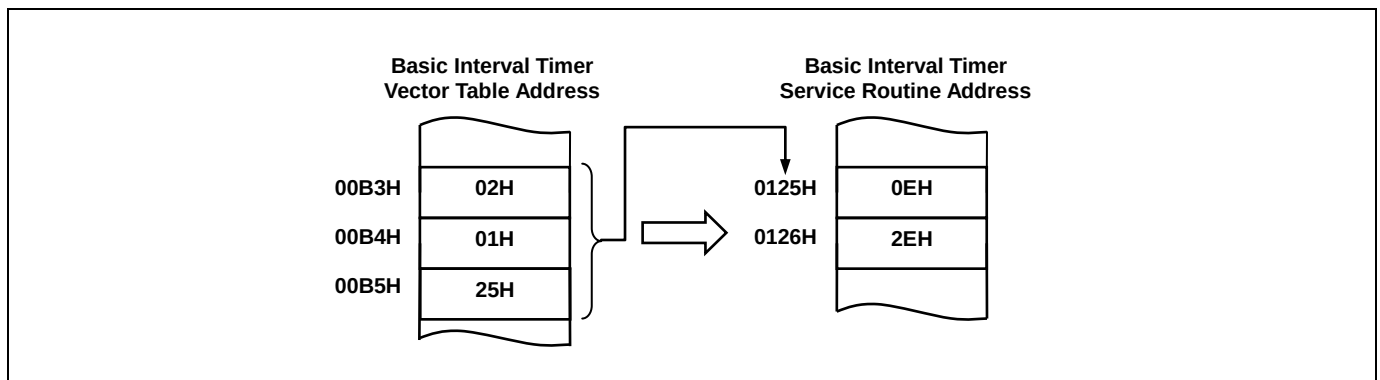


Figure 10.7 Correspondence between Vector Table Address and the Entry Address of ISR

10.10 Saving/Restore General-Purpose Registers

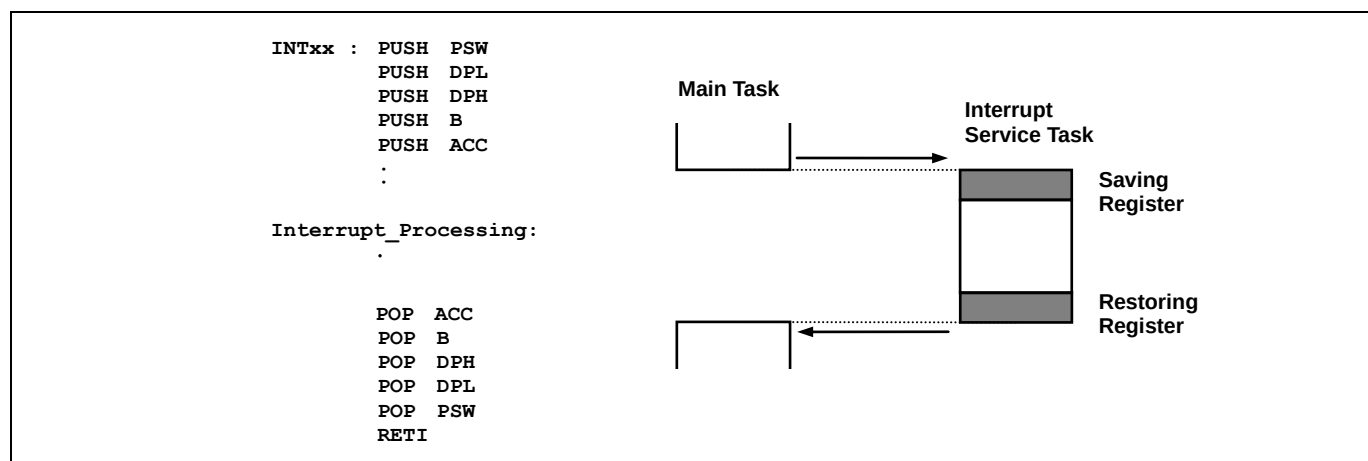


Figure 10.8 Saving/Restore Process Diagram and Sample Source

10.11 Interrupt Timing

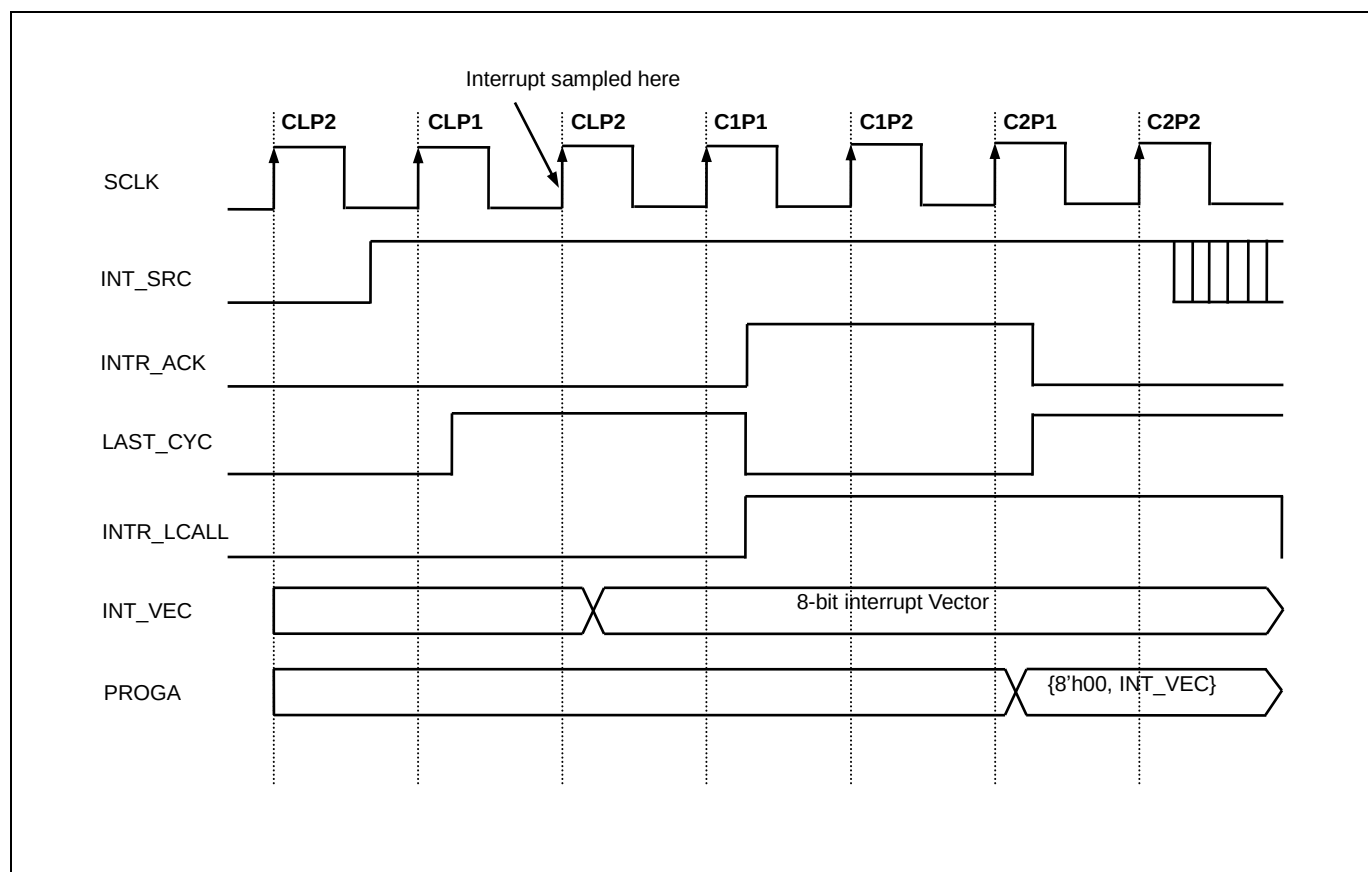


Figure 10.9 Timing Chart of Interrupt Acceptance and Interrupt Return Instruction

Interrupt source sampled at last cycle of the command. When sampling interrupt source, it is decided to low 8-bit of interrupt vector. M8051W core makes interrupt acknowledge at first cycle of command, executes long call to jump interrupt routine as INT_VEC.

NOTE)

1. command cycle CLPx: L=Last cycle, 1=1st cycle or 1st phase, 2=2nd cycle or 2nd phase

10.12 Interrupt Register Overview

10.12.1 Interrupt Enable Register (IE, IE1, IE2, IE3, IE4, IE5)

Interrupt enable register consists of Global interrupt control bit (EA) and peripheral interrupt control bits. Totally 32 peripheral are able to control interrupt.

10.12.2 Interrupt Priority Register (IP, IP1)

The 32 interrupt divides 8 groups which have each 4 interrupt sources. A group can decide 4 levels interrupt priority using interrupt priority register. Level 3 is the high priority, while level 0 is the low priority. Initially, IP, IP1 reset value is '0'. At that initialization, low interrupt number has a higher priority than high interrupt number. If decided the priority, low interrupt number has a higher priority than high interrupt number in that group.

10.12.3 External Interrupt Flag Register (EIFLAG)

The external interrupt flag register is set to '1' when the external interrupt generating condition is satisfied. The flag is cleared when the interrupt routine is executed. Alternatively, the flag can be cleared by writing a '0' to it.

10.12.4 External Interrupt Edge Register (EIEDGE)

The External interrupt edge register determines which type of edge or level sensitive interrupt. Initially, default value is level. For level, write '0' to related bit. For edge, write '1' to related bit.

10.12.5 External Interrupt Edge Register (EIEDGE)

According to EIEDGE register, the external interrupt polarity (EIPOLA) register has a different meaning. If EIEDGE is level type, EIPOLA is able to have Low/High level value. If EIEGDE is edge type, EIPOLA is able to have rising/falling edge value.

10.12.6 External Interrupt Enable Register (EIENAB)

When the external interrupt enable register is written to '1', the corresponding external pin interrupt is enabled. The EIEDGE and EIPOLA register defines whether the external interrupt is activated on rising or falling edge or level sensed.

10.12.7 External Interrupt Both Edge Enable Register (EIBOTH)

When the external interrupt both edge enable register is written to '1', the corresponding external pin interrupt is enabled by both edges. Initially, default value is disabled.

10.12.8 Register Map

Name	Address	Dir	Default	Description
IE	A8H	R/W	00H	Interrupt Enable Register
IE1	A9H	R/W	00H	Interrupt Enable Register 1
IE2	AAH	R/W	00H	Interrupt Enable Register 2
IE3	ABH	R/W	00H	Interrupt Enable Register 3
IE4	ACH	R/W	00H	Interrupt Enable Register 4
IE5	ADH	R/W	00H	Interrupt Enable Register 5
IP	B8H	R/W	00H	Interrupt Priority Register
IP1	F8H	R/W	00H	Interrupt Priority Register 1
EIENAB	A3H	R/W	00H	External Interrupt Enable Register
EIFLAG	A4H	R/W	00H	External Interrupt Flag Register
EIEDGE	A5H	R/W	00H	External Interrupt Edge Register
EIPOLA	A6H	R/W	00H	External Interrupt Polarity Register
EIBOTH	A7H	R/W	00H	External Interrupt Both Edge Enable Register

Table 10.3 Register Map

10.13 Interrupt Register Description

The Interrupt Register is used for controlling interrupt functions. Also it has External interrupt control registers. The interrupt register consists of Interrupt Enable Register (IE), Interrupt Enable Register 1 (IE1), Interrupt Enable Register 2 (IE2), Interrupt Enable Register 3 (IE3), Interrupt Enable Register 4 (IE4) and Interrupt Enable Register 5 (IE5). For external interrupt, it consists of External Interrupt Flag Register (EIFLAG), External Interrupt Edge Register (EIEDGE), External Interrupt Polarity Register (EIPOLA), External Interrupt Enable Register (EIENAB) and External Interrupt Both Edge Enable Register (EIBOTH).

10.13.1 Register Description for Interrupt

IE (Interrupt Enable Register) : A8H

7	6	5	4	3	2	1	0
EA	-	INT5E	INT4E	INT3E	INT2E	INT1E	INT0E
RW	-	RW	RW	RW	RW	RW	RW

Initial value : 00H

EA	Enable or disable all interrupt bits
0	All Interrupt disable
1	All Interrupt enable
INT5E	Reserved
0	Disable
1	Enable
INT4E	Enable or disable Pin Change Interrupt 0 (Port 0)
0	Disable
1	Enable
INT3E	Enable or disable External Interrupt 3
0	Disable
1	Enable
INT2E	Enable or disable External Interrupt 2
0	Disable
1	Enable
INT1E	Enable or disable External Interrupt 1
0	Disable
1	Enable
INT0E	Enable or disable External Interrupt 0
0	Disable
1	Enable

IE1 (Interrupt Enable Register 1) : A9H

7	6	5	4	3	2	1	0
-	-	INT11E	INT10E	INT9E	INT8E	INT7E	INT6E
-	-	RW	RW	RW	RW	RW	RW

Initial value : 00H

INT11E	Enable or disable USART1 Tx Interrupt
0	Disable
1	Enable
INT10E	Enable or disable USART1 Rx Interrupt
0	Disable
1	Enable
INT9E	Enable or disable I2C Interrupt
0	Disable
1	Enable
INT8E	Enable or disable SPI0 Interrupt
0	Disable
1	Enable
INT7E	Enable or disable USART0 Tx Interrupt
0	Disable
1	Enable
INT6E	Enable or disable USART0 Rx Interrupt
0	Disable
1	Enable

IE2 (Interrupt Enable Register 2) : AAH

7	6	5	4	3	2	1	0
-	-	INT17E	INT16E	INT15E	INT14E	INT13E	INT12E
-	-	RW	RW	RW	RW	RW	RW

Initial value : 00H

INT17E	Enable or disable EEPROM Interrupt
0	Disable
1	Enable
INT16E	Enable or disable Timer 4 Interrupt
0	Disable
1	Enable
INT15E	Enable or disable Timer 3 Interrupt
0	Disable
1	Enable
INT14E	Enable or disable Timer 2 Interrupt
0	Disable
1	Enable
INT13E	Enable or disable Timer 1 Interrupt
0	Disable
1	Enable
INT12E	Enable or disable Timer 0 Interrupt
0	Disable
1	Enable

IE3 (Interrupt Enable Register 3) : ABH

7	6	5	4	3	2	1	0
-	-	INT23E	INT22E	INT21E	INT20E	INT19E	INT18E
R	R	RW	RW	RW	RW	RW	RW

Initial value : 00H

INT23E	Reserved
0	Disable
1	Enable
INT22E	Enable or disable BIT Interrupt
0	Disable
1	Enable
INT21E	Enable or disable WDT Interrupt
0	Disable
1	Enable
INT20E	Enable or disable WT Interrupt
0	Disable
1	Enable
INT19E	Enable or disable Analog Comparator Interrupt
0	Disable
1	Enable
INT18E	Enable or disable ADC Interrupt
0	Disable
1	Enable

IE4 (Interrupt Enable Register 4) : ACH

7	6	5	4	3	2	1	0
-	-	INT29E	INT28E	INT27E	INT26E	INT25E	INT24E
R	R	RW	RW	RW	RW	RW	RW

Initial value : 00H

INT29E	Enable or disable External Interrupt 5
0	Disable
1	Enable
INT28E	Enable or disable External Interrupt 4
0	Disable
1	Enable
INT27E	Reserved
0	Disable
1	Enable
INT26E	Reserved
0	Disable
1	Enable
INT25E	Reserved
0	Disable
1	Enable
INT24E	Reserved
0	Disable
1	Enable

IE5 (Interrupt Enable Register 5) : ADH

7	6	5	4	3	2	1	0
-	-	INT35E	INT34E	INT33E	INT32E	INT31E	INT30E
R	R	RW	RW	RW	RW	RW	RW

Initial value : 00H

INT35E	Reserved
0	Disable
1	Enable
INT34E	Reserved
0	Disable
1	Enable
INT33E	Reserved
0	Disable
1	Enable
INT32E	Reserved
0	Disable
1	Enable
INT31E	Enable or disable External Interrupt 7
0	Disable
1	Enable
INT30E	Enable or disable External Interrupt 6
0	Disable
1	enable

IP (Interrupt Priority Register) : B8H

7	6	5	4	3	2	1	0
IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

IP1 (Interrupt Priority Register 1) : F8H

7	6	5	4	3	2	1	0
IP17	IP16	IP15	IP14	IP13	IP12	IP11	IP10
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

IP[7:0], IP1[7:0] Select Interrupt Group Priority

IP1x	IPx	Description
0	0	level 0 (lowest)
0	1	level 1
1	0	level 2
1	1	level 3 (highest)

EIFLAG (External Interrupt Flag Register) : A4H

7	6	5	4	3	2	1	0
FLAG7	FLAG6	FLAG5	FLAG4	FLAG3	FLAG2	FLAG1	FLAG0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- FLAG[7:0]** If External Interrupt is occurred, the flag becomes '1'. The flag can be cleared by writing a '0' to bit
- 0 External Interrupt not occurred
 - 1 External Interrupt occurred

EIEDGE (External Interrupt Edge Register) : A5H

7	6	5	4	3	2	1	0
EDGE7	EDGE6	EDGE5	EDGE4	EDGE3	EDGE2	EDGE1	EDGE0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- EDGE[7:0]** Determines which type of edge or level sensitive interrupt may occur.
- 0 Level (default)
 - 1 Edge

EIPOLA (External Interrupt Polarity Register) : A6H

7	6	5	4	3	2	1	0
POLA7	POLA6	POLA5	POLA4	POLA3	POLA2	POLA1	POLA0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- POLA[7:0]** According to EIEDGE, External interrupt polarity register has a different means. If EIEDGE is level type, external interrupt polarity is able to have Low/High level value. If EIEDGE is edge type, external interrupt polarity is able to have rising/ falling edge value.
- Level case:
- 0 When High level, Interrupt occurred (default)
 - 1 When Low level, Interrupt occurred
- Edge case:
- 0 When Rising edge, Interrupt occurred (default)
 - 1 When Falling edge, Interrupt occurred

EIENAB (External Interrupt Enable Register) : A3H

7	6	5	4	3	2	1	0
ENAB7	ENAB6	ENAB5	ENAB4	ENAB3	ENAB2	ENAB1	ENAB0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- ENAB[7:0]** Control External Interrupt
- 0 Disable (default)
 - 1 Enable

EIBOTH (External Interrupt Both Edge Enable Register) : A7H

7	6	5	4	3	2	1	0
BOTH7	BOTH6	BOTH5	BOTH4	BOTH3	BOTH2	BOTH1	BOTH0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

BOTH[7:0] Determines which type of interrupt may occur, EIBOTH or EIEDGE+EIPOLA. if EIBOTH is enable, EIEDGE and EIPOLA register value don't matter.

0 Disable (default)

1 Enable

11 Peripheral Hardware

11.1 Clock Generator

11.1.1 Overview

As shown in Figure 11.1, the clock generator produces the basic clock pulses which provide the system clock to be supplied to the CPU and the peripheral hardware. It contains main-frequency clock oscillator. The system clock operation can be easily obtained by attaching a crystal between the XIN and XOUT pin, respectively. The system clock can also be obtained from the external oscillator. In this case, it is necessary to put the external clock signal into the XIN pin and open the XOUT pin. The default system clock is INT-RC Oscillator and the default division rate is one. In order to stabilize system internally, use 1MHz RING oscillator for BIT, WDT and ports de-bounce.

- Calibrated Internal RC Oscillator (8MHz)
 - . INT-RC OSC/1 (Default system clock)
 - . INT-RC OSC/2 (4MHz)
 - . INT-RC OSC/4 (2MHz)
 - . INT-RC OSC/8 (1MHz)
- Crystal Oscillator (1~16MHz)
- Sub-Clock Crystal Oscillator (32.768kHz)

11.1.2 Block Diagram

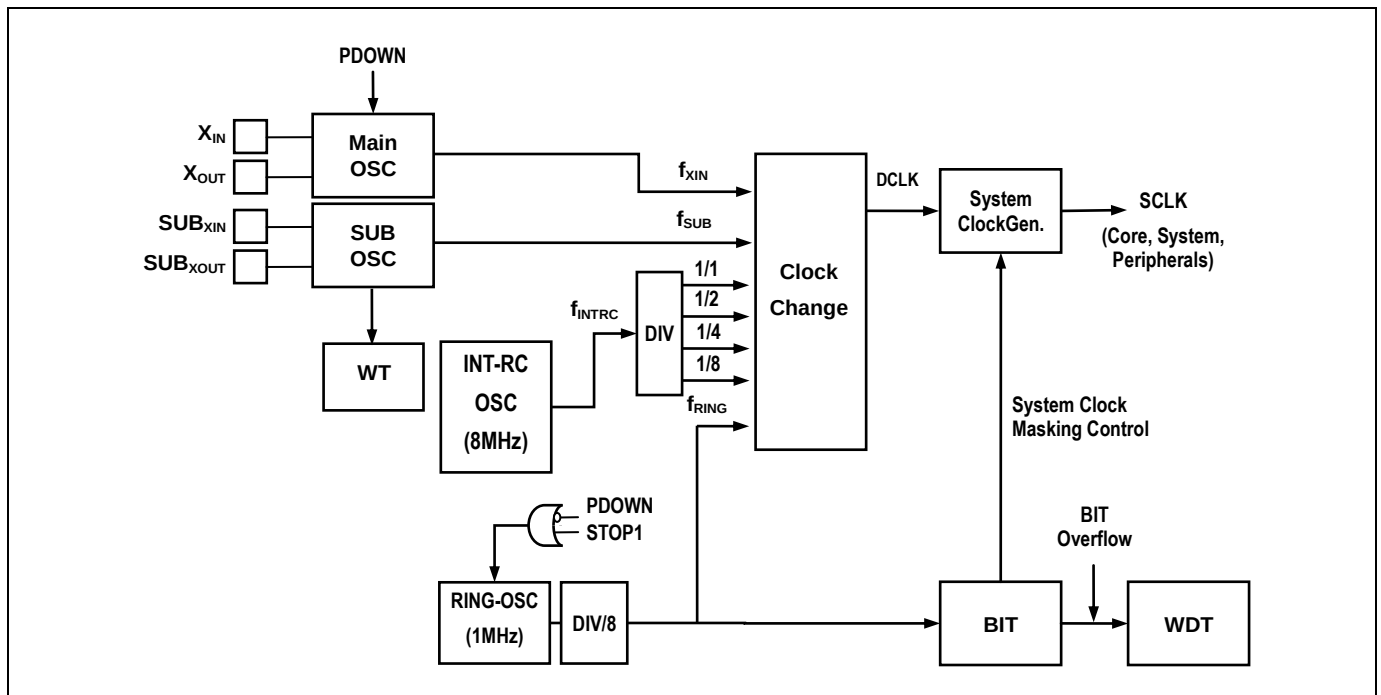


Figure 11.1 Clock Generator Block Diagram

11.1.3 Register Map

Name	Address	Dir	Default	Description
SCCR	8AH	R/W	04H	System and Clock Control Register

Table 11.1 Register Map

11.1.4 Clock Generator Register Description

The Clock Generation Register uses clock control for system operation. The clock generation consists of System and Clock register.

11.1.5 Register Description for Clock Generator

SCCR (System and Clock Control Register) : 8AH

7	6	5	4	3	2	1	0
STOP1	DIV1	DIV0	CBYS	ISTOP	XSTOP	CS1	CS0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 04H

STOP1	Control the STOP Mode NOTE) when PCON=0x03, It is applied. But when PCON=0x01, don't set this bit. 0 STOP2 Mode (at PCON=0x03) (default) 1 STOP1 Mode (at PCON=0x03)		
DIV[1:0]	When using fINTRC as system clock, determine division rate. NOTE) when using fINTRC as system clock, only division rate come into effect. NOTE) To change by software, CBYS set to '1' DIV1 DIV0 description 0 0 fINTRC/1 (8MHz) 0 1 fINTRC/2 (4MHz) 1 0 fINTRC/4 (2MHz) 1 1 fINTRC/8 (1MHz)		
CBYS	Control the scheme of clock change. If this bit set to '0', clock change is controlled by hardware. But if this set to '1', clock change is controlled by software. Ex) when setting CS[1:0], if CBYS bit set to '0', it is not changed right now, CPU goes to STOP mode and then when wake-up, it applies to clock change. NOTE) when clear this bit, keep other bits in SCCR. 0 Clock changed by hardware during stop mode (default) 1 Clock changed by software		
ISTOP	Control the operation of INT-RC Oscillation NOTE) when CBYS='1', It is applied 0 RC-Oscillation enable (default) 1 RC-Oscillation disable		
XSTOP	Control the operation of X-Tal Oscillation NOTE1) when CBYS='1', It is applied NOTE2) if XINENA bit in FUSE_CONF to '0', XSTOP is fixed to '1' 0 X-Tal Oscillation enable 1 X-Tal Oscillation disable (default)		
CS[1:0]	Determine System Clock NOTE) by CBYS bit, reflection point is decided CS1 CS0 Description		

0	0	fINTRC INTRC (8MHz)
0	1	fXIN Main Clock (1~16MHz)
1	0	fSUB (32.768kHz)
1	1	fRING (125kHz)

11.2 Basic Interval Timer

11.2.1 Overview

The MC95FG308 has one 8-bit Basic Interval Timer that is free-run and can't stop. Block diagram is shown in Figure 11.2. In addition, the Basic Interval Timer generates the time base for watchdog timer counting. It also provides a basic interval timer interrupt (BITF).

The MC95FG308 has these Basic Interval Timer (BIT) features:

- During Power On, BIT gives a stable clock generation time
- On exiting Stop mode, BIT gives a stable clock generation time
- As clock function, time interrupt occurrence

11.2.2 Block Diagram

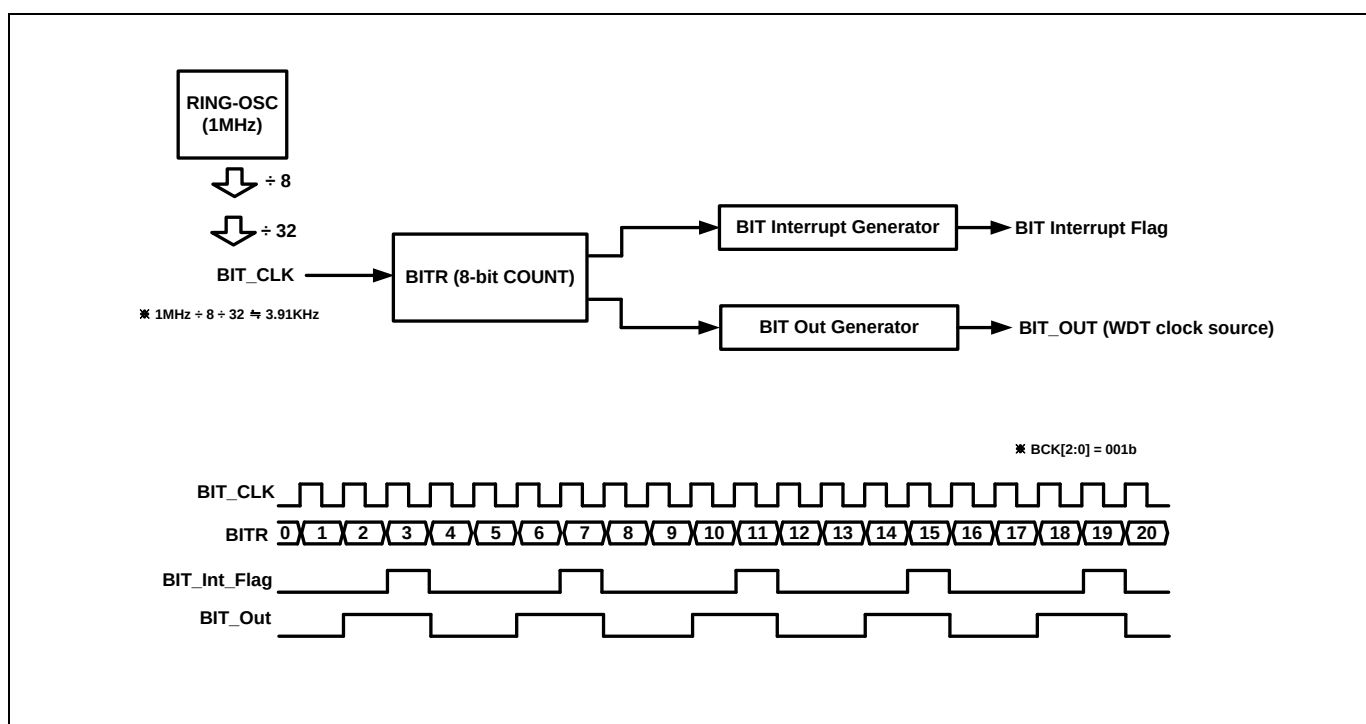


Figure 11.2 Basic Interval Timer Block Diagram

11.2.3 Register Map

Name	Address	Dir	Default	Description
BCCR	8BH	R/W	05H	BIT Clock Control Register
BITR	8CH	R	00H	Basic Interval Timer Register

Table 11.2 Register Map

11.2.4 Basic Interval Timer Register Description

The Basic Interval Timer Register consists of Basic Clock control register (BCCR) and Basic Interval Timer register (BITR). If BCLR bit set to '1', BITR becomes '0' and then counts up. After 1 machine cycle, BCLR bit is cleared as '0' automatically.

11.2.5 Register Description for Basic Interval Timer

BCCR (BIT Clock Control Register) : 8BH

7	6	5	4	3	2	1	0
BITF	-	-	-	BCLR	BCK2	BCK1	BCK0
RW	R	R	R	RW	RW	RW	RW

Initial value : 05H

BITF When BIT Interrupt occurs, this bit becomes '1'. For clearing bit, write '0' to this bit.

0 no generation
1 generation

BCLR If BCLR bit is written to '1', BIT Counter is cleared as '0'

0 Free Running
1 Clear Counter

BCK[2:0] Select BIT overflow period (BIT Clock $\approx$ 3.9kHz)

BCK2	BCK1	BCK0	
0	0	0	0.512msec (BIT Clock * 2)
0	0	1	1.024msec
0	1	0	2.048msec
0	1	1	4.096msec
1	0	0	8.192msec
1	0	1	16.384msec (default)
1	1	0	32.768msec
1	1	1	65.536msec

BITR (Basic Interval Timer Register) : 8CH

7	6	5	4	3	2	1	0
BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
R	R	R	R	R	R	R	R

Initial value : 00H

BIT[7:0] BIT Counter

11.3 Watch Dog Timer

11.3.1 Overview

The watchdog timer rapidly detects the CPU malfunction such as endless looping caused by noise or the like, and resumes the CPU to the normal state. The watchdog timer signal for detecting malfunction can be selected either a reset CPU or an interrupt request. When the watchdog timer is not being used for malfunction detection, it can be used as a timer to generate an interrupt at fixed intervals. It is possible to use free running 8-bit timer mode (WDTRSON='0') or watch dog timer mode (WDTRSON='1') as setting WDTMR[6] bit. If writing WDTMR[5] to '1', WDT counter value is cleared and counts up. After 1 machine cycle, this bit has '0' automatically. The watchdog timer consists of 8-bit binary counter and the watchdog timer data register. When the value of 8-bit binary counter is equal to the 8 bits of WDTR, the interrupt request flag is generated. This can be used as Watchdog timer interrupt or reset the CPU in accordance with the bit WDTRSON.

The clock source of Watch Dog Timer is BIT overflow output. The interval of watchdog timer interrupt is decided by BIT overflow period and WDTR set value. The equation is as below

$$\text{WDT Interrupt Interval} = (\text{BIT Interrupt Interval}) \times (\text{WDTR Value} + 1)$$

11.3.2 Block Diagram

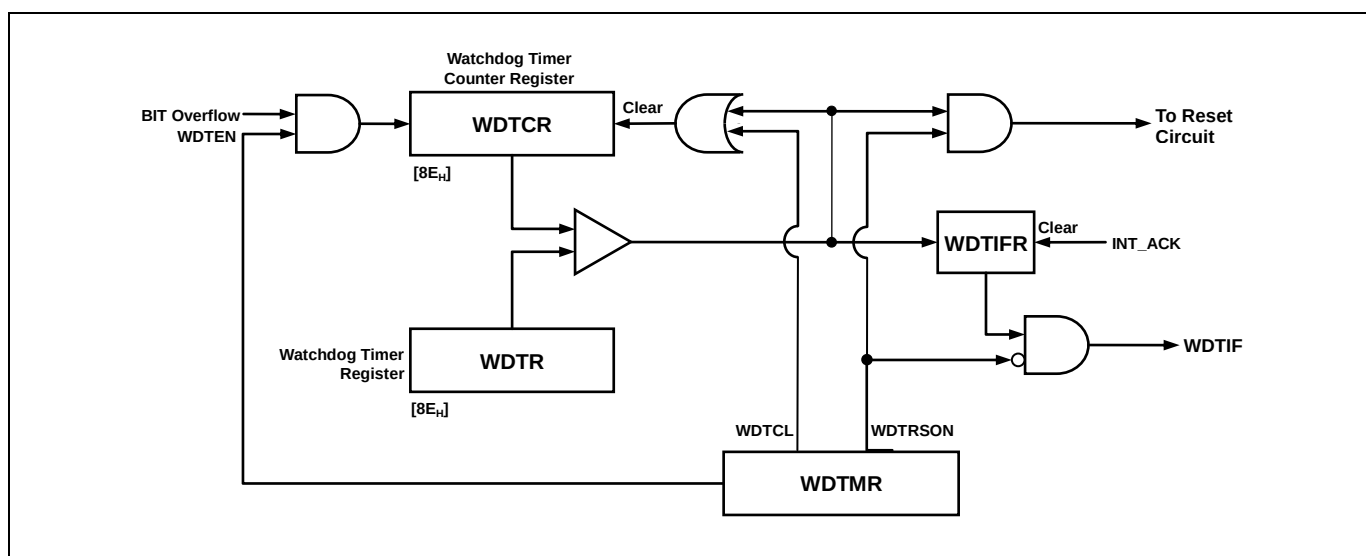


Figure 11.3 WDT Block Diagram

11.3.3 Register Map

Name	Address	Dir	Default	Description
WDTR	8EH	W	FFH	Watch Dog Timer Register
WDCR	8EH	R	00H	Watch Dog Timer Counter Register
WDTMR	8DH	R/W	00H	Watch Dog Timer Mode Register

Table 11.3 Register Map

11.3.4 Watch Dog Timer Register Description

The Watch dog timer (WDT) Register consists of Watch Dog Timer Register (WDTR), Watch Dog Timer Counter Register (WDTCR) and Watch Dog Timer Mode Register (WDTMR).

11.3.5 Register Description for Watch Dog Timer

WDTR (Watch Dog Timer Register: Write Case) : 8EH

7	6	5	4	3	2	1	0
WDTR7	WDTR6	WDTR5	WDTR4	WDTR3	WDTR2	WDTR1	WDTR0
W	W	W	W	W	W	W	W

Initial value : FFH

WDTR[7:0] Set a period
 $\text{WDT Interrupt Interval} = (\text{BIT Interrupt Interval}) \times (\text{WDTR Value} + 1)$

NOTE)

- To guarantee proper operation, the data should be greater than 01H.

WDTCR (Watch Dog Timer Counter Register: Read Case) : 8EH

7	6	5	4	3	2	1	0
WDTCR7	WDTCR6	WDTCR5	WDTCR4	WDTCR3	WDTCR2	WDTCR1	WDTCR0
R	R	R	R	R	R	R	R

Initial value : 00H

WDTCR[7:0] WDT Counter

WDTMR (Watch Dog Timer Mode Register) : 8DH

7	6	5	4	3	2	1	0
WDTEN	WDTRSON	WDTCL	-	-	-	-	WDTIFR
RW	RW	RW	-	-	-	-	RW

Initial value : 00H

WDTEN Control WDT operation
 0 disable
 1 enable

WDTRSON Control WDT Reset operation
 0 Free Running 8-bit timer
 1 Watch Dog Timer Reset ON

WDTCL Clear WDT Counter
 0 Free Run
 1 Clear WDT Counter (auto clear after 1 Cycle)

WDTIFR When WDT Interrupt occurs, this bit becomes '1'. For clearing bit, write '0' to this bit or auto clear by INT_ACK signal.
 0 WDT Interrupt no generation
 1 WDT Interrupt generation

11.3.6 WDT Interrupt Timing Waveform

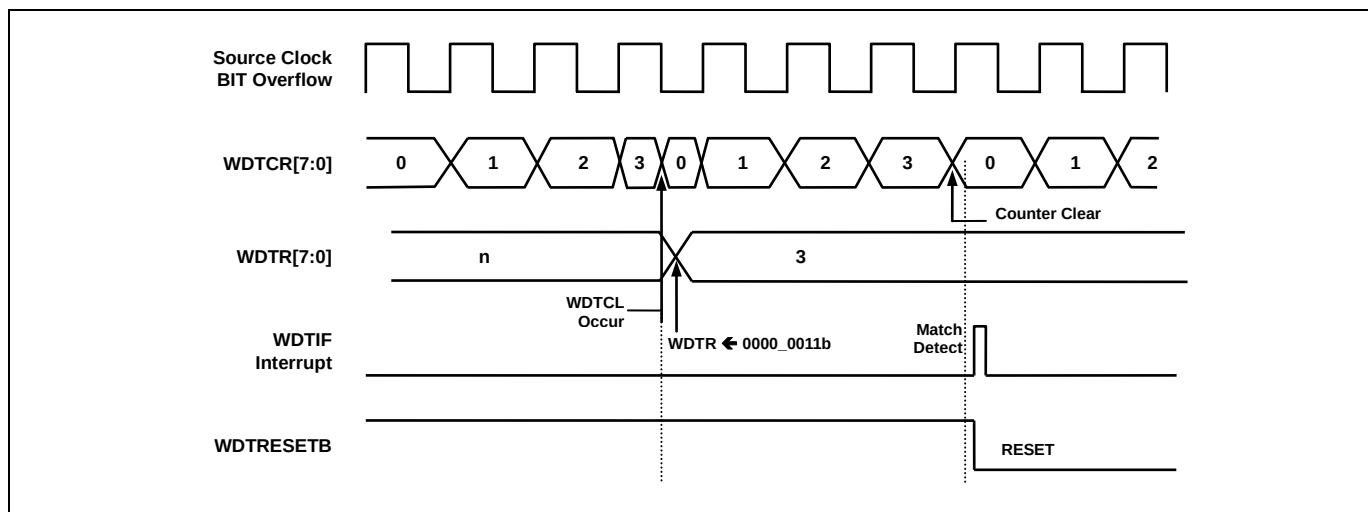


Figure 11.4 WDT Interrupt Timing Waveform

11.4 Watch Timer

11.4.1 Overview

The watch timer has the function for RTC (Real Time Clock) operation. It is generally used for RTC design. The internal structure of the watch timer consists of the clock source select circuit, timer counter circuit, output select circuit and watch timer mode register. To operate the watch timer, determine the input clock source, output interval and set WTEN to '1' in watch timer mode register (WTMR). It is able to execute simultaneously or individually. To stop or reset WT, clear the WTEN bit in WTMR register. Even if CPU is STOP mode, sub clock is able to be alive so WT can continue the operation. The watch timer counter circuits may be composed of 21-bit counter which is low 14-bit with binary counter and high 7-bit with auto reload counter in order to raise resolution. In WTR, it can control WT clear and set Interval value at write time, and it can read 7-bit WT counter value at read time.

11.4.2 Block Diagram

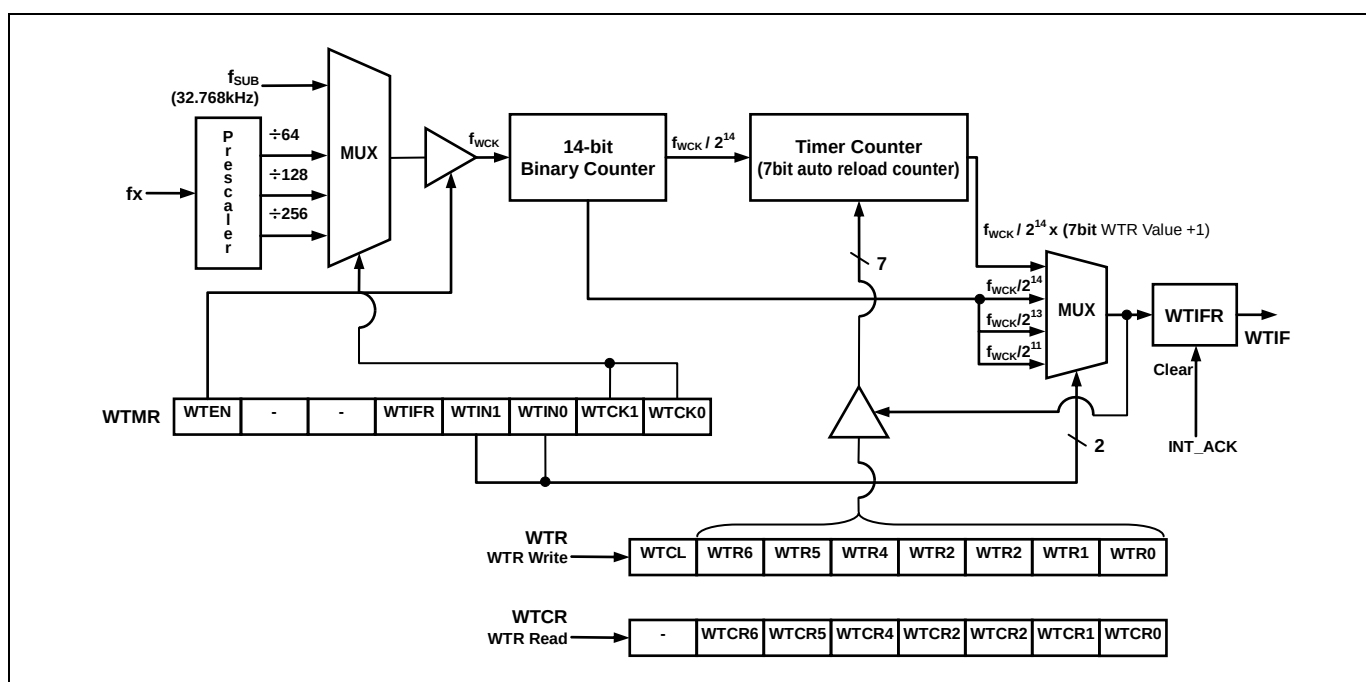


Figure 11.5 Watch Timer Block Diagram

11.4.3 Register Map

Name	Address	Dir	Default	Description
WTMR	9DH	R/W	00H	Watch Timer Mode Register
WTR	9EH	W	7FH	Watch Timer Register
WTCR	9EH	R	00H	Watch Timer Counter Register

Table 11.4 Register Map

11.4.4 Watch Timer Register Description

The watch timer register (WT) consists of Watch Timer Mode Register (WTMR), Watch Timer Counter Register (WTCR) and Watch Timer Register (WTR). As WTMR is 6-bit writable/readable register, WTMR can control the clock source (WTCK), interrupt interval (WTIN) and function enable/disable (WTEN). Also there is WT interrupt flag bit (WTIFR).

11.4.5 Register Description for Watch Timer

WTMR (Watch Timer Mode Register) : 9DH

7	6	5	4	3	2	1	0
WTEN	-	-	WTIFR	WTIN1	WTIN0	WTCK1	WTCK0
RW	-	-	RW	RW	RW	RW	RW

Initial value : 00H

WTEN Control Watch Timer

0 disable

1 enable

WTIFR When WT Interrupt occurs, this bit becomes '1'. For clearing bit, write '0' to this bit or auto clear by INT_ACK signal.

0 WT Interrupt no generation

1 WT Interrupt generation

WTIN[1:0] Determine interrupt interval

WTIN1	WTIN0	description
0	0	fwck/2048
0	1	fwck/8192
1	0	fwck/16384
1	1	fwck/16384 x (7bit WT Value)

WTCK[1:0] Determine Source Clock

WTCK1	WTCK0	description
0	0	fsub
0	1	fx/256
1	0	fx/128
1	1	fx/64

NOTE)

1. Remark: fx– Main system clock oscillation frequency
2. fsub- Sub clock oscillation frequency
3. fwck- selected Watch Timer clock

WTR (Watch Timer Register: Write Case) : 9EH

7	6	5	4	3	2	1	0
WTCL	WTR6	WTR5	WTR4	WTR3	WTR2	WTR1	WTR0
W	W	W	W	W	W	W	W

Initial value : 7FH

WTCL Clear WT Counter

0 Free Run

1 Clear WT Counter (auto clear after 1 Cycle)

WTR[6:0] Set WT periodWT Interrupt Interval=(fwck/2¹⁴) x(7bit WT Value+1)**NOTE)**

1. To guarantee proper operation, it is greater than 01H to write WTR.

WTCR (Watch Timer Counter Register: Read Case) : 9EH

7	6	5	4	3	2	1	0
	WTCR6	WTCR5	WTCR4	WTCR3	WTCR2	WTCR1	WTCR0
-	R	R	R	R	R	R	R

Initial value : 00H

WTCR[6:0] WT Counter

11.5 Timer/PWM

11.5.1 8-bit Timer/Event Counter 0, 1

11.5.1.1 Overview

Timer 0 and timer 1 can be used either two 8-bit timer/counter or one 16-bit timer/counter with combine them. Each 8-bit timer/event counter module has multiplexer, 8-bit timer data register, 8-bit counter register, mode register, input capture register, comparator. For PWM, it has PWM register (T1PPR, T1ADR, T1BDR, T1CDR, T1PCR, T1PCR2, T1PCR3, T1PHR, T1DLYA, T1DLYB, T1DLYC, T1ISR, T1IMSK).

It has seven operating modes:

- 8-bit timer/counter mode
- 8-bit capture mode
- 8-bit compare output mode
- 16-bit timer/counter mode
- 16-bit capture mode
- 16-bit compare output mode
- PWM mode

NOTE)

1. TxDR must be set to higher than 0x03 for guaranteeing operation.

The timer/counter can be clocked by an internal or an external clock source (external EC0). The clock source is selected by clock select logic which is controlled by the clock select (T0CK[2:0], T1CK[3:0]). Also the timer/PWM/event counter 1 can use more clock sources than timer/event counter 0.

- TIMER0 clock source: fX/2, 4, 8, 32, 128, 512, 2048, EC0
- TIMER1 clock source: fX/1, 2, 4, 8, 16, 32, 64, 128, 256, 512, 1024, 2048, 4096, 8192, 16384, T0CK

In the capture mode, by INT0, INT1, the data is captured into Input Capture Register. The timer 0 outputs the compare result to T0 port in 8/16-bit mode. Also the timer 1 outputs the result to T1 port in the timer mode and the PWM wave form to PWMA, PWMAB(bar), PWMB, PWMBB, PWMC, PWMCB Port(6-channel) in the PWM mode.

16BIT	CAP0	CAP1	PWM1E	T0CK[2:0]	T1CK[3:0]	T0/1 PE	Timer 0	Timer 1
0	0	0	0	XXX	XXXX	00	8-bit Timer	8-bit Timer
0	0	1	0	111	XXXX	00	8-bit Event Counter	8-bit Capture
0	1	0	0	XXX	XXXX	01	8-bit Capture	8-bit Compare Output
0	0	0	1	XXX	XXXX	11	8-bit Timer/Counter	10-bit PWM
1	0	0	0	XXX	1111	00	16-bit Timer	
1	0	0	0	111	1111	00	16-bit Event Counter	
1	1	1	0	XXX	1111	00	16-bit Capture	
1	0	0	0	XXX	1111	01	16-bit Compare Output	

Table 11.5 Timer 0,1 operating modes

11.5.1.2 8-bit Timer/Counter Mode

The 8-bit Timer/Counter Mode is selected by control registers as shown in Figure 11.6.

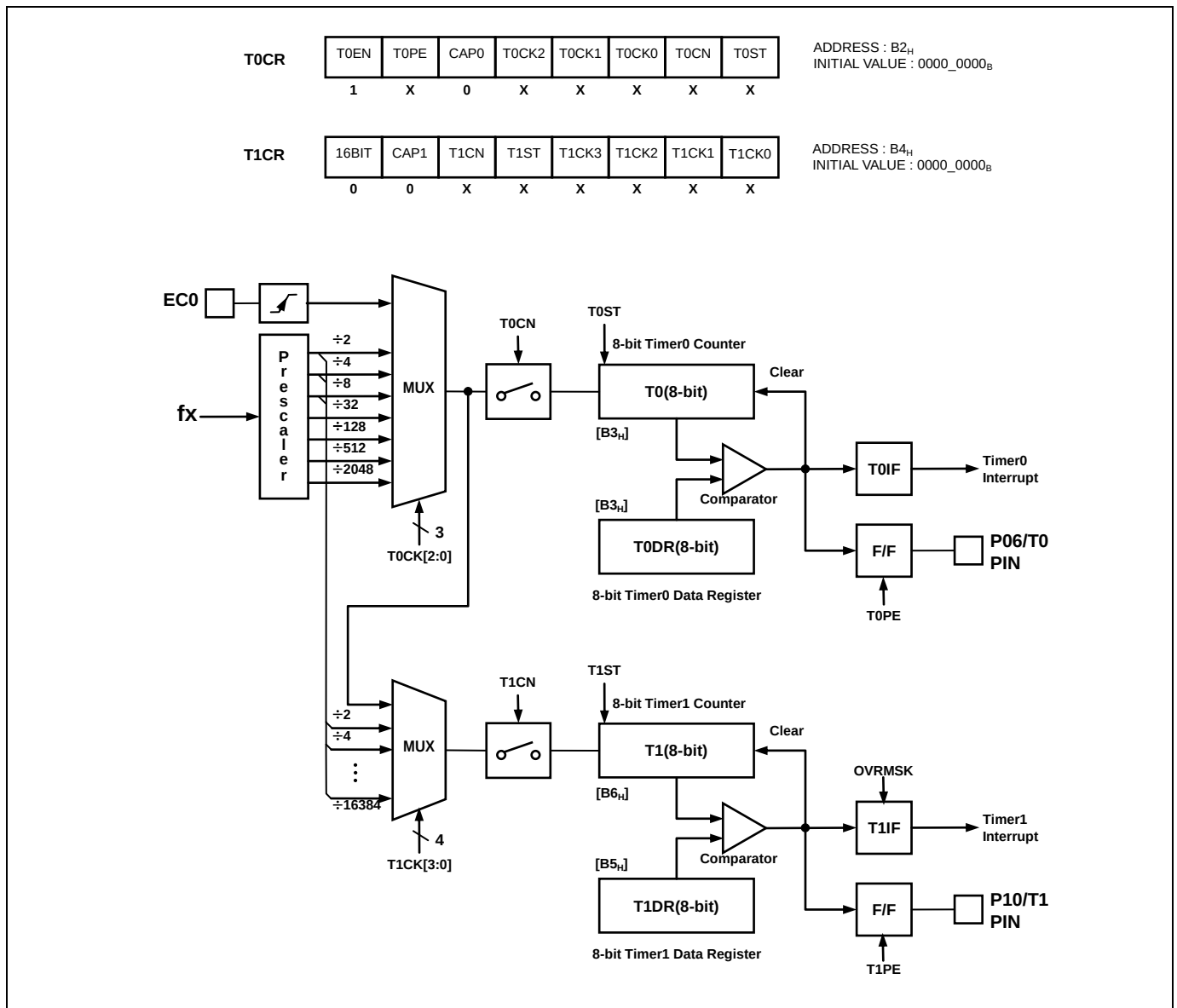


Figure 11.6 8-bit Timer/Event Counter 0, 1 Block Diagram

The two 8-bit timers have each counter and data register. The counter register is increased by internal or external clock input. The timer 0 can use the input clock with one of 2, 4, 8, 32, 128, 512, 2048 prescaler division rates (T0CK[2:0]). The timer 1 can use the input clock with one of 1, 2, 8 ~ 16384 and timer 0 overflow clock (T1CK[3:0]). When the value of T0,1 value and the value of T0DR, T1DR are respectively identical in Timer 0, 1, the interrupt of Timer 0, 1 occurs. The external clock (EC0) counts up the timer at the rising edge. If EC0 is selected from T0CK[2:0], EC0 port becomes input port. The timer 1 can't use the external EC0 clock.

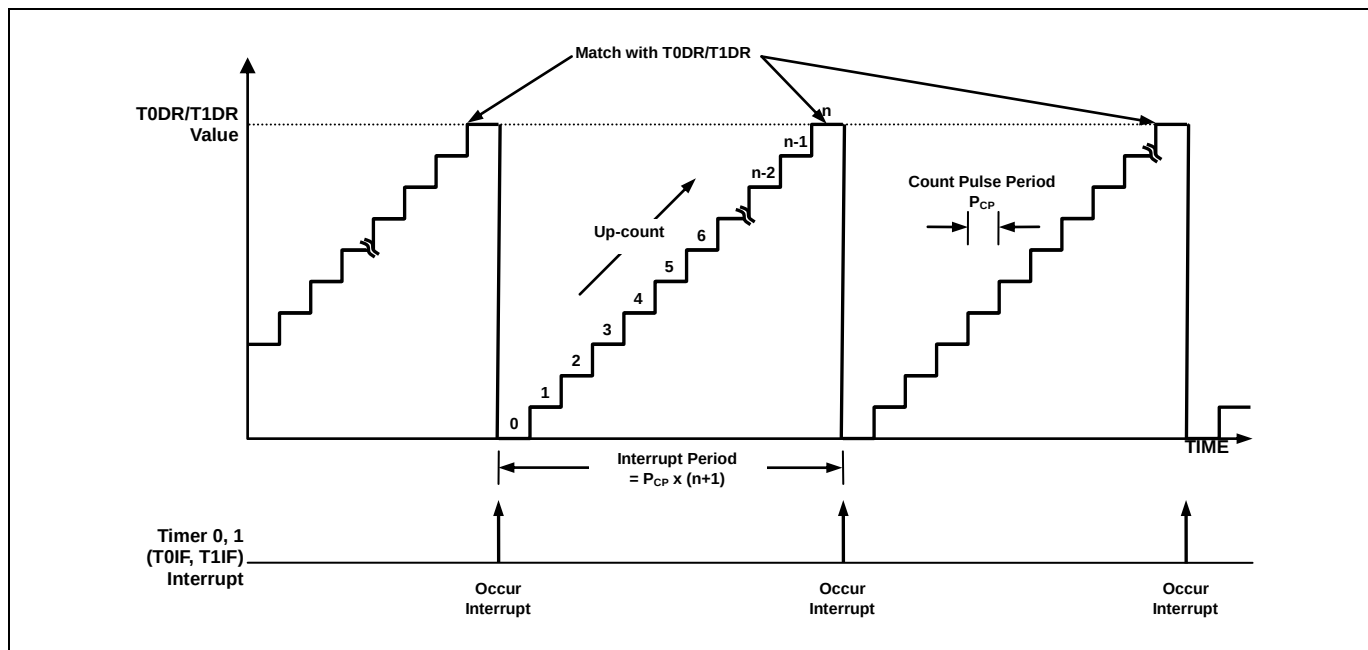


Figure 11.7 Timer/Event Counter 0, 1 Example

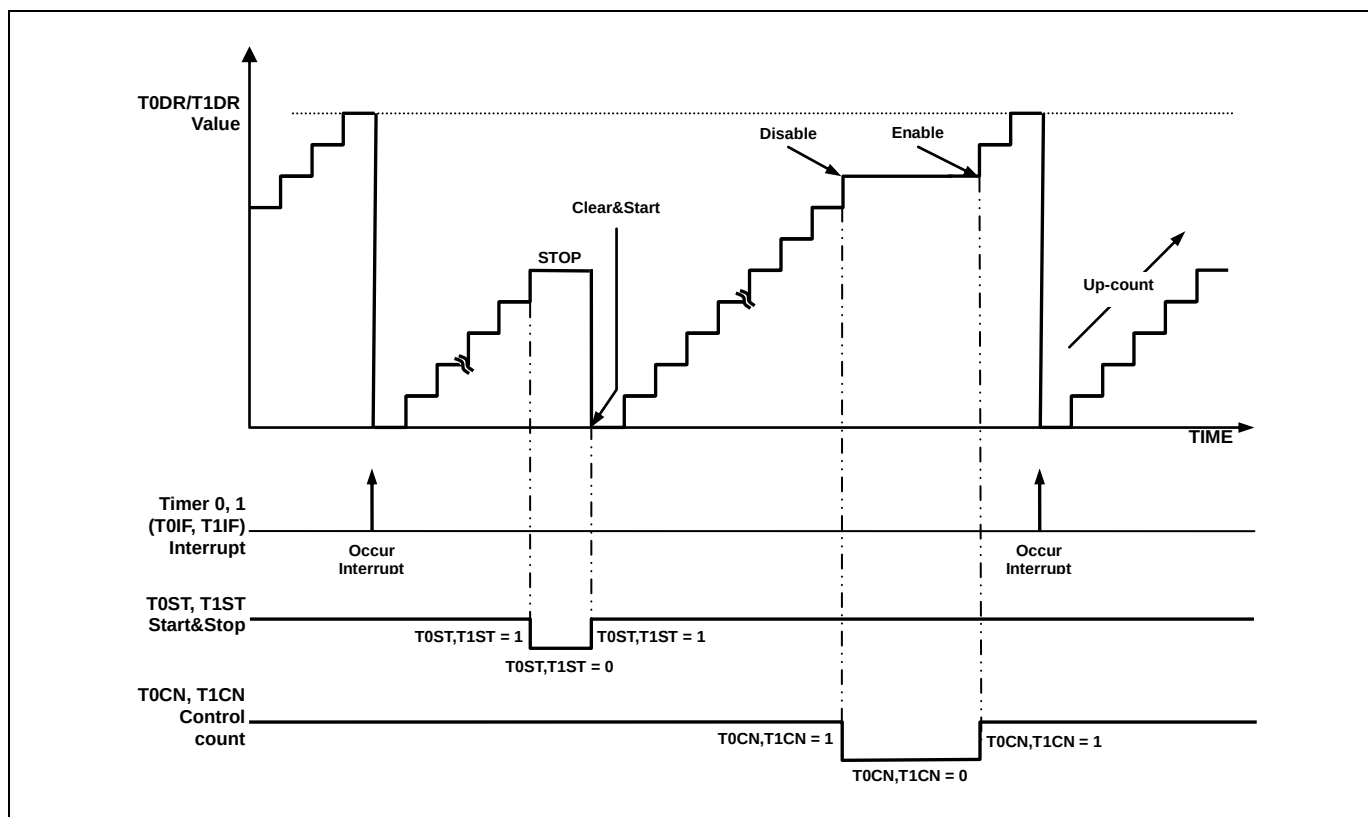


Figure 11.8 Timer/Event Counter0, 1 Count Operation

11.5.1.3 16-bit Timer/Counter Mode

The timer register is being run with all 16 bits. A 16-bit timer/counter register T0, T1 are incremented from 0003H to FFFFH until it matches T0DR, T1DR and then resets to 0000H. The match output generates the Timer 0 interrupt (No timer 1 interrupt). The clock source is selected from T0CK[2:0] and T1CK[3:0] must set 1111b and 16BIT bit must set to '1'. The timer 0 is LSB 8-bit, the timer 1 is MSB 8-bit. T0DR must not be 0x00 (0x01~0xFF). The 16-bit mode selection is shown as Figure 11.9.

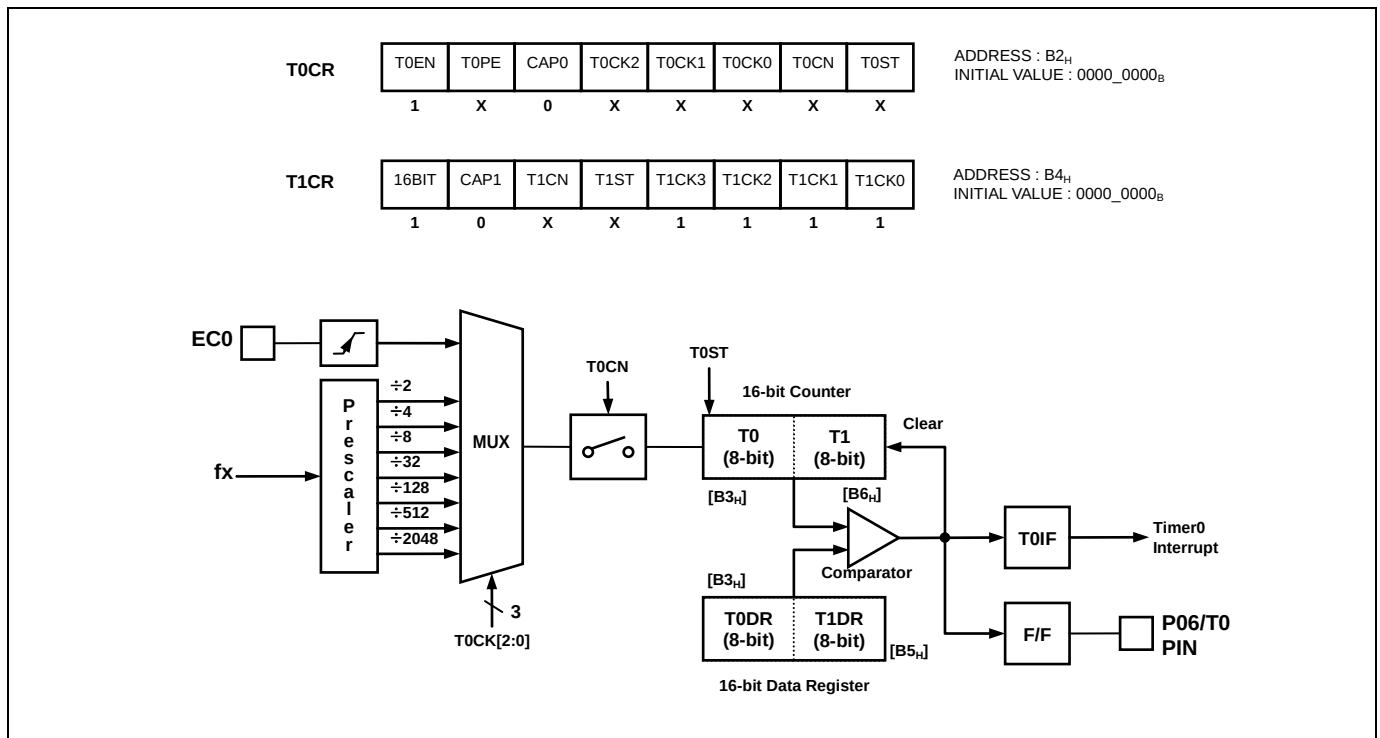


Figure 11.9 16-bit Timer/Counter for Time 0, 1

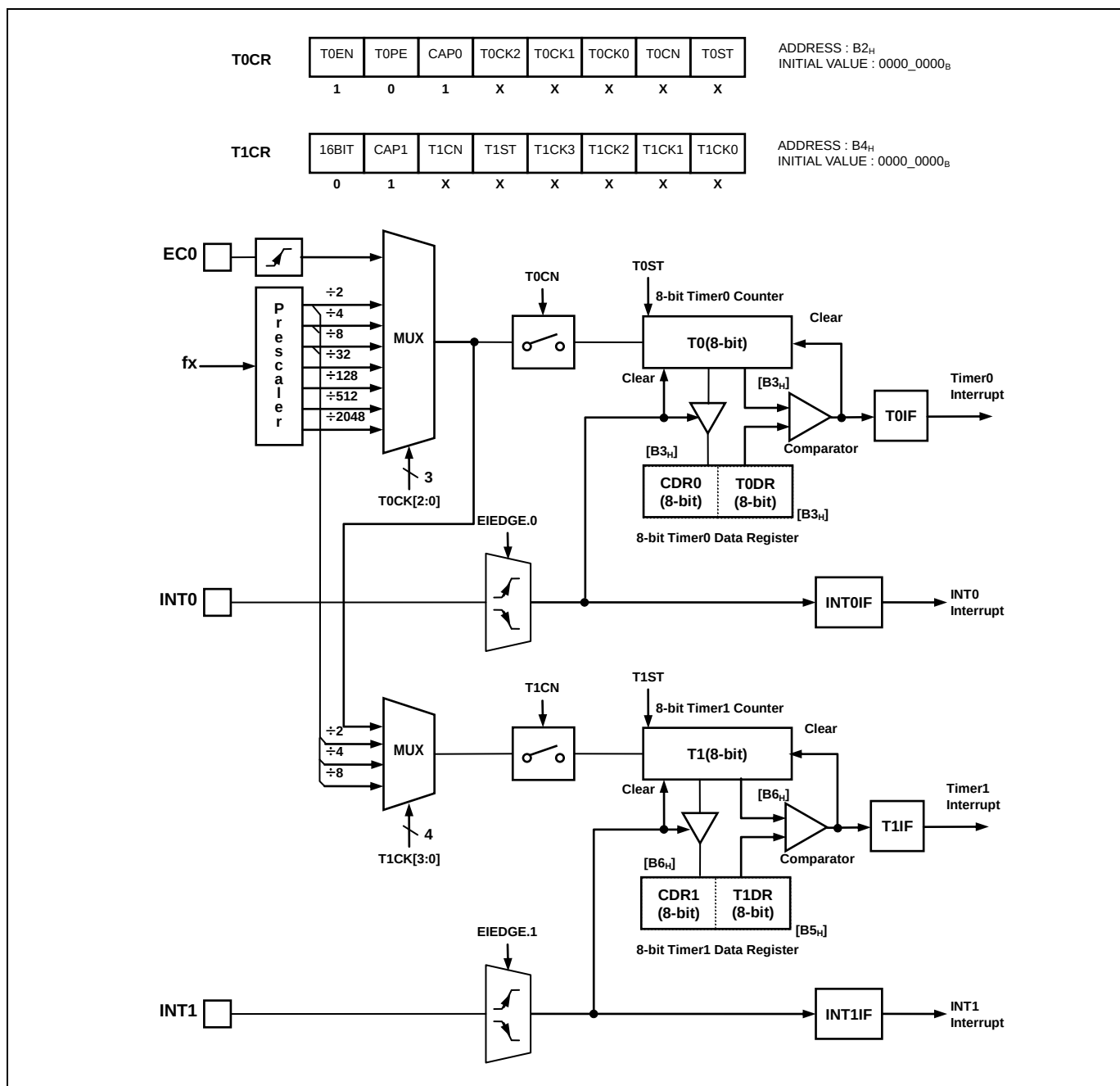
11.5.1.4 8-bit Capture Mode

The timer 0, 1 capture mode is set by CAP0, CAP1 as '1'. The clock source can use the internal/external clock. Basically, it has the same function of the 8-bit timer/counter mode and the interrupt occurs at T0, T1 and T0DR, T1DR matching time, respectively. The capture result is loaded into CDR0, CDR1. The T0, T1 value is automatically cleared by hardware and restarts counter.

This timer interrupt in capture mode is very useful when the pulse width of captured signal is wider than the maximum period of timer.

As the EIEDGE and EIPOLA register setting, the external interrupt INT1, INT0 function is chosen.

The CDR0, T0 and T0DR are in same address. In the capture mode, reading operation reads the CDR0, not T0DR because path is opened to the CDR0. The CDR1 has the same function.



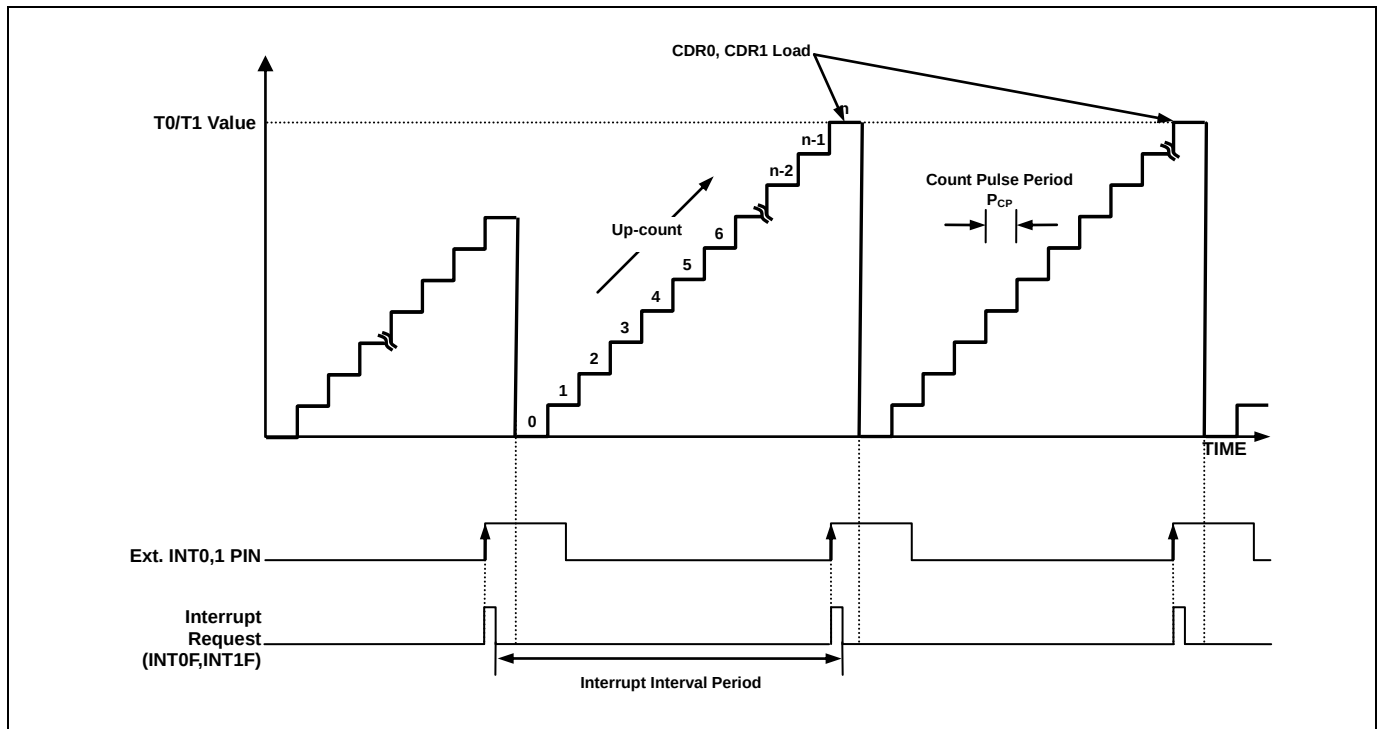


Figure 11.11 Input Capture Mode Operation of Timer 0, 1

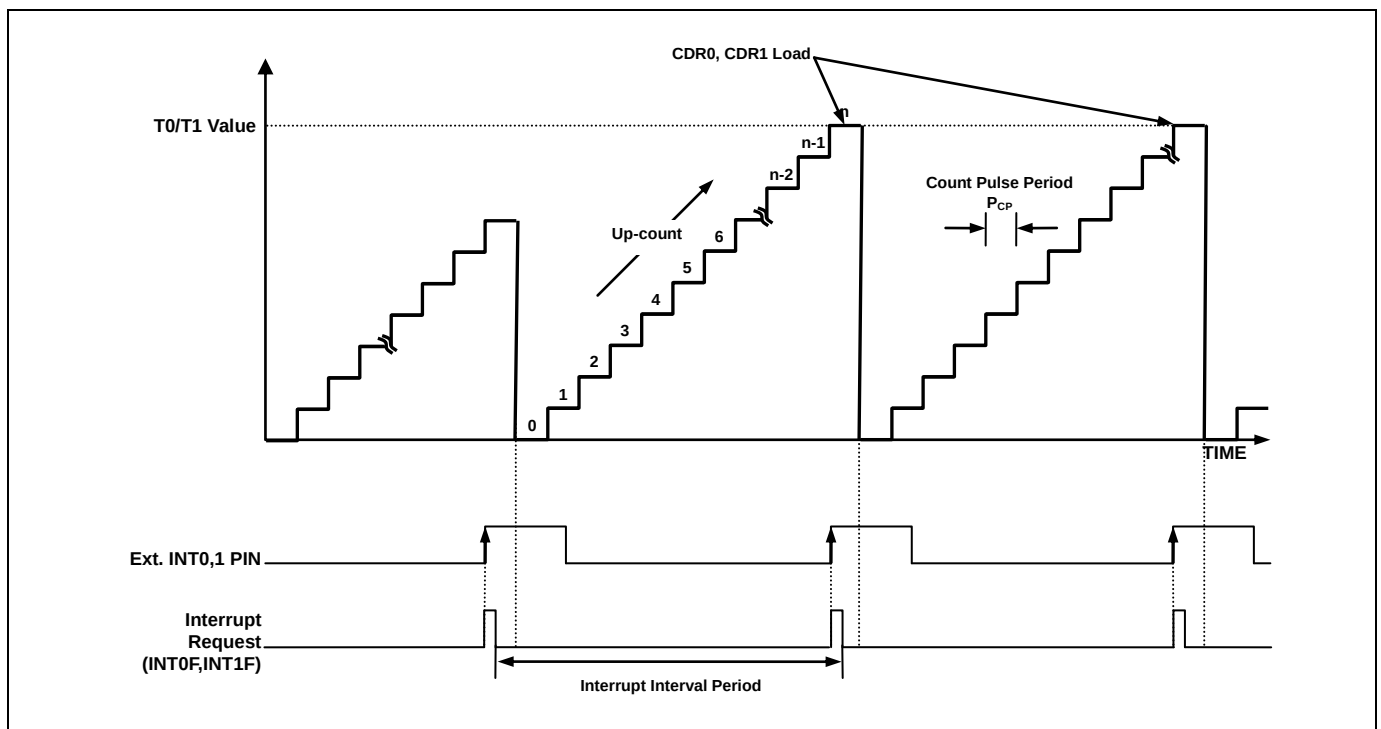


Figure 11.12 Express Timer Overflow in Capture Mode

11.5.1.5 16-bit Capture Mode

The 16-bit capture mode is the same operation as 8-bit capture mode, except that the timer register uses 16 bits.

The clock source is selected from T0CK[2:0] and T1CK[3:0] must set 1111b and 16BIT bit must set to '1'. The 16-bit mode setting is shown as Figure 11.13.

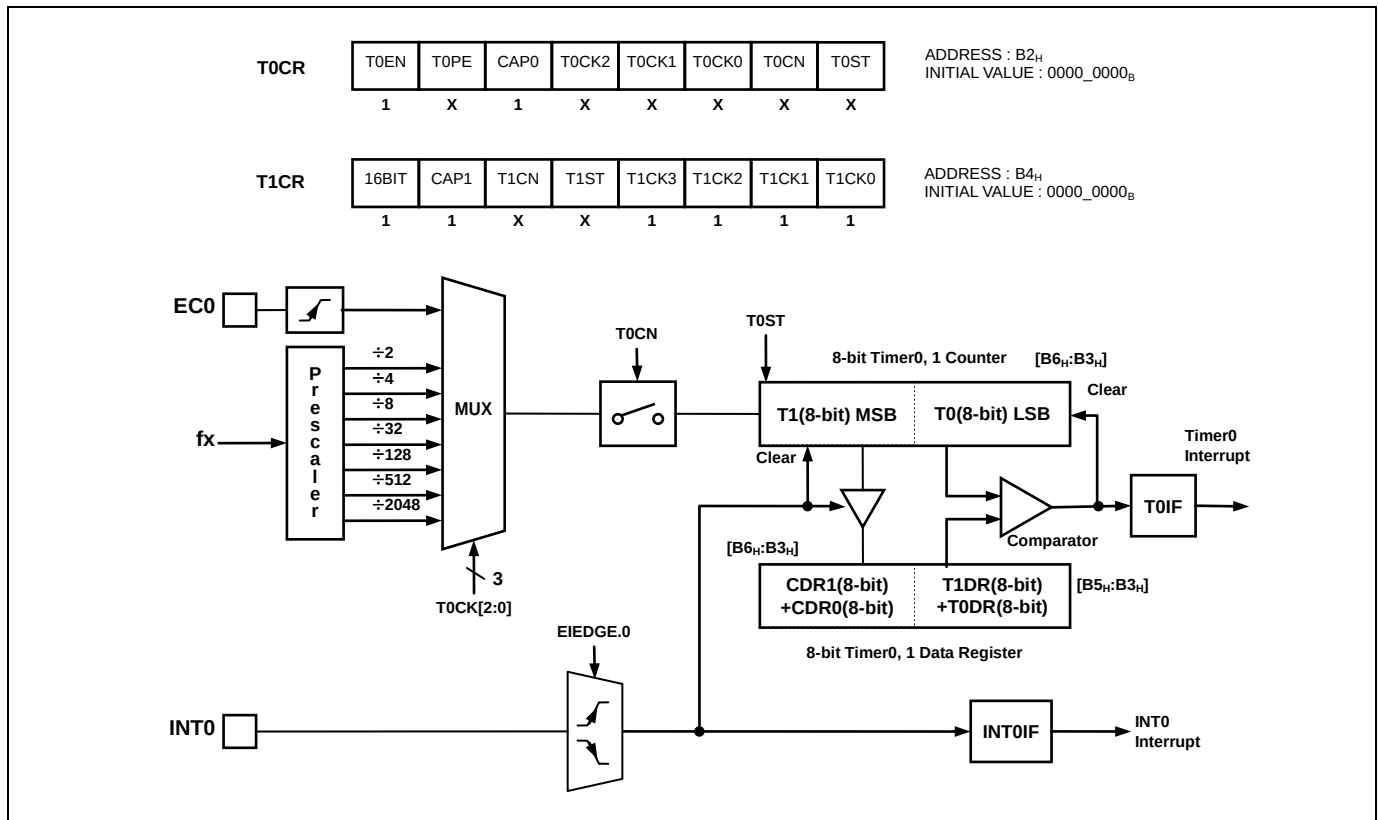


Figure 11.13 16-bit Capture Mode of Timer 0, 1

11.5.1.6 PWM Mode

The timer 1 has a high speed PWM (pulse Width Modulation) function. In PWM mode, the 6-channel pins output up to 10-bit resolution PWM output. This pin should be configured as a PWM output by set PWM1E to '1'. The period of the PWM output is determined by the T1PPR (PWM period register) + T1PHR[1:0], T1xDR (each channel PWM duty register) + T1PHR[7:2].

$$\text{PWM Period} = [\text{T1PHR}[1:0] \text{T1PPR}] \times \text{Source Clock}$$

$$\text{PWM Duty(A-ch)} = [\text{T1PHR}[7:6] \text{T1ADR}] \times \text{Source Clock}$$

NOTE)

1. T1PPR must be set to higher than T1PDR for guaranteeing operation.

Resolution	Frequency		
	T1CK[3:0]=0001 (250ns)	T1CK[3:0]=0010 (500ns)	T1CK[3:0]=0100 (2us)
10-bit	3.9kHz	1.95kHz	0.49kHz
9-bit	7.8kHz	3.9kHz	0.98kHz
8-bit	15.6kHz	7.8kHz	1.95kHz
7-bit	31.2kHz	15.6kHz	3.91kHz

Table 11.6 PWM Frequency vs. Resolution at 8MHz

The POLx bit of T1PCR3 register decides the polarity of duty cycle. If the duty value is set same to the period value, the PWM output is determined by the bit POLx (1: High, 0: Low). And if the duty value is set to "00H", the PWM output is determined by the bit POLx (1: Low, 0: High). PWM output is not retain high or low but toggle.

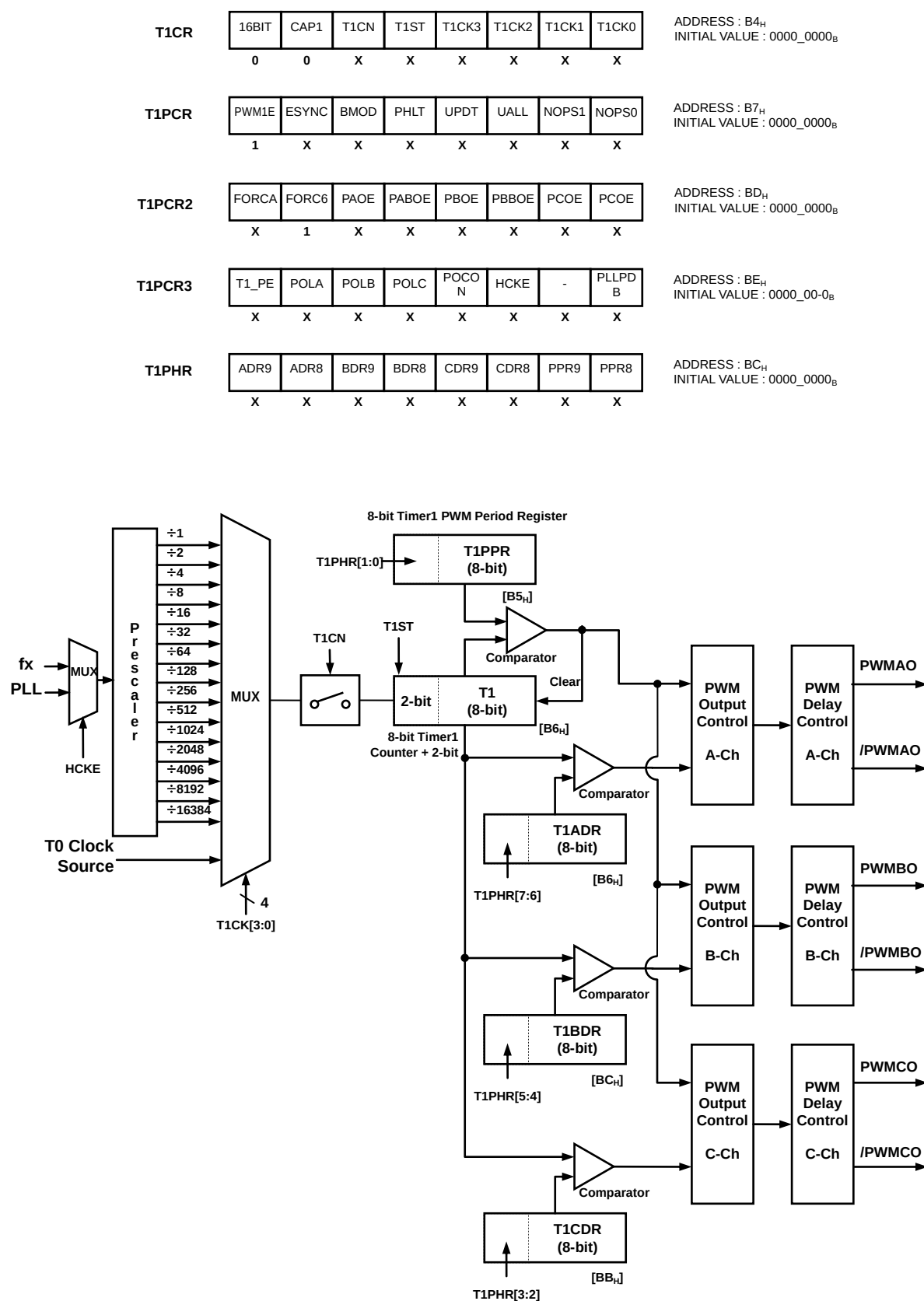


Figure 11.14 PWM Mode (Force 6-ch)

T1CR	16BIT	CAP1	T1CN	T1ST	T1CK3	T1CK2	T1CK1	T1CK0	ADDRESS : B4 _H INITIAL VALUE : 0000_0000 _B
	0	0	X	X	X	X	X	X	
T1PCR	PWM1E	ESYNC	BMOD	PHLT	UPDT	UALL	NOPS1	NOPS0	ADDRESS : B7 _H INITIAL VALUE : 0000_0000 _B
	1	X	X	X	X	X	X	X	
T1PCR2	FORCA	FORC6	PAOE	PABOE	PBOE	PBBOE	PCOE	PCOE	ADDRESS : BD _H INITIAL VALUE : 0000_0000 _B
	1	X	X	X	X	X	X	X	
T1PCR3	T1_PE	POLA	POLB	POLC	POCO N	HCKE	-	PLLPD B	ADDRESS : BE _H INITIAL VALUE : 0000_00-0 _B
	X	X	X	X	X	X	X	X	
T1PHR	ADR9	ADR8	BDR9	BDR8	CDR9	CDR8	PPR9	PPR8	ADDRESS : BC _H INITIAL VALUE : 0000_0000 _B
	X	X	X	X	X	X	X	X	

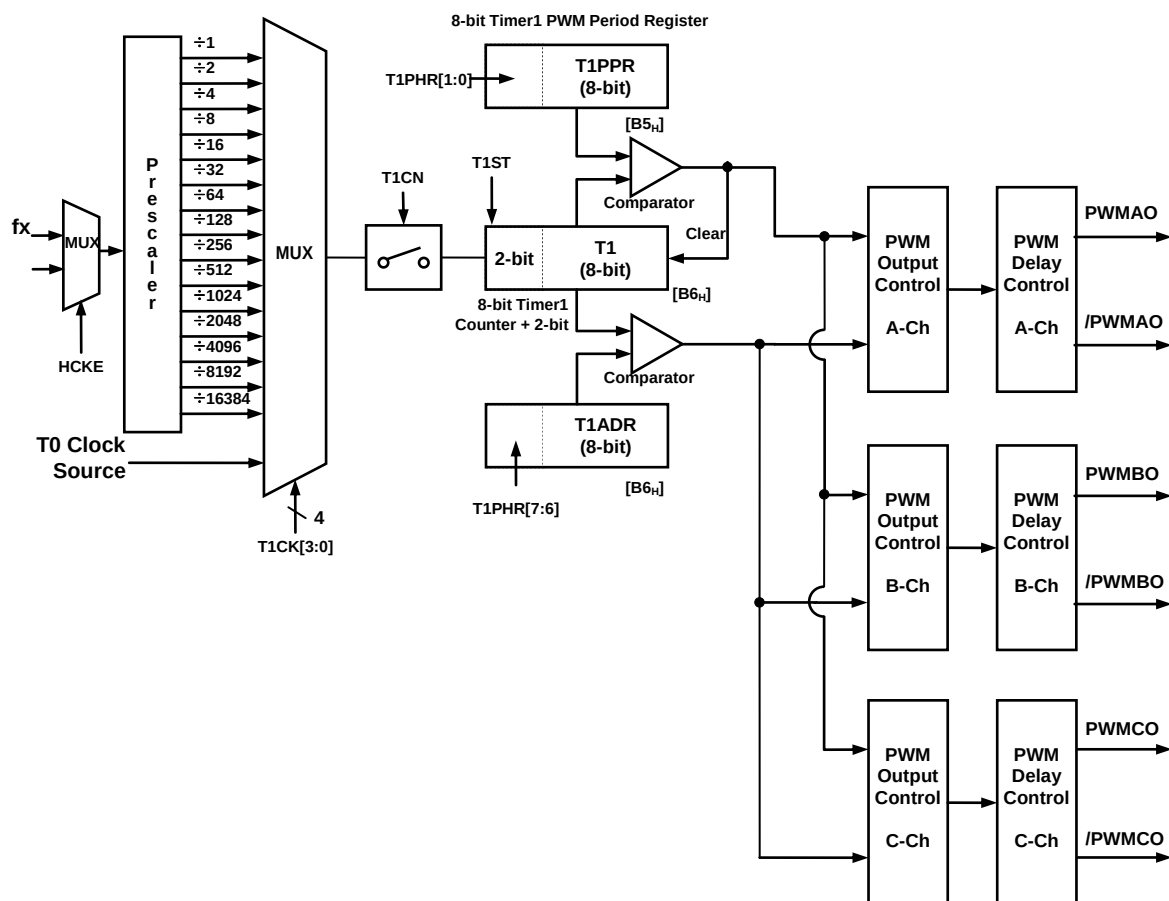


Figure 11.15 PWM Mode (Force All-ch)

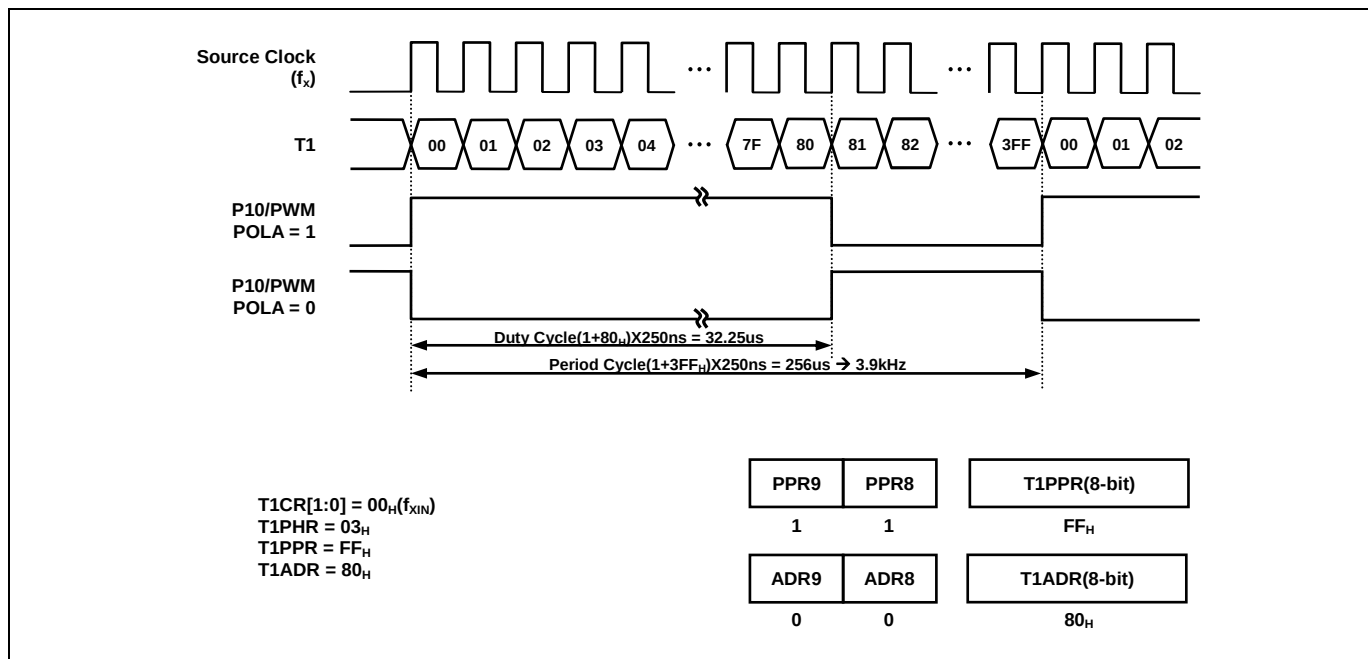


Figure 11.16 Example of PWM at 4MHz

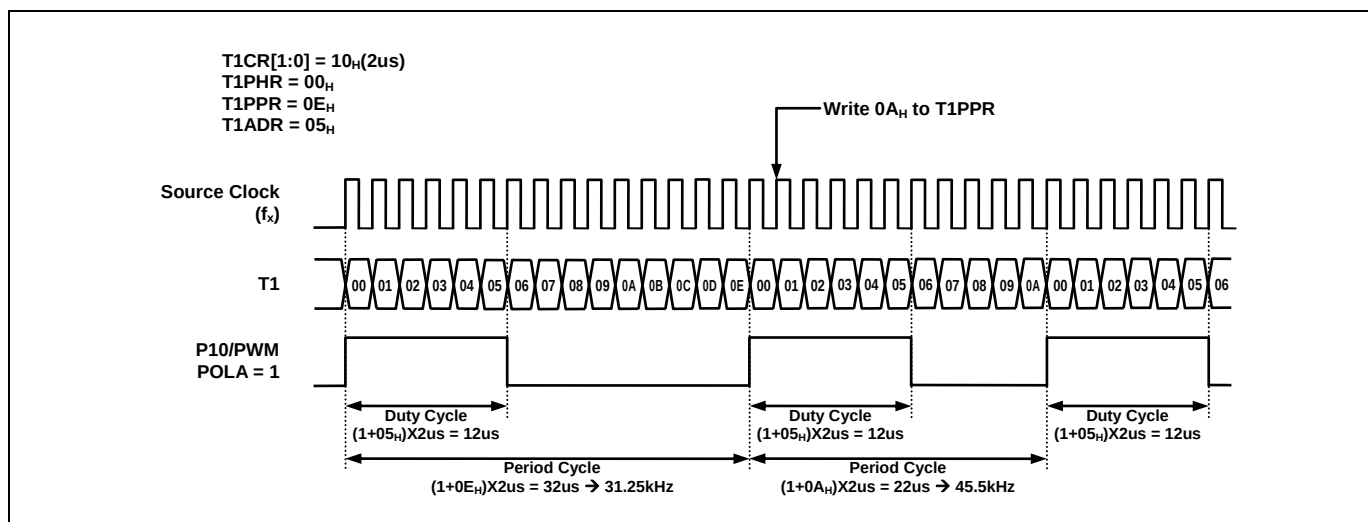


Figure 11.17 Example of Changing the Period in Absolute Duty Cycle at 4Mhz

Update period & duty register value at once

The period and duty of PWM comes to move from temporary registers to PPR (PWM Period Register) and PDR (PWM Duty Register) when always period match occurs. If you want that the period and duty is immediately changed, the UPDT bit in the T1PCR register must set to '1'. It should be noted that it needs the 3 cycle of timer clock for data transfer in the internal clock synchronization circuit. So the update data is written before 3 cycle of timer clock to get the right output waveform.

Phase correction & Frequency correction

On operating PWM, it is possible that it is changed the phase and the frequency by using BMOD bit (back-to-back mode) in T1PCR register. (Figure 11.18, Figure 11.19, Figure 11.20 referred)

In the back-to-back mode, the counter of PWM repeats up/down count. In fact, the effective duty and period becomes twofold of the register set values. (Figure 11.18, Figure 11.19 referred)

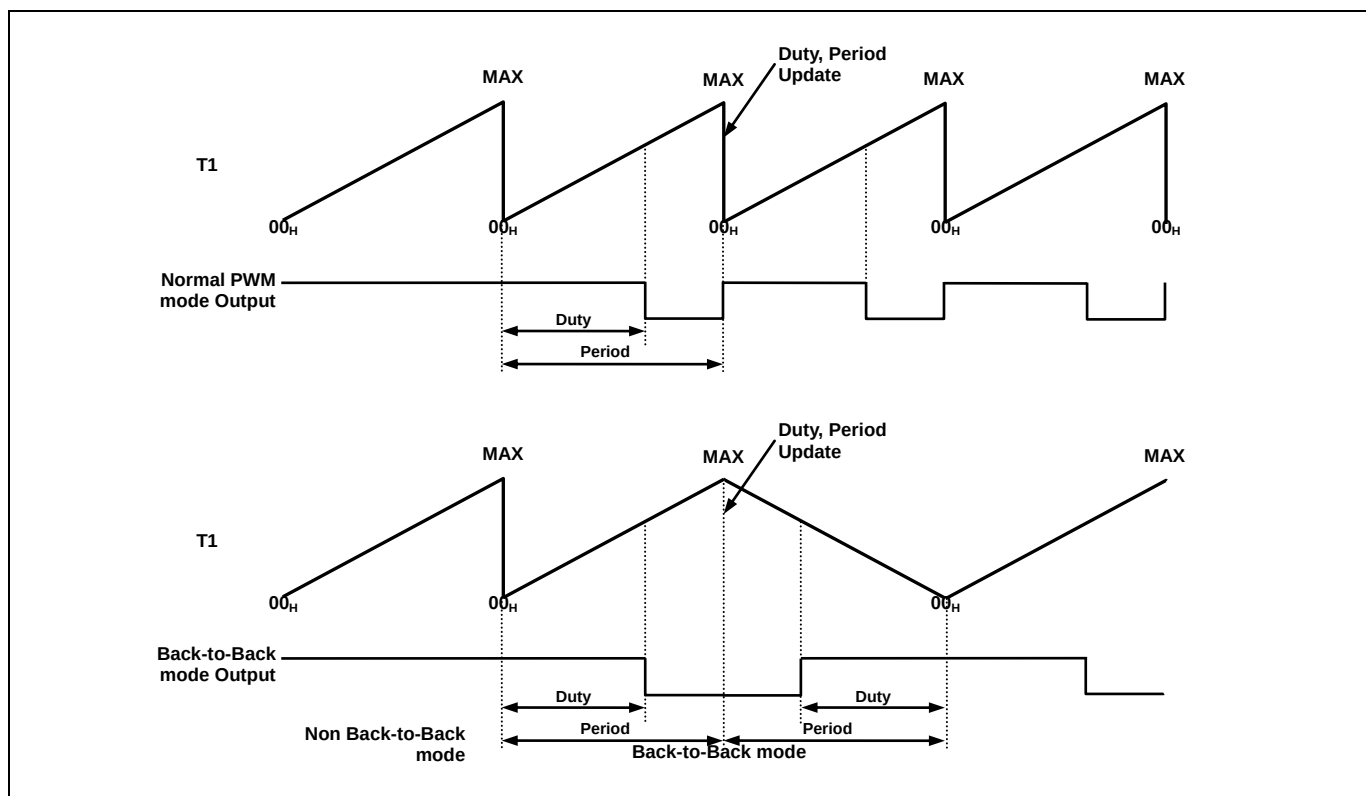


Figure 11.18 Example of PWM Output Waveform

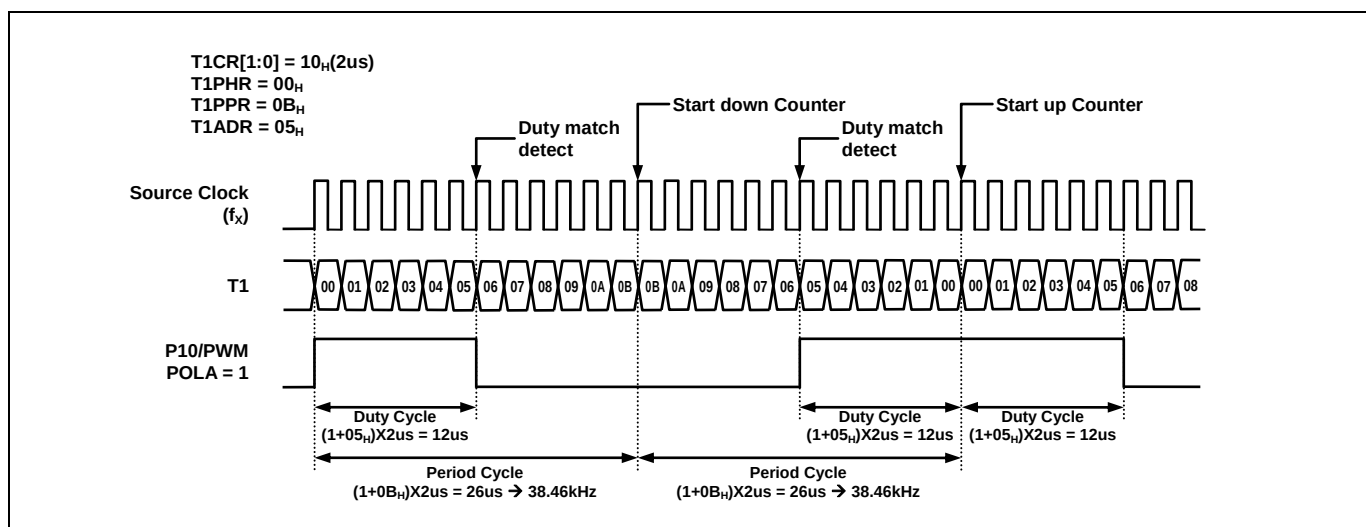


Figure 11.19 Example of PWM waveform in Back-to-Back mode at 4Mhz

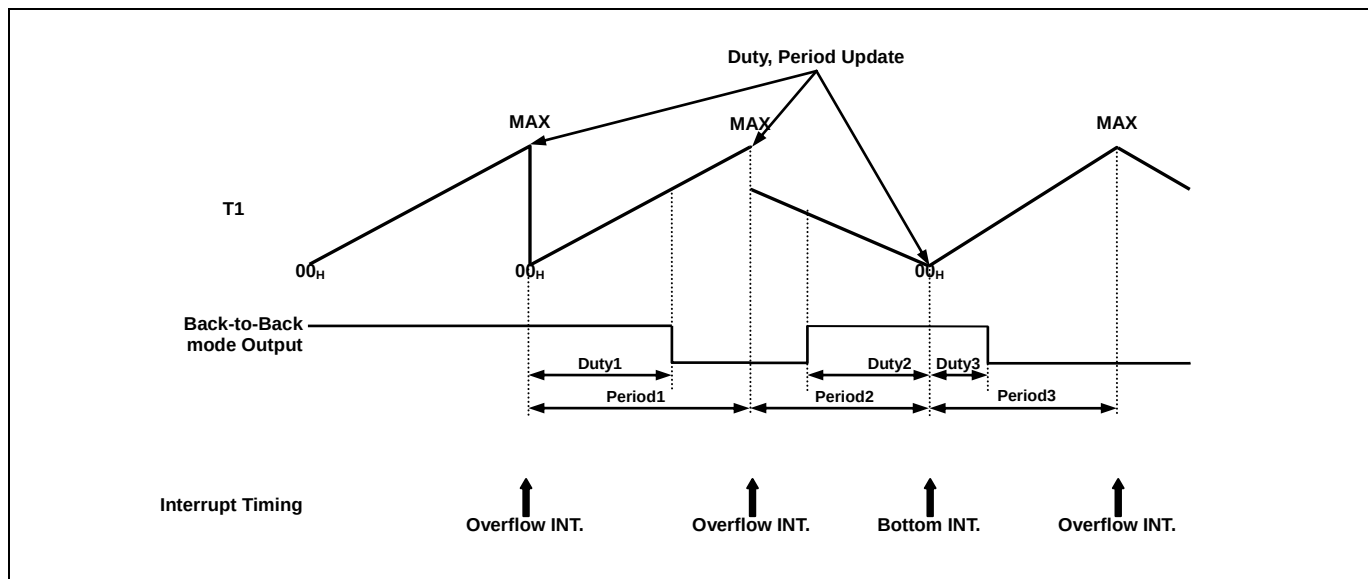


Figure 11.20 Example of Phase Correction and Frequency correction of PWM

External Sync

If using ESYNC bit of T1PCR register, it is possible to synchronize the output of PWM from external signal.

If ESYNC bit sets to '1', the external signal moves to PWM module through the BLNKB pin (P16). If BLNKB signal is low, immediately PWM output becomes a reset value, and internal counter becomes reset. If BLNKB signal returns to '1', the counter is started again and PWM output is normally generated. (Figure 11.21 referred)

PWM Halt

If using PHLT bit of T1PCR register, it is possible to stop PWM operation by the software. During PHLT bit being '1', PWM output becomes a reset value, and internal counter becomes reset as 0. Without changing PWM setting, temporarily it is able to stop PWM. In case of T1CN, when stopping counter, PWM output pin remains before states. But if PHLT bit sets to '1', PWM output pin has reset value.

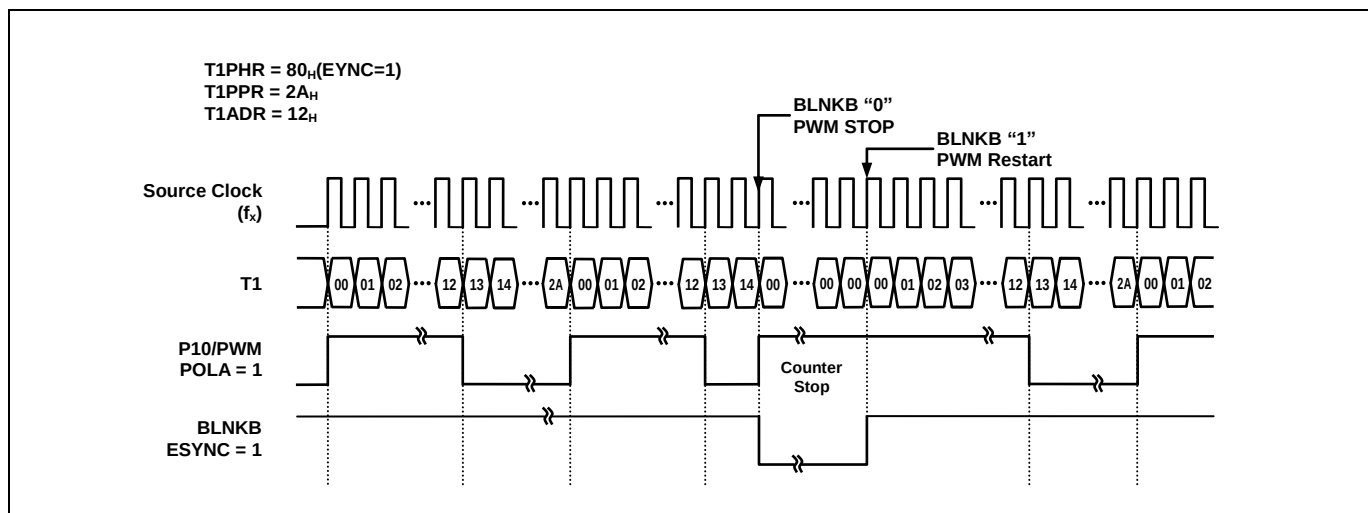


Figure 11.21 Example of PWM External Synchronization with BLNKB Input

FORCE Drive ALL ch with A-ch mode

If FORCA bit sets to '1', it is possible to enable or disable all PWM output pins through PWM outputs which occur from A-ch duty counter. It is noted that the inversion outputs of A, B, C channel have the same A-ch output waveform. According to POLA/B/C, it is able to control the inversion of outputs.

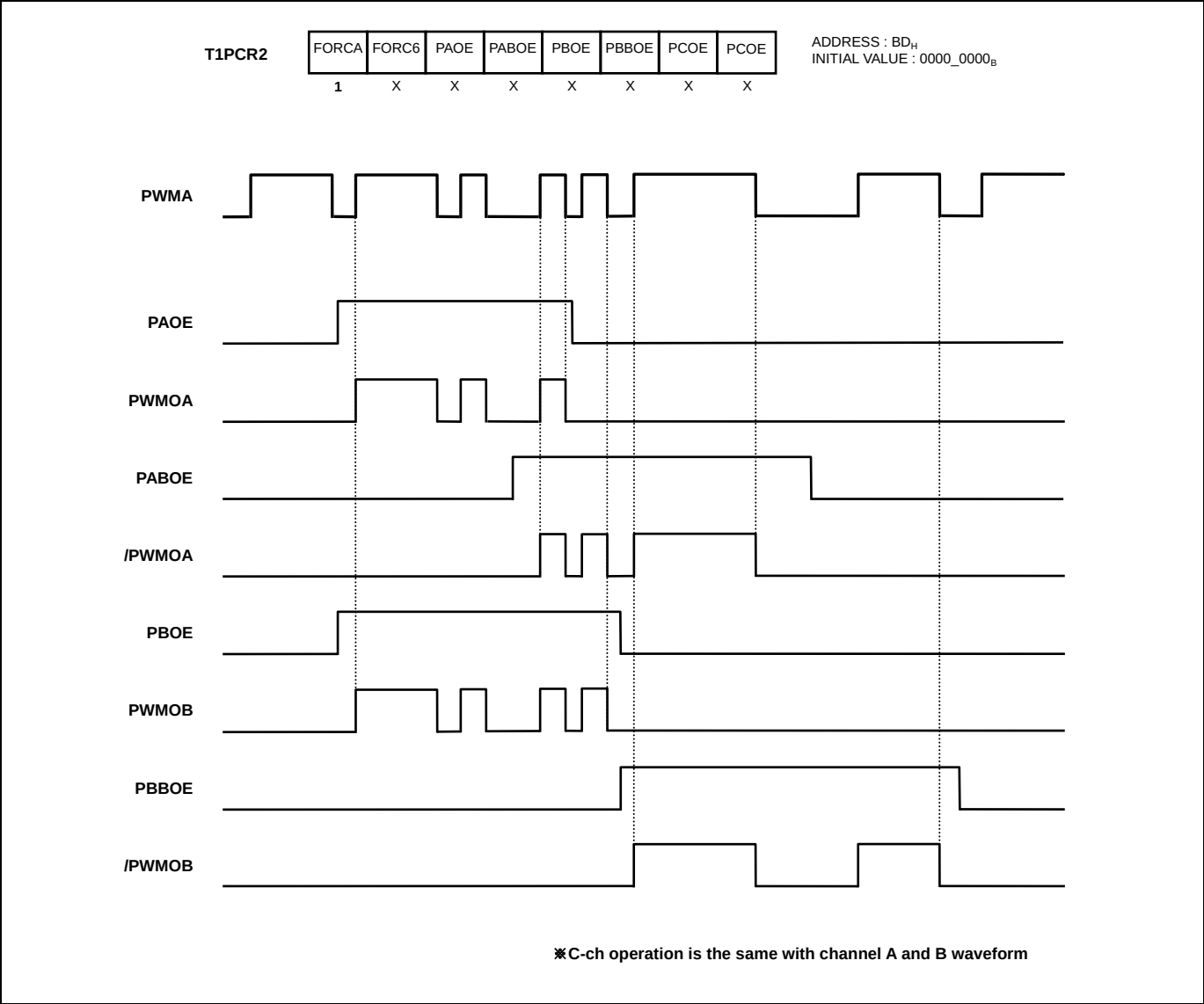


Figure 11.22 Example of Force Drive All-ch with A-ch

FORCE 6-ch Drive

If FORC6 bit sets to '1', it is possible to enable or disable PWM output pin and inversion output pin generated through the duty counter of each channel. The inversion output is the reverse phase of the PWM output. A A/AB output of the A-channel duty register, a B/BB output of the B-channel duty register, a C/CB output of the C-channel duty register are controlled respectively. If the UALL bit is set to '1', it is updated B/C channel duty at the same time, when it is written by a A-channel duty register.

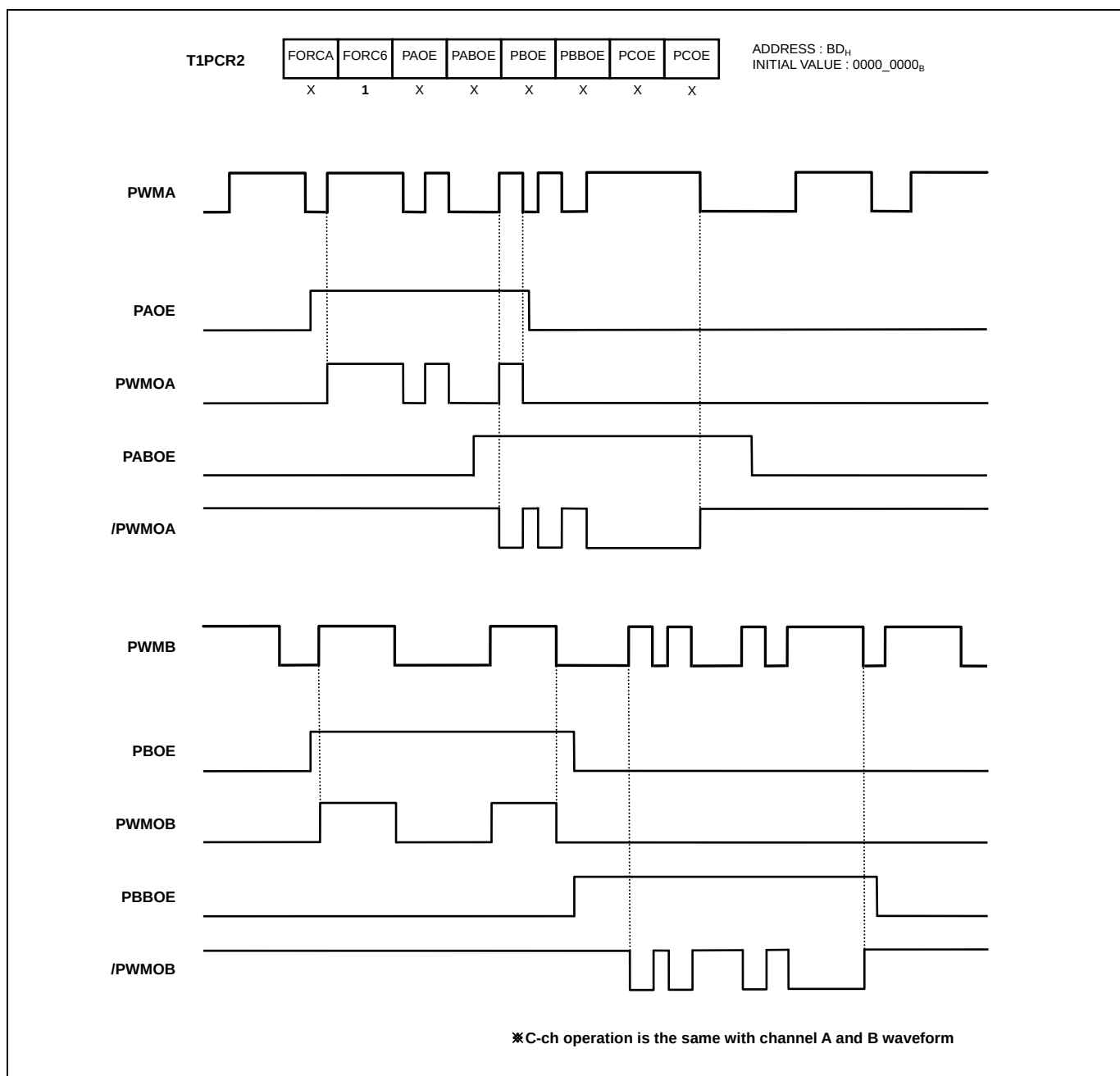


Figure 11.23 Example of Force Drive 6-ch Mode

T1CR	16BIT	CAP1	T1CN	T1ST	T1CK3	T1CK2	T1CK1	T1CK0	ADDRESS : B4 _H INITIAL VALUE : 0000_0000 _B
	0	0	X	X	X	X	X	X	
T1PCR	PWM1E	ESYNC	BMOD	PHLT	UPDT	UALL	NOPS1	NOPS0	ADDRESS : B7 _H INITIAL VALUE : 0000_0000 _B
	X	X	X	X	X	X	X	X	
T1PCR2	FORCA	FORC6	PAOE	PABOE	PBOE	PBBOE	PCOE	PCOE	ADDRESS : BD _H INITIAL VALUE : 0000_0000 _B
	X	X	X	X	X	X	X	X	
T1PCR3	T1_PE	POLA	POLB	POLC	POCON	HCKE	-	PLLPD B	ADDRESS : BE _H INITIAL VALUE : 0000_00-0 _B
	X	X	X	X	X	X	X	X	

PWM1E	T1_PE	FORCA FORC6	POCON	P1xE P1xBE	Port Control
0	1	X	X	X	T1 (timer1) output enable
1	1	0	0	X	All 6 PWM outputs enable
1	1	0	1	X	GPIO get control, when PWM stop*
1	X	1	0	0	Corresponding PWM output "0"
1	X	1	0	1	Corresponding PWM outputs enable
1	X	1	1	0	GPIO get control for disabled channels
1	X	1	1	1	Corresponding PWM outputs enable

* PWM stop condition : when ESYNC = "1", BLANKB can stop PWM1 or PHLT bit was set("1")

When POCON was set "1", ports direction of the disabled PWM channels would be controlled by GPIO registers. So if user set GPIO direction register as input mode for corresponding pins, disabled PWM pins would be input mode.

The port is fixed as the output at the Timer mode. But at the PWM mode, using POCON bit, when PWM output port does not work, it can change the state of output port to input (high-Z) state. It is determined from the port control register to select in/out signal. If using FORCE mode, it can only change the wanted channel direction of the 6-channel outputs. In the FORCE mode, the channel direction of the disabled output is determined by each port control register bit, regardless of the PWM stop.

Figure 11.24 PWM Port control

PWM output Delay

If using the PDLYA, PDLYB, PDLYC register, it can delay PWM output based on the rising edge. At that time, it does not change the falling edge, so the duty is reduced as the time delay. In POLA/B/C setting to '0', the delay is applied to the falling edge. In POLA/B/C setting to '1', the delay is applied to the rising edge. It can produce a pair of Non-overlapping clock. The each channel is able to have 4-bit delay. As it can select the clock up to 1/8 divided clock using NOPS1, NOPS0, the delay of its maximum 128 timer clock cycle is produced.

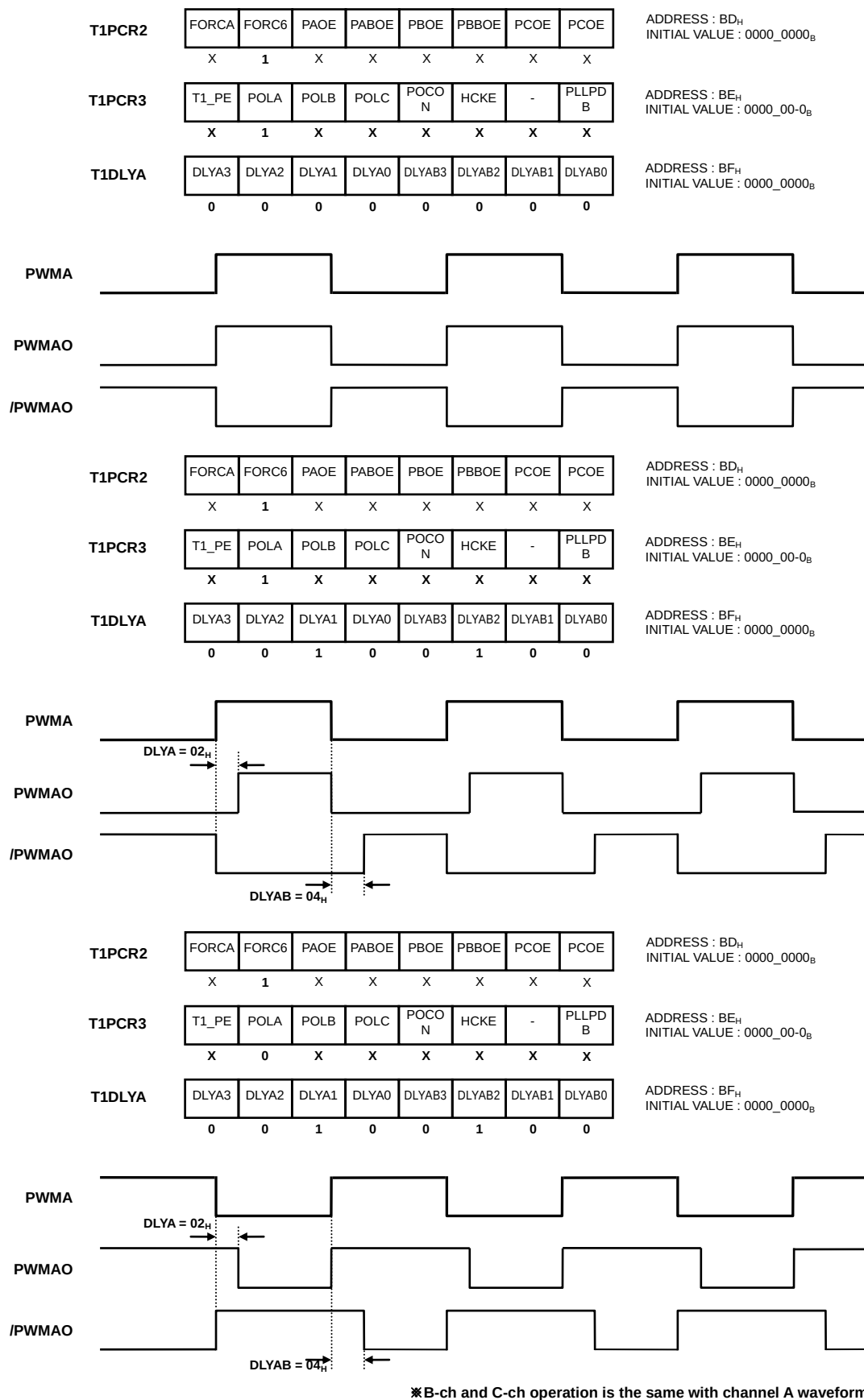


Figure 11.25 Example of PWM Delay

11.5.1.7 8-bit (16-bit) Compare Output Mode

If the T1 (T0+T1) value and the T1DR (T0DR+T1DR) value are matched, T1/PWM1A port outputs. The output is 50:50 of duty square wave, the frequency is following.

$$f_{COMP} = \frac{\text{Oscillator Frequency}}{2 \times \text{Prescaler Value} \times (TDR + 1)}$$

To export the compare output as T1/PWM1A, the T1_PE bit in the T1PCR3 register must set to '1'.

11.5.1.8 Register Map

Name	Address	Dir	Default	Description
T0CR	B2H	R/W	00H	Timer 0 Mode Control Register
T0	B3H	R	00H	Timer 0 Register
T0DR	B3H	W	FFH	Timer 0 Data Register
CDR0	B3H	R	00H	Capture 0 Data Register
T1CR	B4H	R/W	00H	Timer 1 Mode Control Register
T1DR	B5H	W	FFH	Timer 1 Data Register
T1PPR	B5H	W	FFH	Timer 1 PWM Period Register
T1	B6H	R	00H	Timer 1 Register
T1ADR	B6H	R/W	7FH	Timer 1 PWM 1A Duty Register
CDR1	B6H	R	00H	Capture 1 Data Register
T1PCR	B7H	W	00H	Timer 1 PWM Control Register
T1BDR	BAH	R/W	7FH	Timer 1 PWM 1B Duty Register
T1CDR	BBH	R/W	7FH	Timer 1 PWM 1C Duty Register
T1PHR	BCH	R/W	00H	Timer 1 PWM High Register
T1PCR2	BDH	R/W	00H	Timer 1 PWM Control Register 2
T1PCR3	BEH	R/W	00H	Timer 1 PWM Control Register 3
T1DLYA	BFH	R/W	00H	PWM1 Non-Overlap Delay Register ch. A/AB
T1DLYB	C2H	R/W	00H	PWM1 Non-Overlap Delay Register ch. B/BB
T1DLYC	C3H	R/W	00H	PWM1 Non-Overlap Delay Register ch. C/CB
T1ISR	C4H	R/W	00H	Timer 1 Interrupt Status Register
T1IMSK	C5H	R/W	00H	Timer 1 Interrupt Mask Register
PLLCR	85H	R/W	42H	Timer1 PLL Control Register

Table 11.7 Register Map

11.5.1.9 Timer/Counter 0 Register Description

The Timer/Counter 0,1 register consists of Timer 0 Mode Control Register (T0CR), Timer 0 Register (T0), Timer 0 Data Register (T0DR), Capture 0 Data Register (CDR0), Timer 1 Mode Control Register (T1CR), Timer 1 Data Register (T1DR), Timer 1 PWM Period Register (T1PPR), Timer 1 Register (T1), Timer 1 PWM 1A Duty Register (T1ADR), Capture 1 Data Register (CDR1), Timer 1 PWM Control Register (T1PCR), Timer 1 PWM 1B Duty Register (T1BDR), Timer 1 PWM 1C Duty Register (T1CDR), Timer 1 PWM High Register (T1PHR), Timer 1 PWM Control Register 2 (T1PCR2), Timer 1 PWM Control Register 3 (T1PCR3), PWM1 Non-Overlap Delay Register ch. A/AB (T1DLYA), PWM1 Non-Overlap Delay Register ch. B/BB (T1DLYB), PWM1 Non-Overlap Delay Register ch. C/CB (T1DLYC), Timer 1 Interrupt Status Register (T1ISR), Timer 1 Interrupt Mask Register (T1IMSK) and PLL Control Register (PLLCR)

11.5.1.10 Register description for Timer/Counter 0, 1

T0CR (Timer 0 Mode Control Register) : B2H

7	6	5	4	3	2	1	0
T0EN	T0_PE	CAPO	T0CK2	T0CK1	T0CK0	T0CN	T0ST
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

T0EN	Control Timer 0			
	0	Timer 0 disable		
	1	Timer 0 enable		
T0_PE	Control Timer 0 Output port			
	0	Timer 0 Output disable		
	1	Timer 0 Output enable		
CAPO	Control Timer 0 operation mode			
	0	Timer/Counter mode		
	1	Capture mode		
T0CK[2:0]	Select Timer 0 clock source. Fx is main system clock frequency			
	T0CK2	T0CK1	T0CK0	description
	0	0	0	fx/2
	0	0	1	fx/4
	0	1	0	fx/8
	0	1	1	fx/32
	1	0	0	fx/128
	1	0	1	fx/512
	1	1	0	fx/2048
	1	1	1	External Clock (EC0)
T0CN	Control Timer 0 Count pause/continue			
	0	Temporary count stop		
	1	Continue count		
T0ST	Control Timer 0 start/stop			
	0	Counter stop		
	1	Clear counter and start		

T0 (Timer 0 Register: Read Case) : B3H

7	6	5	4	3	2	1	0
T07	T06	T05	T04	T03	T02	T01	T00
R	R	R	R	R	R	R	R

Initial value : 00H

T0[7:0] T0 Counter**T0DR (Timer 0 Data Register: Write Case) : B3H**

7	6	5	4	3	2	1	0
T0D7	T0D6	T0D5	T0D4	T0D3	T0D2	T0D1	T0D0
W	W	W	W	W	W	W	W

Initial value : FFH

T0D[7:0] T0 Compare**CDR0 (Capture 0 Data Register: Read Case, Capture mode only) : B3H**

7	6	5	4	3	2	1	0
CDR07	CDR06	CDR05	CDR04	CDR03	CDR02	CDR01	CDR00
R	R	R	R	R	R	R	R

Initial value : 00H

CDR0[7:0] T0 Capture**T1CR (Timer 1 Mode Count Register) : B4H**

7	6	5	4	3	2	1	0
16BIT	CAP1	T1CN	T1ST	T1CK3	T1CK2	T1CK1	T1CK0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

16BIT Select Timer 1 8/16-bit

0 8-bit
 1 16-bit

CAP1 Control Timer 1 operation mode

0 Timer/Counter mode
 1 Capture mode

T1CN Control Timer 1 Count pause/continue

0 Temporary count stop
 1 Continue count

T1ST Control Timer 1 start/stop

0 Counter stop
 1 Clear counter and start

T1CK[3:0] Select Timer 1 clock source. Fx is main system clock frequency

T1CK3	T1CK2	T1CK1	T1CK0	description
0	0	0	0	fx
0	0	0	1	fx/2
0	0	1	0	fx/4
0	0	1	1	fx/8
0	1	0	0	fx/16
0	1	0	1	fx/32
0	1	1	0	fx/64
0	1	1	1	fx/128

1	0	0	0	fx/256
1	0	0	1	fx/512
1	0	1	0	fx/1024
1	0	1	1	fx/2048
1	1	0	0	fx/4096
1	1	0	1	fx/8192
1	1	1	0	fx/16384
1	1	1	1	Using Timer 0 Clock

NOTE)

1. If you want to use “Using Timer 0 Clock”, you can set T0EN bit in T0CR

T1DR (Timer 1 Data Register: Write Case) : B5H

7	6	5	4	3	2	1	0
T1D7	T1D6	T1D5	T1D4	T1D3	T1D2	T1D1	T1D0
W	W	W	W	W	W	W	W

Initial value : FFH

T1D[7:0] T1 Compare

T1PPR (Timer 1 PWM Period Register: Write Case PWM mode only) : B5H

7	6	5	4	3	2	1	0
T1PP7	T1PP6	T1PP5	T1PP4	T1PP3	T1PP2	T1PP1	T1PP0
W	W	W	W	W	W	W	W

Initial value : FFH

T1PP[7:0] T1 PWM period

T1 (Timer 1 Register: Read Case) : B6H

7	6	5	4	3	2	1	0
T17	T16	T15	T14	T13	T12	T11	T10
R	R	R	R	R	R	R	R

Initial value : 00H

T1[7:0] T1 Counter period

T1ADR (Timer 1 PWM 1A Duty Register PWM mode only) : B6H

7	6	5	4	3	2	1	0
PAD7	PAD6	PAD5	PAD4	PAD3	PAD2	PAD1	PAD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 7FH

T1ADR[7:0] T1 PWM Duty
NOTE) only write, when PWM1E '1'

CDR1 (Capture 1 Data Register: Read Case, Capture mode only) : B6H

7	6	5	4	3	2	1	0
CDR17	CDR16	CDR15	CDR14	CDR13	CDR12	CDR11	CDR10
R	R	R	R	R	R	R	R

Initial value : 00H

CDR1[7:0] T1 Capture

T1PCR (Timer 1 PWM Control Register) : B7H

7	6	5	4	3	2	1	0
PWM1E	ESYNC	BMOD	PHLT	UPDT	UALL	NOPS1	NOPS0
W	W	W	W	W	W	W	W

Initial value : 00H

PWM1E	Control PWM		
	0	PWM disable	
	1	PWM enable	
ESYNC	Select the operation of External Sync Mode		
	0	External Sync Mode disable	
	1	External Sync Mode enable (using with BLNKB(P16))	
BMOD	Control Back-To-Back Mode operation		
	0	BtB mode disable (only up count)	
	1	BtB mode enable (Up/Down count)	
PHLT	Control PWM		
	0	PWM running	
	1	PWM stop	
UPDT	Determine the update time of PPR, PDR		
	0	Update at period match	
	1	Update at any time (after 3 timer clock, update)	
UALL	Control update all duty register		
	0	Write duty register separately	
	1	Write all duty registers (via A duty)	
NOPS1[1:0]	Select on-Overlap prescaler		
	NOTE) fpwm: PWM operation clock frequency		
	NOPS1	NOPS0	description
	0	0	fpwm
	0	1	fpwm/2
	1	0	fpwm/4
	1	1	fpwm/8

T1BDR (Timer 1 PWM 1B Duty Register) : BAH

7	6	5	4	3	2	1	0
PBD7	PBD6	PBD5	PBD4	PBD3	PBD2	PBD1	PBD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 7FH

T1BDR[7:0] PWM 1B ch Duty**NOTE)** only write, when PWM1E '1'**T1CDR (Timer 1 PWM 1C Duty Register) : BBH**

7	6	5	4	3	2	1	0
PCD7	PCD6	PCD5	PCD4	PCD3	PCD2	PCD1	PCD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 7FH

T1CDR[7:0] PWM 1C ch Duty**NOTE)** only write, when PWM1E '1'**T1PHR (Timer 1 PWM High Register) : BCH**

7	6	5	4	3	2	1	0
ADR9	ADR8	BDR9	BDR8	CDR9	CDR8	PPR9	PPR8
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

ADR[9:8] PWM 1A High (bit[9:8])**BDR[9:8]** PWM 1B High (bit[9:8])**CDR[9:8]** PWM 1C High (bit[9:8])**PPR[9:8]** PERIOD High (bit[9:8])

PERIOD:

DUTY A:

DUTY B:

DUTY C:

PPR9

PPR8

ADR9

ADR8

BDR9

BDR8

CDR9

CDR8

T1PPR[7:0]

P1ADR[7:0]

P1BDR[7:0]

P1CDR[7:0]

T1PCR2 (Timer 1 PWM Control Register 2) : BDH

7	6	5	4	3	2	1	0
FORCA	FORC6	PAOE	PABOE	PBOE	PBBOE	PCOE	PCBOE
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- FORCA** Control Force Drive A Channel mode
 0 Force Drive A Channel mode disable
 1 Force Drive A Channel mode enable
- FORC6** Control Force 6 Channel mode
 Note) PAOE~PCBOE is effective when FORC6 sets to '1'
 0 Force 6 Channel mode disable
 1 Force 6 Channel mode enable
- PAOE/
PABOE** Select Channel A/AB operation
 0 P1A (or P1AB) output disable
 1 P1A (or P1AB) output enable
- PBOE/
PBBOE** Select Channel B/BB operation
 0 P1B (or P1BB) output disable
 1 P1B (or P1BB) output enable
- PCOE/
PCBOE** Select Channel C/CB operation
 0 P1C (or P1CB) output disable
 1 P1C (or P1CB) output enable

T1PCR3 (Timer 1 PWM Control Register 3) : BEH

7	6	5	4	3	2	1	0
T1_PE	POLA	POLB	POLC	POCON	HCKE	-	PLLPDB
RW	RW	RW	RW	RW	RW	-	RW

Initial value : 00H

- T1_PE** Control Timer1/PWM1 Output port
 0 T1, PWM1 Output operation disable
 1 T1, PWM1 Output operation enable
- POLA** Configure PWM A-ch polarity
 0 Negative (Duty Match time, Clear)
 1 Positive (Duty Match time, Set)
- POLB** Configure PWM B-ch polarity
 0 Negative (Duty Match time, Clear)
 1 Positive (Duty Match time, Set)
- POLC** Configure PWM C-ch polarity
 0 Negative (Duty Match time, Clear)
 1 Positive (Duty Match time, Set)
- POCON** Control PWM output operation
 0 PWM output control disable
 1 PWM output control enable
- HCKE** Select High frequency
 Note) fCK is system frequency, Fout is PLL output frequency
 0 High frequency disable
 1 High frequency enable (Fout > 3* fCK)
- PLLPDB** Control PLL power Down mode
 0 PLL disable (power down mode)
 1 PLL enable (for stable, needs 1ms wait)

T1DLYA (PWM1 Non-Overlap Delay Register for channel A/AB) : BFH

7	6	5	4	3	2	1	0
DLYA3	DLYA2	DLYA1	DLYA0	DLYAB3	DLYAB2	DLYAB1	DLYAB0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

DLYA[3:0] PWM A channel Output Delay (Rising edge only)**DLYAB[3:0]** PWM AB channel Output Delay (Rising edge only)**T1DLYB (PWM1 Non-Overlap Delay Register for channel B/BB) : C2H**

7	6	5	4	3	2	1	0
DLYB3	DLYB2	DLYB1	DLYB0	DLYBB3	DLYBB2	DLYBB1	DLYBB0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

DLYB[3:0] PWM B channel Output Delay (Rising edge only)**DLYBB[3:0]** PWM BB channel Output Delay (Rising edge only)**T1DLYC (PWM1 Non-Overlap Delay Register for channel C/CB) : C3H**

7	6	5	4	3	2	1	0
DLYC3	DLYC2	DLYC1	DLYC0	DLYCB3	DLYCB2	DLYCB1	DLYCB0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

DLYC[3:0] PWM C channel Output Delay (Rising edge only)**DLYCB[3:0]** PWM CB channel Output Delay (Rising edge only)

T1ISR (Timer 1 Interrupt Status Register) : C4H

7	6	5	4	3	2	1	0
IOVR	IBTM	ICMA	ICMB	ICMC	ICAP	-	-
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- IOVR** Overflow (match with T1DR in Timer mode or T1PPR in PWM mode) interrupt status
 Note) for clear, write '1' to this bit
 0 Overflow no occurrence
 1 Overflow occurrence
- IBTM** Timer Bottom (goto zero) interrupt status in PWM Back-to-Back mode)
 Note) for clear, write '1' to this bit
 0 Timer Bottom no occurrence
 1 Timer Bottom occurrence
- ICMA** PWM A-ch Duty Match interrupt status
 Note) for clear, write '1' to this bit
 0 PWM A-ch Duty Match no occurrence
 1 PWM A-ch Duty Match occurrence
- ICMB** PWM B-ch Duty Match interrupt status
 Note) for clear, write '1' to this bit
 0 PWM B-ch Duty Match no occurrence
 1 PWM B-ch Duty Match occurrence
- ICMC** PWM C-ch Duty Match interrupt status
 Note) for clear, write '1' to this bit
 0 PWM C-ch Duty Match no occurrence
 1 PWM C-ch Duty Match occurrence
- ICAP** Timer Capture event interrupt status
 Note) for clear, write '1' to this bit
 0 Timer Capture event no occurrence
 1 Timer Capture event occurrence

T1MSK (Timer 1 Interrupt Mask Register) : C5H

7	6	5	4	3	2	1	0
OVRMSK	BTMMSK	CMAMSK	CMBMSK	CMCMSK	CAPMSK	-	-
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

- OVRMSK** Control Overflow interrupt
0 Overflow interrupt disable
1 Overflow interrupt enable
- BTMMSK** Control Timer Bottom interrupt
0 Timer Bottom interrupt disable
1 Timer Bottom interrupt enable
- CMAMSK** Control Timer Compare Match (or PWM A-ch Match) interrupt
0 Timer Compare Match (or PWM A-ch Match) interrupt disable
1 Timer Compare Match (or PWM A-ch Match) interrupt enable
- CMBMSK** Control PWM B-ch Match interrupt
0 PWM B-ch Match interrupt disable
1 PWM B-ch Match interrupt enable
- CMCMSK** Control PWM C-ch Match interrupt
0 PWM C-ch Match interrupt disable
1 PWM C-ch Match interrupt enable
- CAPMSK** Control Timer Capture event interrupt
0 Timer Capture event interrupt disable
1 Timer Capture event interrupt enable

PLLCTCR (PLL Control Register) : 85H

7	6	5	4	3	2	1	0
-	PLLCT6	PLLCT5	PLLCT4	PLLCT3	PLLCT2	PLLCT1	PLLCT0
-	RW	RW	RW	RW	RW	RW	RW

Initial value : 42H

PLLCT[6:5] Pre Scaler (divider) Control

PLLCT6	PLLCT5	description
0	0	Div 1
0	1	Div 2
1	0	Div 4
1	1	Div 8

PLLCT[4] Feedback Control

0	Div 64
1	Div 50

PLLCT[3:1] Post Scaler (divider) Control (FOUT=fvco/M)

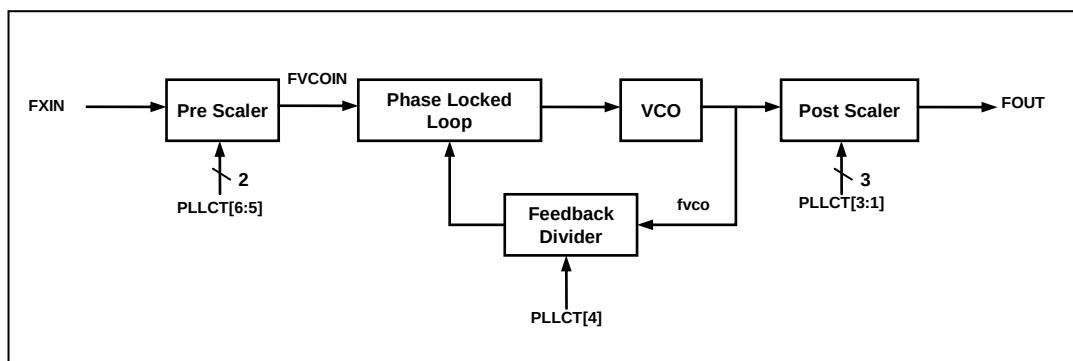
PLLCT3	PLLCT2	PLLCT1	description
0	0	0	M=1
0	0	1	M=2
0	1	0	M=4
0	1	1	M=5
1	0	0	M=6
1	0	1	M=8
1	1	0	M=10
1	1	1	M=16

PLLCT[0] PLL enable (this bit should enable before 1ms for using PLL)

0	PLL disable
1	PLL enable

Note)

1. FVCOIN value must be 2MHz for desire FOUT.
2. To change PLL frequency during the operation, PLL must be disabled before XPLLCT change



$$FVCOIN = 2\text{MHz (to be fixed)} = FXIN / \text{Pre-Divide}$$

$$FVCO = FVCOIN * \text{Feedback-Divider} = 100\text{MHz or } 128\text{MHz}$$

$$FOUT = FVCO / \text{Post-Divider}$$

11.5.2 8-bit Timer/Event Counter 2, 3

11.5.2.1 Overview

Timer 2 and timer 3 can be used either two 8-bit timer/counter or one 16-bit timer/counter with combine them. Each 8-bit timer/event counter module has multiplexer, 8-bit timer data register, 8-bit counter register, mode register, input capture register, comparator. For PWM, it has PWM register (T3PPR, T3PDR, T3PWHR).

It has seven operating modes:

- 8-bit Timer/Counter Mode
- 8-bit Capture Mode
- 8-bit Compare Output Mode
- 16-bit Timer/Counter Mode
- 16-bit Capture Mode
- 16-bit Compare Output Mode
- PWM Mode

The timer/counter can be clocked by an internal or external clock source (external EC2). The clock source is selected by clock select logic which is controlled by the clock select (T2CK[2:0], T3CK[1:0]).

- TIMER2 clock source : fX/1, 2, 4, 64, 256, 1024, 4096, EC2

- TIMER3 clock source : fX/1, 2, 16, T2CK

In the capture mode, by INT2, INT3, the data is captured into Input Capture Register. The Timer 2 outputs the compare result to T2 port in 8/16-bit mode. Also the timer 3 outputs the result T3 port in the timer mode and the PWM waveform to PWM3 in the PWM mode.

16BIT	CAP2	CAP3	PWM3E	T2CK[2:0]	T3CK[1:0]	T2/3_PE	Timer 2	Timer 3
0	0	0	0	XXX	XX	00	8-bit Timer	8-bit Timer
0	0	1	0	111	XX	00	8-bit Event Counter	8-bit Capture
0	1	0	0	XXX	XX	01	8-bit Capture	8-bit Compare Output
0	0	0	1	XXX	XX	11	8-bit Timer/Counter	10-bit PWM
1	0	0	0	XXX	11	00	16-bit Timer	
1	0	0	0	111	11	00	16-bit Event Counter	
1	1	1	0	XXX	11	00	16-bit Capture	
1	0	0	0	XXX	11	01	16-bit Compare Output	

Table 11.8 Operating Modes of Timer

11.5.2.2 8-bit Timer/Counter Mode

The 8-bit Timer/Counter Mode is selected by control registers as shown in Figure 11.26.

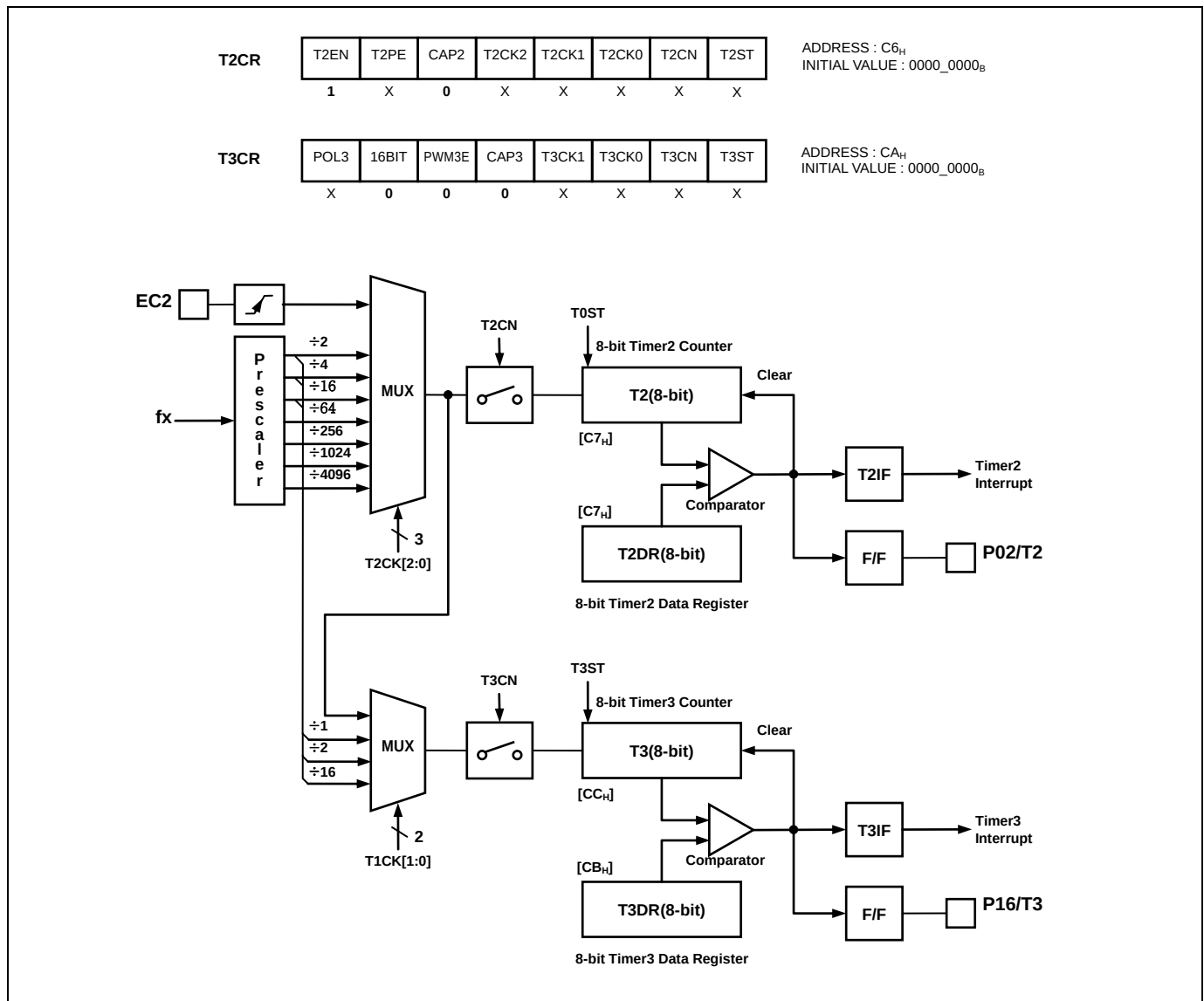


Figure 11.26 8-bit Timer/Event Counter2, 3 Block Diagram

The two 8-bit timers have each counter and data register. The counter register is increased by internal or external clock input. The timer 2 can use the input clock with 2, 4, 16, 64, 256, 1024, 4096 prescaler division rates (T2CK[2:0]). The timer 3 can use the input clock with 1, 2, 16 and timer 2 overflow clock (T3CK[1:0]). When the value of T2, 3 value and the value of T2DR, T3DR are respectively identical in Timer 2, 3, the interrupt of timer T2, 3 occurs. The external clock (EC2) counts up the timer at the rising edge. If EC2 is selected from T2CK[2:0], EC2 port becomes input port. The timer 3 can't use the external EC clock.

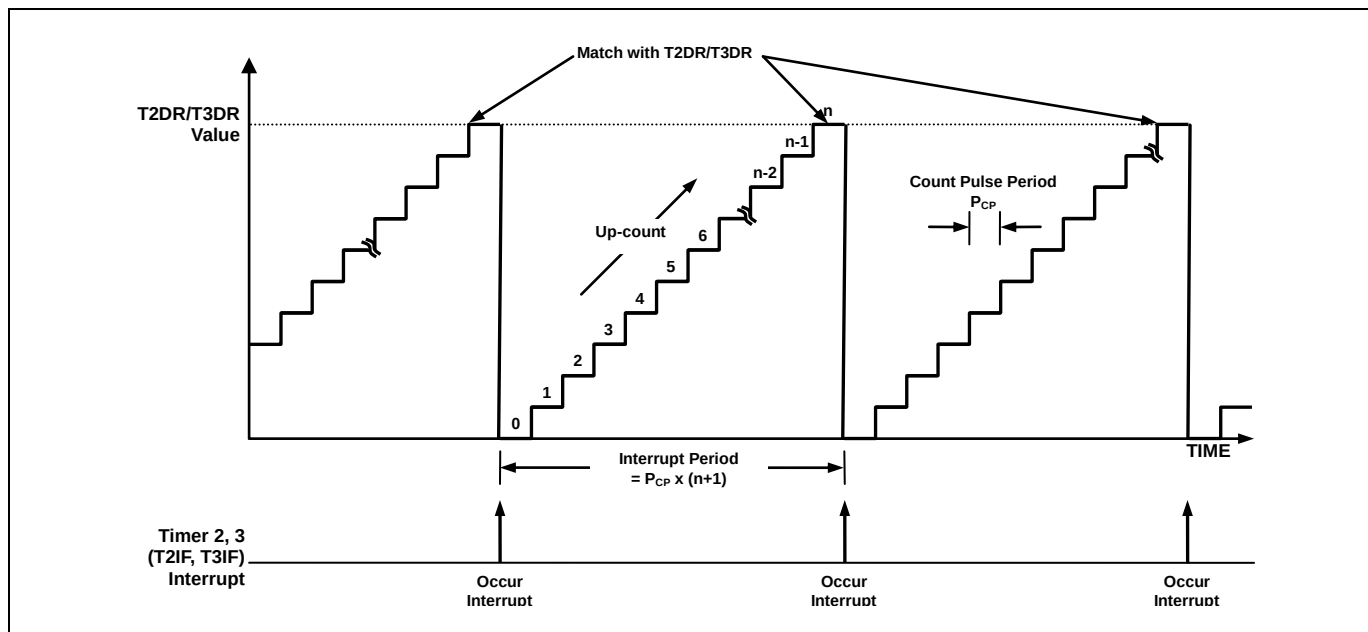


Figure 11.27 Timer/Event Counter2, 3 Example

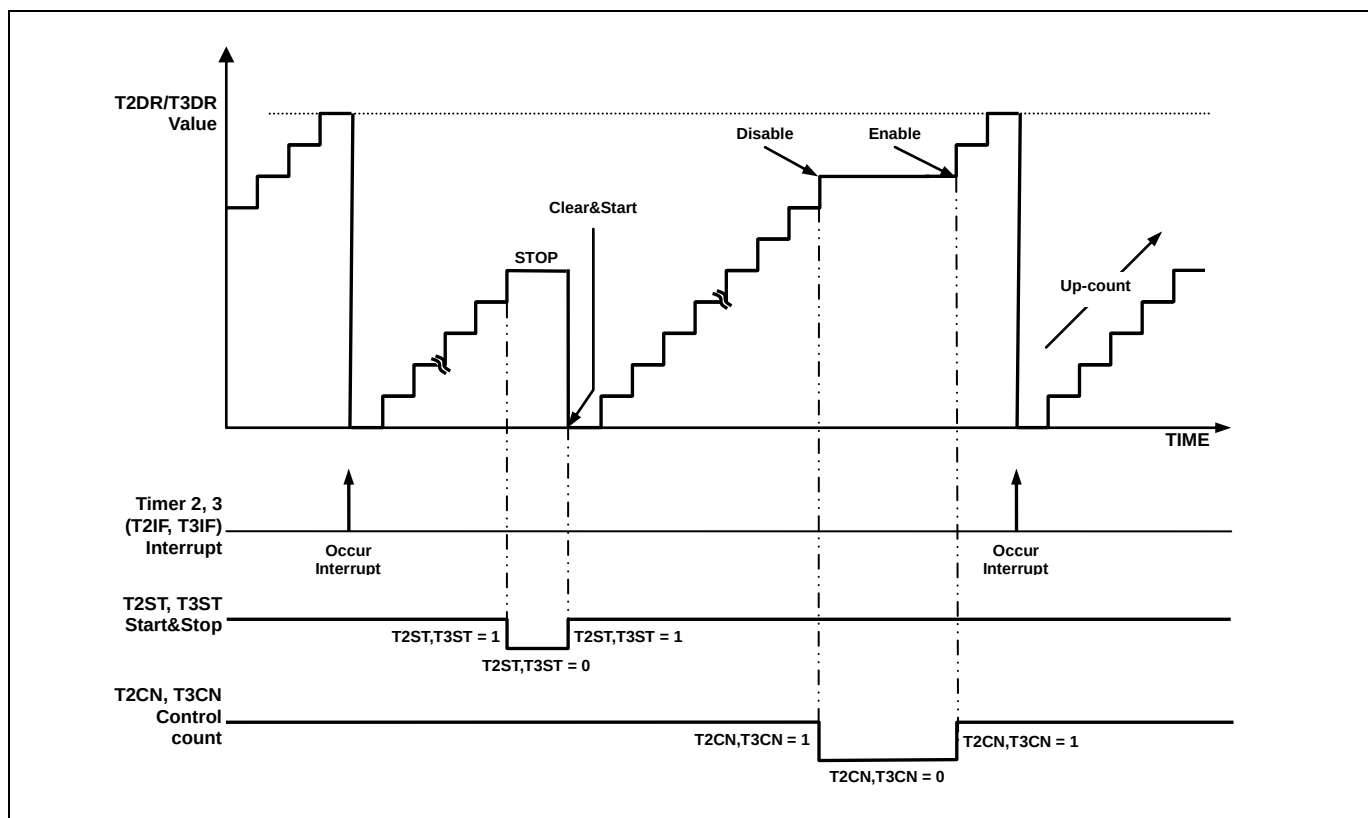


Figure 11.28 Operation Example of Timer/Event Counter2, 3

11.5.2.3 16-bit Timer/Counter Mode

The timer register is being run with all 16 bits. A 16-bit timer/counter register T2, T3 are incremented from 0003H to FFFFH until it matches T2DR, T3DR and then resets to 0000H. the match output generates the Timer 2 interrupt (no timer 3 interrupt). The clock source is selected from T2CK[2:0] and T3CK[1:0] must set 11b and 16BIT bit must set to '1'. The timer 2 is LSB 8-bit, the timer 3 is MSB 8-bit. T2DR must not be 0x00(0x01~0xFF). The 16-bit mode setting is shown as Figure 11.29.

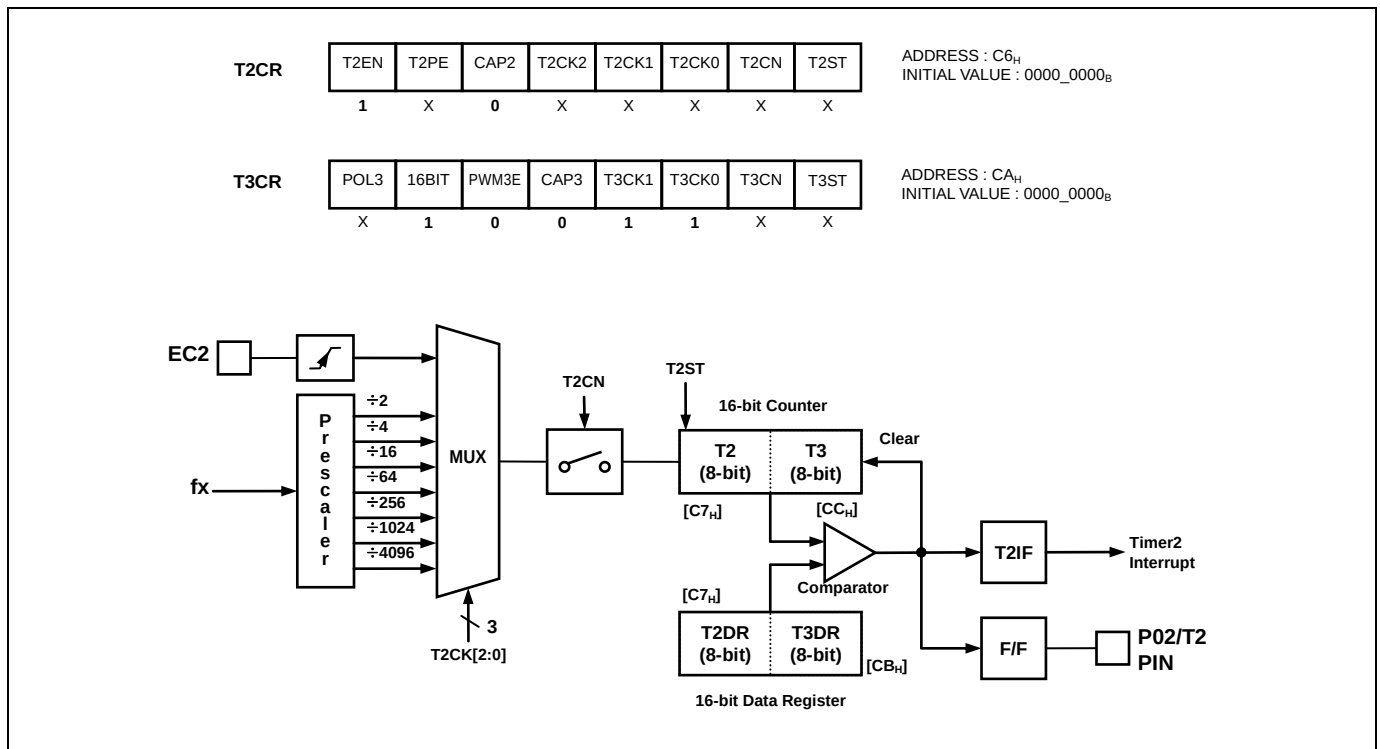


Figure 11.29 16-bit Timer/Event Counter2, 3 Block Diagram

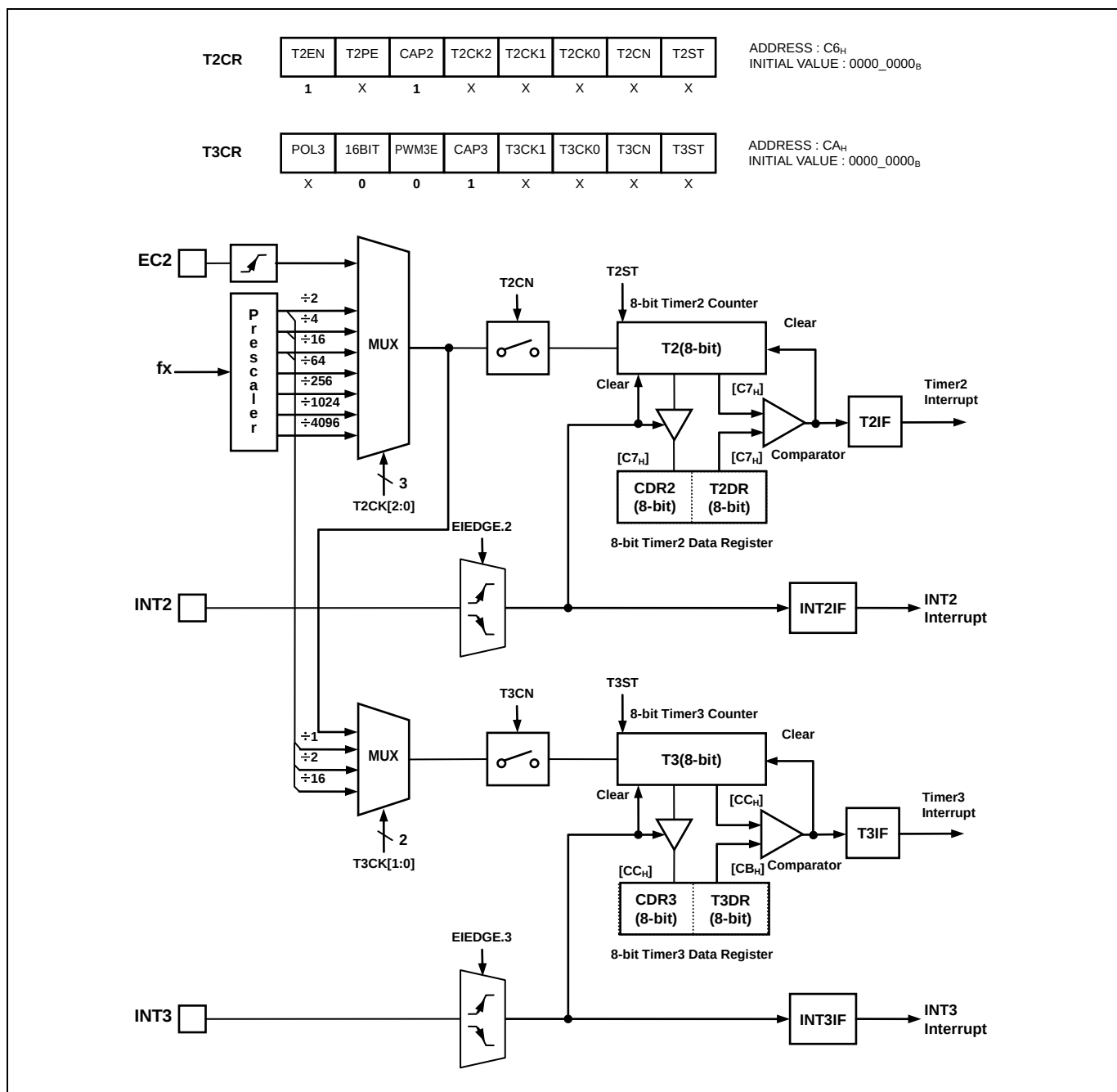
11.5.2.4 8-bit Capture Mode

The timer 2, 3 capture mode is set by CAP2, CAP3 as '1'. The clock source can use the internal/external clock. Basically, it has the same function of the 8-bit timer/counter mode and the interrupt occurs at T 2, 3 and T2DR, T3DR matching time, respectively. The capture result is loaded into CDR2, CDR3. The T2, T3 value is automatically cleared by hardware and restarts counter.

This timer interrupt in capture mode is very useful when the pulse width of captured signal is wider than the maximum period of timer.

As the EIEDGE and EIPOLA register setting, the external interrupt INT2, INT3 function is chosen.

The CDR2, T2 and T2DR are in same address. In the capture mode, reading operation is read the CDR2, not T2DR because path is opened to the CDR2. The CDR3 has the same function.



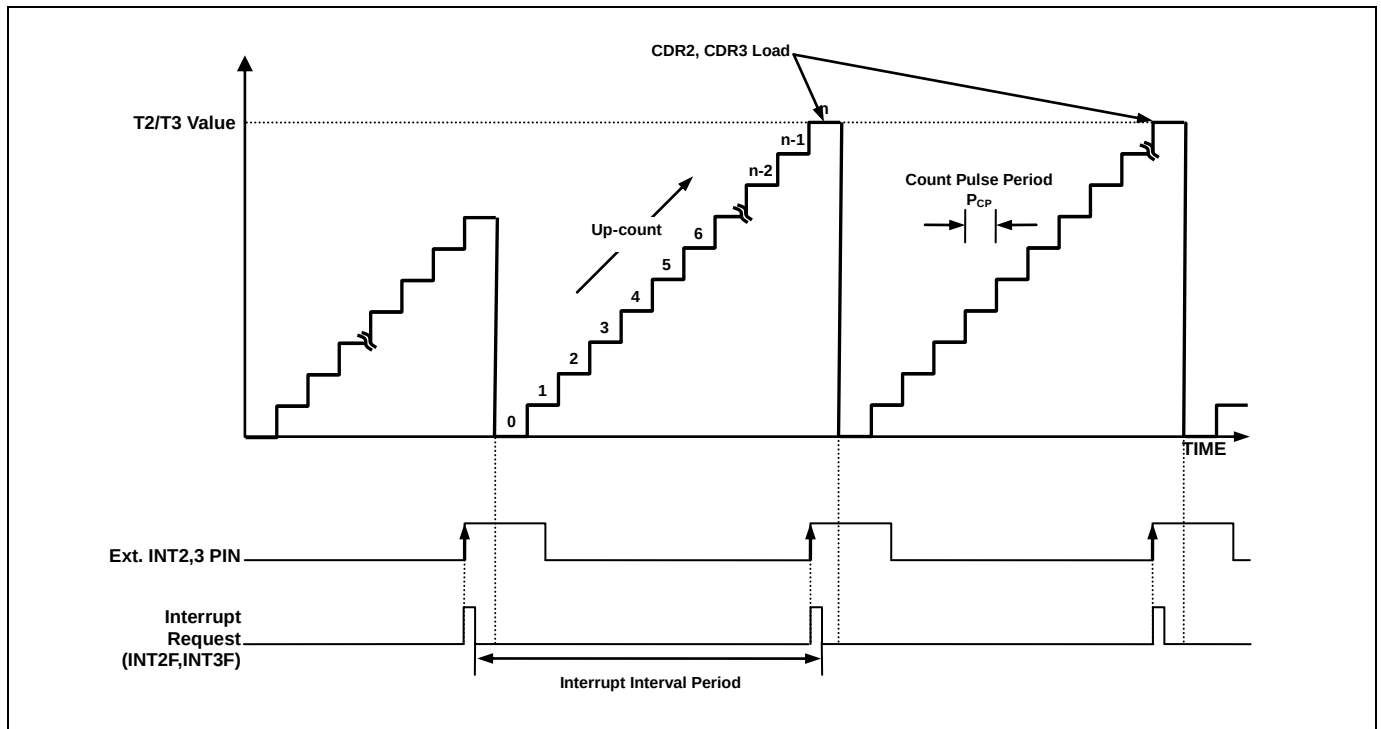


Figure 11.31 Input Capture Mode Operation of Timer 2, 3

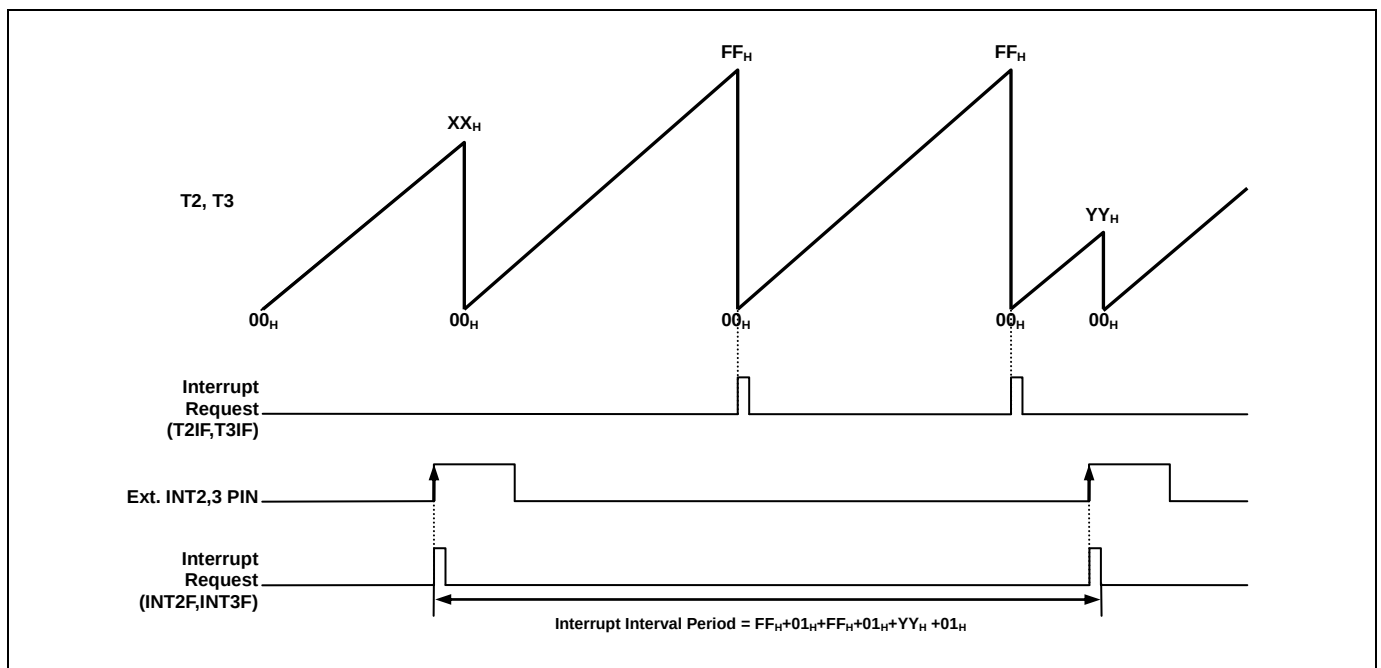


Figure 11.32 Express Timer Overflow in Capture Mode

11.5.2.5 16-bit Capture Mode

The 16-bit capture mode is the same operation as 8-bit capture mode, except that the timer register uses 16 bits.

The clock source is selected from T2CK[2:0] and T3CK[1:0] must set 11b and 16BIT bit must set to '1'. The 16-bit mode setting is shown as Figure 11.33.

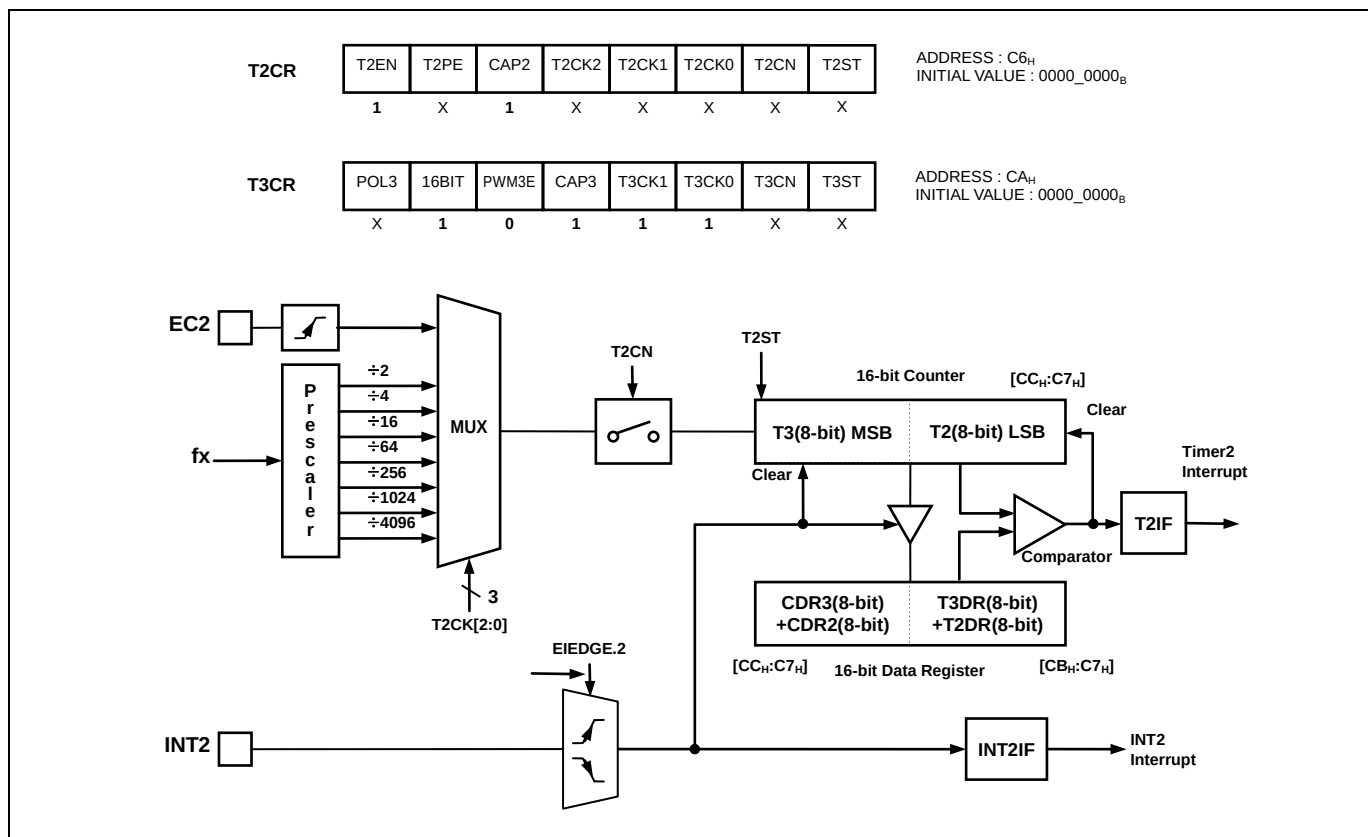


Figure 11.33 16-bit Capture Mode of Timer 2, 3

11.5.2.6 PWM Mode

The timer 3 has a PWM (pulse Width Modulation) function. In PWM mode, the T3/PWM3 output pin outputs up to 10-bit resolution PWM output. This pin should be configured as a PWM output by set T3_PE to '1'. The period of the PWM output is determined by the T3PPR (PWM period register) + T3PWHR[3:2] + T3PWHR[1:0]

$$\text{PWM Period} = [T3PWHR[3:2]T3PPR] \times \text{Source Clock}$$

$$\text{PWM Duty} = [T3PWHR[1:0] T3PDR] \times \text{Source Clock}$$

Resolution	Frequency		
	T3CK[1:0]=00 (125ns)	T3CK[1:0]=01 (250ns)	T3CK[1:0]=10 (2us)
10-bit	7.8kHz	3.9kHz	0.49kHz
9-bit	15.6kHz	7.8kHz	0.98kHz
8-bit	31.2kHz	15.6kHz	1.95kHz
7-bit	62.4kHz	31.2kHz	3.91kHz

Table 11.9 PWM Frequency vs. Resolution at 8MHz

The POL bit of T3CR register decides the polarity of duty cycle. If the duty value is set same to the period value, the PWM output is determined by the bit POL (1: High, 0: Low). And if the duty value is set to "00H", the PWM output is determined by the bit POL (1: Low, 0: High). If duty value and period value are equal, PWM output is not retain high or low but toggle.

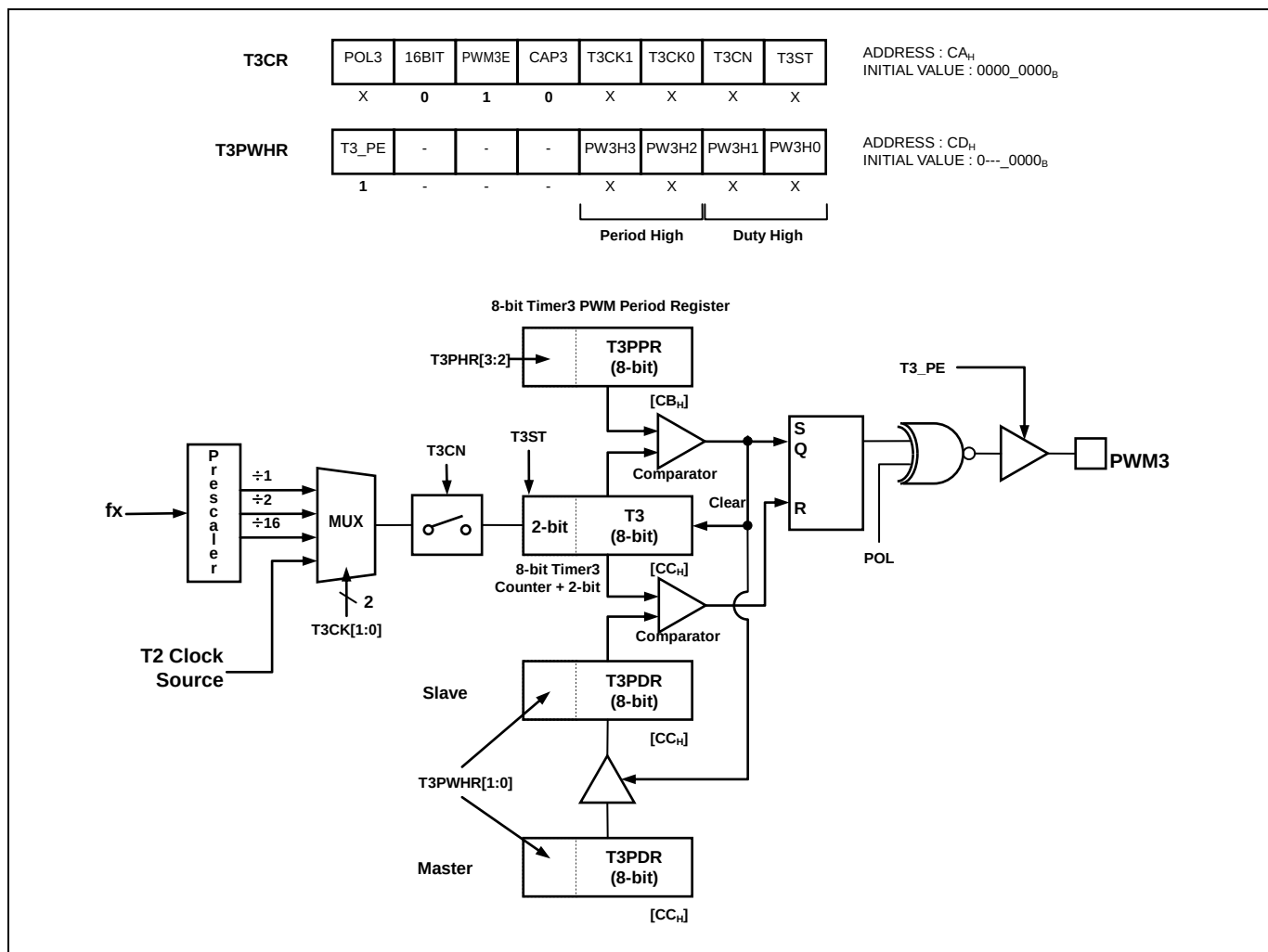


Figure 11.34 PWM Mode

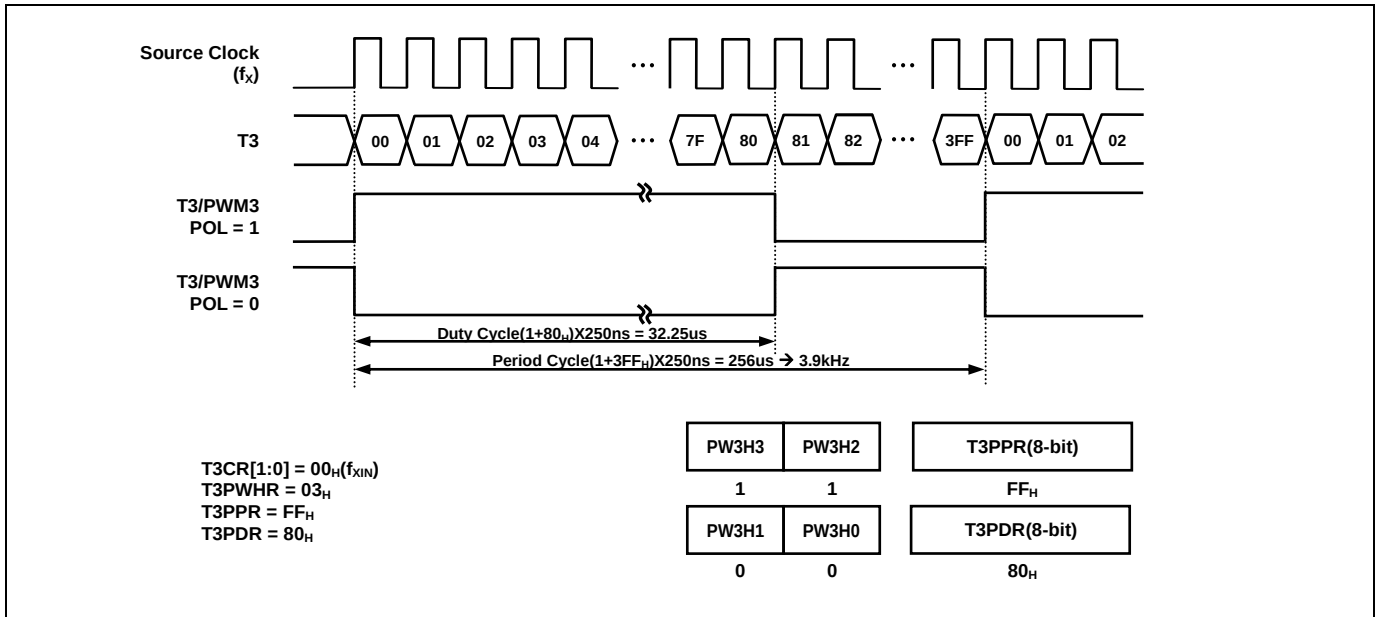


Figure 11.35 Example of PWM at 4MHz

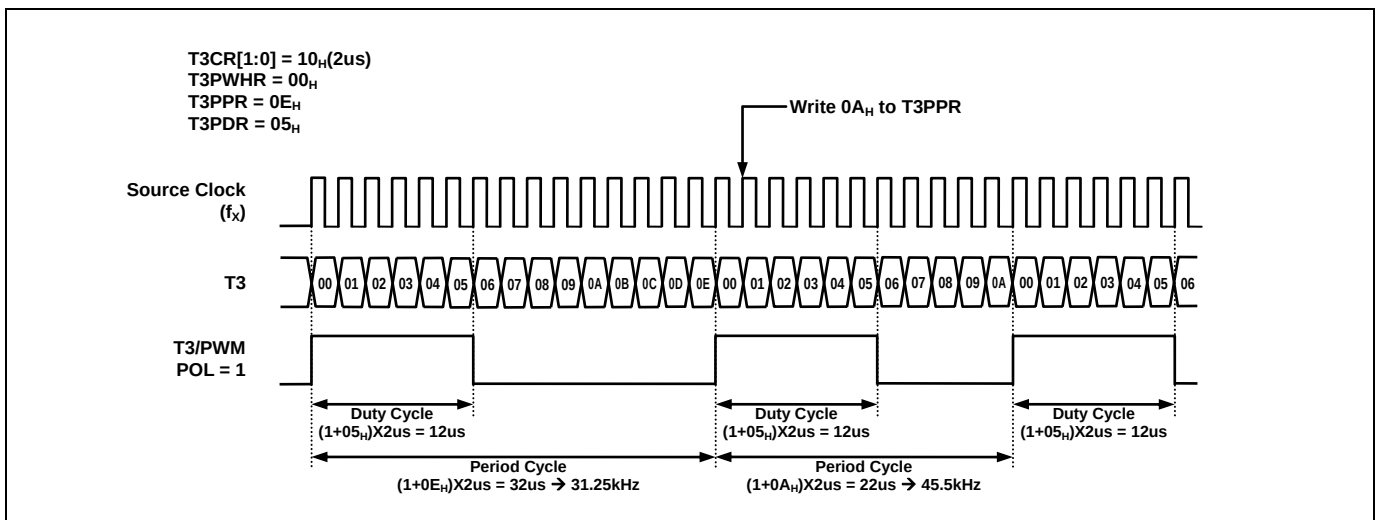


Figure 11.36 Example of Changing the Period in Absolute Duty Cycle at 4Mhz

11.5.2.7 8-bit (16-bit) Compare Output Mode

If the T3 (T2+T3) value and the T3DR (T2DR+T3DR) value are matched, T3/PWM3 port outputs. The output is 50:50 of duty square wave, the frequency is following

$$f_{COMP} = \frac{\text{Oscillator Frequency}}{2 \times \text{Prescaler Value} \times (TDR + 1)}$$

To export the compare output as T3/PWM3, the T3_PE bit in the T3PWHR register must set to '1'.

11.5.2.8 Register Map

Name	Address	Dir	Default	Description
T2CR	C6	R/W	00H	Timer 2 Mode Control Register
T2	C7	R	00H	Timer 2 Register
T2DR	C7	W	FFH	Timer 2 Data Register
CDR2	C7	R	00H	Capture 2 Data Register
T3CR	CA	R/W	00H	Timer 3 Mode Control Register
T3DR	CB	W	FFH	Timer 3 Data Register
T3PPR	CB	W	FFH	Timer 3 PWM Period Register
T3	CC	R	00H	Timer 3 Register
T3PDR	CC	R/W	00H	Timer 3 PWM Duty Register
CDR3	CC	R	00H	Capture 3 Data Register
T3PWHR	CD	W	00H	Timer 3 PWM High Register

Table 11.10 Register Map**11.5.2.9 Timer/Counter 2, 3 Register description**

The Timer/Counter 2, 3 Register consists of Timer 2 Mode Control Register (T2CR), Timer 2 Register (T2), Timer 2 Data Register (T2DR), Capture 2 Data Register (CDR2), Timer 3 Mode Control Register (T3CR), Timer 3 Data Register (T3DR), Timer 3 PWM Period Register (T3PPR), Timer 3 Register (T3), Timer 3 PWM Duty Register (T3PDR), Capture 3 Data Register (CDR3) and Timer 3 PWM High Register (T3PWHR).

11.5.2.10 Register description for Timer/Counter 2, 3

T2CR (Timer 2 Mode Control Register) : C6H

7	6	5	4	3	2	1	0
T2EN	T2_PE	CAP2	T2CK2	T2CK1	T2CK0	T2CN	T2ST
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

T2EN	Control Timer 2			
	0	Timer 2 disable		
	1	Timer 2 enable		
T2_PE	Control Timer 2 Output port			
	0	Timer 2 Output disable		
	1	Timer 2 Output enable		
CAP2	Control Timer 2 operation mode			
	0	Timer/Counter mode		
	1	Capture mode		
T2CK[2:0]	Select Timer 2 clock source. Fx is main system clock frequency			
	T2CK2	T2CK1	T2CK0	Description
	0	0	0	fx/2
	0	0	1	fx/4
	0	1	0	fx/16
	0	1	1	fx/64
	1	0	0	fx/256
	1	0	1	fx/1024
	1	1	0	fx/4096
	1	1	1	External Clock (EC2)
T2CN	Control Timer 2 Count pause/continue			
	0	Temporary count stop		
	1	Continue count		
T2ST	Control Timer 2 start/stop			
	0	Counter stop		
	1	Clear counter and start		

T2 (Timer 2 Register: Read Case) : C7H

7	6	5	4	3	2	1	0
T27	T26	T25	T24	T23	T22	T21	T20
R	R	R	R	R	R	R	R

Initial value : 00H

T2[7:0] T2 Counter data

T2DR (Timer 2 Data Register: Write Case) : C7H

7	6	5	4	3	2	1	0
T2D7	T2D6	T2D5	T2D4	T2D3	T2D2	T2D1	T2D0
W	W	W	W	W	W	W	W

Initial value : FFH

T2D[7:0] T2 Compare data

CDR2 (Capture 2 Data Register: Read Case) : C7H

7	6	5	4	3	2	1	0
CDR27	CDR26	CDR25	CDR24	CDR23	CDR22	CDR21	CDR20
R	R	R	R	R	R	R	R

Initial value : 00H

CDR2[7:0] T2 Capture data**T3CR (Timer 3 Mode Count Register) : CAH**

7	6	5	4	3	2	1	0
POL	16BIT	PWM3E	CAP3	T3CK1	T3CK0	T3CN	T3ST
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

POL Configure PWM polarity

0 Negative (Duty Match: Clear)

1 Positive (Duty Match: Set)

16BIT Select Timer 1 8/16-bit

0 8-bit

1 16-bit

PWM3E Control PWM enable

0 PWM disable

1 PWM enable

CAP3 Control Timer 3 mode

0 Timer/Counter mode

1 Capture mode

T3CK[1:0] Select clock source of Timer 3. Fx is the frequency of main system.

T3CK1	T3CK0	Description
-------	-------	-------------

0	0	fx
---	---	----

0	1	fx/2
---	---	------

1	0	fx/16
---	---	-------

1	1	Use Timer 2 Clock
---	---	-------------------

(NOTE) If you want to use "Using Timer 2 Clock", you can set T2EN bit in T2CR**T3CN** Control Timer 3 Count pause/continue

0 Temporary count stop

1 Continue count

T3ST Control Timer 3 start/stop

0 Counter stop

1 Clear counter and start

T3DR (Timer 3 Data Register: Write Case) : CBH

7	6	5	4	3	2	1	0
T3D7	T3D6	T3D5	T3D4	T3D3	T3D2	T3D1	T3D0
W	W	W	W	W	W	W	W

Initial value : FFH

T3D[7:0] T3 Compare data

T3PPR (Timer 3 PWM Period Register: Write Case PWM mode only) : CBH

7	6	5	4	3	2	1	0
T3PP7	T3PP6	T3PP5	T3PP4	T3PP3	T3PP2	T3PP1	T3PP0
W	W	W	W	W	W	W	W

Initial value : FFH

T3PP[7:0] T3 PWM Period data**T3 (Timer 3 Register: Read Case) : CCH**

7	6	5	4	3	2	1	0
T37	T36	T35	T34	T33	T32	T31	T30
R	R	R	R	R	R	R	R

Initial value : 00H

T3[7:0] T3 Counter Period data**T3PDR (Timer 3 PWM Duty Register) : CCH**

7	6	5	4	3	2	1	0
T3PD7	T3PD6	T3PD5	T3PD4	T3PD3	T3PD2	T3PD1	T3PD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

T3PD[7:0] T3 PWM Duty data
NOTE) only write, when PWM3E '1'

CDR3 (Capture 3 Data Register: Read Case) : CCH

7	6	5	4	3	2	1	0
CDR37	CDR36	CDR35	CDR34	CDR33	CDR32	CDR31	CDR30
R	R	R	R	R	R	R	R

Initial value : 00H

CDR3[7:0] T3 Capture data**T3PWHR (Timer 3 PWM High Register) : CDH**

7	6	5	4	3	2	1	0
T3_PE	-	-	-	PW3H3	PW3H2	PW3H1	PW3H0
W	-	-	-	W	W	W	W

Initial value : 00H

T3_PE Control Timer 3 Output port operation
NOTE) only writable bit. Be careful
 0 Timer 3 Output disable
 1 Timer 3 Output enable

PW3H[3:2] PWM period High value (bit [9:8])**PW3H[1:0]** PWM duty High value (bit [9:8])

PERIOD:

PW3H3	PW3H2
-------	-------

T3PPR[7:0]

 DUTY:

PW3H1	PW3H0
-------	-------

T3PDR[7:0]

11.5.3 16-bit Timer 4

11.5.3.1 Overview

The 16-bit timer 4 consists of Multiplexer, Timer Data Register High/Low, Timer Register High/Low, Timer Mode Control Register. It is able to use internal 16-bit timer/ counter without a port output function.

The 16-bit timer 4 is able to use the divided clock of the main clock selected from pre-scalar output.

11.5.3.2 16-bit Timer/Counter Mode

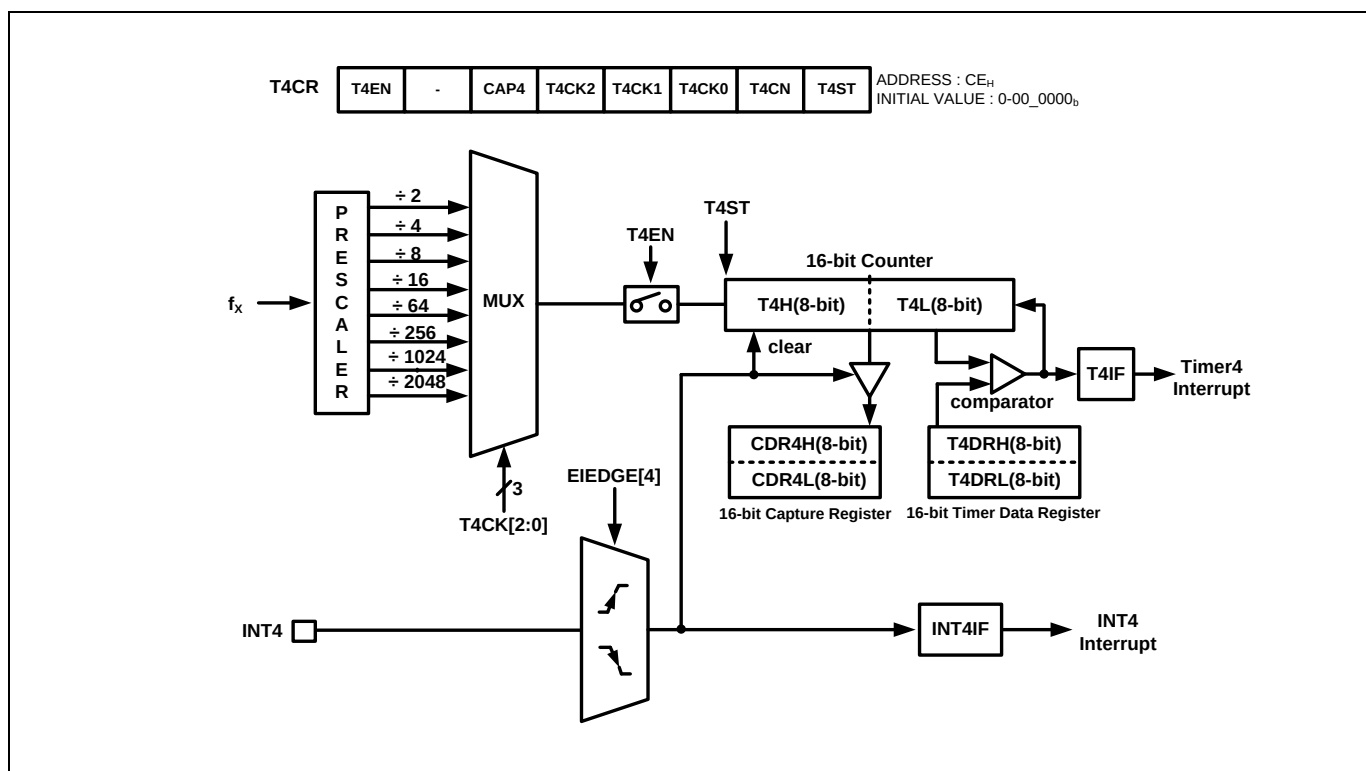


Figure 11.37 Timer4 16-bit Mode Block Diagram

11.5.3.3 Register Map

Name	Address	Dir	Default	Description
T4CR	0xCE	R/W	00H	Timer 4 Mode Control Register
T4L	0xCF	R	00H	Timer 4 Low Register
T4LDR	0xCF	W	FFH	Timer 4 Low Data Register
LCDR4	0xCF	R	00H	Low Capture 4 Data Register
T4H	0xD5	R	00H	Timer 4 High Register
T4HDR	0xD5	R/W	00H	Timer 4 High Data Register
HCDR4	0xD5	R	00H	High Capture 4 Data Register

Table 11.11 Register Map

11.5.3.4 Timer 4 Register description

The timer 4 register consists of Timer 4 Mode Control Register (T4CR), Timer 4 Low Register (T4L), Timer 4 Low Data Register (T4LDR), Low Capture 4 Data Register (LCDR4), Timer 4 High Register (T4H), Timer 4 High Data Register (T4HDR), High Capture 4 Data Register (HCDR4).

11.5.3.5 Register description for Timer 4

T4CR (Timer 4 Mode Control Register) : CEH

7	6	5	4	3	2	1	0
T4EN	-	CAP4	T4CK2	T4CK1	T4CK0	T4CN	T4ST
RW	-	RW	RW	RW	RW	RW	RW

Initial value : 00H

T4EN	Control Timer 4 operation			
0	Timer 4 disable			
1	Timer 4 enable			
CAP4	Control Timer 4 mode			
0	Timer/Counter mode			
1	Capture mode			
T4CK[2:0]	Select Timer 4 clock source. fx is main system clock frequency			
	T4CK2	T4CK1	T4CK0	Description
0	0	0	0	fx/2
0	0	0	1	fx/4
0	1	0	0	fx/8
0	1	1	1	fx/16
1	0	0	0	fx/64
1	0	1	1	fx/256
1	1	0	0	fx/1024
1	1	1	1	fx/2048
T4CN	Control Timer 4 Count pause/continue			
0	Temporary count stop			
1	Continue count			
T4ST	Control Timer 4 start/stop			
0	Counter stop			
1	Clear Counter and start			

T4L (Timer 4 Low Register: Read Case) : CFH

7	6	5	4	3	2	1	0
T4L7	T4L6	T4L5	T4L4	T4L3	T4L2	T4L1	T4L0
R	R	R	R	R	R	R	R

Initial value : 00H

T4L[7:0] T4L Counter

T4LDR (Timer 4 Low Data Register: Write Case) : CFH

7	6	5	4	3	2	1	0
T4LD7	T4LD6	T4LD5	T4LD4	T4LD3	T4LD2	T4LD1	T4LD0
W	W	W	W	W	W	W	W

Initial value : FFH

T4LD[7:0] T4L Compare**LCDR4 (Low Capture 4 Data Register: Read Case) : CFH**

7	6	5	4	3	2	1	0
LCDR47	LCDR46	LCDR45	LCDR44	LCDR43	LCDR42	LCDR41	LCDR40
R	R	R	R	R	R	R	R

Initial value : 00H

LCDR4[7:0] T4L Capture data**T4H (Timer 4 High Register: Read Case) : D5H**

7	6	5	4	3	2	1	0
T4H7	T4H6	T4H5	T4H4	T4H3	T4H2	T4H1	T4H0
R	R	R	R	R	R	R	R

Initial value : 00H

T4H[7:0] T4H Counter Period**T4HDR (Timer 4 High Data Register: Write Case) : D5H**

7	6	5	4	3	2	1	0
T4HD7	T4HD6	T4HD5	T4HD4	T4HD3	T4HD2	T4HD1	T4HD0
W	W	W	W	W	W	W	W

Initial value : FFH

T4HD[7:0] T4H Compare**HCDR4 (High Capture 4 Data Register: Read Case) : D5H**

7	6	5	4	3	2	1	0
HCDR47	HCDR46	HCDR45	HCDR44	HCDR43	HCDR42	HCDR41	HCDR40
R	R	R	R	R	R	R	R

Initial value : 00H

HCDR4[7:0] T4H Capture data

11.5.4 Timer Interrupt Status Register (TMISR)

11.5.4.1 Register description for TMISR

TMISR (Timer Interrupt Status Register) : AFH

7	6	5	4	3	2	1	0
-	-	TMIF5	TMIF4	TMIF3	TMIF2	TMIF1	TMIF0
-	-	R	R	R	R	R	R

Initial value : 00H

TMIF5	Timer 5 Interrupt Flag
0	No Timer 5 interrupt
1	Timer 5 interrupt occurred, write "1" to clear interrupt flag
TMIF4	Timer 4 Interrupt Flag
0	No Timer 4 interrupt
1	Timer 4 interrupt occurred, write "1" to clear interrupt flag
TMIF3	Timer 3 Interrupt Flag
0	No Timer 3 interrupt
1	Timer 3 interrupt occurred, write "1" to clear interrupt flag
TMIF2	Timer 2 Interrupt Flag
0	No Timer 2 interrupt
1	Timer 2 interrupt occurred, write "1" to clear interrupt flag
TMIF1	Timer 1 Interrupt Flag
0	No Timer 1 interrupt
1	Timer 1 interrupt occurred, write "1" to clear interrupt flag
TMIF0	Timer 0 Interrupt Flag
0	No Timer 0 interrupt
1	Timer 0 interrupt occurred, write "1" to clear interrupt flag

NOTE)

1. The Timer Interrupt Status Register contains interrupt information of each timers. Even if user disabled timer interrupt at IE2, user could check timer interrupt condition from this register.

11.6 Buzzer Driver

11.6.1 Overview

The Buzzer consists of 8-bit Counter and BUZDR (Buzzer Data Register), BUZCR (Buzzer Control Register). The Square Wave (61.035Hz~125kHz, @8MHz) gets out of P12/BUZ pin. BUZDR (Buzzer Data Register) controls the Buzzer frequency (look at the following expression). In the BUZCR (Buzzer Control Register), BUCK[1:0] selects source clock divided from prescaler.

$$f_{\text{BUZ}}(\text{Hz}) = \frac{\text{Oscillator Frequency}}{2 \times \text{Prescaler Ratio} \times (\text{BUZDR} + 1)}$$

BUZDR[7:0]	Buzzer Frequency (kHz)			
	BUZCR[2:1]=00	BUZCR[2:1]=01	BUZCR[2:1]=10	BUZCR[2:1]=11
0000_0000	125kHz	62.5kHz	31.25kHz	15.625kHz
0000_0001	62.5kHz	31.25kHz	15.625kHz	7.812kHz
...	...	...	...	...
1111_1101	492.126Hz	246.063Hz	123.031Hz	61.515Hz
1111_1110	490.196Hz	245.098Hz	122.549Hz	61.274Hz
1111_1111	488.281Hz	244.141Hz	122.07Hz	61.035Hz

Table 11.12 Buzzer Frequency at 8MHz

11.6.2 Block Diagram

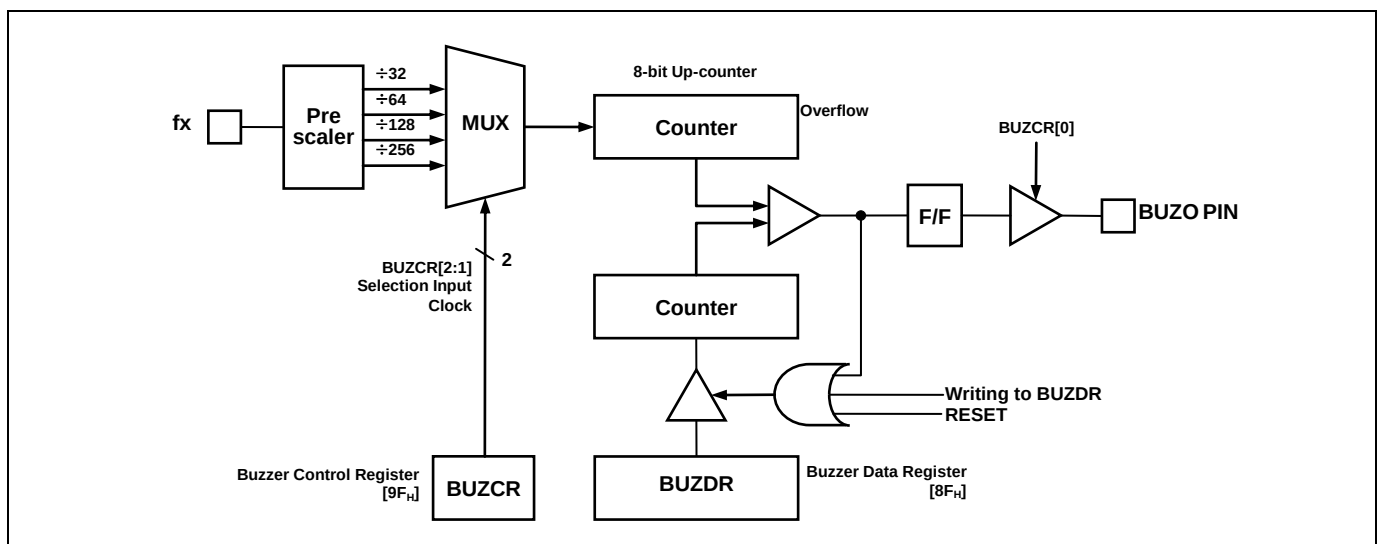


Figure 11.38 Buzzer Driver Block Diagram

11.6.3 Register Map

Name	Address	Dir	Default	Description
BUZDR	8FH	R/W	FFH	Buzzer Data Register
BUZCR	9FH	R/W	00H	Buzzer Control Register

Table 11.13 Register Map

11.6.4 Buzzer Driver Register Description

Buzzer Driver consists of Buzzer Data Register (BUZDR), Buzzer Control Register (BUZCR).

11.6.5 Register Description for Buzzer Driver

BUZDR (Buzzer Data Register) : 8FH

7	6	5	4	3	2	1	0
BUZDR7	BUZDR6	BUZDR5	BUZDR4	BUZDR3	BUZDR2	BUZDR1	BUZDR0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : FFH

BUZDR[7:0] This bits control the Buzzer frequency
Its resolution is 00H ~ FFH

BUZCR (Buzzer Control Register) : 9FH

7	6	5	4	3	2	1	0
-	-	-	-	-	BUCK1	BUCK0	BUZEN
-	-	-	-	-	RW	RW	RW

Initial value : 00H

BUCK[1:0] Buzzer Driver Source Clock Selection

BUCK1	BUCK0	Source Clock
-------	-------	--------------

0	0	fx/32
---	---	-------

0	1	fx/64
---	---	-------

1	0	fx/128
---	---	--------

1	1	fx/256
---	---	--------

BUZEN Buzzer Driver Operation Control

0	Buzzer Driver disable
---	-----------------------

1	Buzzer Driver enable
---	----------------------

NOTE)

1. fx: System clock oscillation frequency.

11.7 USART

11.7.1 Overview

The Universal Synchronous and Asynchronous serial Receiver and Transmitter (USART) is a highly flexible serial communication device. The main features are listed below.

- Full Duplex Operation (Independent Serial Receive and Transmit Registers)
- Asynchronous or Synchronous Operation
- Master or Slave Clocked Synchronous and SPI Operation
- Supports all four SPI Modes of Operation (Mode 0, 1, 2, 3)
- LSB First or MSB First Data Transfer @SPI mode
- High Resolution Baud Rate Generator
- Supports Serial Frames with 5,6,7,8, or 9 Data bits and 1 or 2 Stop bits
- Odd or Even Parity Generation and Parity Check Supported by Hardware
- Data OverRun Detection
- Framing Error Detection
- Digital Low Pass Filter
- Three Separate Interrupts on TX Complete, TX Data Register Empty and RX Complete
- Double Speed Asynchronous Communication Mode

USART has three main parts of Clock Generator, Transmitter and Receiver. The Clock Generation logic consists of synchronization logic for external clock input used by synchronous or SPI slave operation, and the baud rate generator for asynchronous or master (synchronous or SPI) operation. The Transmitter consists of a single write buffer, a serial shift register, parity generator and control logic for handling different serial frame formats. The write buffer allows a continuous transfer of data without any delay between frames. The receiver is the most complex part of the USART module due to its clock and data recovery units. The recovery unit is used for asynchronous data reception. In addition to the recovery unit, the Receiver includes a parity checker, a shift register, a two level receive FIFO (UDATAx) and control logic. The Receiver supports the same frame formats as the Transmitter and can detect Frame Error, Data OverRun and Parity Errors.

11.7.2 Block Diagram

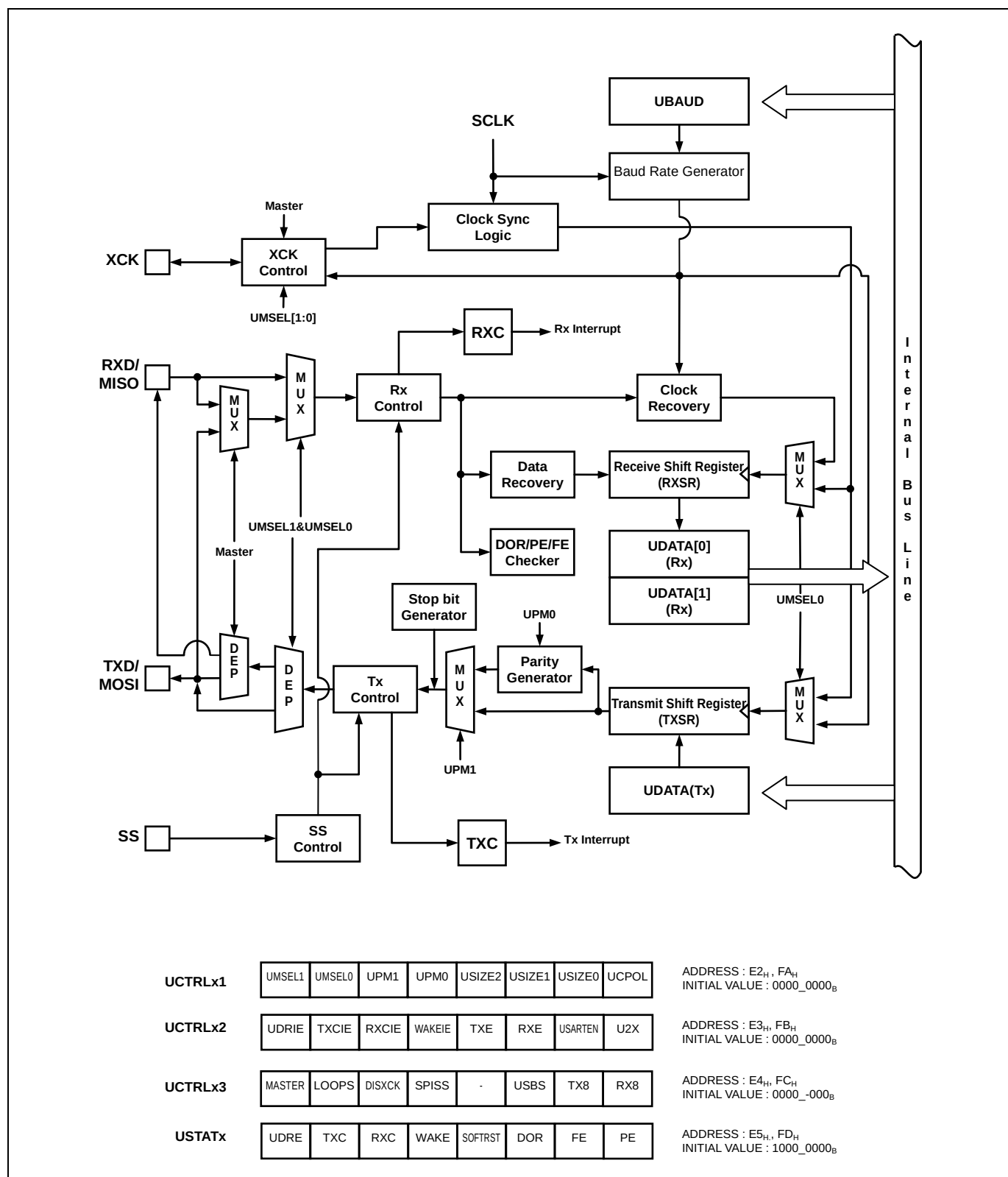


Figure 11.39 USART Block Diagram

11.7.3 Clock Generation

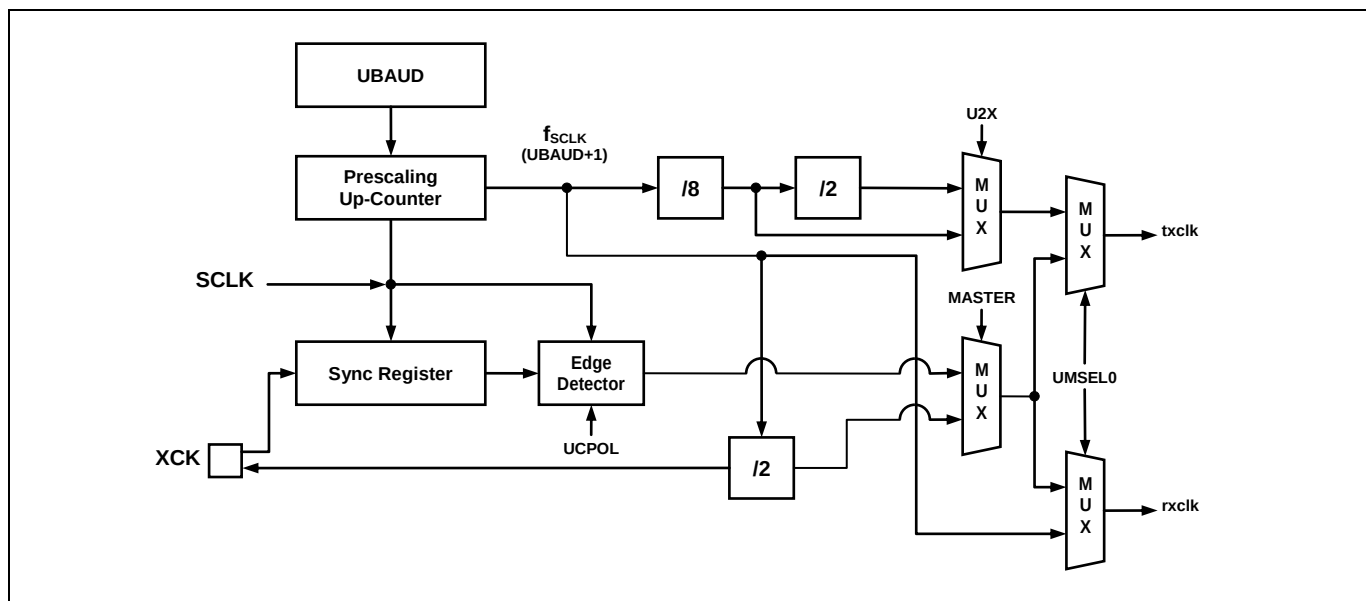


Figure 11.40 Clock Generation Block Diagram

The Clock generation logic generates the base clock for the Transmitter and Receiver. The USART supports four modes of clock operation and those are Normal Asynchronous, Double Speed Asynchronous, Master Synchronous and Slave Synchronous. The clock generation scheme for Master SPI and Slave SPI mode is the same as Master Synchronous and Slave Synchronous operation mode. The UMSELn bit in UCTRLx1 register selects between asynchronous and synchronous operation. Asynchronous Double Speed mode is controlled by the U2X bit in the UCTRLx2 register. The MASTER bit in UCTRLx2 register controls whether the clock source is internal (Master mode, output port) or external (Slave mode, input port). The XCK pin is only active when the USART operates in Synchronous or SPI mode.

Table below contains equations for calculating the baud rate (in bps).

Operating Mode	Equation for Calculating Baud Rate
Asynchronous Normal Mode (U2X=0)	$\text{Baud Rate} = \frac{f_{\text{SCLK}}}{16(\text{UBAUD}_x + 1)}$
Asynchronous Double Speed Mode (U2X=1)	$\text{Baud Rate} = \frac{f_{\text{SCLK}}}{8(\text{UBAUD}_x + 1)}$
Synchronous or SPI Master Mode	$\text{Baud Rate} = \frac{f_{\text{SCLK}}}{2(\text{UBAUD}_x + 1)}$

Table 11.14 Equations for Calculating Baud Rate Register Setting

11.7.4 External Clock (XCK)

External clocking is used by the synchronous or SPI slave modes of operation.

External clock input from the XCK pin is sampled by a synchronization logic to remove meta-stability. The output from the synchronization logic must then pass through an edge detector before it can be used by the Transmitter and Receiver. This process introduces a two CPU clock period delay and therefore the maximum frequency of the external XCK pin is limited by the following equation.

$$f_{XCK} = \frac{f_{SCLK}}{4}$$

where f_{XCK} is the frequency of XCK and f_{SCLK} is the frequency of main system clock (SCLK).

11.7.5 Synchronous mode Operation

When synchronous or SPI mode is used, the XCK pin will be used as either clock input (slave) or clock output (master). The dependency between the clock edges and data sampling or data change is the same. The basic principle is that data input on RXD (MISO in SPI mode) pin is sampled at the opposite XCK clock edge of the edge in the data output on TXD (MOSI in SPI mode) pin is changed.

The UCPOL bit in UCTRLx1 register selects which XCK clock edge is used for data sampling and which is used for data change. As shown in the figure below, when UCPOL is zero the data will be changed at rising XCK edge and sampled at falling XCK edge.

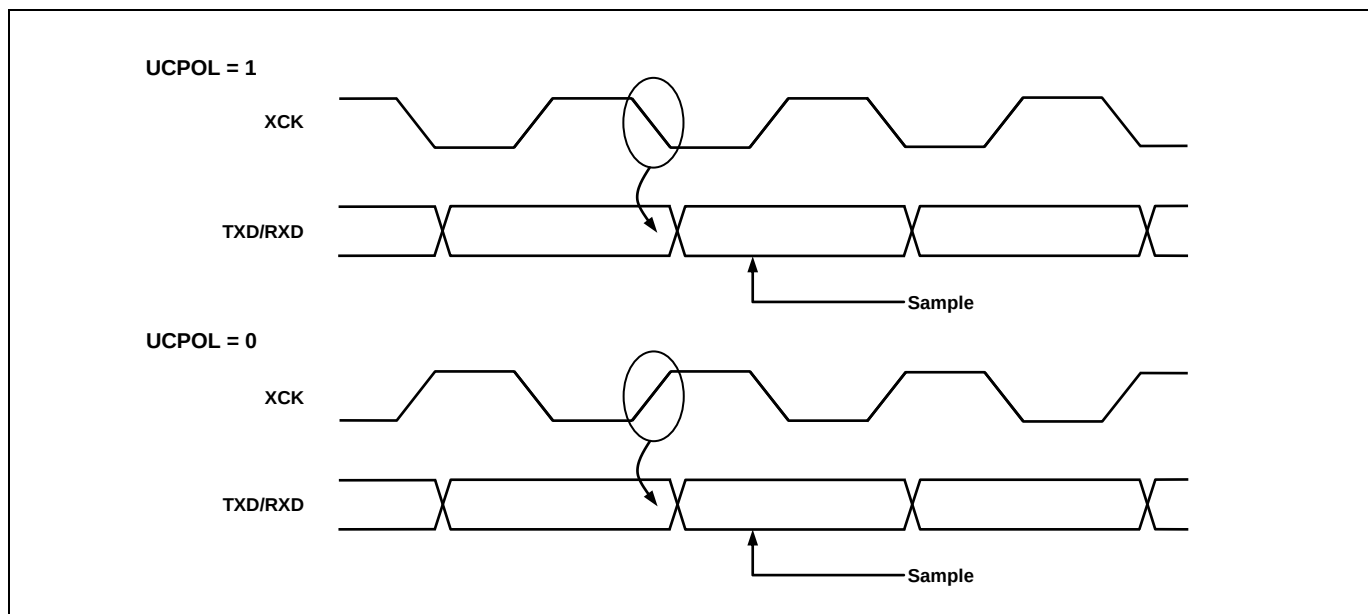


Figure 11.41 Synchronous Mode XCKn Timing

11.7.6 Data format

A serial frame is defined to be one character of data bits with synchronization bits (start and stop bits), and optionally a parity bit for error checking.

The USART supports all 30 combinations of the following as valid frame formats.

- 1 start bit
- 5, 6, 7, 8 or 9 data bits
- no, even or odd parity bit
- 1 or 2 stop bits

A frame starts with the start bit followed by the least significant data bit (LSB). Then the next data bits, up to a total of nine, are succeeding, ending with the most significant bit (MSB). If enabled the parity bit is inserted after the data bits, before the stop bits. A high to low transition on data pin is considered as start bit. When a complete frame is transmitted, it can be directly followed by a new frame, or the communication line can be set to an idle state. The idle means high state of data pin. The next figure shows the possible combinations of the frame formats. Bits inside brackets are optional.

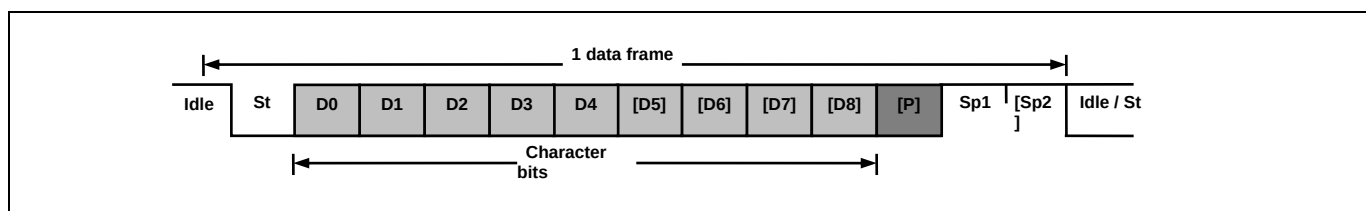


Figure 11.42 frame format

1 data frame consists of the following bits

- Idle No communication on communication line (TxD/RxD)
- St Start bit (Low)
- Dn Data bits (0~8)
- Parity bit ----- Even parity, Odd parity, No parity
- Stop bit(s) ----- 1 bit or 2 bits

The frame format used by the USART is set by the USIZE[2:0], UPM[1:0] and USBS bits in UCTRLx1 register. The Transmitter and Receiver use the same setting.

11.7.7 Parity bit

The parity bit is calculated by doing an exclusive-or of all the data bits. If odd parity is used, the result of the exclusive-or is inverted. The parity bit is located between the MSB and first stop bit of a serial frame.

$$P_{\text{even}} = D_{n-1} \wedge \dots \wedge D_3 \wedge D_2 \wedge D_1 \wedge D_0 \wedge 0$$

$$P_{\text{odd}} = D_{n-1} \wedge \dots \wedge D_3 \wedge D_2 \wedge D_1 \wedge D_0 \wedge 1$$

P_{even} : Parity bit using even parity

P_{odd} : Parity bit using odd parity

D_n : Data bit n of the character

11.7.8 USART Transmitter

The USART Transmitter is enabled by setting the TXE bit in UCTRLx1 register. When the Transmitter is enabled, the normal port operation of the TXD pin is overridden by the serial output pin of USART. The baud-rate, operation mode and frame format must be setup once before doing any transmissions. If synchronous or SPI operation is used, the clock on the XCK pin will be overridden and used as transmission clock. If USART operates in SPI mode, SS pin is used as SS input pin in slave mode or can be configured as SS output pin in master mode. This can be done by setting SPISS bit in UCTRLx3 register.

11.7.8.1 Sending Tx data

A data transmission is initiated by loading the transmit buffer (UDATAx register I/O location) with the data to be transmitted. The data written in transmit buffer is moved to the shift register when the shift register is ready to send a new frame. The shift register is loaded with the new data if it is in idle state or immediately after the last stop bit of the previous frame is transmitted. When the shift register is loaded with new data, it will transfer one complete frame at the settings of control registers. If the 9-bit characters are used in asynchronous or synchronous operation mode (USIZE[2:0]=7), the ninth bit must be written to the TX8 bit in UCTRLx3 register before loading transmit buffer (UDATA register).

11.7.8.2 Transmitter flag and interrupt

The USART Transmitter has 2 flags which indicate its state. One is USART Data Register Empty (UDRE) and the other is Transmit Complete (TxC). Both flags can be interrupt sources.

UDRE flag indicates whether the transmit buffer is ready to be loaded with new data. This bit is set when the transmit buffer is empty and cleared when the transmit buffer contains data to be transmitted that has not yet been moved into the shift register. And also this flag can be cleared by writing '0' to this bit position. Writing '1' to this bit position is prevented.

When the Data Register Empty Interrupt Enable (UDRIE) bit in UCTRL2 register is set and the Global Interrupt is enabled, USART Data Register Empty Interrupt is generated while UDRE flag is set.

The Transmit Complete (TxC) flag bit is set when the entire frame in the transmit shift register has been shifted out and there are no more data in the transmit buffer. The TxC flag is automatically cleared when the Transmit Complete Interrupt service routine is executed, or it can be cleared by writing '0' to TxC bit in USTAT register.

When the Transmit Complete Interrupt Enable (TxCIE) bit in UCTRL2 register is set and the Global Interrupt is enabled, USART Transmit Complete Interrupt is generated while TxC flag is set.

11.7.8.3 Parity Generator

The Parity Generator calculates the parity bit for the sending serial frame data. When parity bit is enabled (UPM[1]=1), the transmitter control logic inserts the parity bit between the MSB and the first stop bit of the sending frame.

11.7.8.4 Disabling Transmitter

Disabling the Transmitter by clearing the TXE bit will not become effective until ongoing transmission is completed. When the Transmitter is disabled, the TXD pin is used as normal General Purpose I/O (GPIO) or primary function pin.

11.7.9 USART Receiver

The USART Receiver is enabled by setting the RXE bit in the UCTRLx1 register. When the Receiver is enabled, the normal pin operation of the RXD pin is overridden by the USART as the serial input pin of the Receiver. The baud-rate, mode of operation and frame format must be set before serial reception. If synchronous or SPI operation is used, the clock on the XCK pin will be used as transfer clock. If USART operates in SPI mode, SS pin is used as SS input pin in slave mode or can be configured as SS output pin in master mode. This can be done by setting SPISS bit in UCTRLx3 register.

11.7.9.1 Receiving Rx data

When USART is in synchronous or asynchronous operation mode, the Receiver starts data reception when it detects a valid start bit (LOW) on RXD pin. Each bit after start bit is sampled at pre-defined baud-rate (asynchronous) or sampling edge of XCK (synchronous), and shifted into the receive shift register until the first stop bit of a frame is received. Even if there's 2nd stop bit in the frame, the 2nd stop bit is ignored by the Receiver. That is, receiving the first stop bit means that a complete serial frame is present in the receiver shift register and contents of the shift register are to be moved into the receive buffer. The receive buffer is read by reading the UDATAx register.

If 9-bit characters are used (USIZE[2:0] = 7) the ninth bit is stored in the RX8 bit position in the UCTRLx3 register. The 9th bit must be read from the RX8 bit before reading the low 8 bits from the UDATAx register. Likewise, the error flags FE, DOR, PE must be read before reading the data from UDATAx register. This is because the error flags are stored in the same FIFO position of the receive buffer.

11.7.9.2 Receiver flag and interrupt

The USART Receiver has one flag that indicates the Receiver state.

The Receive Complete (RXC) flag indicates whether there are unread data present in the receive buffer. This flag is set when there are unread data in the receive buffer and cleared when the receive buffer is empty. If the Receiver is disabled (RXE=0), the receiver buffer is flushed and the RXC flag is cleared.

When the Receive Complete Interrupt Enable (RXCIE) bit in the UCTRLx2 register is set and Global Interrupt is enabled, the USART Receiver Complete Interrupt is generated while RXC flag is set.

The USART Receiver has three error flags which are Frame Error (FE), Data OverRun (DOR) and Parity Error (PE). These error flags can be read from the USTATx register. As data received are stored in the 2-level receive buffer, these error flags are also stored in the same position of receive buffer. So, before reading received data from UDATAx register, read the USTATx register first which contains error flags.

The Frame Error (FE) flag indicates the state of the first stop bit. The FE flag is zero when the stop bit was correctly detected as one, and the FE flag is one when the stop bit was incorrect, ie detected as zero. This flag can be used for detecting out-of-sync conditions between data frames.

The Data OverRun (DOR) flag indicates data loss due to a receive buffer full condition. A DOR occurs when the receive buffer is full, and another new data is present in the receive shift register which are to be stored into the receive buffer. After the DOR flag is set, all the incoming data are lost. To prevent data loss or clear this flag, read the receive buffer.

The Parity Error (PE) flag indicates that the frame in the receive buffer had a Parity Error when received. If Parity Check function is not enabled ($UPM[1]=0$), the PE bit is always read zero.

Note) The error flags related to receive operation are not used when USART is in SPI mode.

11.7.9.3 Parity Checker

If Parity bit is enabled ($UPM[1]=1$), the Parity Checker calculates the parity of the data bits in incoming frame and compares the result with the parity bit from the received serial frame.

11.7.9.4 Disabling Receiver

In contrast to Transmitter, disabling the Receiver by clearing RXE bit makes the Receiver inactive immediately. When the Receiver is disabled the Receiver flushes the receive buffer and the remaining data in the buffer is all reset. The RXD pin is not overridden the function of USART, so RXD pin becomes normal GPIO or primary function pin.

11.7.9.5 Asynchronous Data Reception

To receive asynchronous data frame, the USART includes a clock and data recovery unit. The Clock Recovery logic is used for synchronizing the internally generated baud-rate clock to the incoming asynchronous serial frame on the RXD pin.

The Data recovery logic samples and low pass filters the incoming bits, and this removes the noise of RXD pin.

The next figure illustrates the sampling process of the start bit of an incoming frame. The sampling rate is 16 times the baud-rate for normal mode, and 8 times the baud rate for Double Speed mode ($U2X=1$). The horizontal arrows show the synchronization variation due to the asynchronous sampling process. Note that larger time variation is shown when using the Double Speed mode.

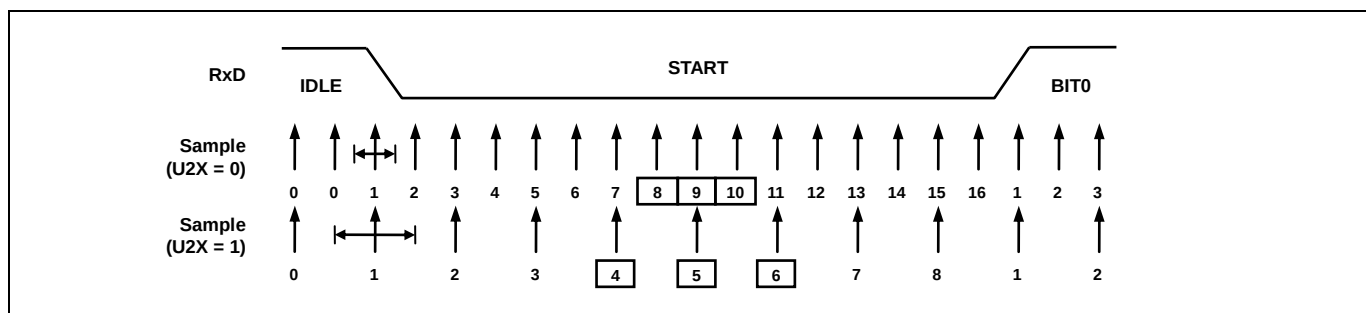


Figure 11.43 Start bit Sampling

When the Receiver is enabled (RXE=1), the clock recovery logic tries to find a high to low transition on the RXD line, the start bit condition. After detecting high to low transition on RXD line, the clock recovery logic uses samples 8,9, and 10 for Normal mode, and samples 4, 5, and 6 for Double Speed mode to decide if a valid start bit is received. If more than 2 samples have logical low level, it is considered that a valid start bit is detected and the internally generated clock is synchronized to the incoming data frame. And the data recovery can begin. The synchronization process is repeated for each start bit.

As described above, when the Receiver clock is synchronized to the start bit, the data recovery can begin. Data recovery process is almost similar to the clock recovery process. The data recovery logic samples 16 times for each incoming bits for Normal mode and 8 times for Double Speed mode. And uses sample 8, 9, and 10 to decide data value for Normal mode, samples 4, 5, and 6 for Double Speed mode. If more than 2 samples have low levels, the received bit is considered to a logic 0 and more than 2 samples have high levels, the received bit is considered to a logic 1. The data recovery process is then repeated until a complete frame is received including the first stop bit. The decided bit value is stored in the receive shift register in order. Note that the Receiver only uses the first stop bit of a frame. Internally, after receiving the first stop bit, the Receiver is in idle state and waiting to find start bit.

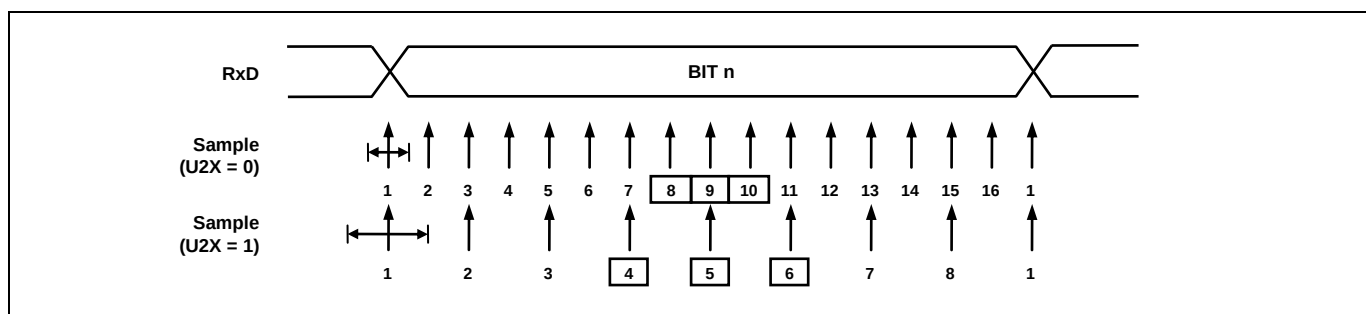


Figure 11.44 Sampling of Data and Parity bit

The process for detecting stop bit is like clock and data recovery process. That is, if 2 or more samples of 3 center values have high level, correct stop bit is detected, else a Frame Error flag is set. After deciding first stop bit whether a valid stop bit is received or not, the Receiver goes idle state and monitors the RXD line to check a valid high to low transition is detected (start bit detection).

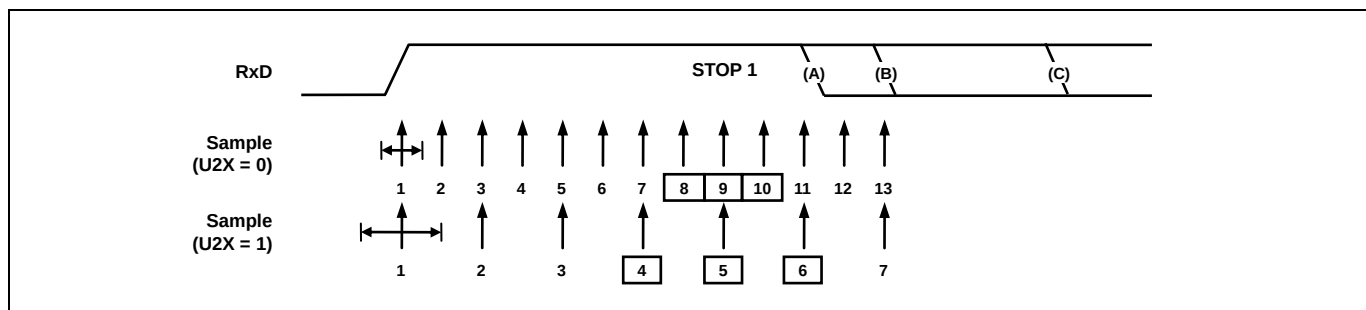


Figure 11.45 Stop bit Sampling and Next Start bit Sampling

11.7.10 SPI Mode

The USART can be set to operate in industrial standard SPI compliant mode. The SPI mode has the following features.

- Full duplex, three-wire synchronous data transfer
- Master or Slave operation
- Supports all four SPI modes of operation (mode0, 1, 2, and 3)
- Selectable LSB first or MSB first data transfer
- Double buffered transmit and receive
- Programmable transmit bit rate

When SPI mode is enabled (UMSEL[1:0]=3), the Slave Select (SS) pin becomes active low input in slave mode operation, or can be output in master mode operation if SPISS bit is set.

Note that during SPI mode of operation, the pin RXD is renamed as MISO and TXD is renamed as MOSI for compatibility to other SPI devices.

11.7.10.1 SPI Clock formats and timing

To accommodate a wide variety of synchronous serial peripherals from different manufacturers, the USART has a clock polarity bit (UCPOL) and a clock phase control bit (UCPHA) to select one of four clock formats for data transfers. UCPOL selectively insert an inverter in series with the clock. UCPHA chooses between two different clock phase relationships between the clock and data. Note that UCPHA and UCPOL bits in UCTRLx1 register have different meanings according to the UMSEL[1:0] bits which decides the operating mode of USART.

Table below shows four combinations of UCPOL and UCPHA for SPI mode 0, 1, 2, and 3.

SPI Mode	UCPOL	UCPHA	Leading Edge	Trailing Edge
0	0	0	Sample (Rising)	Setup (Falling)
1	0	1	Setup (Rising)	Sample (Falling)
2	1	0	Sample (Falling)	Setup (Rising)
3	1	1	Setup (Falling)	Sample (Rising)

Table 11.15 CPOL Functionality

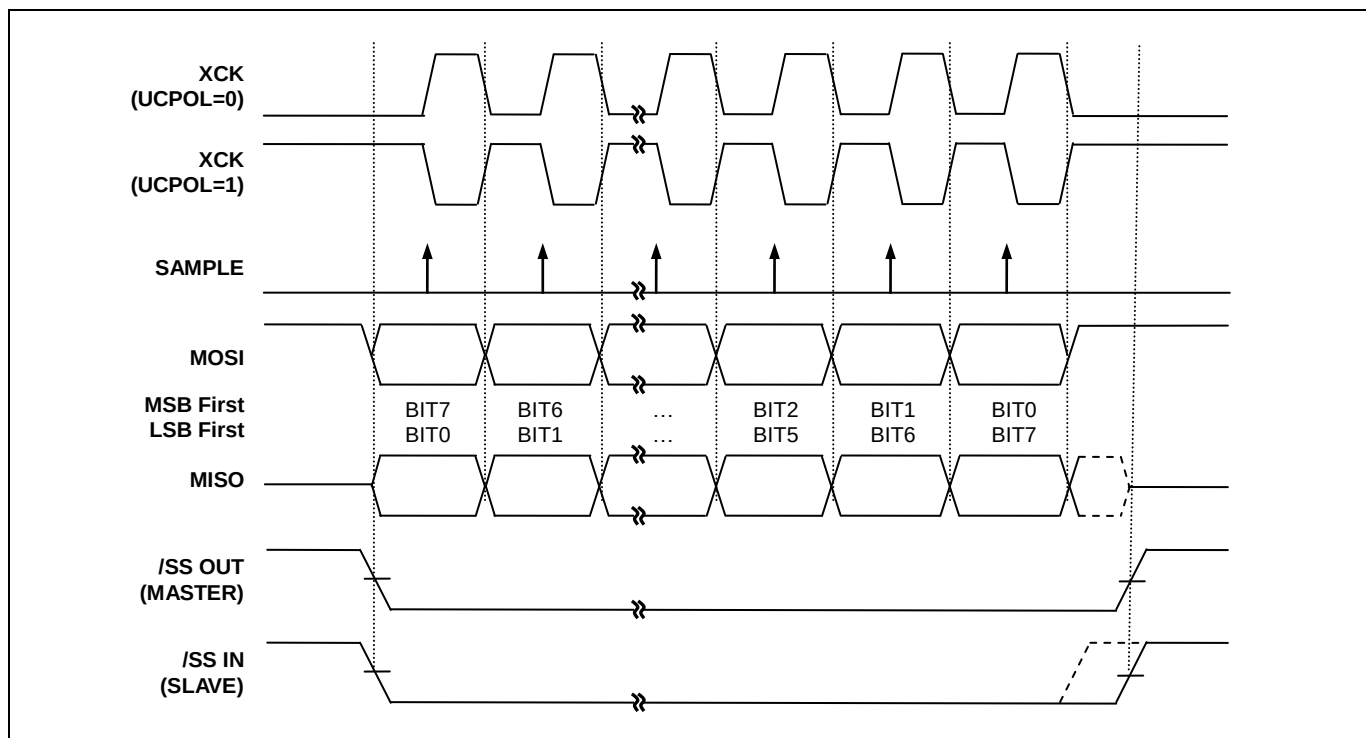


Figure 11.46 SPI Clock Formats when UCPHA=0

When UCPHA=0, the slave begins to drive its MISO output with the first data bit value when SS goes to active low. The first XCK edge causes both the master and the slave to sample the data bit value on their MISO and MOSI inputs, respectively. At the second XCK edge, the USART shifts the second data bit value out to the MOSI and MISO outputs of the master and slave, respectively. Unlike the case of UCPHA=1, when UCPHA=0, the slave's SS input must go to its inactive high level between transfers. This is because the slave can prepare the first data bit when it detects falling edge of SS input.

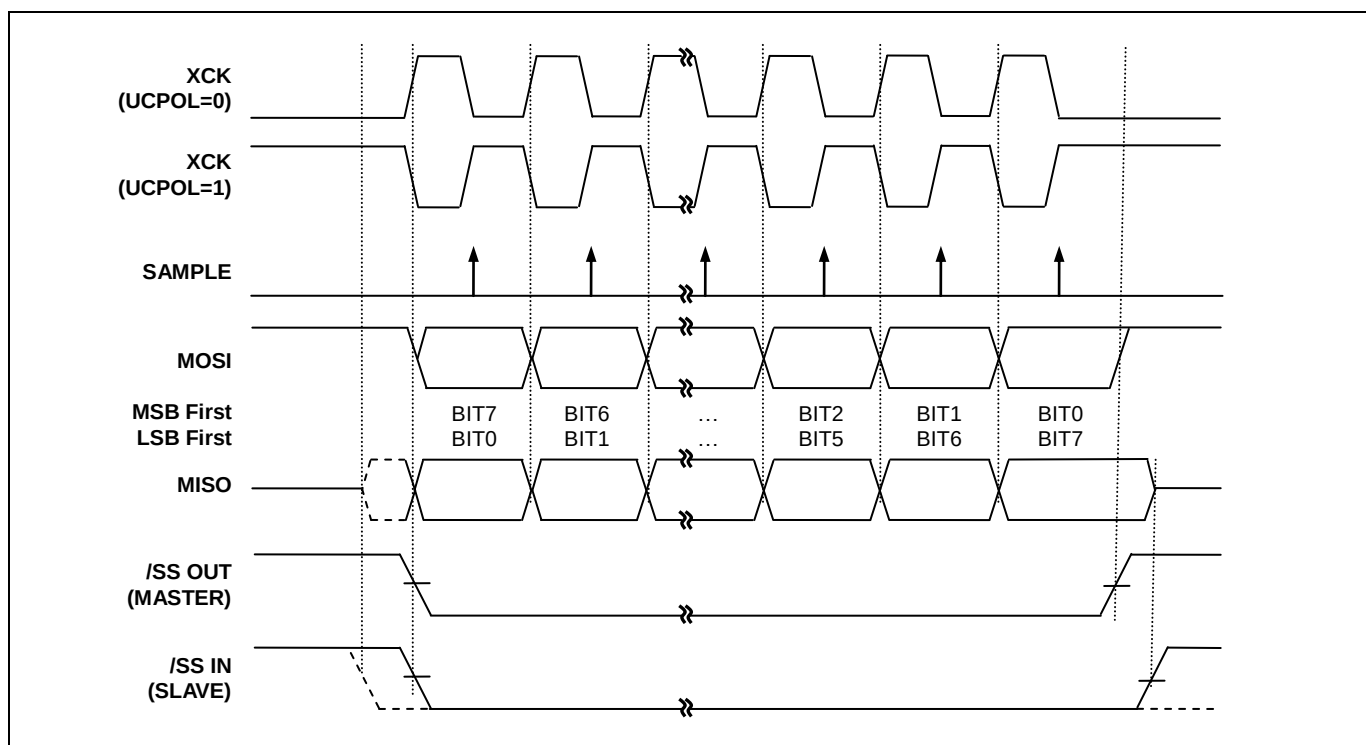


Figure 11.47 SPI Clock Formats when UCPHA=1

When UCPHA=1, the slave begins to drive its MISO output when SS goes active low, but the data is not defined until the first XCK edge. The first XCK edge shifts the first bit of data from the shifter onto the MOSI output of the master and the MISO output of the slave. The next XCK edge causes both the master and slave to sample the data bit value on their MISO and MOSI inputs, respectively. At the third XCK edge, the USART shifts the second data bit value out to the MOSI and MISO output of the master and slave respectively. When UCPHA=1, the slave's SS input is not required to go to its inactive high level between transfers.

Because the SPI logic reuses the USART resources, SPI mode of operation is similar to that of synchronous or asynchronous operation. An SPI transfer is initiated by checking for the USART Data Register Empty flag (UDRE=1) and then writing a byte of data to the UDATA Register. In master mode of operation, even if transmission is not enabled (TXE=0), writing data to the UDATA register is necessary because the clock XCK is generated from transmitter block.

11.7.11 Register Map

Name	Address	Dir	Default	Description
UCTRL01	E2H	R/W	00H	USART Control 1 Register 0
UCTRL02	E3H	R/W	00H	USART Control 2 Register 0
UCTRL03	E4H	R/W	00H	USART Control 3 Register 0
USTAT0	E5H	R	80H	USART Status Register 0
UBAUD0	E6H	R/W	FFH	USART Baud Rate Generation Register 0
UDATA0	E7H	R/W	FFH	USART Data Register 0
UCTRL11	FAH	R/W	00H	USART Control 1 Register 1
UCTRL12	FBH	R/W	00H	USART Control 2 Register 1
UCTRL13	FCH	R/W	00H	USART Control 3 Register 1
USTAT1	FDH	R	80H	USART Status Register 1
UBAUD1	FEH	R/W	FFH	USART Baud Rate Generation Register 1
UDATA1	FFH	R/W	FFH	USART Data Register 1

Table 11.16 Register Map

11.7.12 USART Register Description

USART module consists of USART Control 1 Register (UCTRLx1), USART Control 2 Register (UCTRLx2), USART Control 3 Register (UCTRLx3), USART Status Register (USTATx), USART Data Register (UDATAx), and USART Baud Rate Generation Register (UBAUDx).

11.7.13 Register Description for USART

UCTRLx1 (USART Control 1 Register) E2H, FAH

7	6	5	4	3	2	1	0
UMSEL1	UMSEL0	UPM1	UPM0	USIZE2	USIZE1 UDORD	USIZE0 UCPHA	UCPOL
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00_H**UMSEL[1:0]** Selects operation mode of USART

UMSEL1	UMSEL0	Operating Mode
0	0	Asynchronous Mode (Normal Uart)
0	1	Synchronous Mode (Synchronous Uart)
1	0	Reserved
1	1	SPI Mode

UPM[1:0] Selects Parity Generation and Check methods

UPM1	UPM0	Parity mode
0	0	No Parity
0	1	Reserved
1	0	Even Parity
1	1	Odd Parity

USIZE[2:0] When in asynchronous or synchronous mode of operation, selects the length of data bits in frame.

USIZE2	USIZE1	USIZE0	Data length
0	0	0	5-bit
0	0	1	6-bit
0	1	0	7-bit
0	1	1	8-bit
1	0	0	Reserved
1	0	1	Reserved
1	1	0	Reserved
1	1	1	9-bit

UDORD This bit is in the same bit position with USIZE1. In SPI mode, when set to one the MSB of the data byte is transmitted first. When set to zero the LSB of the data byte is transmitted first.

0	LSB First
1	MSB First

UCPOL Selects polarity of XCK in synchronous or SPI mode

0	TXD change @Rising Edge, RXD change @Falling Edge
1	TXD change @ Falling Edge, RXD change @ Rising Edge

UCPHA This bit is in the same bit position with USIZE0. In SPI mode, along with UC POL bit, selects one of two clock formats for different kinds of synchronous serial peripherals. Leading edge means first XCK edge and trailing edge means 2nd or last clock edge of XCK in one XCK pulse. And Sample means detecting of incoming receive bit, Setup means preparing transmit data.

UCPOL	UCPHA	Leading Edge	Trailing Edge
0	0	Sample (Rising)	Setup (Falling)
0	1	Setup (Rising)	Sample (Falling)
1	0	Sample (Falling)	Setup (Rising)
1	1	Setup (Falling)	Sample (Rising)

UCTRL2 (USART Control 2 Register) E3H, FBH

7	6	5	4	3	2	1	0
UDRIE	TXCIE	RXCIE	WAKEIE	TXE	RXE	USARTEN	U2X
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00_H

UDRIE	Interrupt enable bit for USART Data Register Empty. 0 Interrupt from UDRE is inhibited (use polling) 1 When UDRE is set, request an interrupt
TXCIE	Interrupt enable bit for Transmit Complete. 0 Interrupt from TXC is inhibited (use polling) 1 When TXC is set, request an interrupt
RXCIE	Interrupt enable bit for Receive Complete 0 Interrupt from RXC is inhibited (use polling) 1 When RXC is set, request an interrupt
WAKEIE	Interrupt enable bit for Asynchronous Wake in STOP mode. When device is in stop mode, if RXD goes to LOW level an interrupt can be requested to wake-up system. 0 Interrupt from Wake is inhibited 1 When WAKE is set, request an interrupt
TXE	Enables the transmitter unit. 0 Transmitter is disabled 1 Transmitter is enabled
RXE	Enables the receiver unit. 0 Receiver is disabled 1 Receiver is enabled
USARTEN	Activate USART module by supplying clock. 0 USART is disabled (clock is halted) 1 USART is enabled
U2X	This bit only has effect for the asynchronous operation and selects receiver sampling rate. 0 Normal asynchronous operation 1 Double Speed asynchronous operation

UCTRL3 (USART Control 3 Register) E4H, FCH

7	6	5	4	3	2	1	0
MASTER	LOOPS	DISXCK	SPISS	-	USBS	TX8	RX8
RW	RW	RW	RW	-	RW	RW	RW

Initial value : 00_H

MASTER	Selects master or slave in SPI or Synchronous mode operation and controls the direction of XCK pin. 0 Slave mode operation and XCK is input pin. 1 Master mode operation and XCK is output pin
LOOPS	Controls the Loop Back mode of USART, for test mode 0 Normal operation 1 Loop Back mode
DISXCK	In Synchronous mode of operation, selects the waveform of XCK output. 0 XCK is free-running while USART is enabled in synchronous master mode. 1 XCK is active while any frame is on transferring.
SPISS	Controls the functionality of SS pin in master SPI mode. 0 SS pin is normal GPIO or other primary function 1 SS output to other slave device
USBS	Selects the length of stop bit in Asynchronous or Synchronous mode of operation. 0 1 Stop bit 1 2 Stop bit
TX8	The ninth bit of data frame in Asynchronous or Synchronous mode of operation. Write this bit first before loading the UDATA register. 0 MSB (9 th bit) to be transmitted is '0' 1 MSB (9 th bit) to be transmitted is '1'
RX8	The ninth bit of data frame in Asynchronous or Synchronous mode of operation. Read this bit first before reading the receive buffer. 0 MSB (9 th bit) received is '0' 1 MSB (9 th bit) received is '1'

USTAT (USART Status Register) E5H

7	6	5	4	3	2	1	0
UDRE	TXC	RXC	WAKE	SOFTTRST	DOR	FE	PE
RW	RW	RW	RW	RW	R	R	R

Initial value : 80_H

UDRE	The UDRE flag indicates if the transmit buffer (UDATA) is ready to be loaded with new data. If UDRE is '1', it means the transmit buffer is empty and can hold one or two new data. This flag can generate an UDRE interrupt. Writing '0' to this bit position will clear UDRE flag. 0 Transmit buffer is not empty. 1 Transmit buffer is empty.
TXC	This flag is set when the entire frame in the transmit shift register has been shifted out and there is no new data currently present in the transmit buffer. This flag is automatically cleared when the interrupt service routine of a TXC interrupt is executed. It is also cleared by writing '0' to this bit position. This flag can generate a TXC interrupt. 0 Transmission is ongoing. 1 Transmit buffer is empty and the data in transmit shift register are shifted out completely.
RXC	This flag is set when there are unread data in the receive buffer and cleared when all the data in the receive buffer are read. The RXC flag can be used to generate a RXC interrupt. 0 There is no data unread in the receive buffer 1 There are more than 1 data in the receive buffer
WAKE	This flag is set when the RX pin is detected low while the CPU is in stop mode. This flag can be used to generate a WAKE interrupt. This bit is set only when in asynchronous mode of operation. ^{NOTE} 0 No WAKE interrupt is generated. 1 WAKE interrupt is generated.
SOFTTRST	This is an internal reset and only has effect on USART. Writing '1' to this bit initializes the internal logic of USART and is auto cleared. 0 No operation 1 Reset USART
DOR	This bit is set if a Data OverRun occurs. While this bit is set, the incoming data frame is ignored. This flag is valid until the receive buffer is read. 0 No Data OverRun 1 Data OverRun detected
FE	This bit is set if the first stop bit of next character in the receive buffer is detected as '0'. This bit is valid until the receive buffer is read. 0 No Frame Error 1 Frame Error detected
PE	This bit is set if the next character in the receive buffer has a Parity Error when received while Parity Checking is enabled. This bit is valid until the receive buffer is read. 0 No Parity Error 1 Parity Error detected

NOTE)

1. When the WAKE function of USART is used as a release source from STOP mode, it is required to clear this bit in the RX interrupt service routine. Else the device will not wake-up from STOP mode again by the change of RX pin.

UBAUD (USART Baud-Rate Generation Register) E6H, FEH

7	6	5	4	3	2	1	0
UBAUD7	UBAUD6	UBAUD5	UBAUD4	UBAUD3	UBAUD2	UBAUD1	UBAUD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : FF_H

UBAUD [7:0] The value in this register is used to generate internal baud rate in asynchronous mode or to generate XCK clock in synchronous or SPI mode. To prevent malfunction, do not write '0' in asynchronous mode, and do not write '0' or '1' in synchronous or SPI mode.

UDATA (USART Data Register) E7H, FFH

7	6	5	4	3	2	1	0
UDATA7	UDATA6	UDATA5	UDATA4	UDATA3	UDATA2	UDATA1	UDATA0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : FF_H

UDATA [7:0] The USART Transmit Buffer and Receive Buffer share the same I/O address with this DATA register. The Transmit Data Buffer is the destination for data written to the UDATA register. Reading the UDATA register returns the contents of the Receive Buffer.

Write this register only when the UDRE flag is set. In SPI or synchronous master mode, write this register even if TX is not enabled to generate clock, XCK.

11.7.14 Baud Rate setting (example)

Baud Rate	fOSC=1.00MHz				fOSC=1.8432MHz				fOSC=2.00MHz			
	U2X=0		U2X=1		U2X=0		U2X=1		U2X=0		U2X=1	
	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR
2400	25	0.2%	51	0.2%	47	0.0%	95	0.0%	51	0.2%	103	0.2%
4800	12	0.2%	25	0.2%	23	0.0%	47	0.0%	25	0.2%	51	0.2%
9600	6	-7.0%	12	0.2%	11	0.0%	23	0.0%	12	0.2%	25	0.2%
14.4K	3	8.5%	8	-3.5%	7	0.0%	15	0.0%	8	-3.5%	16	2.1%
19.2K	2	8.5%	6	-7.0%	5	0.0%	11	0.0%	6	-7.0%	12	0.2%
28.8K	1	8.5%	3	8.5%	3	0.0%	7	0.0%	3	8.5%	8	-3.5%
38.4K	1	-18.6%	2	8.5%	2	0.0%	5	0.0%	2	8.5%	6	-7.0%
57.6K	-	-	1	8.5%	1	-25.0%	3	0.0%	1	8.5%	3	8.5%
76.8K	-	-	1	-18.6%	1	0.0%	2	0.0%	1	-18.6%	2	8.5%
115.2K	-	-	-	-	-	-	1	0.0%	-	-	1	8.5%
230.4K	-	-	-	-	-	-	-	-	-	-	-	-
Baud Rate	fOSC=3.6864MHz				fOSC=4.00MHz				fOSC=7.3728MHz			
	U2X=0		U2X=1		U2X=0		U2X=1		U2X=0		U2X=1	
	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR
2400	95	0.0%	191	0.0%	103	0.2%	207	0.2%	191	0.0%	-	-
4800	47	0.0%	95	0.0%	51	0.2%	103	0.2%	95	0.0%	191	0.0%
9600	23	0.0%	47	0.0%	25	0.2%	51	0.2%	47	0.0%	95	0.0%
14.4K	15	0.0%	31	0.0%	16	2.1%	34	-0.8%	31	0.0%	63	0.0%
19.2K	11	0.0%	23	0.0%	12	0.2%	25	0.2%	23	0.0%	47	0.0%
28.8K	7	0.0%	15	0.0%	8	-3.5%	16	2.1%	15	0.0%	31	0.0%
38.4K	5	0.0%	11	0.0%	6	-7.0%	12	0.2%	11	0.0%	23	0.0%
57.6K	3	0.0%	7	0.0%	3	8.5%	8	-3.5%	7	0.0%	15	0.0%
76.8K	2	0.0%	5	0.0%	2	8.5%	6	-7.0%	5	0.0%	11	0.0%
115.2K	1	0.0%	3	0.0%	1	8.5%	3	8.5%	3	0.0%	7	0.0%
230.4K	-	-	1	0.0%	-	-	1	8.5%	1	0.0%	3	0.0%
250K	-	-	1	-7.8%	-	-	1	0.0%	1	-7.8%	3	-7.8%
0.5M	-	-	-	-	-	-	-	-	-	-	1	-7.8%
Baud Rate	fOSC=8.00MHz				fOSC=11.0592MHz				fOSC=14.7456MHz			
	U2X=0		U2X=1		U2X=0		U2X=1		U2X=0		U2X=1	
	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR	UBAUD	ERROR
2400	207	0.2%	-	-	-	-	-	-	-	-	-	-
4800	103	0.2%	207	0.2%	143	0.0%	-	-	191	0.0%	-	-
9600	51	0.2%	103	0.2%	71	0.0%	143	0.0%	95	0.0%	191	0.0%
14.4K	34	-0.8%	68	0.6%	47	0.0%	95	0.0%	63	0.0%	127	0.0%
19.2K	25	0.2%	51	0.2%	35	0.0%	71	0.0%	47	0.0%	95	0.0%
28.8K	16	2.1%	34	-0.8%	23	0.0%	47	0.0%	31	0.0%	63	0.0%
38.4K	12	0.2%	25	0.2%	17	0.0%	35	0.0%	23	0.0%	47	0.0%
57.6K	8	-3.5%	16	2.1%	11	0.0%	23	0.0%	15	0.0%	31	0.0%
76.8K	6	-7.0%	12	0.2%	8	0.0%	17	0.0%	11	0.0%	23	0.0%
115.2K	3	8.5%	8	-3.5%	5	0.0%	11	0.0%	7	0.0%	15	0.0%
230.4K	1	8.5%	3	8.5%	2	0.0%	5	0.0%	3	0.0%	7	0.0%
250K	1	0.0%	3	0.0%	2	-7.8%	5	-7.8%	3	-7.8%	6	5.3%
0.5M	-	-	1	0.0%	-	-	2	-7.8%	1	-7.8%	3	-7.8%
1M	-	-	-	-	-	-	-	-	-	-	1	-7.8%

Table 11.17 Examples of UBAUD Settings for Commonly Used Oscillator Frequencies

11.8 SPI

11.8.1 Overview

There is Serial Peripheral Interface (SPI) one channel in MC95FG308. The SPI allows synchronous serial data transfer between the external serial devices. It can do Full-duplex communication by 4-wire (MOSI, MISO, SCK, SS), support Master/Slave mode, can select serial clock (SCK) polarity, phase and whether LSB first data transfer or MSB first data transfer.

11.8.2 Block Diagram

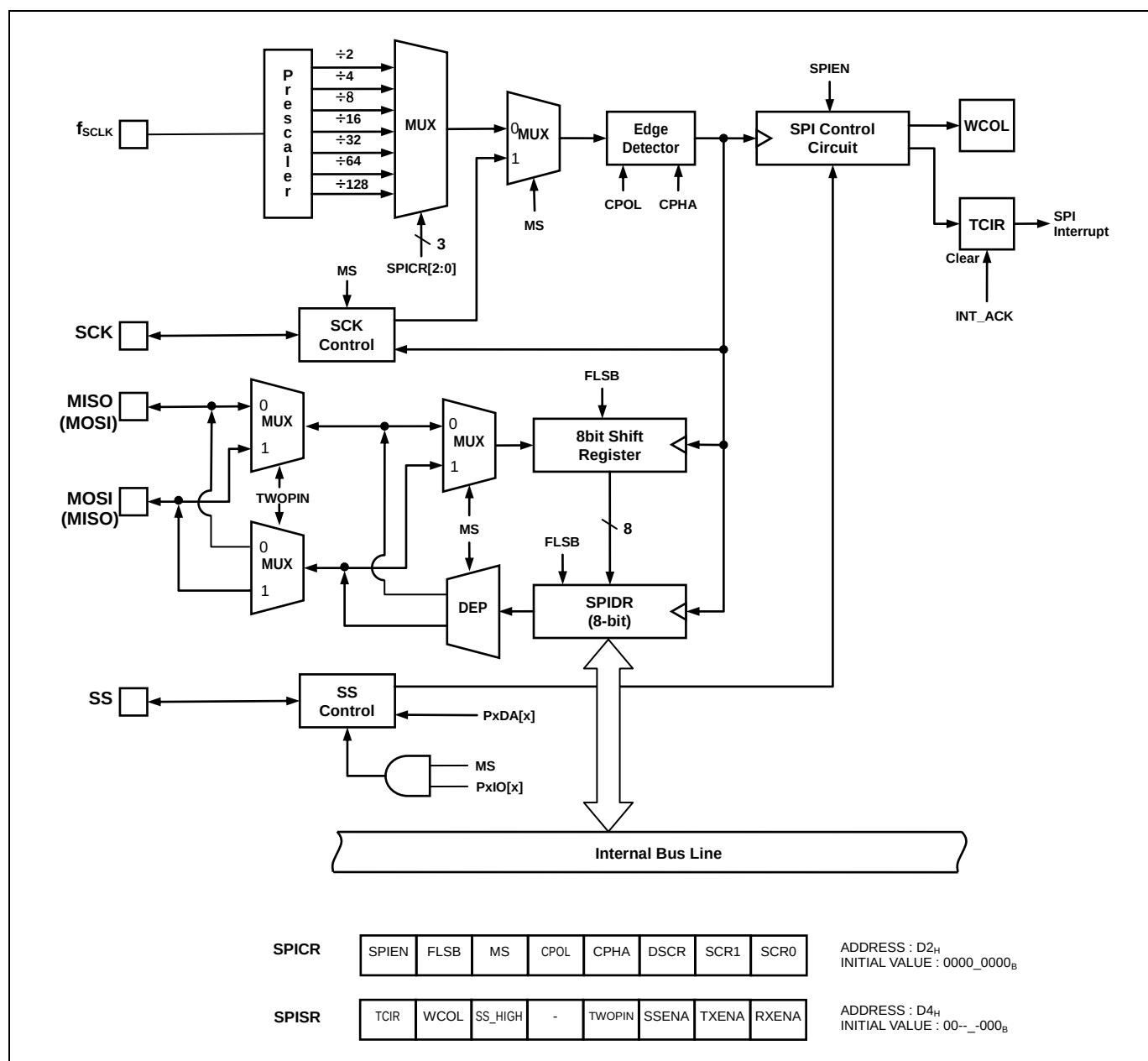


Figure 11.48 SPI Block Diagram

11.8.3 Data Transmit / Receive Operation

User can use SPI for serial data communication by following step

1. Select SPI operation mode(master/slave, polarity, phase) by control register SPICR.
2. When the SPI is configured as a Master, it selects a Slave by SS signal (active low). When the SPI is configured as a Slave, it is selected by SS signal incoming from Master
3. When the user writes a byte to the data register SPIDR, SPI will start an operation.
4. In this time, if the SPI is configured as a Master, serial clock will come out of SCK pin. And Master shifts the eight bits into the Slave (transmit), Slave shifts the eight bits into the Master at the same time (receive). If the SPI is configured as a Slave, serial clock will come into SCK pin. And Slave shifts the eight bits into the Master (transmit), Master shifts the eight bits into the Slave at the same time (receive).
5. When transmit/receive is done, TCIR (Transmit Complete or Interrupt Request) bit will be set. If the SPI interrupt is enabled, an interrupt is requested. And TCIR bit is cleared by hardware when executing the corresponding interrupt. If SPI interrupt is disable, TCIR bit is cleared when user read the status register SPISR, and then access (read/write) the data register SPIDR.

NOTE)

1. If you want to use both transmit and receive, set the TXENA, RXENA bit of SPISR, and if user want to use only either transmit or receive, clear the TXENA or RXENA. In this case, user can use disabled pin by GPIO freely.

11.8.4 SS pin function

1. When the SPI is configured as a Slave, the SS pin is always input. If LOW signal come into SS pin, the SPI logic is active. And if 'HIGH' signal come into SS pin, the SPI logic is stop. In this time, SPI logic will be reset, and invalidated any received data.
2. When the SPI is configured as a Master, the user can select the direction of the SS pin by port direction register (PxIO[x]). If the SS pin is configured as an output, user can use general GPIO output mode. If the SS pin is configured as an input, 'HIGH' signal must come into SS pin to guarantee Master operation. If 'LOW' signal come into SS pin, the SPI logic interprets this as another master selecting the SPI as a slave and starting to send data to it. To avoid bus contention, MS bit of SPICR will be cleared and the SPI becomes a Slave and then, TCIR bit of SPISR will be set, and if the SPI interrupt is enabled, an interrupt is requested.

NOTE)

1. - When the SS pin is configured as an output at Master mode, SS pin's output value is defined by user's software (PxDA[x]). Before SPICR setting, the direction of SS pin must be defined
2. - If you don't need to use SS pin, clear the SENA bit of SPISR. So, you can use disabled pin by GPIO freely. In this case, SS signal is driven by 'HIGH' or 'LOW' internally. In other words, master is 'HIGH', slave is 'LOW'
3. - When SS pin is configured as input(master or slave), if 'HIGH' signal come into SS pin, this flag bit will be set at the SS rising time. And you can clear it by writing '0'.

11.8.5 Timing Waveform

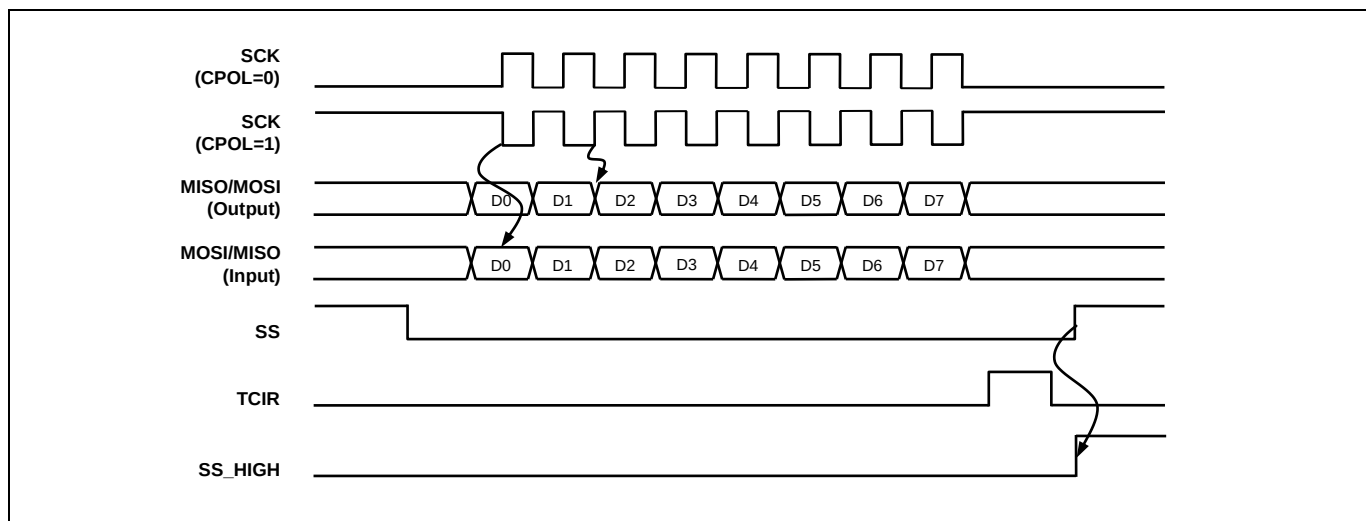


Figure 11.49 SPI Transmit/Receive Timing Diagram at CPHA = 0

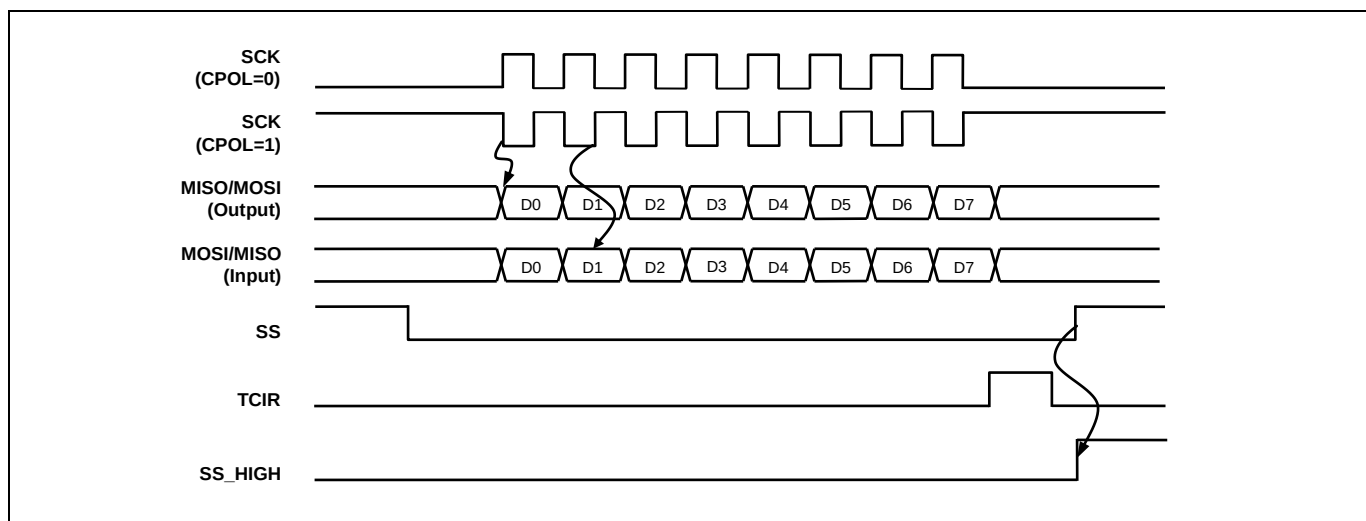


Figure 11.50 SPI Transmit/Receive Timing Diagram at CPHA = 1

11.8.6 Register Map

Name	Address	Dir	Default	Description
SPICR	D2H	R/W	0H	SPI Control Register
SPIDR	D3H	R/W	0H	SPI Data Register
SPISR	D4H	R/W	0H	SPI Status Register

Table 11.18 Register Map

11.8.7 SPI Register description

The SPI Register consists of SPI Control Register (SPICR), SPI Status Register (SPISR) and SPI Data Register (SPIDR)

11.8.8 Register Description for SPI

SPICR (SPI Control Register) : D2H

7	6	5	4	3	2	1	0
SPIEN	FLSB	MS	CPOL	CPHA	DSCR	SCR1	SCR0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

SPIEN This bit controls the SPI operation

0 SPI Disable

1 SPI Enable

FLSB This bit selects the data transmission sequence

0 MSB First

1 LSB First

MS This bit selects whether Master or Slave mode

0 Slave mode

1 Master mode

CPOL These two bits control the serial clock (SCK) mode**CPHA** Clock Polarity (CPOL) bit determine SCK's value at idle mode

Clock Phase (CPHA) bit determine if data is sampled on the leading or trailing edge of SCK. Refer to Figure11.49, Figure 11.50

CPOL	CPHA	Leading Edge	Trailing Edge
0	0	Sample (Rising)	Setup (Falling)
0	1	Setup (Rising)	Sample (Falling)
1	0	Sample (Falling)	Setup (Rising)
1	1	Setup (Falling)	Sample (Rising)

DSCR These three bits select the SCK rate of the device configured as a Master. When DSCR bit is written one, SCK will be doubled in Master mode.**SCR[2:0]**

fx– Main system clock oscillation frequency.

DSCR	SCR1	SCR0	SCK frequency
0	0	0	fx/4
0	0	1	fx/16
0	1	0	fx/64
0	1	1	fx/128
1	0	0	fx/2
1	0	1	fx/8
1	1	0	fx/32
1	1	1	fx/64

SPIDR (SPI Data Register) : D3H

7	6	5	4	3	2	1	0
SPIDR7	SPIDR6	SPIDR5	SPIDR4	SPIDR3	SPIDR2	SPIDR1	SPIDR0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

SPIDR [7:0] SPI data register.
Although you only use reception, user must write any data in here to start the SPI operation.

SPISR (SPI Status Register) : D4H

7	6	5	4	3	2	1	0
TCIR	WCOL	SS_HIGH	-	TWOPIN	SSENA	TXENA	RXENA
R	R	RW	-	RW	RW	RW	RW

Initial value : 00H

TCIR When a serial data transmission is complete, the TCIR bit is set. If the SPI interrupt is enabled, an interrupt is requested. And TCIR bit is cleared by hardware when executing the corresponding interrupt. If SPI interrupt is disable, TCIR bit is cleared when user read the status register SPISR, and then access (read/write) the data register SPIDR.

0 Interrupt cleared
1 Transmission Complete and Interrupt Requested

WCOL This bit is set if the data register SPIDR is written during a data transfer. This bit is cleared when user read the status register SPISR, and then access (read/write) the data register SPIDR.

0 No collision
1 Write Collision

SS_HIGH When SS pin is configured as input(master or slave), if 'HIGH' signal come into SS pin, this flag bit will be set at the SS rising time. And you can clear it by writing '0'.
You can write only zero.

0 Flag is cleared
1 Flag is set

TWOPIN This bit controls the 2 pin operation.
In master mode,
0 Disable
1 Enable

SSENA This bit controls the SS pin operation
0 Disable
1 Enable

TXENA This bit controls a data transfer operation
0 Disable
1 Enable

RXENA This bit controls a data reception operation
0 Disable
1 Enable

Note that if the MS is set to '0', when TWOPIN is set to '0', port 03 is set to MISO and if the MS is set to '0', when TWOPIN is set to '1', port 02 is set to MOSI. But if the MS is set to '1', when TWOPIN is set to '0', port 03 is set to MOSI and if the MS is set to '1', when TWOPIN is set to '1', port 02 is set to MISO.

11.9 I2C

11.9.1 Overview

The I2C is one of industrial standard serial communication protocols, and which uses 2 bus lines Serial Data Line (SDA) and Serial Clock Line (SCL) to exchange data. Because both SDA and SCL lines are open-drain output, each line needs pull-up resistor. The features are as shown below.

- Compatible with I2C bus standard
- Multi-master operation
- Up to 400kHz data transfer speed
- 7-bit address
- Support two slave addresses
- Both master and slave operation
- Bus busy detection

11.9.2 Block Diagram

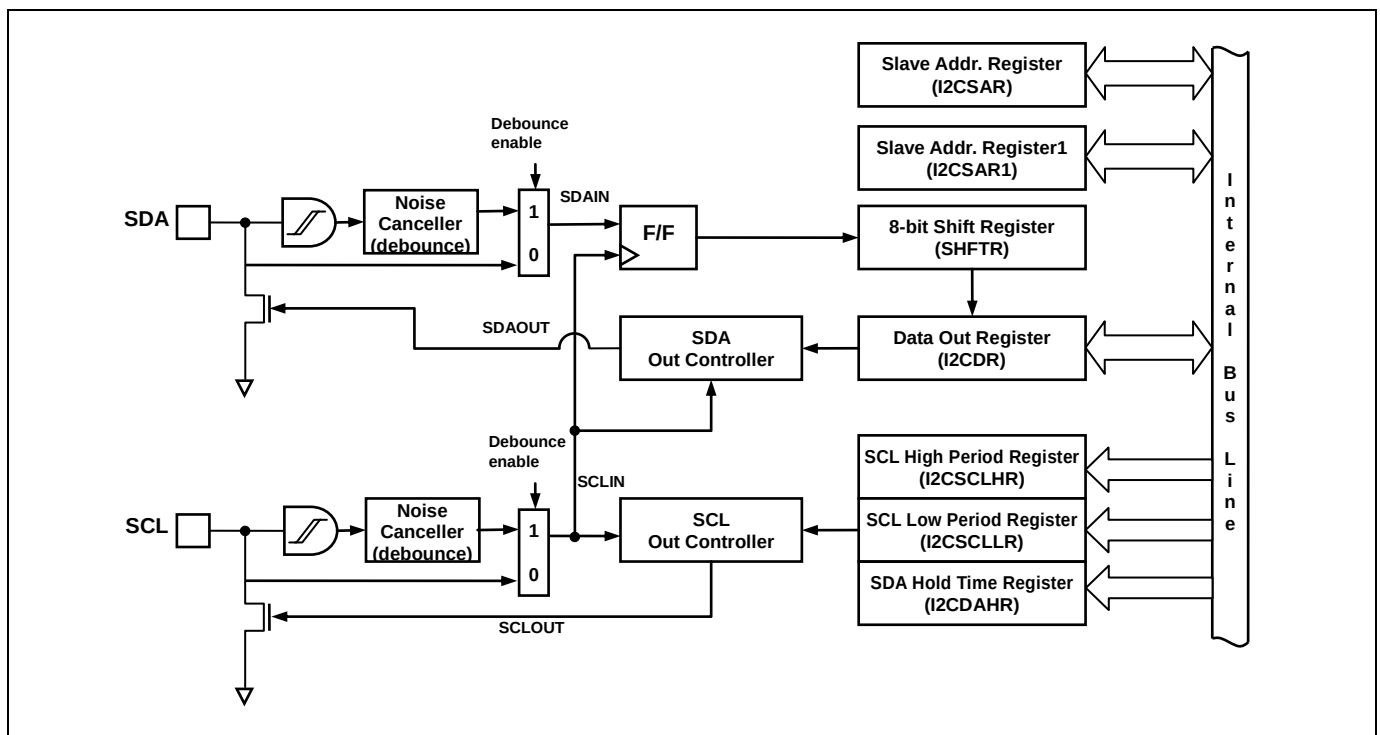


Figure 11.51 I2C Block Diagram

11.9.3 I2C bit Transfer

The data on the SDA line must be stable during HIGH period of the clock, SCL. The HIGH or LOW state of the data line can only change when the clock signal on the SCL line is LOW. The exceptions are START(S), repeated START(Sr) and STOP(P) condition where data line changes when clock line is high.

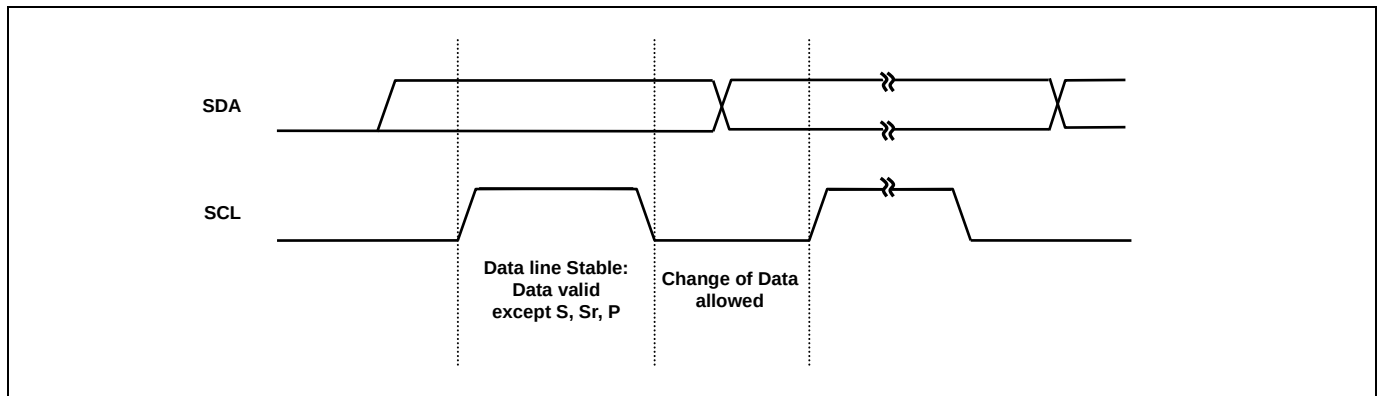


Figure 11.52 Bit Transfer on the I2C-Bus

11.9.4 Start / Repeated Start / Stop

One master can issue a START (S) condition to notice other devices connected to the SCL, SDA lines that it will use the bus. A STOP (P) condition is generated by the master to release the bus lines so that other devices can use it.

A high to low transition on the SDA line while SCL is high defines a START (S) condition.

A low to high transition on the SDA line while SCL is high defines a STOP (P) condition.

START and STOP conditions are always generated by the master. The bus is considered to be busy after START condition. The bus is considered to be free again after STOP condition, ie, the bus is busy between START and STOP condition. If a repeated START condition (Sr) is generated instead of STOP condition, the bus stays busy. So, the START and repeated START conditions are functionally identical.

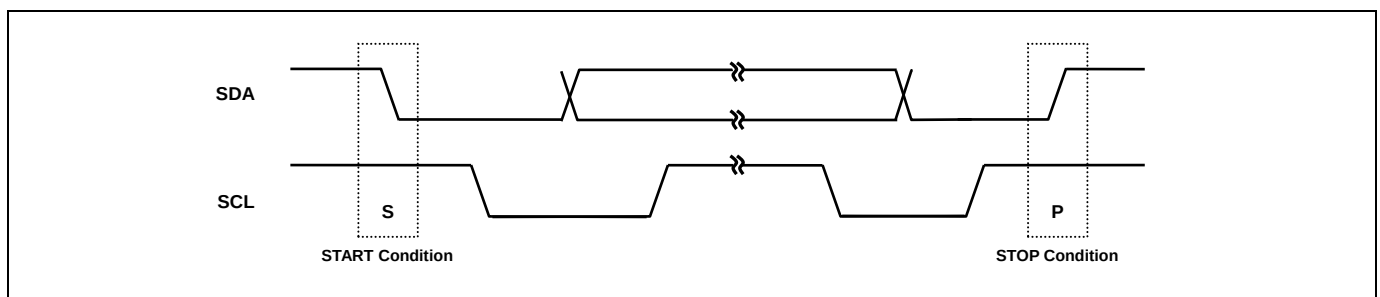


Figure 11.53 START and STOP Condition

11.9.5 Data Transfer

Every byte put on the SDA line must be 8-bit long. The number of bytes that can be transmitted per transfer is unlimited. Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit (MSB) first. If a slave can't receive or transmit another complete byte of data until it has performed some other function, it can hold the clock line SCL LOW to force the master into a wait state. Data transfer then continues when the slave is ready for another byte of data and releases clock line SCL.

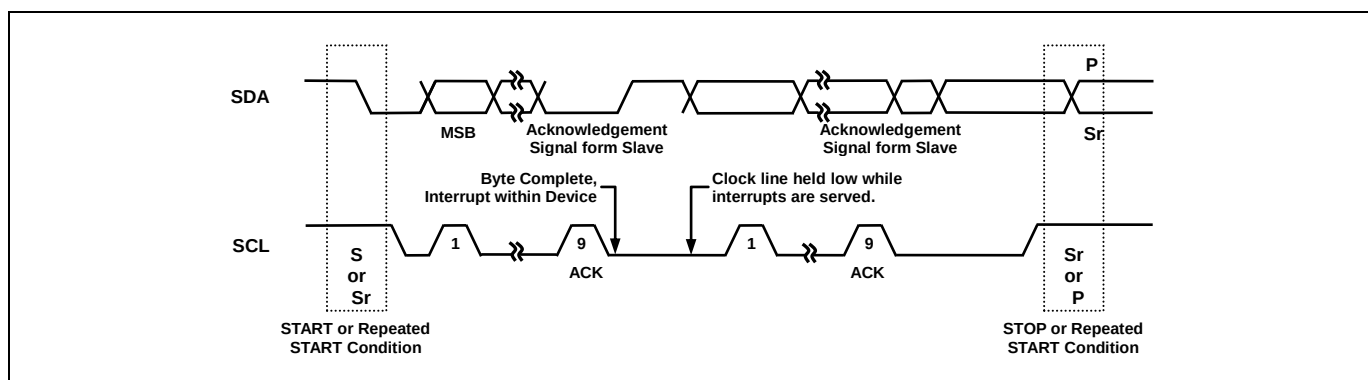


Figure 11.54 STOP or Repeated START Condition

11.9.6 Acknowledge

The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the acknowledge clock pulse so that it remains stable LOW during the HIGH period of this clock pulse. When a slave is addressed by a master (Address Packet), and if it is unable to receive or transmit because it's performing some real time function, the data line must be left HIGH by the slave. And also, when a slave addressed by a master is unable to receive more data bits, the slave receiver must release the SDA line (Data Packet). The master can then generate either a STOP condition to abort the transfer, or a repeated START condition to start a new transfer.

If a master receiver is involved in a transfer, it must signal the end of data to the slave transmitter by not generating an acknowledge on the last byte that was clocked out of the slave. The slave transmitter must release the data line to allow the master to generate a STOP or repeated START condition.

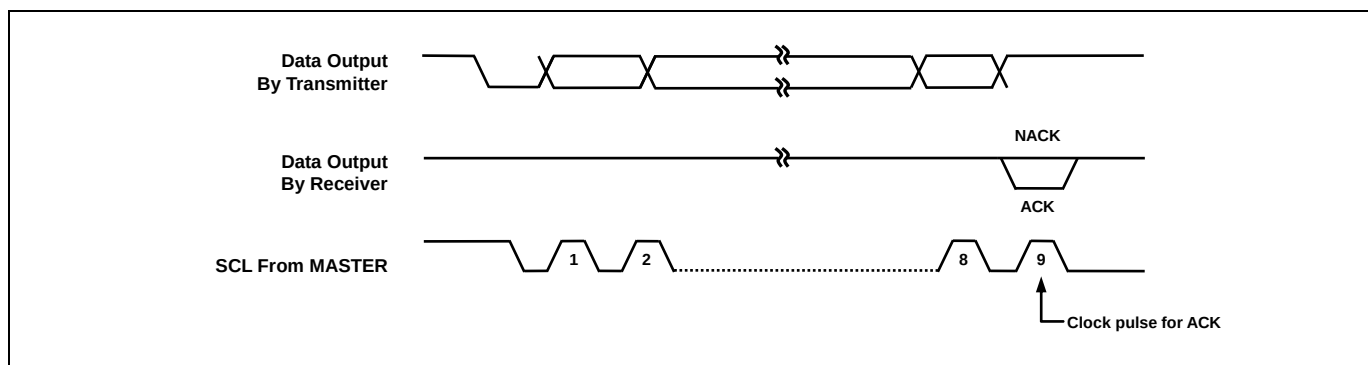


Figure 11.55 Acknowledge on the I2C-Bus

11.9.7 Synchronization / Arbitration

Clock synchronization is performed using the wired-AND connection of I2C interfaces to the SCL line. This means that a HIGH to LOW transition on the SCL line will cause the devices concerned to start counting off their LOW period and it will hold the SCL line in that state until the clock HIGH state is reached. However the LOW to HIGH transition of this clock may not change the state of the SCL line if another clock is still within its LOW period. In this way, a synchronized SCL clock is generated with its LOW period determined by the device with the longest clock LOW period, and its HIGH period determined by the one with the shortest clock HIGH period.

A master may start a transfer only if the bus is free. Two or more masters may generate a START condition. Arbitration takes place on the SDA line, while the SCL line is at the HIGH level, in such a way that the master which transmits a HIGH level, while another master is transmitting a LOW level will switch off its DATA output state because the level on the bus doesn't correspond to its own level. Arbitration continues for many bits until a winning master gets the ownership of I2C bus. Its first stage is comparison of the address bits.

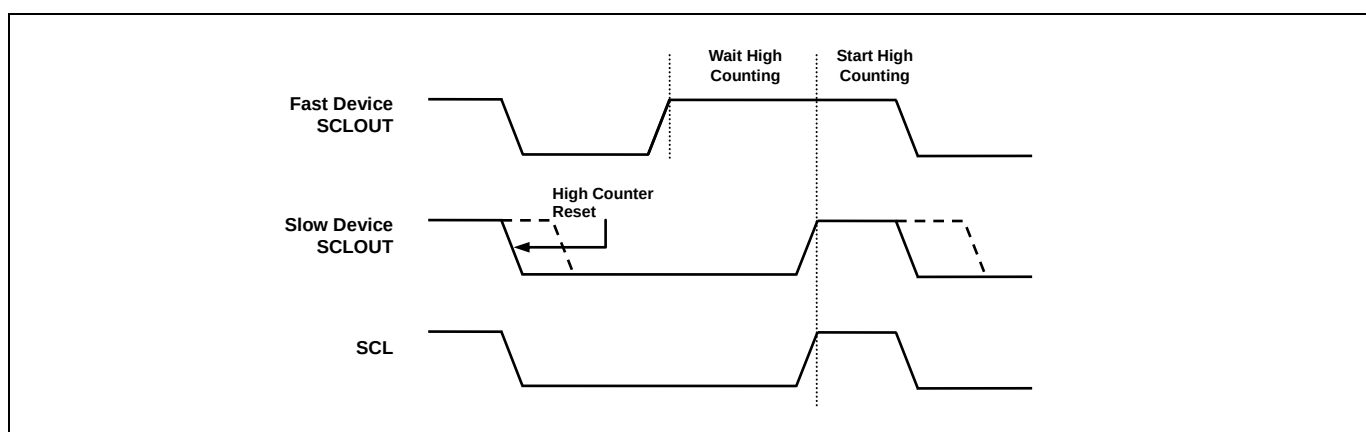


Figure 11.56 Clock Synchronization during Arbitration Procedure

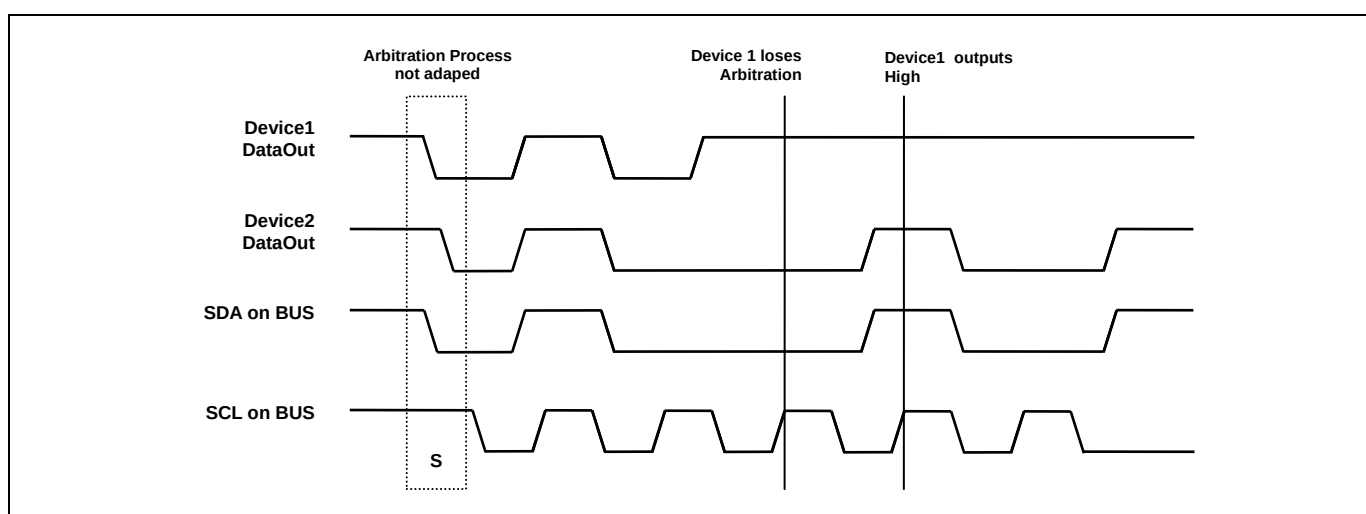


Figure 11.57 Arbitration Procedure of Two Masters

11.9.8 Operation

The I2C is byte-oriented and interrupt based. Interrupts are issued after all bus events except for a transmission of a START condition. Because the I2C is interrupt based, the application software is free to carry on other operations during a I2C byte transfer.

Note that when a I2C interrupt is generated, IIF flag in I2CMR register is set, it is cleared by writing an arbitrary value to I2CSR. When I2C interrupt occurs, the SCL line is hold LOW until writing any value to I2CSR. When the IIF flag is set, the I2CSR contains a value indicating the current state of the I2C bus. According to the value in I2CSR, software can decide what to do next.

I2C can operate in 4 modes by configuring master/slave, transmitter/receiver. The operating mode is configured by a winning master. A more detailed explanation follows below.

11.9.8.1 Master Transmitter

To operate I2C in master transmitter, follow the recommended steps below.

1. Enable I2C by setting IICEN bit in I2CMR. This provides main clock to the peripheral.
2. Load SLA+W into the I2CDR where SLA is address of slave device and W is transfer direction from the viewpoint of the master. For master transmitter, W is '0'. Note that I2CDR is used for both address and data.
3. Configure baud rate by writing desired value to both I2CSCLLR and I2CSCLHR for the Low and High period of SCL line.
4. Configure the I2CSDAHR to decide when SDA changes value from falling edge of SCL. If SDA should change in the middle of SCL LOW period, load half the value of I2CSCLLR to the I2CSDAHR.
5. Set the START bit in I2CMR. This transmits a START condition. And also configure how to handle interrupt and ACK signal. When the START bit is set, 8-bit data in I2CDR is transmitted out according to the baud-rate.
6. This is ACK signal processing stage for address packet transmitted by master. When 7-bit address and 1-bit transfer direction is transmitted to target slave device, the master can know whether the slave acknowledged or not in the 9th high period of SCL. If the master gains bus mastership, I2C generates GCALL interrupt regardless of the reception of ACK from the slave device. When I2C loses bus mastership during arbitration process, the MLOST bit in I2CSR is set, and I2C waits in idle state or can be operate as an addressed slave. To operate as a slave when the MLSOT bit in I2CSR is set, the ACKEN bit in I2CMR must be set and the received 7-bit address must equal to the SLA bits in I2CSAR. In this case I2C operates as a slave transmitter or a slave receiver (go to appropriate section). In this stage, I2C holds the SCL LOW. This is because to decide whether I2C continues serial transfer or stops communication. The following steps continue assuming that I2C does not lose mastership during first data transfer.

I2C (Master) can choose one of the following cases regardless of the reception of ACK signal from slave.

- 1) Master receives ACK signal from slave, so continues data transfer because slave can receive more data from master. In this case, load data to transmit to I2CDR.
- 2) Master stops data transfer even if it receives ACK signal from slave. In this case, set the STOP bit in I2CMR.
- 3) Master transmits repeated START condition with not checking ACK signal. In this case, load SLA+R/W into the I2CDR and set START bit in I2CMR.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1), move to step 7. In case of 2), move to step 9 to handle STOP interrupt. In case of 3), move to step 6 after transmitting the data in I2CDR and if transfer direction bit is '1' go to master receiver section.

7. 1-byte of data is being transmitted. During data transfer, bus arbitration continues.
8. This is ACK signal processing stage for data packet transmitted by master. I2C holds the SCL LOW. When I2C loses bus mastership while transmitting data arbitrating other masters, the MLOST bit in I2CSR is set. If then, I2C waits in idle state. When the data in I2CDR is transmitted completely, I2C generates TEND interrupt.

I2C can choose one of the following cases regardless of the reception of ACK signal from slave.

- 1) Master receives ACK signal from slave, so continues data transfer because slave can receive more data from master. In this case, load data to transmit to I2CDR.
- 2) Master stops data transfer even if it receives ACK signal from slave. In this case, set the STOP bit in I2CMR.
- 3) Master transmits repeated START condition with not checking ACK signal. In this case, load SLA+R/W into the I2CDR and set the START bit in I2CMR.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1), move to step 7. In case of 2), move to step 9 to handle STOP interrupt. In case of 3), move to step 6 after transmitting the data in I2CDR, and if transfer direction bit is '1' go to master receiver section.

9. This is the final step for master transmitter function of I2C, handling STOP interrupt. The STOP bit indicates that data transfer between master and slave is over. To clear I2CSR, write arbitrary value to I2CSR. After this, I2C enters idle state.

11.9.8.2 Master Receiver

To operate I2C in master receiver, follow the recommended steps below.

1. Enable I2C by setting IICEN bit in I2CMR. This provides main clock to the peripheral.
2. Load SLA+R into the I2CDR where SLA is address of slave device and R is transfer direction from the viewpoint of the master. For master receiver, R is '1'. Note that I2CDR is used for both address and data.
3. Configure baud rate by writing desired value to both I2CSCLLR and I2CSCLHR for the Low and High period of SCL line.
4. Configure the I2CSDAHR to decide when SDA changes value from falling edge of SCL. If SDA should change in the middle of SCL LOW period, load half the value of I2CSCLLR to the I2CSDAHR.
5. Set the START bit in I2CMR. This transmits a START condition. And also configure how to handle interrupt and ACK signal. When the START bit is set, 8-bit data in I2CDR is transmitted out according to the baud-rate.
6. This is ACK signal processing stage for address packet transmitted by master. When 7-bit address and 1-bit transfer direction is transmitted to target slave device, the master can know whether the slave acknowledged or not in the 9th high period of SCL. If the master gains bus mastership, I2C generates GCALL interrupt regardless of the reception of ACK from the slave device. When I2C loses bus mastership during arbitration process, the MLOST bit in I2CSR is set, and I2C waits in idle state or can be operate as an addressed slave. To operate as a slave when the MLSOT bit in I2CSR is set, the ACKEN bit in I2CMR must be set and the received 7-bit address must equal to the SLA bits in I2CSAR. In this case I2C operates as a slave transmitter or a slave receiver (go to appropriate section). In this stage, I2C holds the SCL LOW. This is because to decide whether I2C continues

serial transfer or stops communication. The following steps continue assuming that I2C does not lose mastership during first data transfer.

I2C (Master) can choose one of the following cases according to the reception of ACK signal from slave.

- 1) Master receives ACK signal from slave, so continues data transfer because slave can prepare and transmit more data to master. Configure ACKEN bit in I2CMR to decide whether I2C ACKnowledges the next data to be received or not.
- 2) Master stops data transfer because it receives no ACK signal from slave. In this case, set the STOP bit in I2CMR.
- 3) Master transmits repeated START condition due to no ACK signal from slave. In this case, load SLA+R/W into the I2CDR and set START bit in I2CMR.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1), move to step 7. In case of 2), move to step 9 to handle STOP interrupt. In case of 3), move to step 6 after transmitting the data in I2CDR and if transfer direction bit is '0' go to master transmitter section.

7. 1-byte of data is being received.
8. This is ACK signal processing stage for data packet transmitted by slave. I2C holds the SCL LOW. When 1-byte of data is received completely, I2C generates TEND interrupt.

I2C can choose one of the following cases according to the RXACK flag in I2CSR.

- 1) Master continues receiving data from slave. To do this, set ACKEN bit in I2CMR to ACKnowledge the next data to be received.
- 2) Master wants to terminate data transfer when it receives next data by not generating ACK signal. This can be done by clearing ACKEN bit in I2CMR.
- 3) Because no ACK signal is detected, master terminates data transfer. In this case, set the STOP bit in I2CMR.
- 4) No ACK signal is detected, and master transmits repeated START condition. In this case, load SLA+R/W into the I2CDR and set the START bit in I2CMR.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1) and 2), move to step 7. In case of 3), move to step 9 to handle STOP interrupt. In case of 4), move to step 6 after transmitting the data in I2CDR, and if transfer direction bit is '0' go to master transmitter section.

9. This is the final step for master receiver function of I2C, handling STOP interrupt. The STOP bit indicates that data transfer between master and slave is over. To clear I2CSR, write arbitrary value to I2CSR. After this, I2C enters idle state.

11.9.8.3 Slave Transmitter

To operate I2C in slave transmitter, follow the recommended steps below.

1. If the main operating clock (SCLK) of the system is slower than that of SCL, load value 0x00 into I2CSDAHR to make SDA change within one system clock period from the falling edge of SCL. Note that the hold time of SDA is calculated by $SDAH \times \text{period of SCLK}$ where SDAH is multiple of number of SCLK coming from I2CSDAHR. When the hold time of SDA is longer than the period of SCLK, I2C (slave) cannot transmit serial data properly.

2. Enable I2C by setting IICEN bit and INTEN bit in I2CMR. This provides main clock to the peripheral.
3. When a START condition is detected, I2C receives one byte of data and compares it with SLA bits in I2CSAR. If the GCALLEN bit in I2CSAR is enabled, I2C compares the received data with value 0x00, the general call address.
4. If the received address does not equal to SLA bits in I2CSAR, I2C enters idle state ie, waits for another START condition. Else if the address equals to SLA bits and the ACKEN bit is enabled, I2C generates SSEL interrupt and the SCL line is held LOW. Note that even if the address equals to SLA bits, when the ACKEN bit is disabled, I2C enters idle state. When SSEL interrupt occurs, load transmit data to I2CDR and write arbitrary value to I2CSR to release SCL line.
5. 1-byte of data is being transmitted.
6. In this step, I2C generates TEND interrupt and holds the SCL line LOW regardless of the reception of ACK signal from master. Slave can select one of the following cases.

1) No ACK signal is detected and I2C waits STOP or repeated START condition.

2) ACK signal from master is detected. Load data to transmit into I2CDR.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1) move to step 7 to terminate communication. In case of 2) move to step 5. In either case, a repeated START condition can be detected. For that case, move step 4.

7. This is the final step for slave transmitter function of I2C, handling STOP interrupt. The STOP bit indicates that data transfer between master and slave is over. To clear I2CSR, write arbitrary value to I2CSR. After this, I2C enters idle state.

11.9.8.4 Slave Receiver

To operate I2C in slave receiver, follow the recommended steps below.

1. If the main operating clock (SCLK) of the system is slower than that of SCL, load value 0x00 into I2CSDAHR to make SDA change within one system clock period from the falling edge of SCL. Note that the hold time of SDA is calculated by $SDAH \times \text{period of SCLK}$ where SDAH is multiple of number of SCLK coming from I2CSDAHR. When the hold time of SDA is longer than the period of SCLK, I2C (slave) cannot transmit serial data properly.
2. Enable I2C by setting IICEN bit and INTEN bit in I2CMR. This provides main clock to the peripheral.
3. When a START condition is detected, I2C receives one byte of data and compares it with SLA bits in I2CSAR. If the GCALLEN bit in I2CSAR is enabled, I2C compares the received data with value 0x00, the general call address.
4. If the received address does not equal to SLA bits in I2CSAR, I2C enters idle state ie, waits for another START condition. Else if the address equals to SLA bits and the ACKEN bit is enabled, I2C generates SSEL interrupt and the SCL line is held LOW. Note that even if the address equals to SLA bits, when the ACKEN bit is disabled, I2C enters idle state. When SSEL interrupt occurs and I2C is ready to receive data, write arbitrary value to I2CSR to release SCL line.
5. 1-byte of data is being received.
6. In this step, I2C generates TEND interrupt and holds the SCL line LOW regardless of the reception of ACK signal from master. Slave can select one of the following cases.

- 1) No ACK signal is detected (ACKEN=0) and I2C waits STOP or repeated START condition.
- 2) ACK signal is detected (ACKEN=1) and I2C can continue to receive data from master.

After doing one of the actions above, write arbitrary value to I2CSR to release SCL line. In case of 1) move to step 7 to terminate communication. In case of 2) move to step 5. In either case, a repeated START condition can be detected. For that case, move step 4.

7. This is the final step for slave receiver function of I2C, handling STOP interrupt. The STOP bit indicates that data transfer between master and slave is over. To clear I2CSR, write arbitrary value to I2CSR. After this, I2C enters idle state.

11.9.9 Register Map

Name	Address	Dir	Default	Description
I2CMR	DAH	R/W	00H	I2C Mode Control Register
I2CSR	DBH	R	00H	I2C Status Register
I2CSCLLR	DCH	R/W	3FH	SCL Low Period Register
I2CSCLHR	DDH	R/W	3FH	SCL High Period Register
I2CSDAHR	DEH	R/W	01H	SDA Hold Time Register
I2CDR	DFH	R/W	FFH	I2C Data Register
I2CSAR	D7H	R/W	00H	I2C Slave Address Register
I2CSAR1	D6H	R/W	00H	I2C Slave Address Register 1

Table 11.19 Register Map

11.9.10 I2C Register Description

I2C Registers are composed of I2C Mode Control Register (I2CMR), I2C Status Register (I2CSR), SCL Low Period Register (I2CSCLLR), SCL High Period Register (I2CSCLHR), SDA Hold Time Register (I2CSDAHR), I2C Data Register (I2CDR), and I2C Slave Address Register (I2CSAR).

11.9.11 Register Description for I2C

I2CMR (I2C Mode Control Register) : DAH

7	6	5	4	3	2	1	0
IIF	IICEN	RESET	INTEN	ACKEN	MASTER	STOP	START
RW	RW	RW	RW	RW	R	RW	RW

Initial value : 00H

IIF	This is interrupt flag bit. 0 No interrupt is generated or interrupt is cleared 1 An interrupt is generated
IICEN	Enable I2C Function Block (by providing clock) 0 I2C is inactive 1 I2C is active
RESET	Initialize internal registers of I2C. 0 No operation 1 Initialize I2C, auto cleared
INTEN	Enable interrupt generation of I2C. 0 Disable interrupt, operates in polling mode 1 Enable interrupt
ACKEN	Controls ACK signal generation at ninth SCL period. Note) ACK signal is output (SDA=0) for the following 3 cases. When received address packet equals to SLA bits in I2CSAR When received address packet equals to value 0x00 with GCALL enabled When I2C operates as a receiver (master or slave) 0 No ACK signal is generated (SDA=1) 1 ACK signal is generated (SDA=0)
MASTER	Represent operating mode of I2C 0 I2C is in slave mode 1 I2C is in master mode
STOP	When I2C is master, generates STOP condition. 0 No operation 1 STOP condition is to be generated
START	When I2C is master, generates START condition. 0 No operation 1 START or repeated START condition is to be generated

I2CSR (I2C Status Register) : DBH

7	6	5	4	3	2	1	0
GCALL	TEND	STOP	SSEL	MLOST	BUSY	TMODE	RXACK
R	R	R	R	R	R	R	R

Initial value : 00H

GCALL	This bit has different meaning depending on whether I2C is master or slave. NOTE) When I2C is a master, this bit represents whether it received AACK (Address ACK) from slave. When I2C is a slave, this bit is used to indicate general call. 0 No AACK is received (Master mode) 1 AACK is received (Master mode) 0 Received address is not general call address (Slave mode) 1 General call address is detected (Slave mode)
TEND	This bit is set when 1-byte of data is transferred completely. NOTE) 0 1-byte of data is not completely transferred 1 1-byte of data is completely transferred
STOP	This bit is set when STOP condition is detected. NOTE) 0 No STOP condition is detected 1 STOP condition is detected
SSEL	This bit is set when I2C is addressed by other master. NOTE) 0 I2C is not selected as slave 1 I2C is addressed by other master and acts as a slave
MLOST	This bit represents the result of bus arbitration in master mode. NOTE) 0 I2C maintains bus mastership 1 I2C has lost bus mastership during arbitration process
BUSY	This bit reflects bus status. 0 I2C bus is idle, so any master can issue a START condition 1 I2C bus is busy
TMODE	This bit is used to indicate whether I2C is transmitter or receiver. 0 I2C is a receiver 1 I2C is a transmitter
RXACK	This bit shows the state of ACK signal. 0 No ACK is received 1 ACK is generated at ninth SCL period

NOTE)

1. These bits can be source of interrupt.

When an I2C interrupt occurs except for STOP interrupt, the SCL line is hold LOW. To release SCL, write arbitrary value to I2CSR. When I2CSR is written, the TEND, STOP, SSEL, LOST, RXACK bits are cleared.

I2CSCLLR (SCL Low Period Register) : DCH

7	6	5	4	3	2	1	0
SCLL7	SCLL6	SCLL5	SCLL4	SCLL3	SCLL2	SCLL1	SCLL0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 3FH

SCLL[7:0] This register defines the LOW period of SCL when I2C operates in master mode. The base clock is SCLK, the system clock, and the period is calculated by the formula : $t_{SCLK} \times (4 \times SCLL + 1)$ where t_{SCLK} is the period of SCLK.

I2CSCLHR (SCL High Period Register) : DDH

7	6	5	4	3	2	1	0
SCLH7	SCLH6	SCLH5	SCLH4	SCLH3	SCLH2	SCLH1	SCLH0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 3FH

SCLH[7:0] This register defines the HIGH period of SCL when I2C operates in master mode. The base clock is SCLK, the system clock, and the period is calculated by the formula : $t_{SCLK} \times (4 \times SCLH + 3)$ where t_{SCLK} is the period of SCLK.

So, the operating frequency of I2C in master mode (fI2C) is calculated by the following equation.

$$fI2C = \frac{1}{t_{SCLK} \times (4 (SCLL + SCLH) + 4)}$$

I2CSDAHR (SDA Hold Time Register) : DEH

7	6	5	4	3	2	1	0
SDAH7	SDAH6	SDAH5	SDAH4	SDAH3	SDAH2	SDAH1	SDAH0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 01H

SDAH[7:0] This register is used to control SDA output timing from the falling edge of SCL. Note that SDA is changed after $t_{SCLK} \times SDAH$. In master mode, load half the value of SCLL to this register to make SDA change in the middle of SCL. In slave mode, configure this register regarding the frequency of SCL from master. The SDA is changed after $t_{SCLK} \times (SDAH + 1)$. So, to insure normal operation in slave mode, the value $t_{SCLK} \times (SDAH + 1)$ must be smaller than the period of SCL.

I2CDR (I2C Data Register) : DFH

7	6	5	4	3	2	1	0
ICD7	ICD6	ICD5	ICD4	ICD3	ICD2	ICD1	ICD0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : FFH

ICD[7:0] When I2C is configured as a transmitter, load this register with data to be transmitted. When I2C is a receiver, the received data is stored into this register.

I2CSAR (I2C Slave Address Register) : D7H

7	6	5	4	3	2	1	0
SLA7	SLA6	SLA5	SLA4	SLA3	SLA2	SLA1	GCALLEN
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

SLA[7:1] These bits configure the slave address of this I2C module when I2C operates in slave mode.

GCALLEN This bit decides whether I2C allows general call address or not when I2C operates in slave mode.

0 Ignore general call address

1 Allow general call address

I2CSAR1 (I2C Slave Address Register 1) : D6H

7	6	5	4	3	2	1	0
SLA7	SLA6	SLA5	SLA4	SLA3	SLA2	SLA1	GCALLEN
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

SLA[7:1] These bits configure the slave address of this I2C module when I2C operates in slave mode.

GCALLEN This bit decides whether I2C allows general call address or not when I2C operates in slave mode.

0 Ignore general call address

1 Allow general call address

11.10 12-bit A/D Converter

11.10.1 Overview

The analog-to-digital converter (A/D) allows conversion of an analog input signal to a corresponding 12-bit digital value. The A/D module has tenth analog inputs. The output of the multiplex is the input into the converter, which generates the result via successive approximation. The A/D module has four registers which are the control register ADCM (A/D Converter Mode Register), ADCM2 (A/D Converter Mode Register 2) and A/D result register ADCHR (A/D Converter Result High Register) and ADCLR (A/D Converter Result Low Register). It is selected for the corresponding channel to be converted by setting ADSEL[3:0]. To executing A/D conversion, ADST bit sets to '1'. The register ADCHR and ADCLR contains the results of the A/D conversion. When the conversion is completed, the result is loaded into the ADCHR and ADCLR, the A/D conversion status bit AFLAG is set to '1', and the A/D interrupt is set. For processing A/D conversion, AFLAG bit is read as '0'. If using STBY (power down) bit, the ADC is disabled. Also internal timer, external generating event, comparator, the trigger of timer1pwm and etc. can start ADC regardless of interrupt occurrence.

$$\text{ADC Conversion Time} = \text{ADCLK} * 60 \text{ cycles}$$

After STBY bit is reset (ADC power enable) and it is restarted, during some cycle, ADC conversion value may have an inaccurate value.

11.10.2 Block Diagram

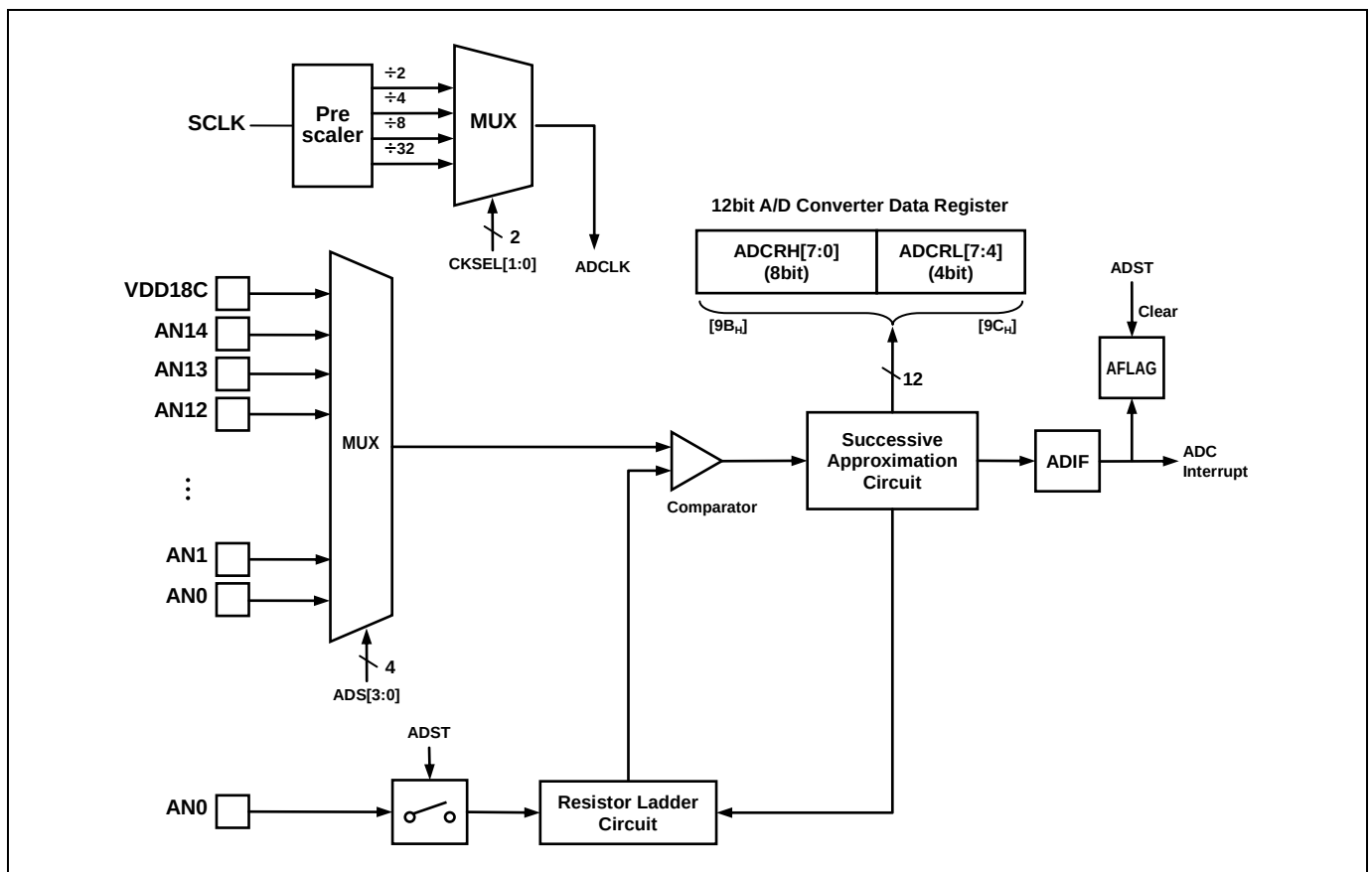


Figure 11.58 ADC Block Diagram

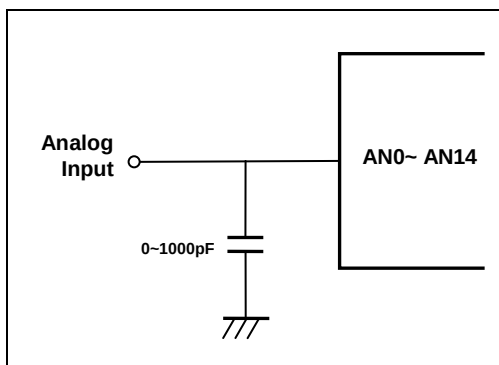


Figure 11.59 A/D Analog Input Pin Connecting Capacitor

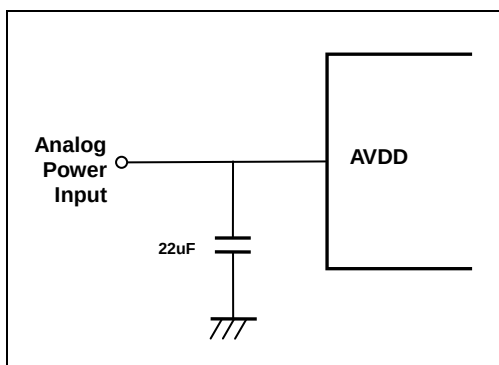


Figure 11.60 A/D Power(AVDD) Pin Connecting Capacitor

11.10.3 ADC Operation

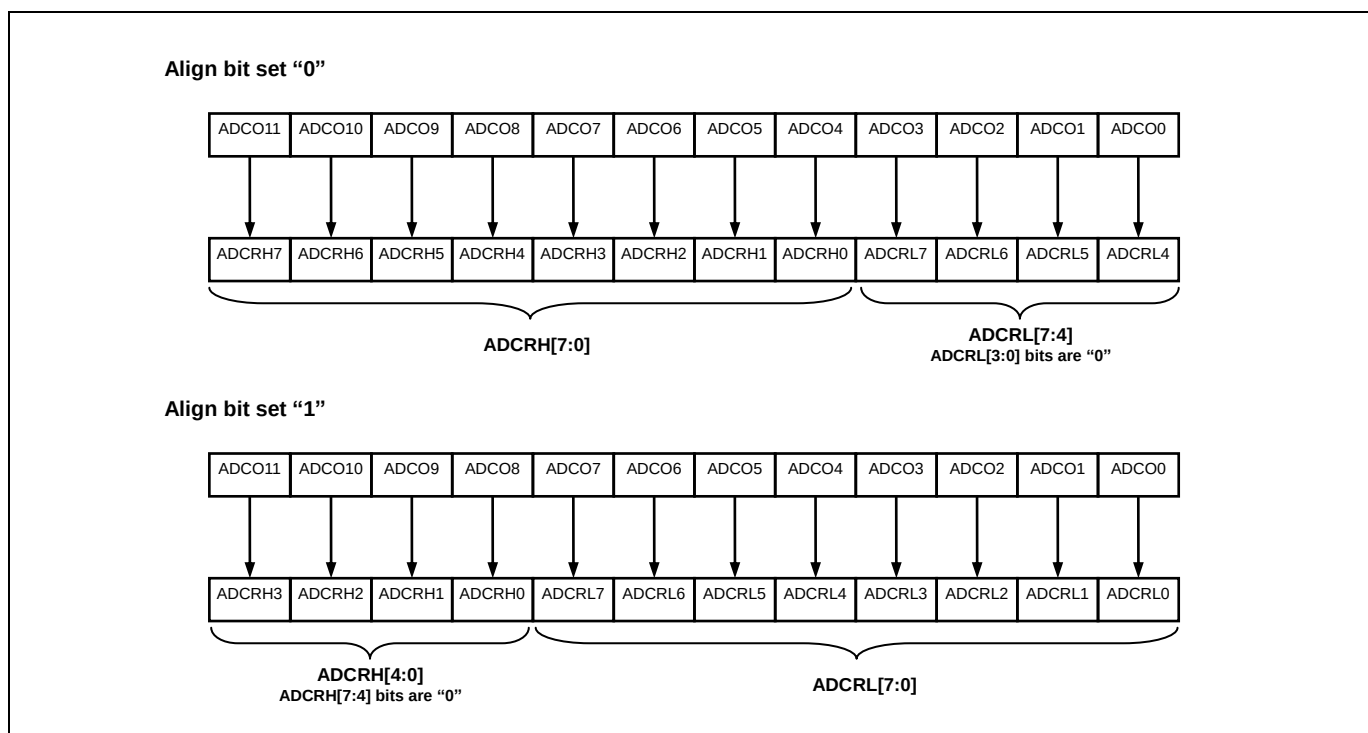


Figure 11.61 ADC Operation for Align bit

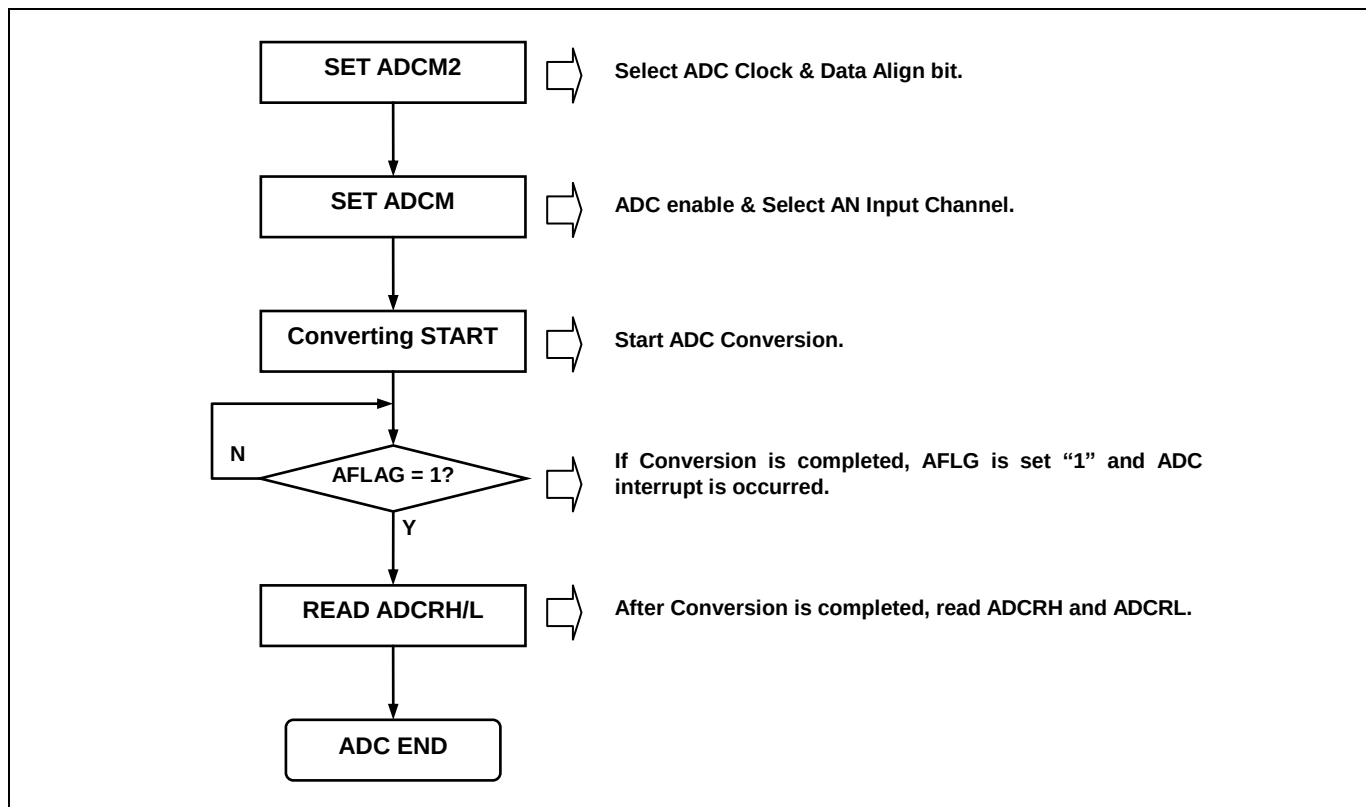


Figure 11.62 Converter Operation Flow

11.10.4 Register Map

Name	Address	Dir	Default	Description
ADCM	9AH	R/W	8FH	A/D Converter Mode Register
ADCRH	9BH	R	-	A/D Converter Result High Register
ADCRL	9CH	R	-	A/D Converter Result Low Register
ADCM2	9BH	R/W	8FH	A/D Converter Mode 2 Register

Table 11.20 Register Map

11.10.5 ADC Register Description

The ADC Register consists of A/D Converter Mode Register (ADCM), A/D Converter Result High Register (ADCRH), A/D Converter Result Low Register (ADCRL), A/D Converter Mode 2 Register (ADCM2).

NOTE)

1. when STBY bit is set to '1', ADCM2 can be read. If ADC enables, it is possible only to write ADCM2. When reading, ADCRH is read.

11.10.6 Register Description for ADC

ADCM (A/D Converter Mode Register) : 9AH

7	6	5	4	3	2	1	0
STBY	ADST	REFSEL	AFLAG	ADSEL3	ADSEL2	ADSEL1	ADSEL0
RW	RW	RW	R	RW	RW	RW	RW

Initial value : 8FH

STBY	Control operation of A/D standby (power down)				
	0	ADC module enable			
	1	ADC module disable (power down)			
ADST	Control A/D Conversion stop/start.				
	0	ADC Conversion Stop			
	1	ADC Conversion Start			
REFSEL	A/D Converter reference selection				
	0	Internal Reference (VDD)			
	1	External Reference(AVREF, AN0 disable)			
AFLAG	A/D Converter operation state				
	0	During A/D Conversion			
	1	A/D Conversion finished			
ADSEL[3:0]	A/D Converter input selection				
	ADSEL3	ADSEL2	ADSEL1	ADSEL0	Description
	0	0	0	0	Channel0(AN0)
	0	0	0	1	Channel1(AN1)
	0	0	1	0	Channel2(AN2)
	0	0	1	1	Channel3(AN3)
	0	1	0	0	Channel4(AN4)
	0	1	0	1	Channel5(AN5)
	0	1	1	0	Channel6(AN6)
	0	1	1	1	Channel7(AN7)
	1	0	0	0	Channel8(AN8)
	1	0	0	1	Channel9(AN9)
	1	0	1	0	Channel10(AN10)
	1	0	1	1	Channel11(AN11)
	1	1	0	0	Channel12(AN12)
	1	1	0	1	Channel13(AN13)
	1	1	1	0	Channel14(AN14)
	1	1	1	1	Channel15(VDD18)

ADCRH (A/D Converter Result High Register) : 9BH

7	6	5	4	3	2	1	0
ADDM11	ADDM10	ADDM9	ADDM8	ADDM7 ADDL11	ADDM6 ADDL10	ADDM5 ADDL9	ADDM4 ADDL8
R	R	R	R	R	R	R	R

Initial value : xxH

ADDM[11:4] MSB align, A/D Converter High result (8-bit)**ADDL[11:8]** LSB align, A/D Converter High result (4-bit)**ADCRL (A/D Converter Result Low Register) : 9CH**

7	6	5	4	3	2	1	0
ADDM3 ADDL7	ADDM2 ADDL6	ADDM1 ADDL5	ADDM0 ADDL4	ADDL3	ADDL2	ADDL1	ADDL0
R	R	R	R	R	R	R	R

Initial value : xxH

ADDM[3:0] MSB align, A/D Converter Low result (4-bit)**ADDL[7:0]** LSB align, A/D Converter Low result (8-bit)**ADCM2 (A/D Converter Mode Register) : 9BH**

7	6	5	4	3	2	1	0
EXTRG	TSEL2	TSEL1	TSEL0	-	ALIGN	CKSEL1	CKSEL0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 01H

EXTRG A/D external Trigger

0 External Trigger disable

1 External Trigger enable

TSEL[2:0] A/D Trigger Source selection

TSEL2 TSEL1 TSEL0 Description

0 0 0 Ext. Interrupt 0

0 0 1 Analog Comparator Low to High Transition

0 1 0 Analog Comparator High to Low Transition

0 1 1 Timer1PWM overflow event

1 0 0 Timer1PWM A-ch event compare match

1 0 1 Timer1PWM B-ch event compare match

1 1 0 Timer1PWM C-ch event compare match

1 1 1 Timer3(PWM) interrupt

ALIGN A/D Converter data align selection.

0 MSB align (ADCRH[7:0], ADCRL[7:4])

1 LSB align (ADCRH[3:0], ADCRL[7:0])

CKSEL[1:0] A/D Converter Clock selection

CKSEL1 CKSEL0 ADC Clock ADC VDD

0 0 fx/2 Test Only

0 1 fx/4 3V~5V

1 0 fx/8 2.7V~3V

1 1 fx/32 2.4V~2.7V

NOTE)

1. fx : system clock
2. ADC clock have to be used 3MHz under

11.11 Analog Comparator

11.11.1 Overview

The Analog Comparator compares the input values on the positive pin AC+ and the negative pin AC-. When the voltage on the positive pin AC+ is higher than the voltage on the negative pin AC-, the Analog Comparator output, ACOUT, is set.

11.11.2 Block Diagram

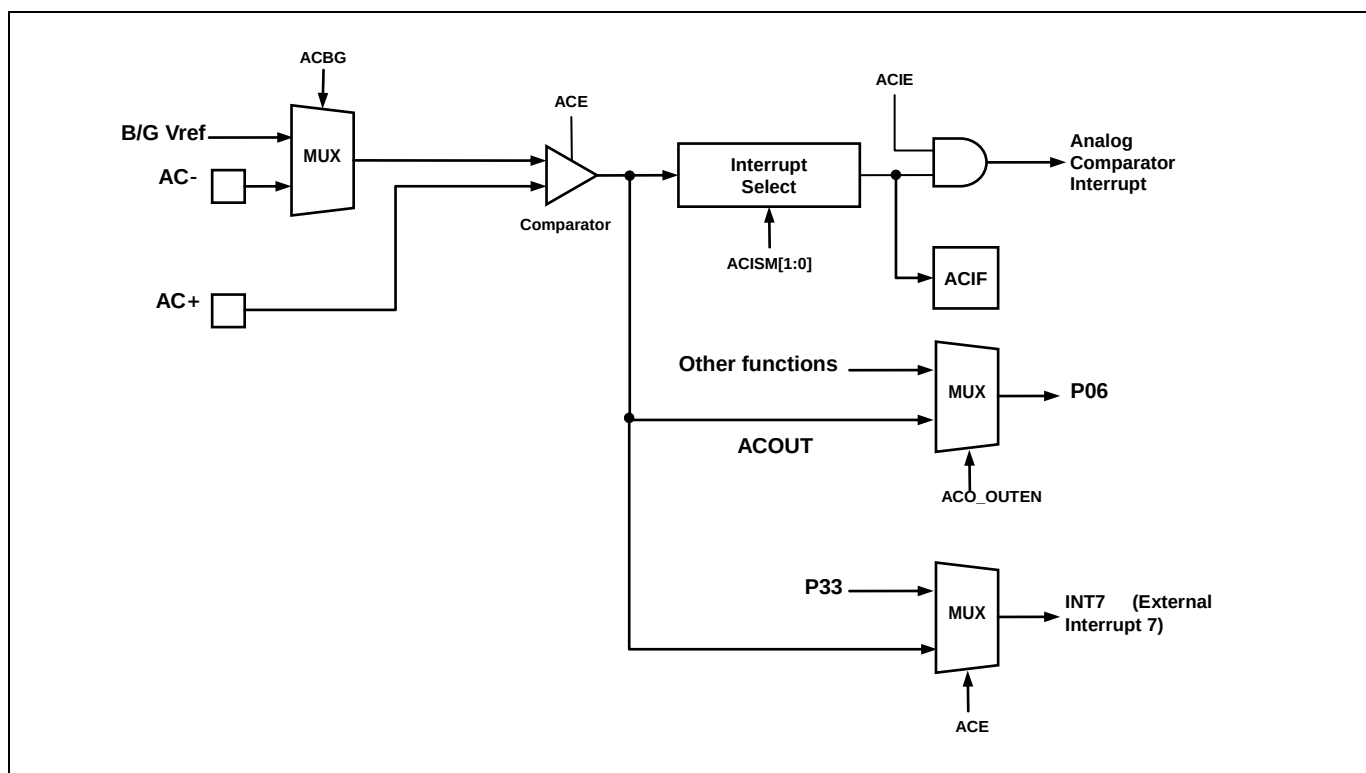


Figure 11.63 Analog Comparator Block Diagram

11.11.3 IN/OUT signal description

ACE : This enables Analog Comparator. When ACE is '0', the output of Comparator goes LOW.

BGR : Band Gap Reference Voltage

ACBG : This selects (-) input source between BGR and AC-. When ACBG is '1', the (-) input to AC is BGR.

AC- : This can be (-) input to the AC, and comes directly from external analog pad.

AC+ : This can be (+) input to the AC, and comes directly from external analog pad.

ACOUT : This is the output of Comparator.

ACO_OUTEN : Analog Comparator output port Enable.

11.11.4 Register Map

Name	Address	Dir	Default	Description
ACCSR	F9H	R/W	00H	Analog Comparator Control & Status Register

Table 11.21 Register Map

11.11.5 Analog Comparator Register Description

Analog Comparator Register has one control register, Analog Comparator Control & Status Register (ACCSR). Note that AMUXENB is the inverted signal of AMUXEN bit which comes from ADC's ADCM2 register.

11.11.6 Register Description for USI0

ACCSR (Analog Comparator Control & Status Register) : F9H

7	6	5	4	3	2	1	0
ACE	ACBG	ACO	ACIF	ACIE	ACO_OUTEN	ACISM1	ACISM0
RW	RW	R	R	RW	RW	RW	RW

Initial value : 00H

ACE	Enable Analog Comparator (AC).						
	0 Disable AC (power down)						
	1 Enable AC						
ACBG	Select (-) input source of AC, Band Gap Reference Voltage or AN4.						
	0 (-) input is from AN4						
	1 (-) input is from Band Gap Reference Voltage						
ACO	This bit represents the value of ACOOUT (Output of Analog Comparator). ACO bit is sampled by SCLK, system clock, twice. When ACE is '0', this bit is also cleared.						
	0 Comparator output is LOW						
	1 Comparator output is HIGH						
ACIF	This bit is set when an Analog Comparator Interrupt is generated according to the ACISM[1:0] bits. This bit is cleared when Analog Comparator Interrupt is executed or '0' is written to this bit field.						
	0 No interrupt generated or cleared						
	1 Interrupt generated						
ACIE	Enable Analog Comparator Interrupt.						
	0 Disable Interrupt, Polling mode operation						
	1 Enable Interrupt						
ACO_OUTEN	Analog Comparator output port Enable						
	0 Disable						
	1 Enable						
ACISM[1:0]	Select Interrupt Mode of Analog Comparator.						
	ACISM1	ACISM0	Description				
	0	0	Reserved				
	0	1	Interrupt on falling edge of ACOOUT				
	1	0	Interrupt on rising edge of ACOOUT				
	1	1	Interrupt on both edge of ACOOUT				

12 Power Down Operation

12.1 Overview

The MC95FG308 has three power-down modes to minimize the power consumption of the device. In power down mode, power consumption is reduced considerably. The device provides three kinds of power saving functions, IDLE, STOP1 and STOP2 mode. In three modes, program is stopped.

12.2 Peripheral Operation in IDLE/STOP Mode

Peripheral	IDLE Mode	STOP1 Mode	STOP2 Mode
CPU	ALL CPU Operation are Disable	ALL CPU Operation are Disable	ALL CPU Operation are Disable
RAM	Retain	Retain	Retain
Basic Interval Timer	Operates Continuously	Operates Continuously	Stop
Watch Dog Timer	Operates Continuously	Operates Continuously	Stop
Watch Timer	Operates Continuously	Stop (Only operate in sub clock mode)	Stop (Only operate in sub clock mode)
TimerP0~4	Operates Continuously	Halted (Only when the Event Counter Mode is Enable, Timer operates Normally)	Halted (Only when the Event Counter Mode is Enable, Timer operates Normally)
ADC	Operates Continuously	Stop	Stop
BUZ	Operates Continuously	Stop	Stop
SPI/SCI	Operates Continuously	Only operate with external clock	Only operate with external clock
I2C	Operates Continuously	Stop	Stop
Internal OSC (8MHz)	Oscillation	Stop	Stop
Main OSC (1~12MHz)	Oscillation	Stop	Stop
Sub OSC (32.768kHz)	Oscillation	Oscillation	Oscillation
Internal RCOSC (125kHz)	Oscillation	Oscillation	Stop
I/O Port	Retain	Retain	Retain
Control Register	Retain	Retain	Retain
Address Data Bus	Retain	Retain	Retain
Release Method	By RESET, all Interrupts	By RESET, Timer Interrupt (EC0, EC2), SIO (External clock), External Interrupt, UART by ACK PCI, I2C (slave mode), WT (sub clock), WDT, BIT	By RESET, Timer Interrupt (EC0, EC2), SIO (External clock), External Interrupt, UART by ACK PCI, I2C (slave mode), WT (sub clock)

Table 12.1 Peripheral Operation during Power Down Mode

12.3 IDLE Mode

The power control register is set to '01h' to enter the IDLE Mode. In this mode, the internal oscillation circuits remain active. Oscillation continues and peripherals are operated normally but CPU stops. It is released by reset or interrupt. To be released by interrupt, interrupt should be enabled before IDLE mode. If using reset, because the device becomes initialized state, the registers have reset value.

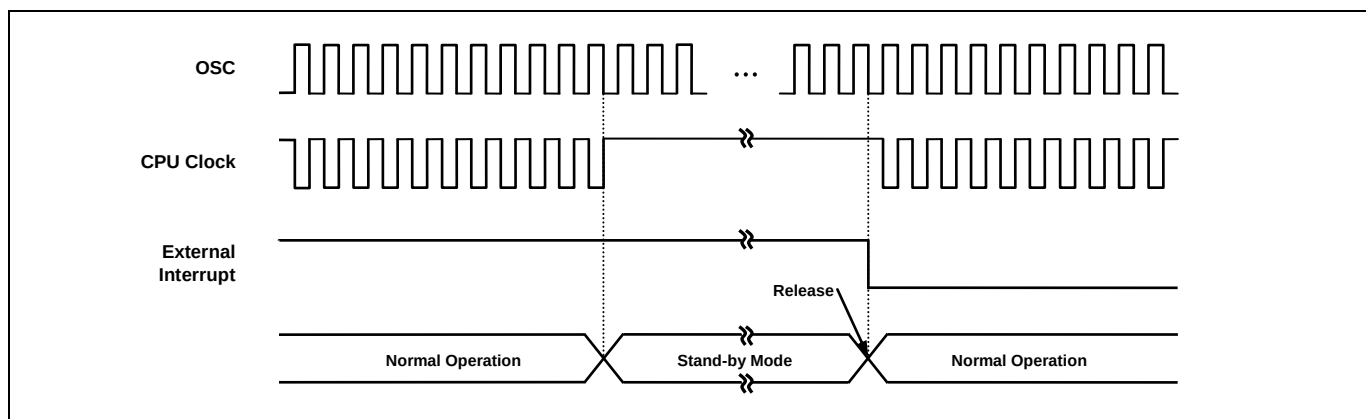


Figure 12.1 IDLE Mode Release Timing by External Interrupt

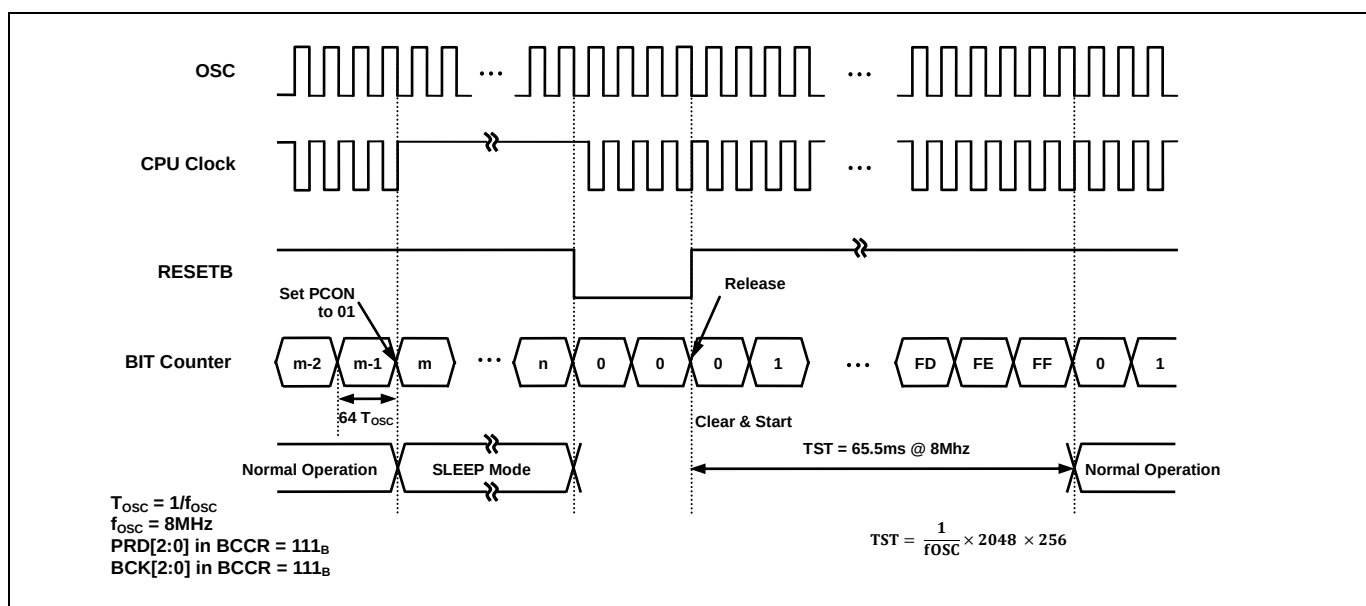


Figure 12.2 IDLE Mode Release Timing by /RESET

(Ex) MOV PCON, #0000_0001b ; setting of IDLE mode : set the bit of STOP and IDLE Control register (PCON)

12.4 STOP Mode

The power control register is set to '03h' to enter the STOP Mode. In the stop mode, the main oscillator, system clock and peripheral clock is stopped, but watch timer continue to operate. With the clock frozen, all functions are stopped, but the on-chip RAM and control registers are held.

The source for exit from STOP mode is hardware reset and interrupts. The reset re-defines all the control registers.

When exit from STOP mode, enough oscillation stabilization time is required to normal operation. Figure 12.3 shows the timing diagram. When released from STOP mode, the Basic interval timer is activated on wake-up. Therefore, before STOP instruction, user must be set its relevant prescaler divide ratio to have long enough time (more than 20msec). this guarantees that oscillator has started and stabilized.

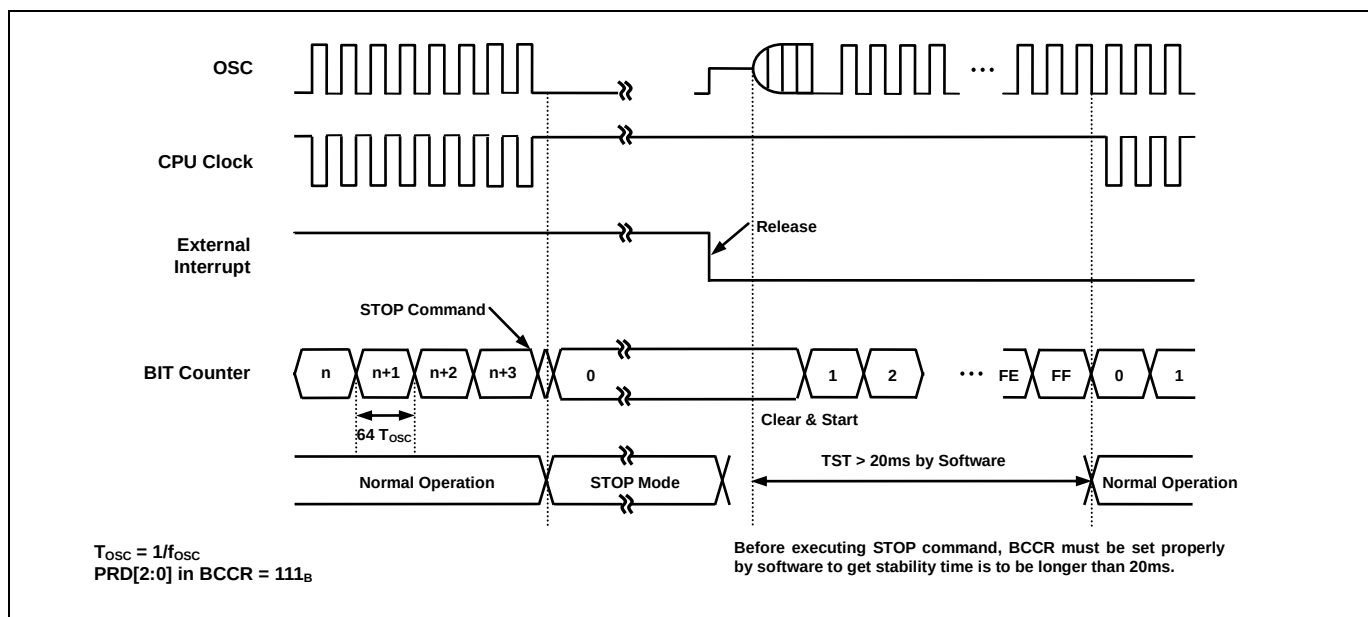


Figure 12.3 STOP Mode Release Timing by External Interrupt

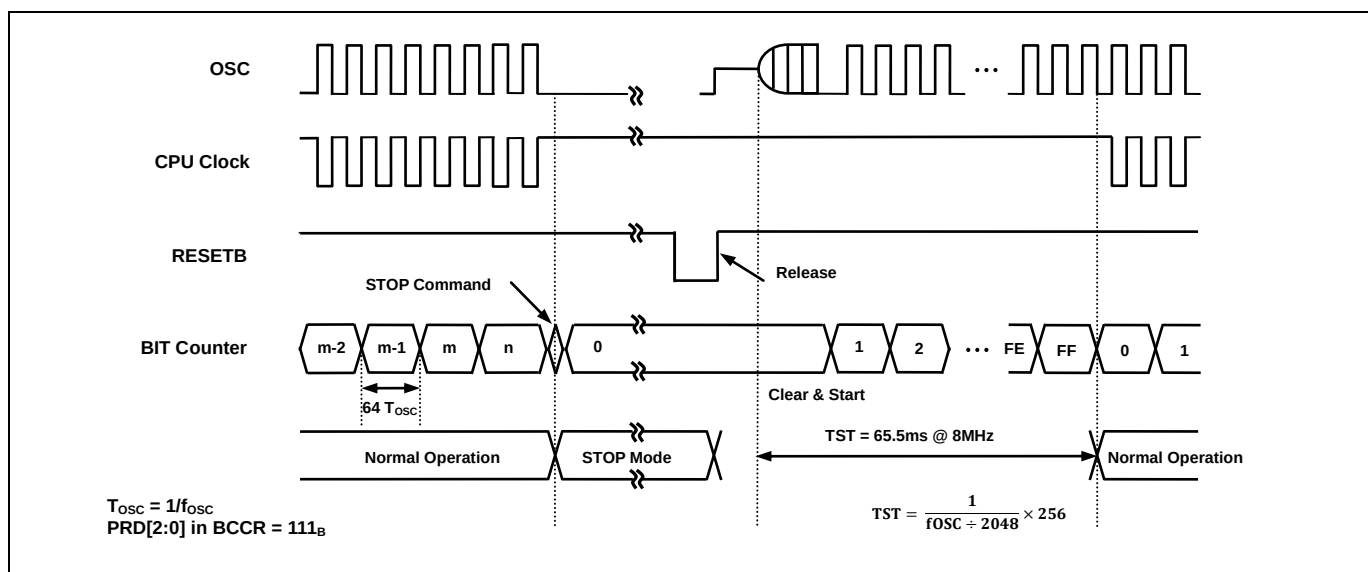


Figure 12.4 STOP Mode Release Timing by /RESET

12.5 Release Operation of STOP1, 2 Mode

After STOP1, 2 mode is released, the operation begins according to content of related interrupt register just before STOP1, 2 mode start (Figure 12.5). Interrupt Enable Flag of All (EA) of IE should be set to `1`. Released by only interrupt which each interrupt enable flag = `1`, and jump to the relevant interrupt service routine.

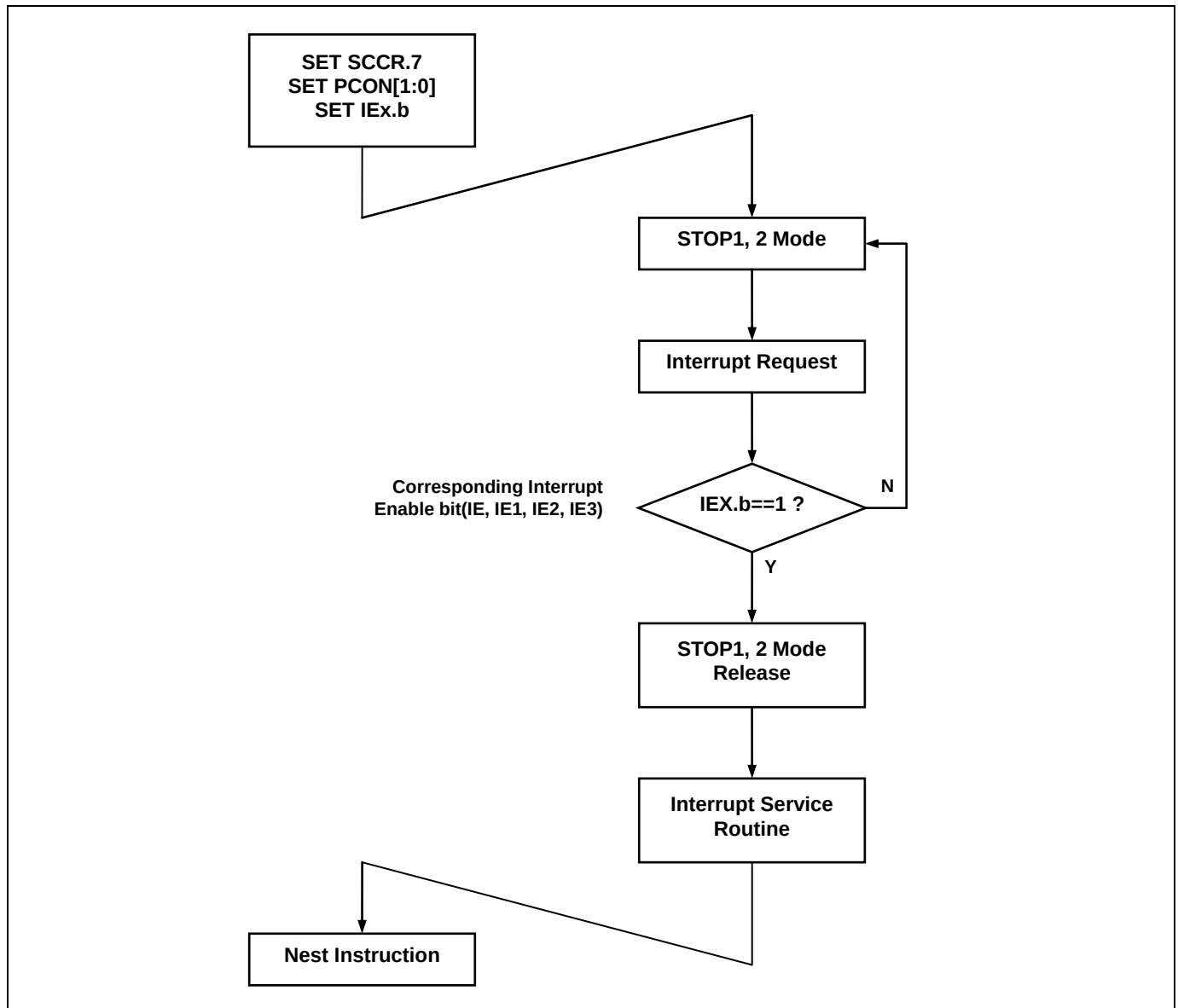


Figure 12.5 STOP1, 2 Mode Release Flow

12.5.1 Register Map

Name	Address	Direction	Default	Description
PCON	87H	R/W	00H	Power Control Register

Table 12.2 Register Map

12.5.2 Power Down Operation Register Description

The power down operation register consists of the power control register (PCON).

12.5.3 Register Description for Power Down Operation

PCON (Power Control Register) : 87H

7	6	5	4	3	2	1	0
bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

IDLE Mode

01H IDLE mode enable

STOP1, 2 Mode

03H STOP1, 2 mode enable

NOTE)

1. To enter IDLE mode, PCON must be set to '01H'.
2. To STOP1,2 mode, PCON must be set to '03H'.
3. (In STOP1,2 mode, PCON register is cleared automatically by interrupt or reset)
4. When PCON is set to '03H', if SCCR[7] is set to '1', it enters the STOP1 mode. if SCCR[7] is cleared to '0', it enters the STOP2 mode
5. The different thing in STOP 1,2 is only clock operation of internal 125kHz-OSC during STOP mode operating.

13 RESET

13.1 Overview

The MC95FG308 has reset by external RESETB pin. The following is the hardware setting value.

On Chip Hardware	Initial Value
Program Counter (PC)	0000h
Accumulator	00h
Stack Pointer (SP)	07h
Peripheral Clock	On
Control Register	Peripheral Registers refer
Brown-Out Detector	Enable

Table 13.1 Reset state

13.2 Reset Source

The MC95FG308 has five types of reset generation procedures. The following is the reset sources.

- External RESETB
- Power ON RESET (POR)
- WDT Overflow Reset (In the case of WDTEN = `1`)
- BOD Reset (In the case of BODEN = `1`)
- OCD Reset

13.3 RESET Block Diagram

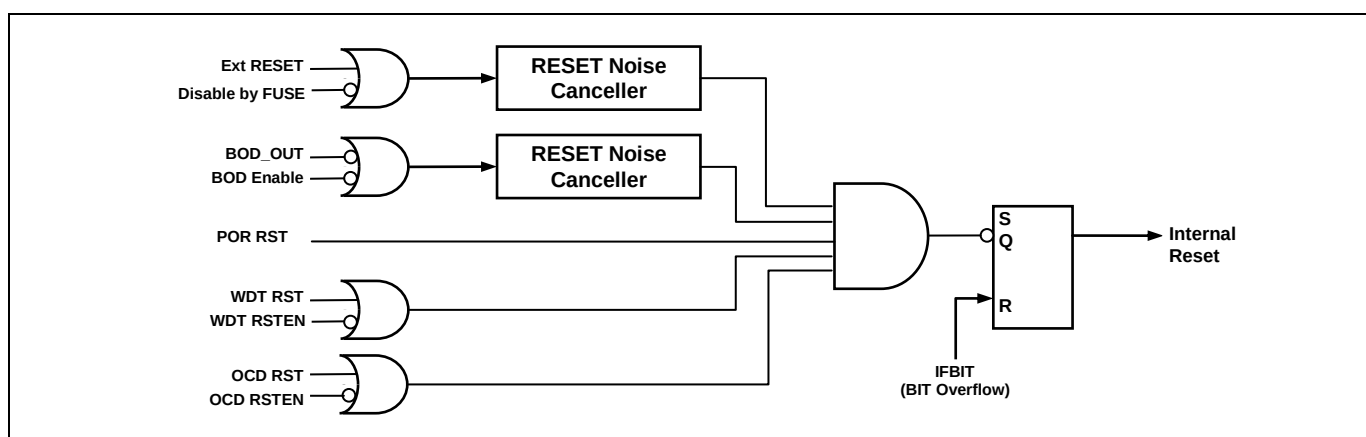


Figure 13.1 RESET Block Diagram

13.4 RESET Noise Canceller

The Figure 13.2 is the Noise canceller diagram for Noise cancel of RESET. It has the Noise cancel value of about 7 μ s (@VDD=5V) to the low input of System Reset.

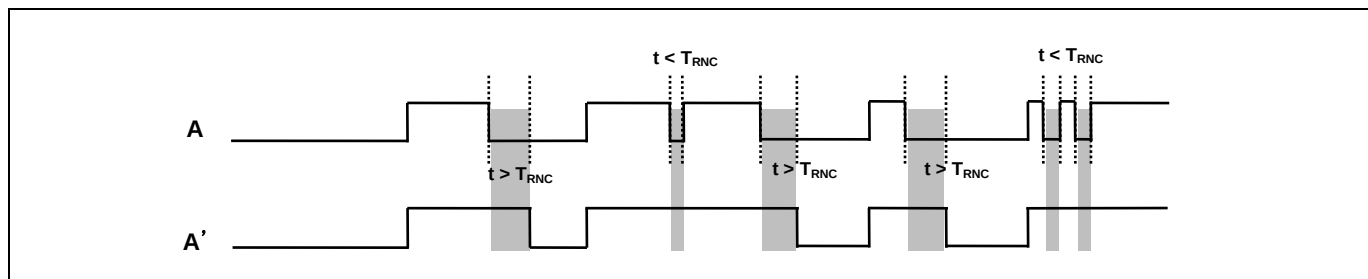


Figure 13.2 Reset noise canceller time diagram

13.5 Power on RESET

When rising device power, the POR (Power ON Reset) have a function to reset the device. If using POR, it executes the device RESET function instead of the RESET IC or the RESET circuits. And External RESET PIN is able to use as Normal I/O pin.

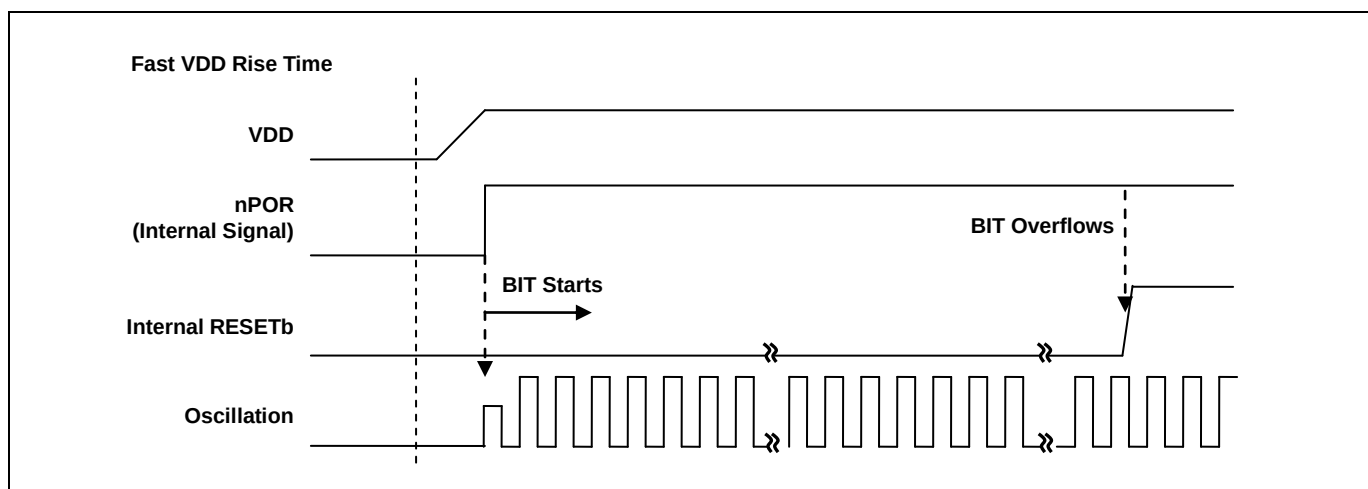


Figure 13.3 Fast VDD rising time

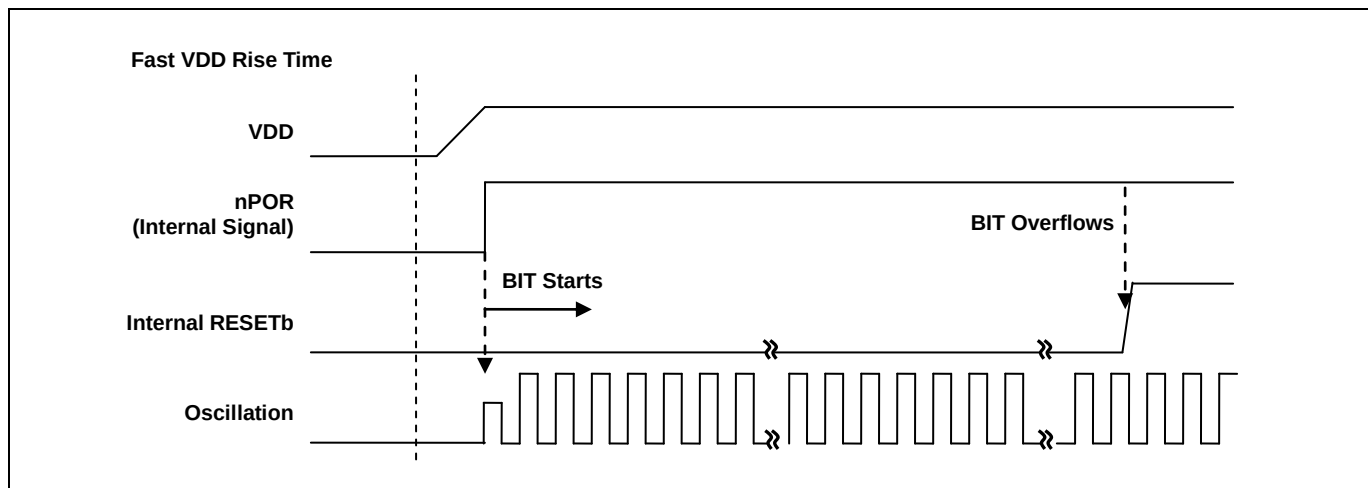


Figure 13.4 Internal RESET Release Timing On Power-Up

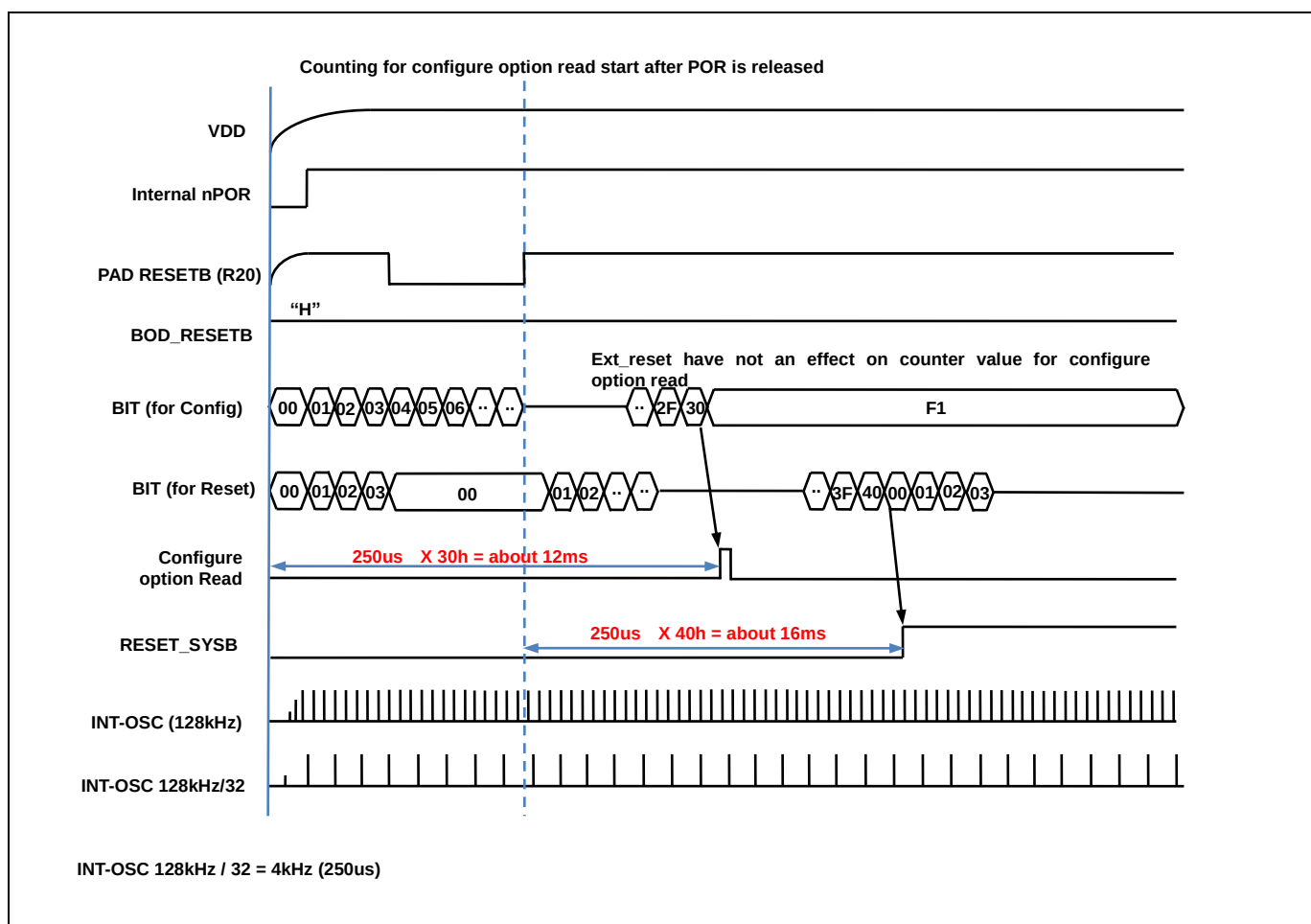


Figure 13.5 Configuration timing when Power-on

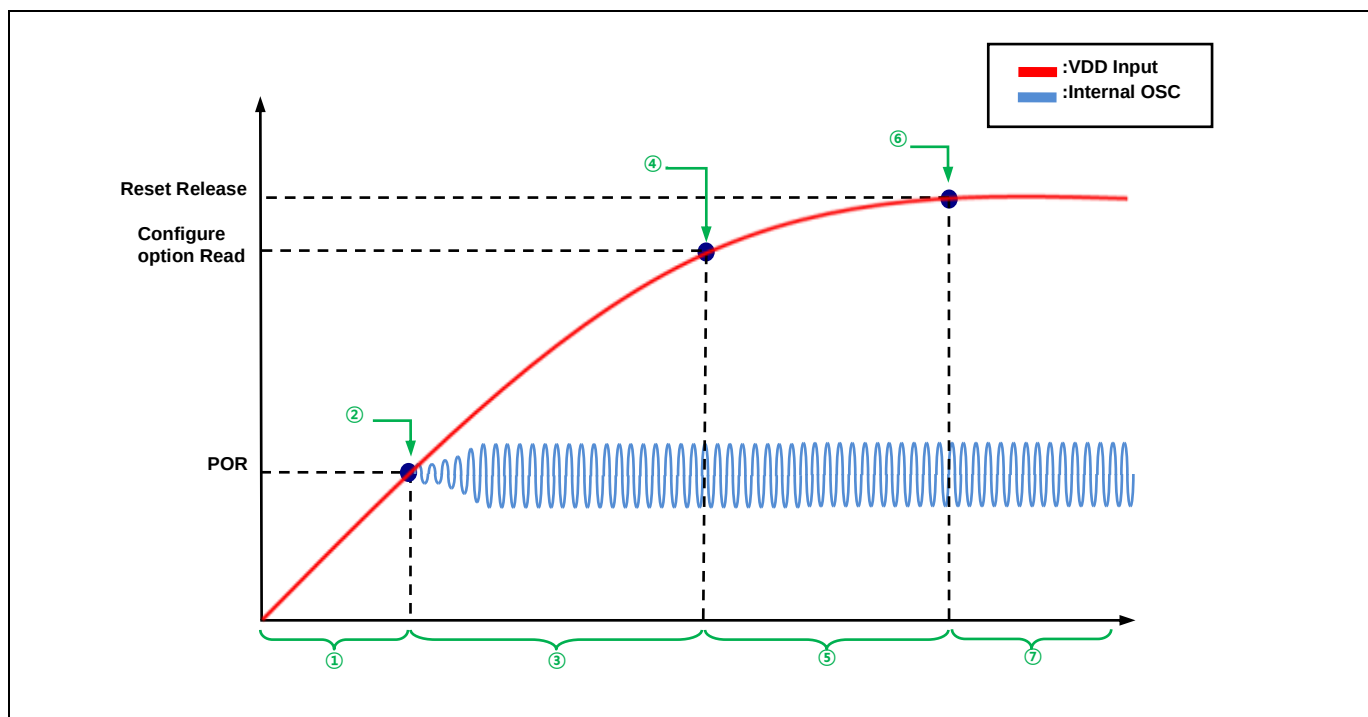


Figure 13.6 Boot Process Waveform

Process	Description	Remarks
①	-No Operation	
②	-1st POR level Detection -Internal OSC (125kHz) ON	-about 1.4V ~ 1.5V
③	- (INT-OSC125kHz/32)×30h Delay section (=12ms) -VDD input voltage must rise over than flash operating voltage for Configure option read	-Slew Rate $\geq 0.025\text{V/ms}$
④	- Configure option read point	-about 1.5V ~ 1.6V -Configure option Value is determined by Writing Option
⑤	- Rising section to Reset Release Level	-16ms point after POR or Ext_reset release
⑥	- Reset Release section (BIT overflow) i) after 16ms, after External Reset Release (External reset) ii) 16ms point after POR (POR only)	- BIT is used for Peripheral stability
⑦	-Normal operation	

Table 13.2 Boot Process Description

13.6 External RESETB Input

The External RESETB is the input to a Schmitt trigger. A reset is accomplished by holding the reset pin low for at least 7 μ s over, within the operating voltage range and oscillation stable, it is applied, and the internal state is initialized. After reset state becomes '1', it needs the stabilization time with 16ms and after the stable state, the internal RESET becomes '1'. The Reset process step needs 5 oscillator clocks. And the program execution starts at the vector address stored at address 0000H.

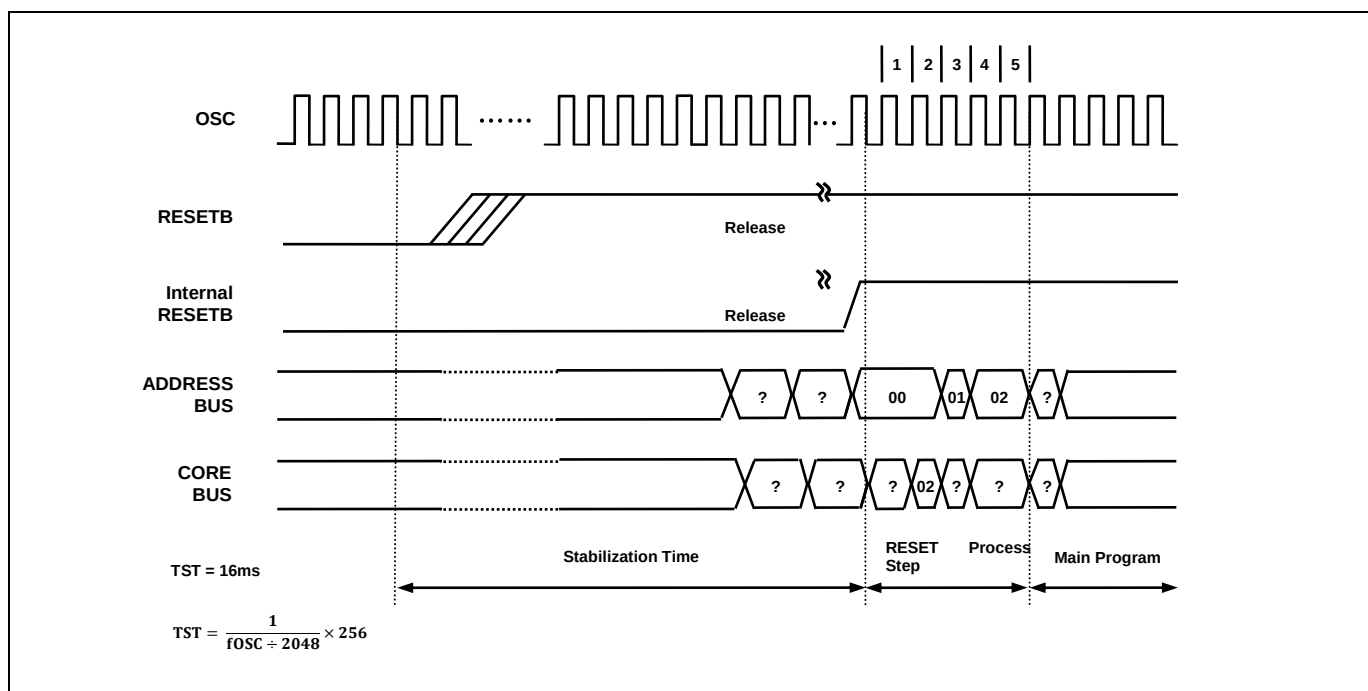


Figure 13.7 Timing Diagram after RESET

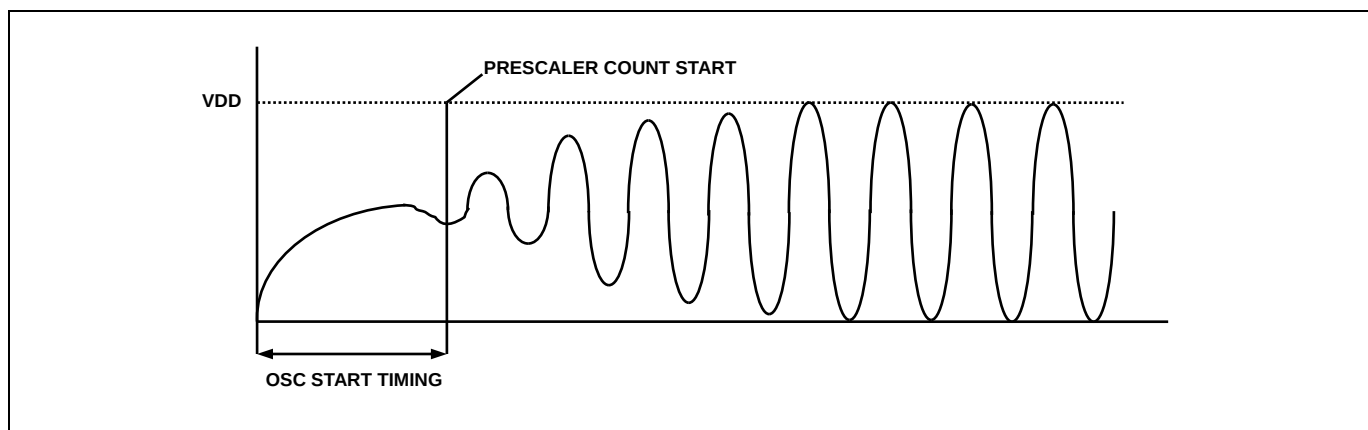


Figure 13.8 Oscillator generating waveform example

Note)

- As shown Figure 13.8, the stable generating time is not included in the start-up time.

13.7 Brown Out Detector Processor

The MC95FG308 has an On-chip Brown-out detection circuit for monitoring the VDD level during operation by comparing it to a fixed trigger level. The trigger level for the BOD can be selected by BODLS[1:0] bit to be 1.6V, 2.5V, 3.6V or 4.2V. In the STOP mode, this will contribute significantly to the total current consumption. So to minimize the current consumption, the BODEN bit is set to off by software.

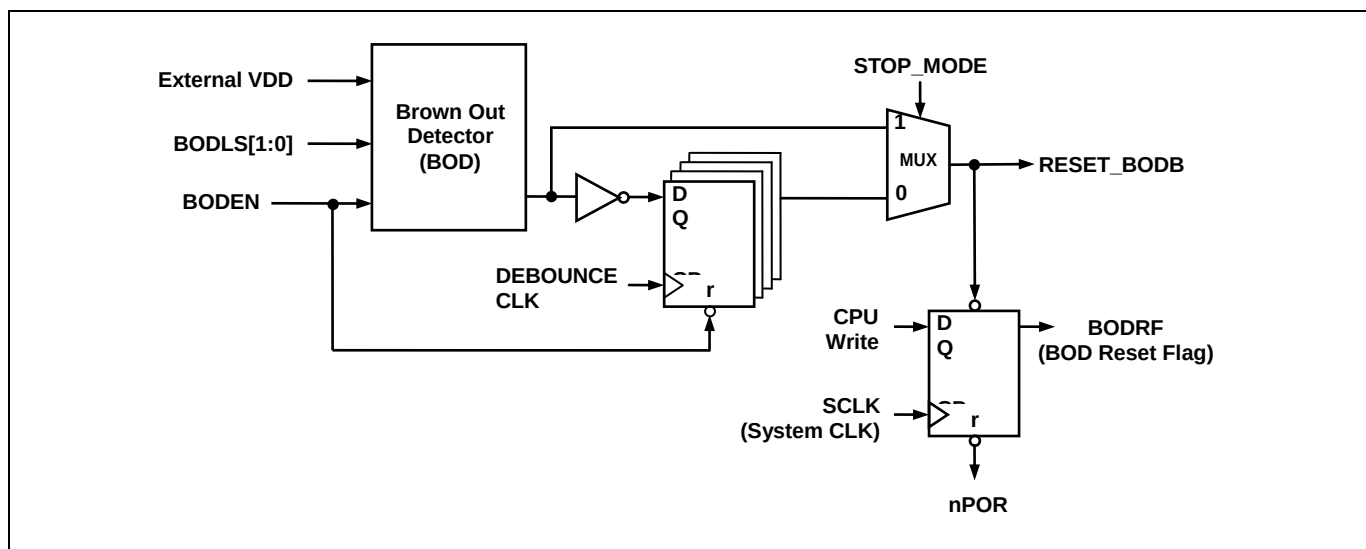


Figure 13.9 Block Diagram of BOD

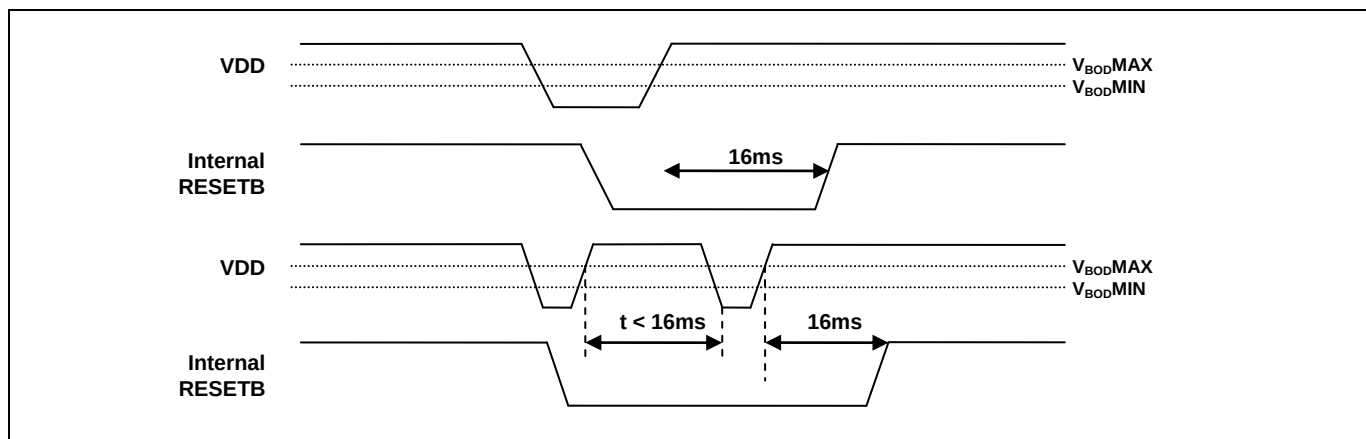


Figure 13.10 Internal Reset at the power fail situation

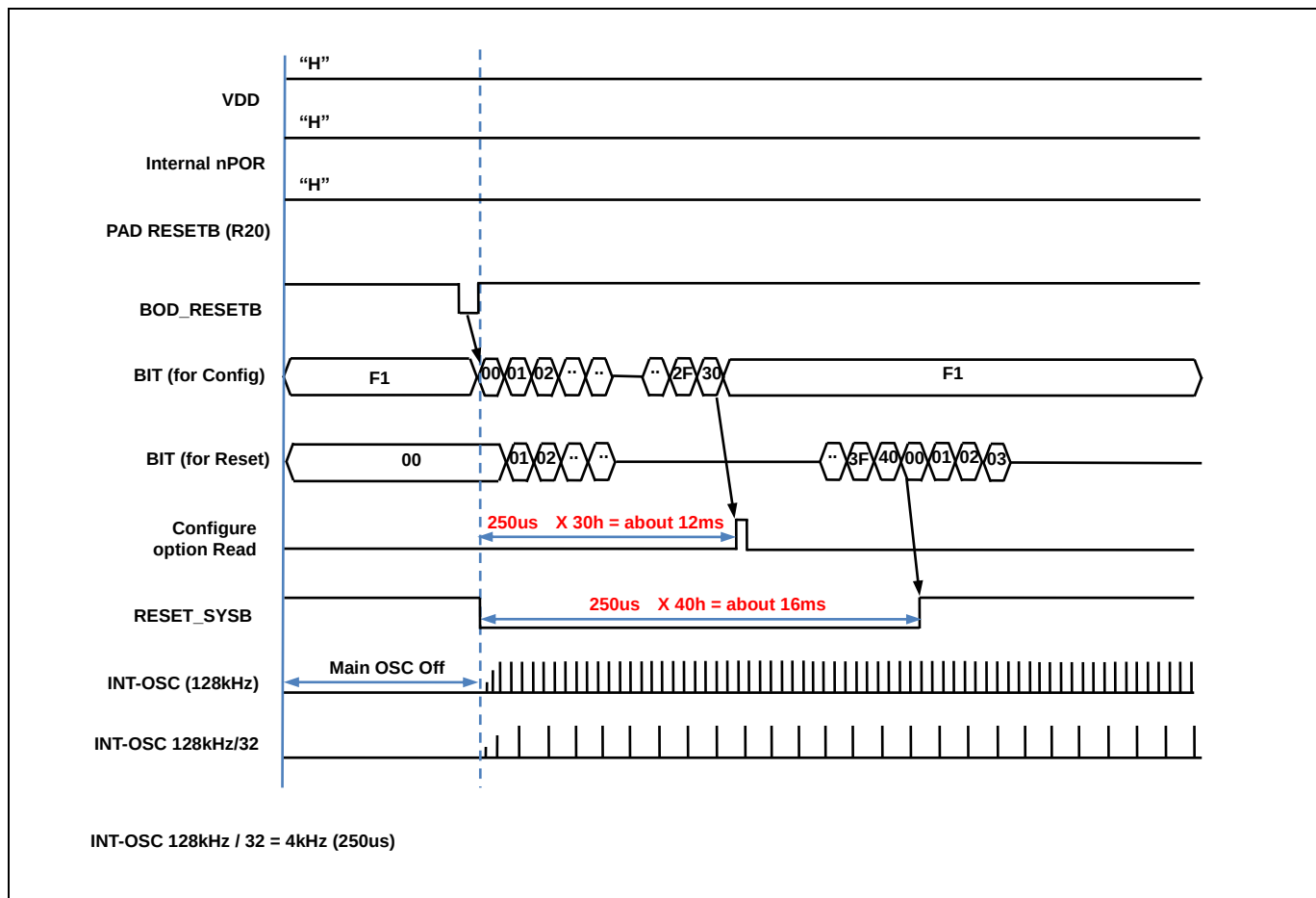


Figure 13.11 Configuration timing when BOD RESET

13.7.1 Register Map

Name	Address	Dir	Default	Description
BODR	86H	R/W	81H	BOD Control Register

Table 13.3 Register Map

13.7.2 Reset Operation Register Description

Reset control Register consists of the BOD Control Register (BODR).

13.7.3 Register Description for Reset Operation

BODR (BOD Control Register) : 86H

7	6	5	4	3	2	1	0
PORF	EXTRF	WDTRF	OCDRF	BODRF	BODLS[1]	BODLS[0]	BODEN
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 81H

PORF	Power-On Reset flag bit. The bit is reset by writing '0' to this bit.		
0	No detection		
1	Detection		
EXTRF	External Reset flag bit. The bit is reset by writing '0' to this bit or by Power ON reset.		
0	No detection		
1	Detection		
WDTRF	Watch Dog Reset flag bit. The bit is reset by writing '0' to this bit or by Power ON reset.		
0	No detection		
1	Detection		
OCDRF	On-Chip Debug Reset flag bit. The bit is reset by writing '0' to this bit or by Power ON reset.		
0	No detection		
1	Detection		
BODRF	Brown-Out Reset flag bit. The bit is reset by writing '0' to this bit or by Power ON reset.		
0	No detection		
1	Detection		
BODLS[1:0]	BOD level Voltage		
	BODLS1	BODLS0	Description
	0	0	1.6V
	0	1	2.5V
	1	0	3.6V
	1	1	4.2V
BODEN	BOD operation		
	0	BOD disable	
	1	BOD enable	

14 On-chip Debug System

14.1 Overview

14.1.1 Description

On-chip debug System (OCD) of MC95FG308 can be used for programming the non-volatile memories and on-chip debugging. Detailed descriptions for programming via the OCD interface can be found in the following chapter.

Figure 14.1 shows a block diagram of the OCD interface and the On-chip Debug system.

14.1.2 Feature

- Two-wire external interface: 1-wire serial clock input, 1-wire bi-directional serial data bus
- Debugger Access to:
 - All Internal Peripheral Units
 - Internal data RAM
 - Program Counter
 - Flash and Data EEPROM Memories
- Extensive On-chip Debug Support for Break Conditions, Including
 - Break Instruction
 - Single Step Break
 - Program Memory Break Points on Single Address
 - Programming of Flash, EEPROM, Fuses, and Lock bits through the two-wire Interface
 - On-chip Debugging Supported by Dr.Choice®
- Operating frequency

Supports the maximum frequency of the target MCU

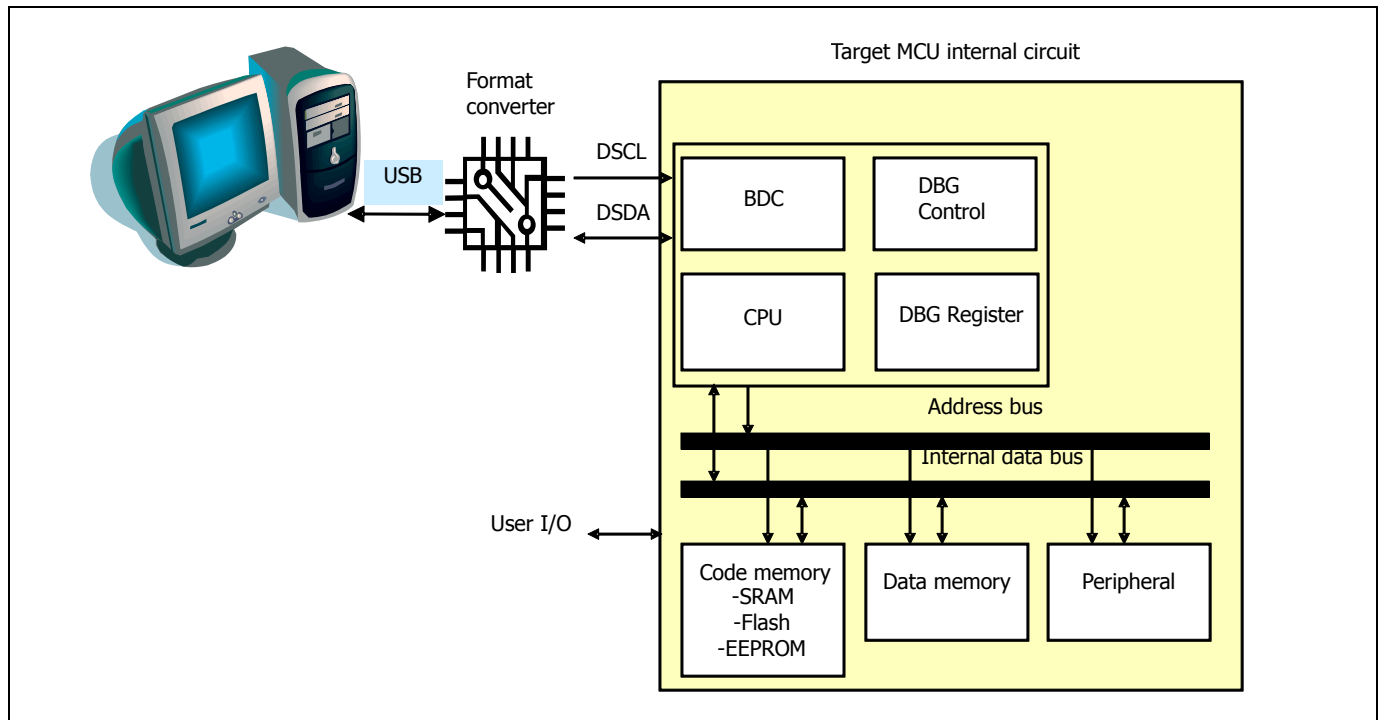


Figure 14.1 Block Diagram of On-chip Debug System

14.2 Two-Pin External Interface

14.2.1 Basic Transmission Packet

- 10-bit packet transmission using two-pin interface.
- 1-packet consists of 8-bit data, 1-bit parity and 1-bit acknowledge.
- Parity is even of '1' for 8-bit data in transmitter.
- Receiver generates acknowledge bit as '0' when transmission for 8-bit data and its parity has no error.
- When transmitter has no acknowledge (Acknowledge bit is '1' at tenth clock), error process is executed in transmitter.
- When acknowledge error is generated, host PC makes stop condition and transmits command which has error again.
- Background debugger command is composed of a bundle of packet.
- Star condition and stop condition notify the start and the stop of background debugger command respectively.

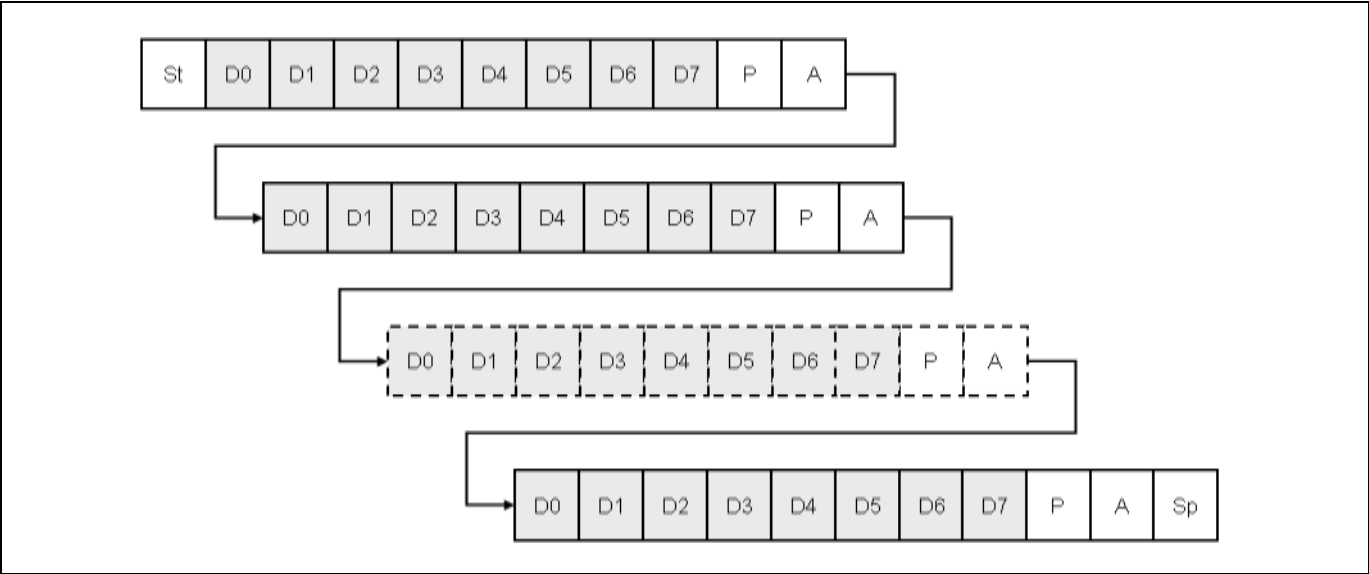


Figure 14.2 10-bit transmission packet

14.2.2 Packet Transmission Timing

14.2.2.1 Data Transfer

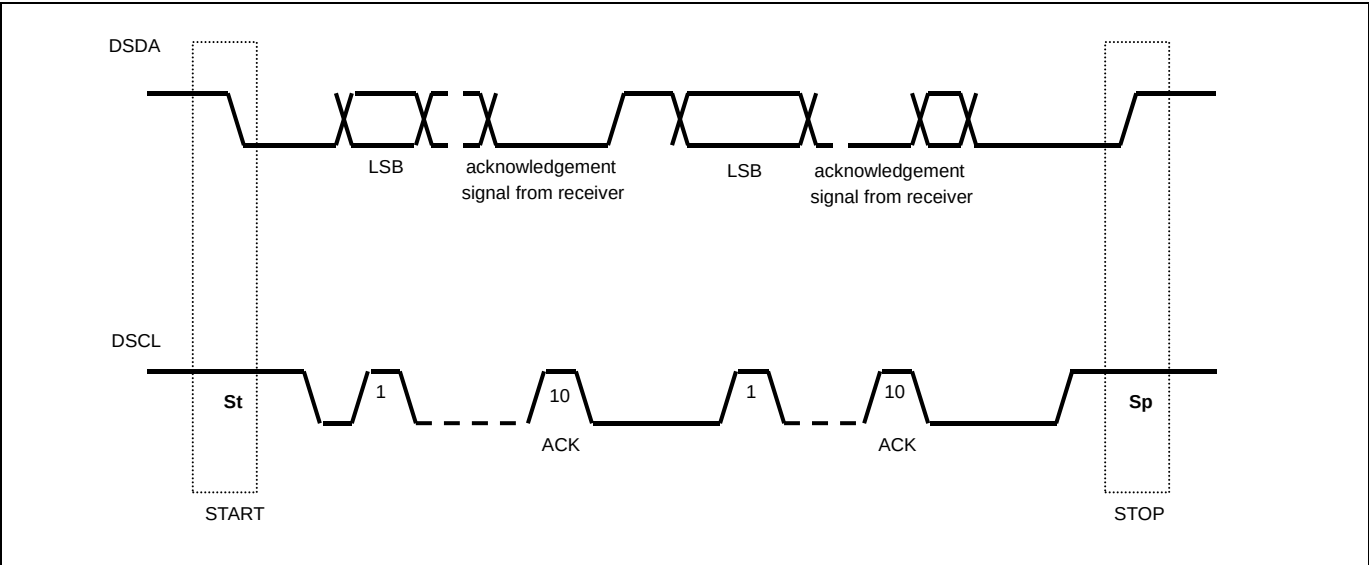


Figure 14.3 Data transfer on the twin bus

14.2.2.2 Bit Transfer

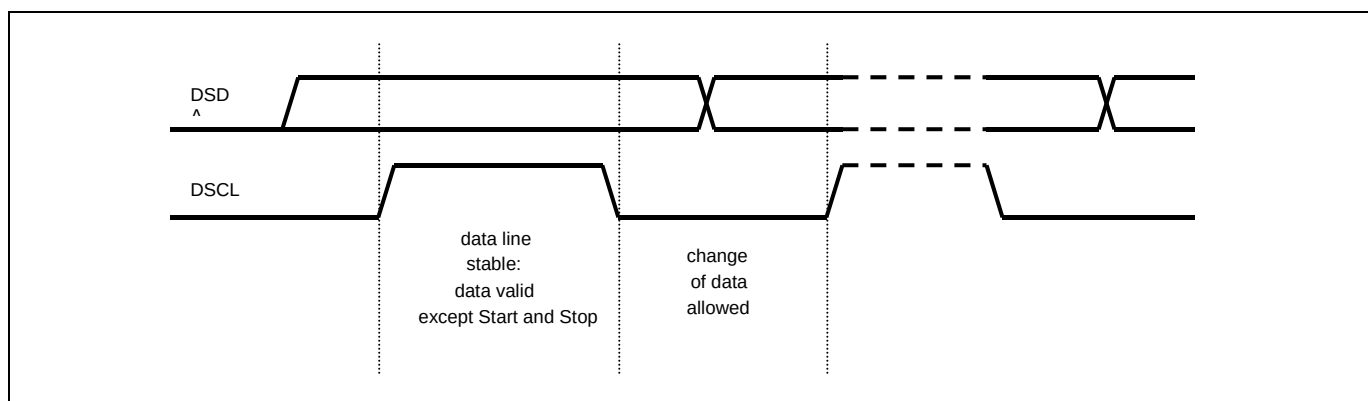


Figure 14.4 Bit transfer on the serial bus

14.2.2.3 Start and Stop Condition

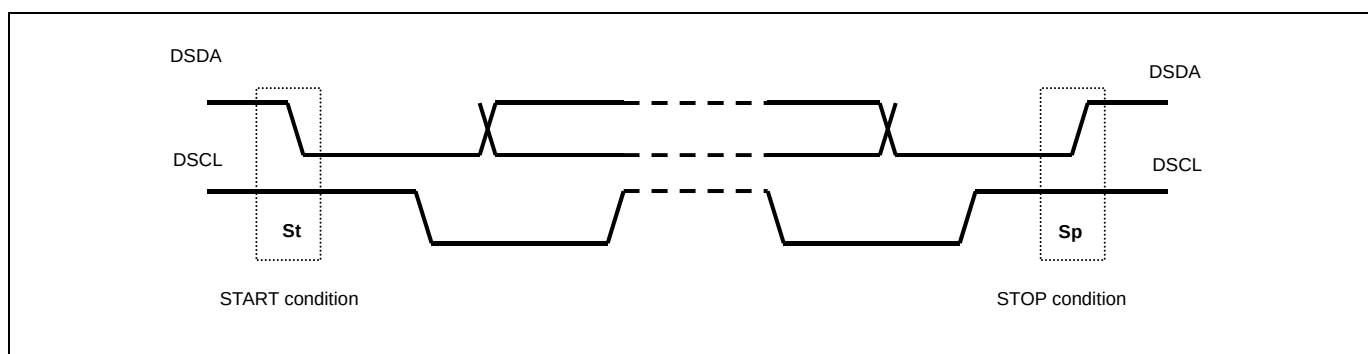


Figure 14.5 Start and stop condition

14.2.2.4 Acknowledge bit

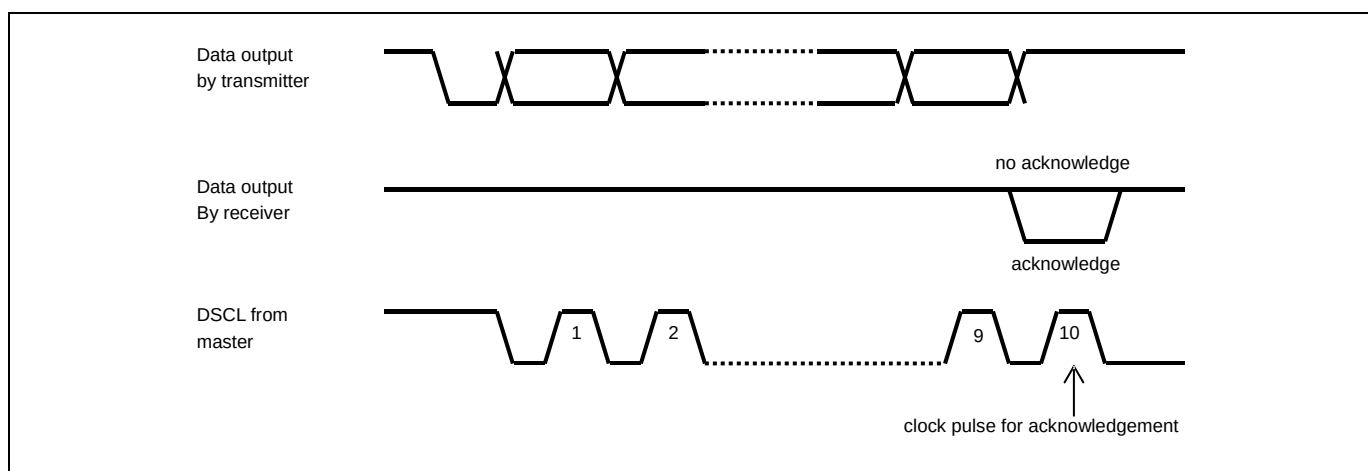


Figure 14.6 Acknowledge on the serial bus

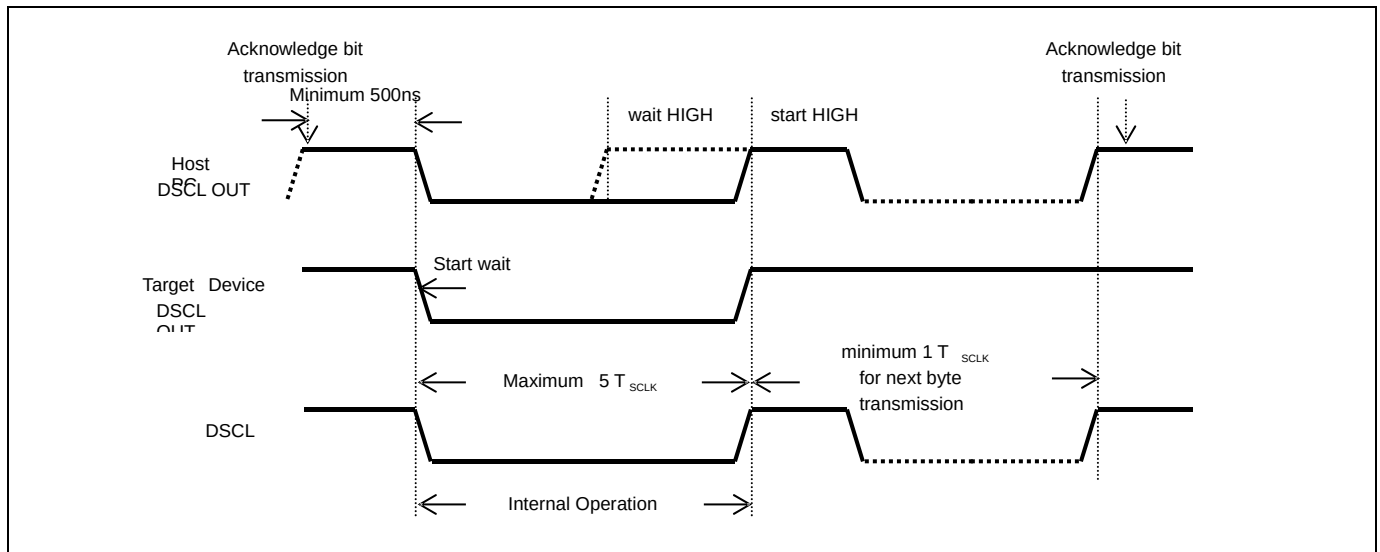


Figure 14.7 Clock synchronization during wait procedure

14.2.3 Connection of Transmission

Two-pin interface connection uses open-drain(wire-AND bidirectional I/O).

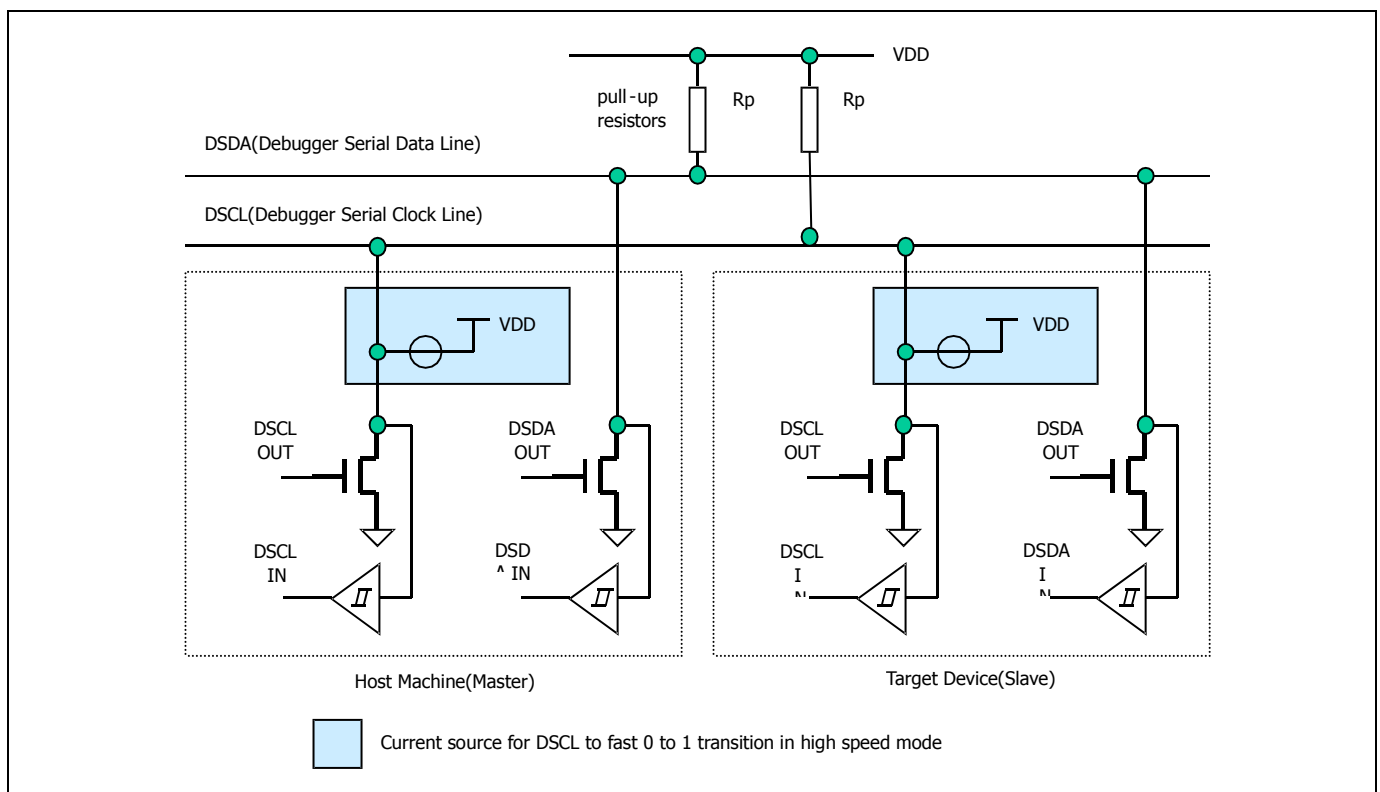


Figure 14.8 Connection of transmission

15 Memory Programming

15.1 Overview

15.1.1 Description

MC95FG308 incorporates flash and data EEPROM memory to which a program can be written, erased, and overwritten while mounted on the board. Also, data EEPROM can be programmed or erased in user program. Flash area can be programmed in only OCD or parallel ROM mode.

Serial ISP modes and byte-parallel ROM writer mode are supported.

15.1.2 Features

- Flash Size : 8Kbytes
- Single power supply program and erase
- Command interface for fast program and erase operation
- Up to 10,000 program/erase cycles at typical voltage and temperature for flash memory
- Up to 100,000 program/erase cycles at typical voltage and temperature for data EEPROM memory
- Security feature

15.2 Flash and EEPROM Control and status register

Registers to control Flash and Data EEPROM are Mode Register (FEMR), Control Register (FECR), Status Register (FESR), Time Control Register (FETCR), Address Low Register (FEARL), Address Middle Register (FEARM), address High Register (FEARH) and Data Register (FEDR). They are mapped to SFR area and can be accessed only in programming mode.

15.2.1 Register Map

Name	Address	Dir	Default	Description
FEMR	EAH	R/W	00H	Flash and EEPROM Mode Register
FECR	EBH	R/W	03H	Flash and EEPROM Control Register
FESR	ECH	R/W	80H	Flash and EEPROM Status Register
FETCR	EDH	R/W	00H	Flash and EEPROM Time Control Register
FEARL	F2H	R/W	00H	Flash and EEPROM Address Low Register
FEARM	F3H	R/W	00H	Flash and EEPROM Address Middle Register
FEARH	F4H	R/W	00H	Flash and EEPROM Address High Register
FEDR	F5H	R/W	00H	Flash and EEPROM Data Register

Table 15.1 Register Map

15.2.2 Register Description for Flash and EEPROM

FEMR (Flash and EEPROM Mode Register) : EAH

7	6	5	4	3	2	1	0
FSEL	ESEL	PGM	ERASE	PBUFF	OTPE	VFY	FEEN
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

FSEL	Select flash memory. 0 Deselect flash memory 1 Select flash memory
ESEL	Select data EEPROM 0 Deselect data EEPROM 1 Select data EEPROM
PGM	Enable program or program verify mode with VFY 0 Disable program or program verify mode 1 Enable program or program verify mode
ERASE	Enable erase or erase verify mode with VFY 0 Disable erase or erase verify mode 1 Enable erase or erase verify mode
PBUFF	Select page buffer 0 Deselect page buffer 1 Select page buffer
OTPE	Select OTP area instead of program memory 0 Deselect OTP area 1 Select OTP area
VFY	Set program or erase verify mode with PGM or ERASE Program Verify: PGM=1, VFY=1 Erase Verify: ERASE=1, VFY=1
FEEN	Enable program and erase of Flash and data EEPROM. When inactive, it is possible to read as normal mode 0 Disable program and erase 1 Enable program and erase

FECR (Flash and EEPROM Control Register) : EBH

7	6	5	4	3	2	1	0
AEF	AEE	EXIT1	EXIT0	WRITE	READ	nFERST	nPBRST
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 03H

AEF	Enable flash bulk erase mode		
0	Disable bulk erase mode of Flash memory		
1	Enable bulk erase mode of Flash memory		
AEE	Enable data EEPROM bulk erase mode		
0	Disable bulk erase mode of data EEPROM		
1	Enable bulk erase mode of data EEPROM		
EXIT[1:0]	Exit from program mode. It is cleared automatically after 1 clock		
	EXIT1	EXIT0	Description
	0	0	Don't exit from program mode
	0	1	Don't exit from program mode
	1	0	Don't exit from program mode
	1	1	Exit from program mode
WRITE	Start to program or erase of Flash and data EEPROM. It is cleared automatically after 1 clock		
0	No operation		
1	Start to program or erase of Flash and data EEPROM		
READ	Start auto-verify of Flash or data EEPROM. It is cleared automatically after 1 clock		
0	No operation		
1	Start auto-verify of Flash or data EEPROM		
nFERST	Reset Flash or data EEPROM control logic. It is cleared automatically after 1 clock		
0	No operation		
1	Reset Flash or data EEPROM control logic.		
nPBRST	Reset page buffer with PBUFF. It is cleared automatically after 1 clock		
	PBUFF	nPBRST	Description
	0	0	Page buffer reset
	1	0	Write checksum reset

WRITE and READ bits can be used in program, erase and verify mode with FEAR registers. Read or writes for memory cell or page buffer uses read and write enable signals from memory controller. Indirect address mode with FEAR is only allowed to program, erase and verify

FESR (Flash and EEPROM Status Register) : ECH

7	6	5	4	3	2	1	0
PEVBSY	VFYGOOD	-	-	ROMINT	WMODE	EMODE	VMODE
R	RW	R	R	RW	R	R	R

Initial value : 80H

- PEVBSY** Operation status flag. It is cleared automatically when operation starts.
Operations are program, erase or verification
0 Busy (Operation processing)
1 Complete Operation
- VFYGOOD** Auto-verification result flag.
0 Auto-verification fails
1 Auto-verification successes
- ROMINT** Flash and Data EEPROM interrupt request flag. Auto-cleared when program/erase/verify starts. Active in program/erase/verify completion
0 No interrupt request.
1 Interrupt request.
- WMODE** Write mode flag
EMODE Erase mode flag
VMODE Verify mode flag

FEARL (Flash and EEPROM address low Register) : F2H

7	6	5	4	3	2	1	0
ARL7	ARL6	ARL5	ARL4	ARL3	ARL2	ARL1	ARL0
W	W	W	W	W	W	W	W

Initial value : 00H

ARL[7:0] Flash and EEPROM address low**FEARM (Flash and EEPROM address middle Register) : F3H**

7	6	5	4	3	2	1	0
ARM7	ARM6	ARM5	ARM4	ARM3	ARM2	ARM1	ARM0
W	W	W	W	W	W	W	W

Initial value : 00H

ARM[7:0] Flash and EEPROM address middle**FEARH (Flash and EEPROM address high Register) : F4H**

7	6	5	4	3	2	1	0
ARH7	ARH6	ARH5	ARH4	ARH3	ARH2	ARH1	ARH0
W	W	W	W	W	W	W	W

Initial value : 00H

ARH[7:0] Flash and EEPROM address high

FEAR registers are used for program, erase and auto-verify. In program and erase mode, it is page address and ignored the same least significant bits as the number of bits of page address. In auto-verify mode, address increases automatically by one.

FEARs are write-only register. Reading these registers returns 24-bit checksum result

FEDR (Flash and EEPROM data control Register) : F5H

7	6	5	4	3	2	1	0
FEDR7	FEDR6	FEDR5	FEDR4	FEDR3	FEDR2	FEDR1	FEDR0
W	W	W	W	W	W	W	W

Initial value : 00H

FEDR[7:0] Flash and EEPROM data

Data register. In no program/erase/verify mode, READ/WRITE of FEDR read or write data from EEPROM or FLASH to this register or from this register to Flash or EEPROM.

The sequence of writing data to this register is used for EEPROM program entry. The mode entrance sequence is to write 0xA5 and 0x5A to it in order.

FETCR (Flash and EEPROM Time control Register) : EDH

7	6	5	4	3	2	1	0
TCR7	TCR6	TCR5	TCR4	TCR3	TCR2	TCR1	TCR0
RW	RW	RW	RW	RW	RW	RW	RW

Initial value : 00H

TCR[7:0] Flash and EEPROM Time control

Program and erase time is controlled by setting FETCR register. Program and erase timer uses 10-bit counter. It increases by one at each divided system clock frequency(=SCLK/128). It is cleared when program or erase starts. Timer stops when 10-bit counter is same to FETCR. PEVBSY is cleared when program, erase or verify starts and set when program, erase or verify stops.

Max program/erase time at 12Mhz system clock : $(255+1) * 2 * (83.3ns * 128) = 5.459ms$

In the case of 10% of error rate of counter source clock, program or erase time is 5.0~5.9ms

* * Program/erase time calculation

for page write or erase, $T_{pe} = (TCON+1) * 2 * (SCLK * 128)$

for bulk erase, $T_{be} = (TCON+1) * 4 * (SCLK * 128)$

	Min	Typ	Max	Unit
program/erase Time	2.4	2.5	2.6	ms

Table 15.2 Program/erase Time

※ Recommended program/erase time at 12MHz (FETCR = 75h)

15.3 Memory map

15.3.1 Flash Memory Map

Program memory uses 8-Kbyte of Flash memory. It is read by byte and written by byte or page. One page is 32-byte

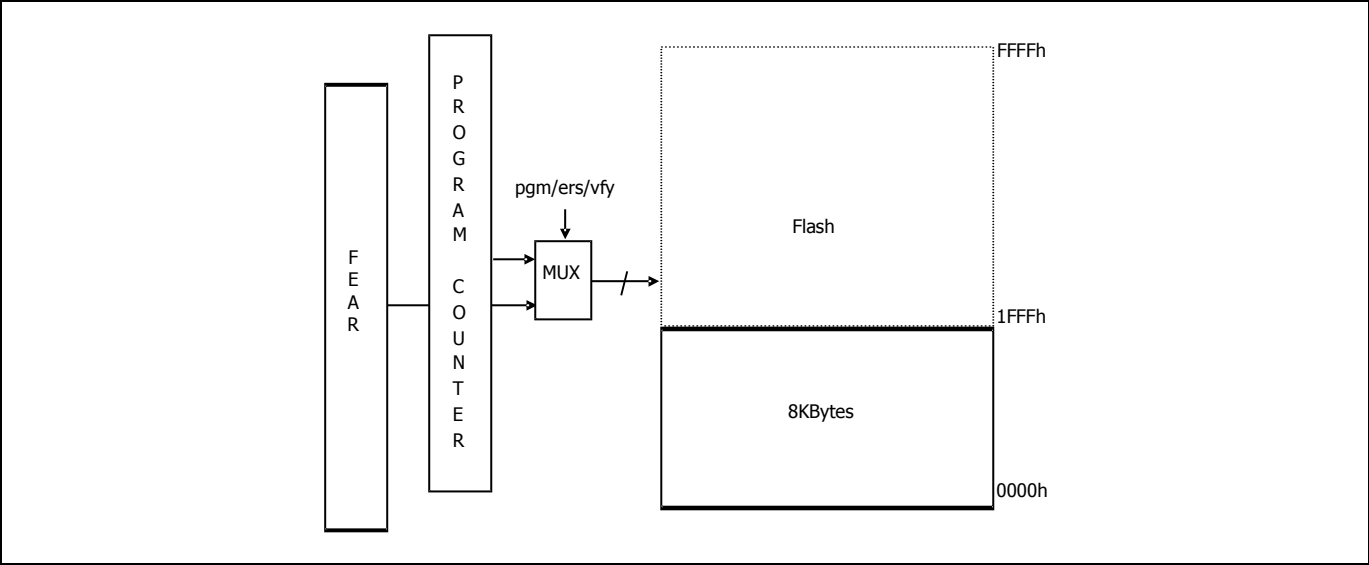


Figure 15.1 Flash Memory Map

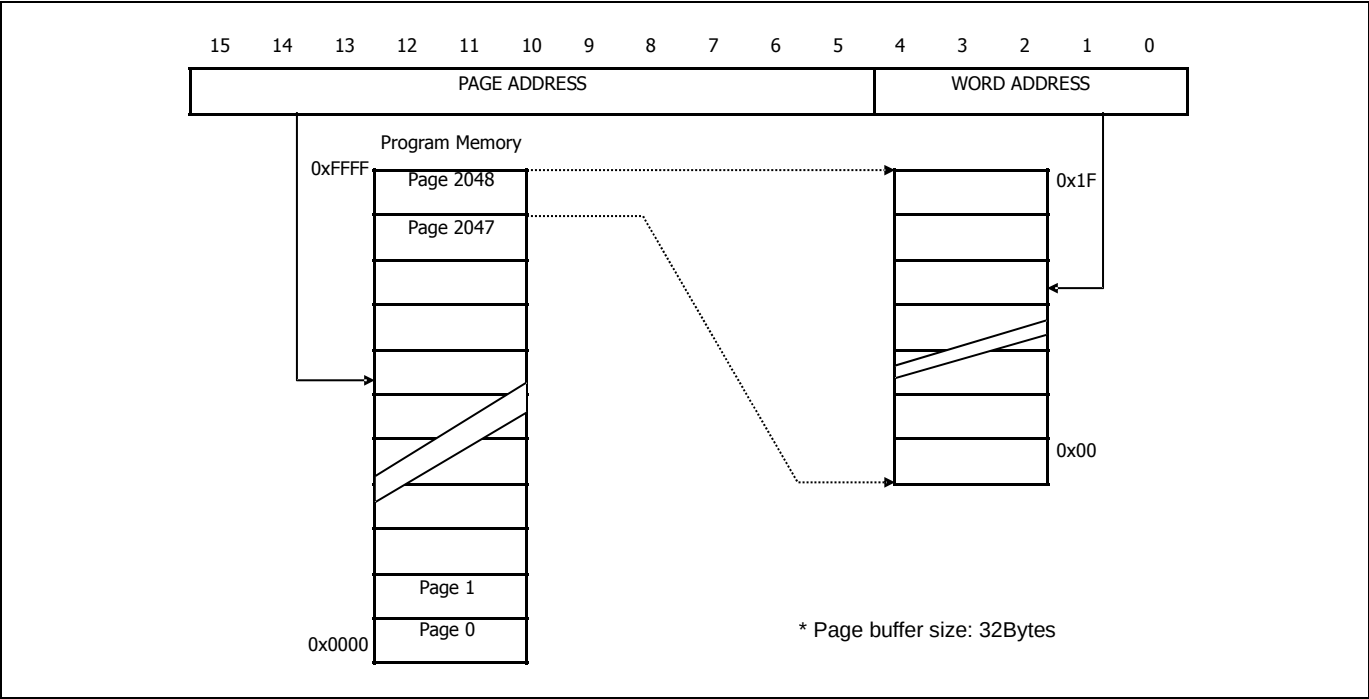


Figure 15.2 Address configuration of Flash memory

15.3.2 Data EEPROM Memory Map

Data EEPROM memory uses 512-byte of EEPROM. It is read by byte and written by byte or page. One page is 16-byte. It is mapped to external data memory of 8051

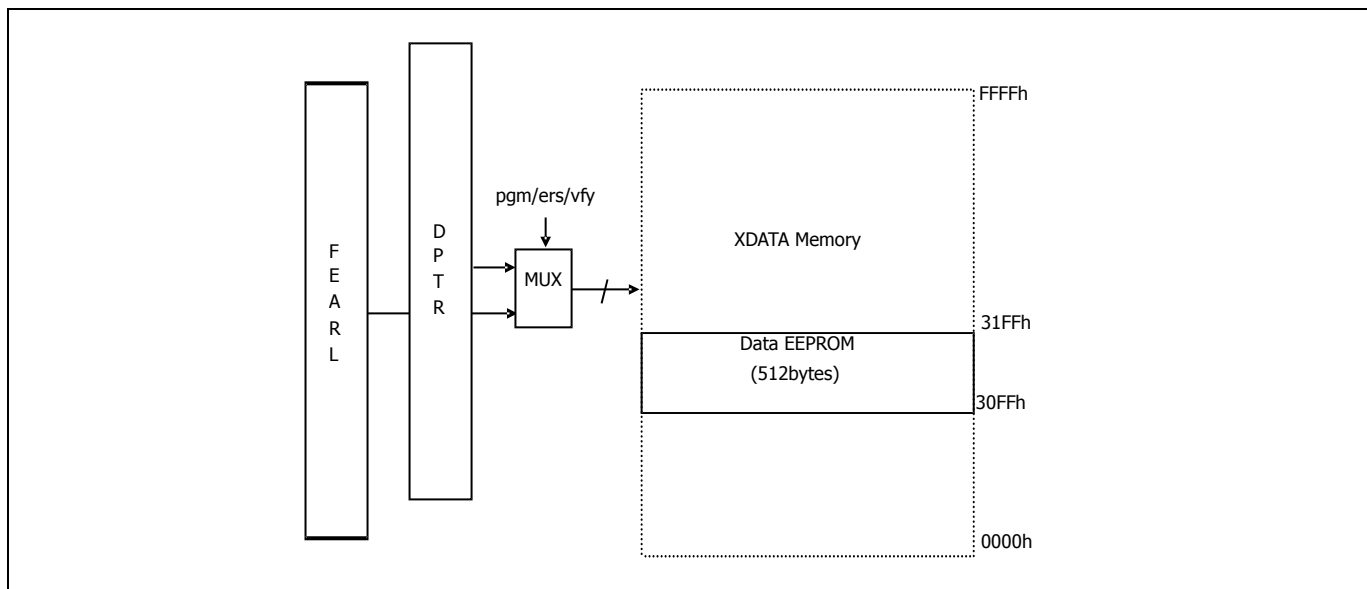


Figure 15.3 Data EEPROM memory map

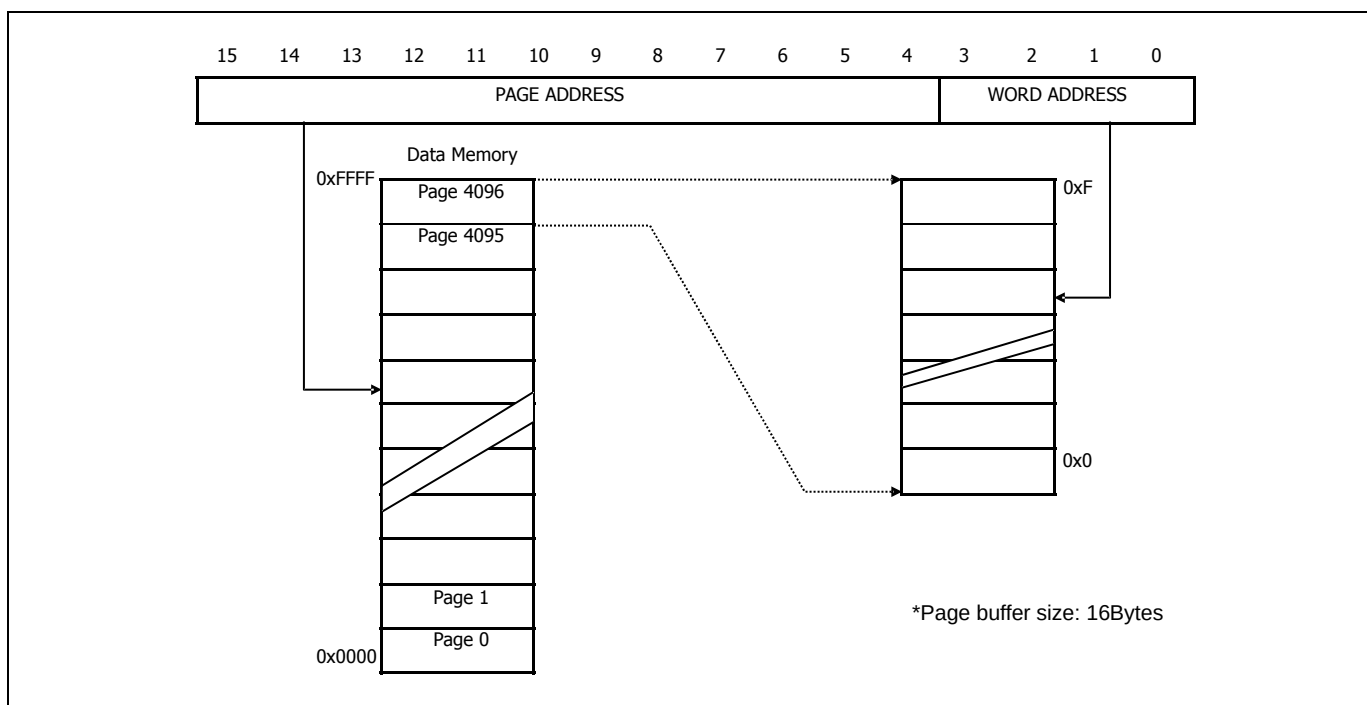


Figure 15.4 Address configuration of data EEPROM

15.4 Serial In-System Program Mode

Serial in-system program uses the interface of debugger which uses two wires. Refer to chapter 14 in details about debugger.

15.4.1 Flash operation

Configuration (This Configuration is just used for follow description)

7	6	5	4	3	2	1	0
-	FEMR[4] & [1]	FEMR[5] & [1]	-	-	FEMR[2]	FECR[6]	FECR[7]
-	ERASE&VFY	PGM&VFY	-	-	OTPE	AEE	AEF

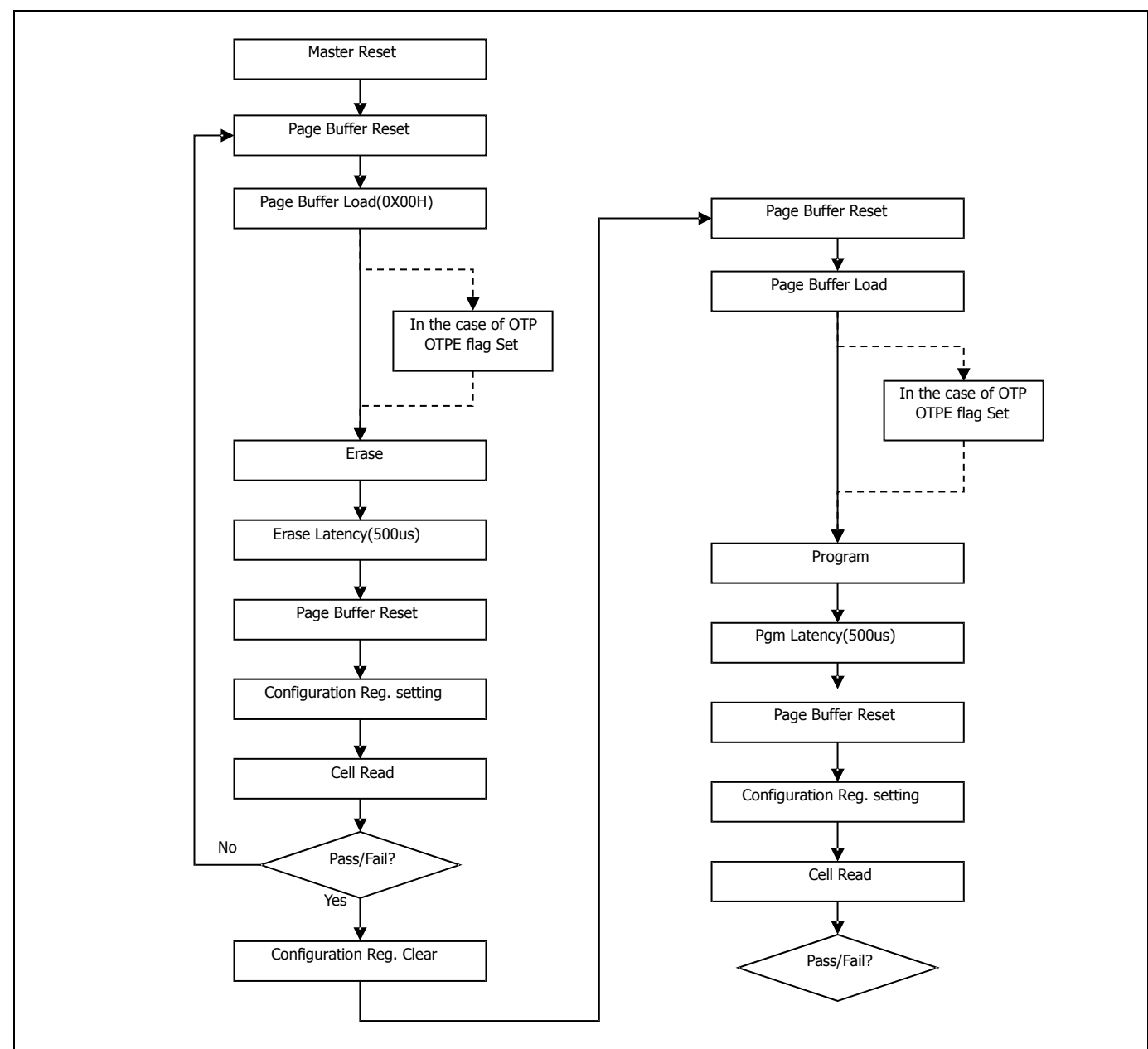


Figure 15.5 The sequence of page program and erase of Flash memory

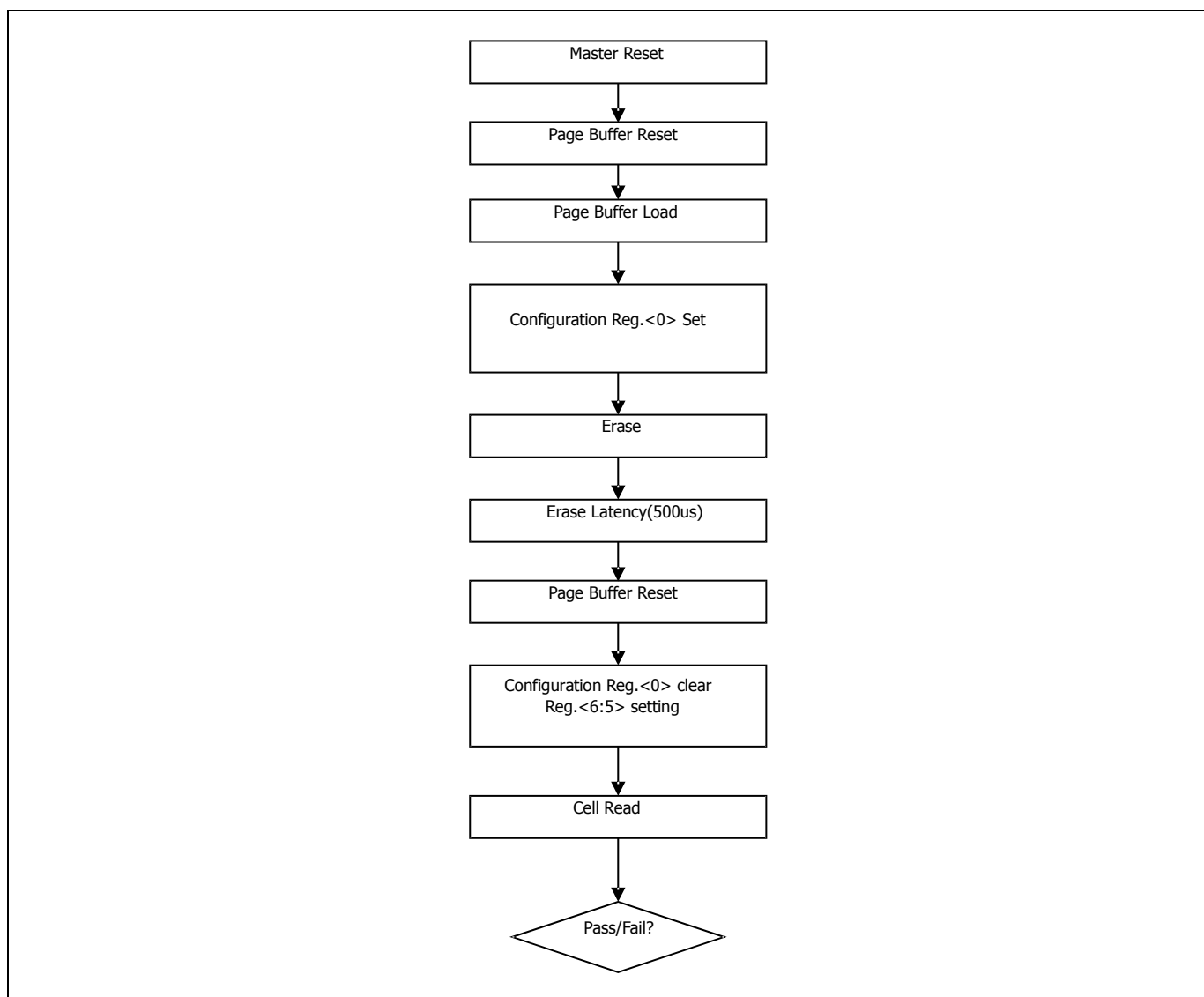


Figure 15.6 The sequence of bulk erase of Flash memory

15.4.1.1 Flash Read

- Step 1. Enter OCD(=ISP) mode.
- Step 2. Set ENBDM bit of BCR.
- Step 3. Enable debug and Request debug mode.
- Step 4. Read data from Flash.

15.4.1.2 Enable program mode

- Step 1. Enter OCD(=ISP) mode.¹
- Step 2. Set ENBDM bit of BCR.
- Step 3. Enable debug and Request debug mode.
- Step 4. Enter program/erase mode sequence.²
 - (1) Write 0xAA to 0xF555.
 - (2) Write 0x55 to 0xFAAA.

(3) Write 0xA5 to 0xF555.

¹ Refer to how to enter ISP mode..

² Command sequence to activate Flash write/erase mode. It is composed of sequentially writing data of Flash memory.

15.4.1.3 Flash write mode

Step 1. Enable program mode.

Step 2. Reset page buffer. FEMR: 1000_0001 FECR:0000_0010

Step 3. Select page buffer. FEMR:1000_1001

Step 4. Write data to page buffer.(Address automatically increases by twin.)

Step 5. Set write mode. FEMR:1010_0001

Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx

Step 7. Set FETCR.

Step 8. Start program. FECR:0000_1011

Step 9. Insert one NOP operation

Step 10. Read FESR until PEVBSY is 1.

Step 11. Repeat step2 to step 8 until all pages are written.

15.4.1.4 Flash page erase mode

Step 1. Enable program mode.

Step 2. Reset page buffer. FEMR: 1000_0001 FECR:0000_0010

Step 3. Select page buffer. FEMR:1000_1001

Step 4. Write 'h00 to page buffer. (Data value is not important.)

Step 5. Set erase mode. FEMR:1001_0001

Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx

Step 7. Set FETCR.

Step 8. Start erase. FECR:0000_1011

Step 9. Insert one NOP operation

Step 10. Read FESR until PEVBSY is 1.

Step 11. Repeat step2 to step 8 until all pages are erased.

15.4.1.5 Flash bulk erase mode

Step 1. Enable program mode.

Step 2. Reset page buffer. FEMR: 1000_0001 FECR:0000_0010

Step 3. Select page buffer. FEMR:1000_1001

Step 4. Write 'h00 to page buffer. (Data value is not important.)

Step 5. Set erase mode. FEMR:1001_0001.

(Only main cell area is erased. For bulk erase including OTP area, select OTP area.(set FEMR to 1000_1101.)

Step 6. Set FETCR

Step 7. Start bulk erase. FECR:1000_1011

Step 8. Insert one NOP operation

Step 9. Read FESR until PEVBSY is 1.

15.4.1.6 Flash OTP area read mode

Step 1. Enter OCD(=ISP) mode.

Step 2. Set ENBDM bit of BCR.

Step 3. Enable debug and Request debug mode.

Step 4. Select OTP area. FEMR:1000_0101

Step 5. Read data from Flash.

15.4.1.7 Flash OTP area write mode

Step 1. Enable program mode.

Step 2. Reset page buffer. FEMR: 1000_0001 FECR:0000_0010

Step 3. Select page buffer. FEMR:1000_1001

Step 4. Write data to page buffer.(Address automatically increases by twin.)

Step 5. Set write mode and select OTP area. FEMR:1010_0101

Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx

Step 7. Set FETCR.

Step 8. Start program. FECR:0000_1011

Step 9. Insert one NOP operation

Step 10. Read FESR until PEVBSY is 1.

15.4.1.8 Flash OTP area erase mode

Step 1. Enable program mode.

Step 2. Reset page buffer. FEMR: 1000_0001 FECR:0000_0010

Step 3. Select page buffer. FEMR:1000_1001

Step 4. Write 'h00 to page buffer. (Data value is not important.)

Step 5. Set erase mode and select OTP area. FEMR:1001_0101

Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx

Step 7. Set FETCR.

Step 8. Start erase. FECR:0000_1011

Step 9. Insert one NOP operation

Step 10. Read FESR until PEVBSY is 1.

15.4.1.9 Flash program verify mode

Step 1. Enable program mode.

Step 2. Set program verify mode. FEMR:1010_0011

Step 3. Read data from Flash.

15.4.1.10 OTP program verify mode

- Step 1. Enable program mode.
- Step 2. Set program verify mode. FEMR:1010_0111
- Step 3. Read data from Flash.

15.4.1.11 Flash erase verify mode

- Step 1. Enable program mode.
- Step 2. Set erase verify mode. FEMR:1001_0011
- Step 3. Read data from Flash.

15.4.1.12 Flash page buffer read

- Step 1. Enable program mode.
- Step 2. Select page buffer. FEMR:1000_1001
- Step 3. Read data from Flash.

15.4.2 Data EEPROM operation

Program and erase operation of Data EEPROM are executed by direct and indirect address mode.
Direct address mode uses external data area of 8051. Indirect address mode uses address register of SFR area..

15.4.2.1 Data EEPROM Read

- Step 1. Enter OCD(=ISP) mode.
- Step 2. Set ENBDM bit of BCR.
- Step 3. Enable debug and Request debug mode.
- Step 4. Read data from Data EEPROM.

15.4.2.2 Enable program mode

- Step 1. Enter OCD(=ISP) mode.¹
- Step 2. Set ENBDM bit of BCR.
- Step 3. Enable debug and Request debug mode.
- Step 4. Enter program/erase mode sequence.²
 - (1) Write 0xA5 to FEDR.
 - (2) Write 0x5A to FEDR.

1 Refer to how to enter ISP mode..

2 Command sequence to activate data EEPROM write/erase mode. It is composed of sequentially writing to data register(FEDR)

15.4.2.3 EEPROM write mode

- Step 1. Enable program mode.
- Step 2. Reset page buffer. FEMR: 0100_0001 FECR:0000_0010
- Step 3. Select page buffer. FEMR:0100_1001
- Step 4. Write data to page buffer.(Address automatically increases by twin.)
- Step 5. Set write mode. FEMR:0110_0001
- Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx
- Step 7. Set FETCR.
- Step 8. Start program. FECR:0000_1011
- Step 9. Insert one NOP operation
- Step 10. Read FESR until PEVBSY is 1.
- Step 11. Repeat step2 to step 8 until all pages are written.

15.4.2.4 EEPROM page erase mode

- Step 1. Enable program mode.
- Step 2. Reset page buffer. FEMR: 0100_0001 FECR:0000_0010
- Step 3. Select page buffer. FEMR:0100_1001
- Step 4. Write 'h00 to page buffer. (Data value is not important.)
- Step 5. Set erase mode. FEMR:0101_0001
- Step 6. Set page address. FEARH:FEARM:FEARL=20'hx_xxxx
- Step 7. Set FETCR.
- Step 8. Start erase. FECR:0000_1011
- Step 9. Insert one NOP operation
- Step 10. Read FESR until PEVBSY is 1.
- Step 11. Repeat step2 to step 8 until all pages are erased.

15.4.2.5 EEPROM bulk erase mode

- Step 1. Enable program mode.
- Step 2. Reset page buffer. FEMR: 0100_0001 FECR:0000_0010
- Step 3. Select page buffer. FEMR:0100_1001
- Step 4. Write 'h00 to page buffer. (Data value is not important.)
- Step 5. Set erase mode. FEMR:0101_0001.
- Step 6. Set FETCR
- Step 7. Start bulk erase. FECR:0100_1011
- Step 8. Insert one NOP operation
- Step 9. Read FESR until PEVBSY is 1.

15.4.2.6 Data EEPROM program verify mode

- Step 1. Enable program mode.

Step 2. Set program verify mode. FEMR:0110_0011

Step 3. Read data from Flash.

15.4.2.7 Data EEPROM erase verify mode

Step 1. Enable program mode.

Step 2. Set erase verify mode. FEMR:0101_0011

Step 3. Read data from Flash.

15.4.2.8 Data EEPROM page buffer read

Step 1. Enable program mode.

Step 2. Select page buffer. FEMR:0100_1001

Step 3. Read data from Flash.

15.4.3 Summary of Flash and Data EEPROM Program/Erase Mode

Operation mode		Description
F L A S H	Flash read	Read cell by byte.
	Flash write	Write cell by bytes or page.
	Flash page erase	Erase cell by page.
	Flash bulk erase	Erase the whole cells.
	Flash program verify	Read cell in verify mode after programming.
	Flash erase verify	Read cell in verify mode after erase.
	Flash page buffer load	Load data to page buffer.
E E P R O M	Data EEPROM read	Read cell by byte.
	Data EEPROM write	Write cell by bytes or page.
	Data EEPROM page erase	Erase cell by page.
	Data EEPROM bulk erase	Erase the whole cells.
	Data EEPROM program verify	Read cell in verify mode after programming.
	Data EEPROM erase verify	Read cell in verify mode after erase.
	Data EEPROM page buffer load	Load data to page buffer.

Table 15.3 Operation Mode

15.5 Parallel Mode

15.5.1 Overview

Parallel program mode transfers address and data by byte. 3-byte address can be entered by one from the least significant byte of address. If only LSB is changed, only one byte can be transferred. And if the second byte is changed, the first and second byte can be transferred. Upper 4-bit of the most significant byte selects memory to be accessed. Table 15.4 shows memory type to be accessible by parallel mode. Address auto-increment is supported when read or write data without address.

The erase and program sequence of Flash and data EEPROM is identical to that of ISP mode except the entrance of parallel mode. Refer to Table 15.5 for the entrance method for parallel mode.

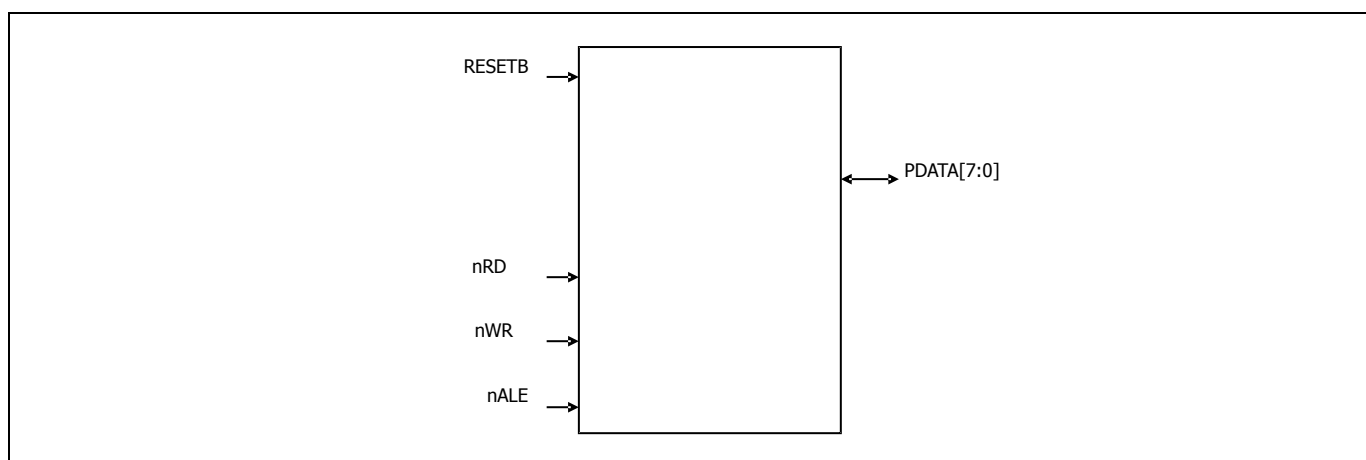


Figure 15.7 Pin diagram for parallel programming

ADDRH[7:4]				Memory Type
0	0	0	0	Program Memory
0	0	0	1	External Memory
0	0	1	0	SFR

Table 15.4 The selection of memory type by ADDRH[7:4]

15.5.2 Parallel Mode instruction format

Instruction	Signal	Instruction Sequence													
n-byte data read with 3-byte address	nALE	L		L		L		H		H		H		H	
	nWR	L	H	L	H	L	H	H	H	H	H	H	H	H	
	nRD	H	H	H	H	H	H	L	H	L	H	L	H	H	
	PDATA	ADDR _L		ADDR _M		ADDR _H		DATA ₀		DATA ₁		---		DATA _n	
n-byte data write with 3-byte address	nALE	L		L		L		H		H		H		H	
	nWR	L	H	L	H	L	H	L	H	L	H	L	H	H	
	nRD	H	H	H	H	H	H	H	H	H	H	H	H	H	
	PDATA	ADDR _L		ADDR _M		ADDR _H		DATA ₀		DATA ₁		---		DATA _n	
n-byte data read with 2-byte address	nALE	L		L		H		H		H		H		H	
	nWR	L	H	L	H	H	H	H	H	H	H	H	H	H	
	nRD	H	H	H	H	L	H	L	H	L	H	L	H	H	
	PDATA	ADDR _L		ADDR _M		DATA ₀		DATA ₁		DATA ₂		---		DATA _n	
n-byte data write with 2-byte address	nALE	L		L		H		H		H		H		H	
	nWR	L	H	L	H	L	H	L	H	L	H	L	H	H	
	nRD	H	H	H	H	H	H	H	H	H	H	H	H	H	
	PDATA	ADDR _L		ADDR _M		DATA ₀		DATA ₁		DATA ₂		---		DATA _n	
n-byte data read with 1-byte address	nALE	L		H		H		H		H		H		H	
	nWR	L	H	H	H	L	H	L	H	L	H	L	H	H	
	nRD	H	H	L	H	H	H	H	H	H	H	H	H	H	
	PDATA	ADDR _L		DATA ₀		DATA ₁		DATA ₂		DATA ₃		---		DATA _n	
n-byte data write with 1-byte address	nALE	L		H		H		H		H		H		H	
	nWR	L	H	L	H	L	H	L	H	L	H	L	H	H	
	nRD	H	H	H	H	H	H	H	H	H	H	H	H	H	
	PDATA	ADDR _L		DATA ₀		DATA ₁		DATA ₂		DATA ₃		---		DATA _n	

Table 15.5 Parallel mode instruction format

15.5.3 Parallel Mode timing diagram

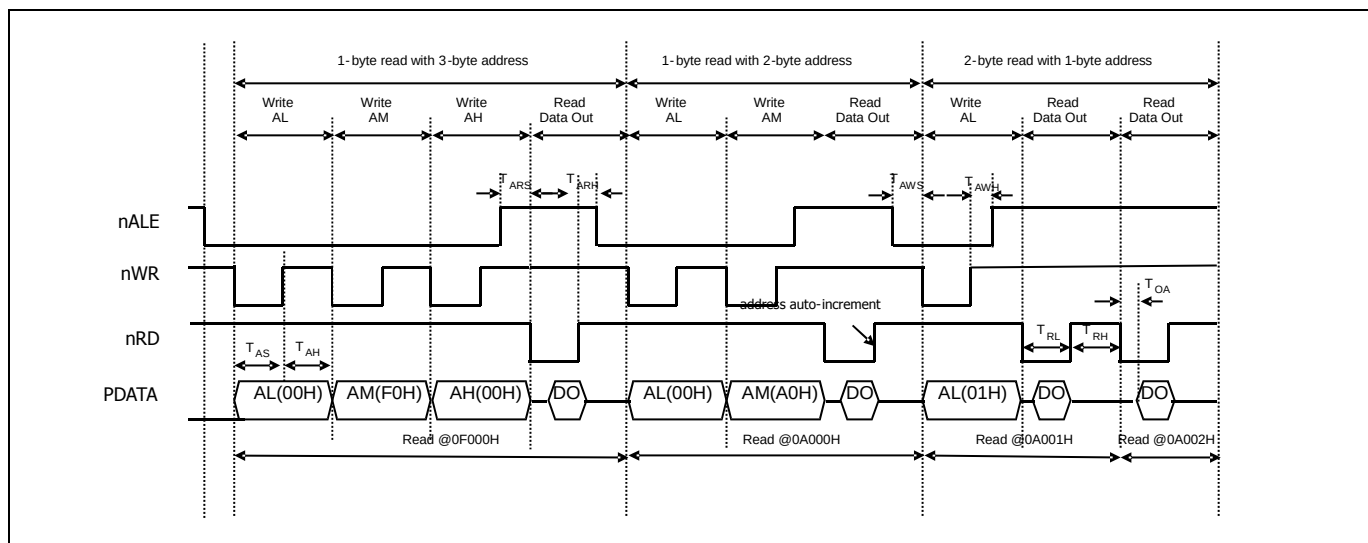


Figure 15.8 Parallel Byte Read Timing of Program Memory

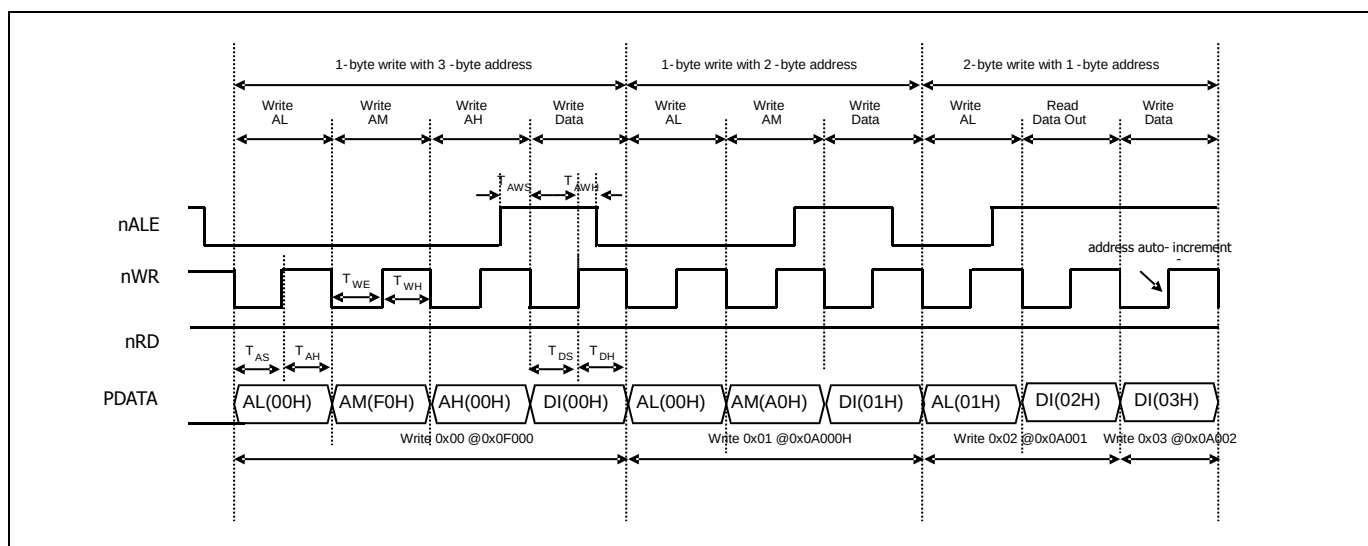


Figure 15.9 Parallel Byte Write Timing of Program Memory

15.6 Mode entrance method of ISP and byte-parallel mode

15.6.1 Mode entrance method for ISP

TARGET MODE	DSDA	DSCL	DSDA
OCD(ISP)	'hC	'hC	'hC

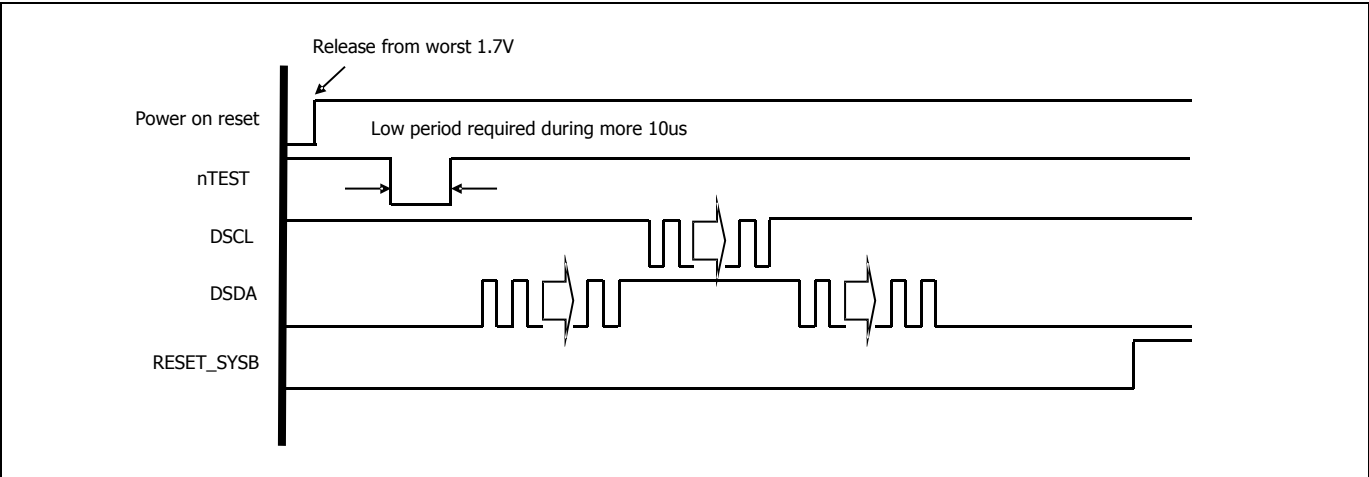


Figure 15.10 ISP mode

15.6.2 Mode entrance of Byte-parallel

TARGET MODE	P0[3:0]	P0[3:0]	P0[3:0]
Byte-Parallel Mode	4'h5	4'hA	4'h5

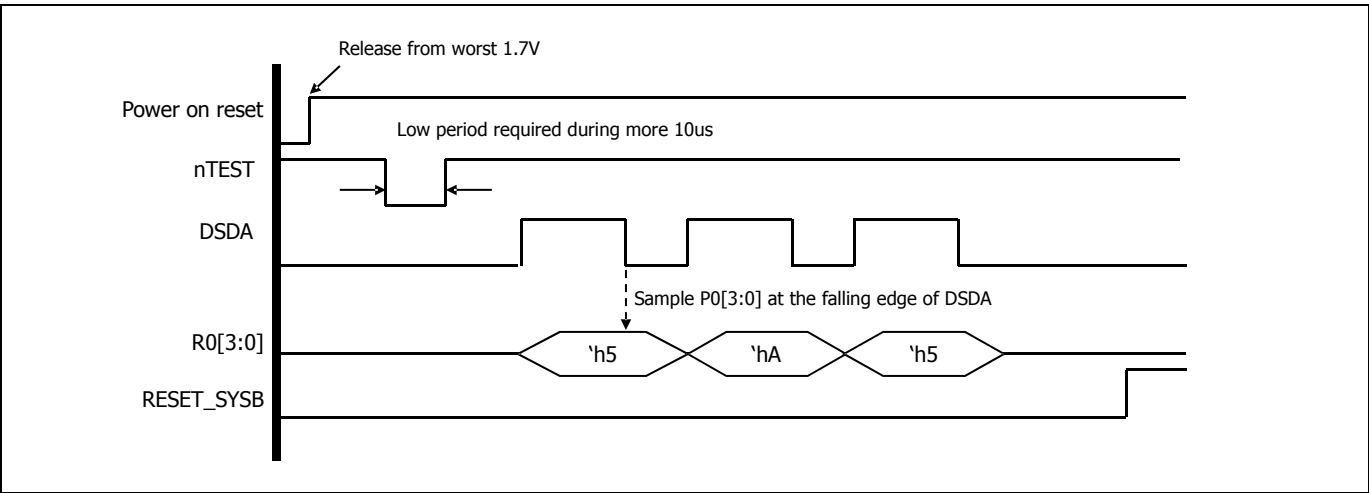


Figure 15.11 Byte-parallel mode

15.7 Security

MC95FG308 provides Lock bits which can be left unprogrammed ("0") or can be programmed ("1") to obtain the additional features listed in Table 15.6. The Lock bits can be erased to "0" with only the bulk erase command and a value of more than 0x80 at FETCR.

LOCK MODE		USER MODE												ISP/PMODE											
		FLASH				DATA EEPROM				OTP				FLASH				DATA EEPROM				OTP			
LOCK E	LOCK F	R	W	P E	B E	R	W	P E	B E	R	W	P E	B E	R	W	P E	B E	R	W	P E	B E	R	W	P E	B E
0	0	O	O	O	X	O	O	O	O	X	X	X	X	O	O	O	O	O	O	O	O	O	O	O	O
0	1	O	O	O	X	O	O	O	O	X	X	X	X	X	X	X	O	O	O	O	O	O	X	X	O
1	0	O	O	O	X	O	O	O	O	X	X	X	X	O	◇	◇	◇	X	X	X	O	O	◇	◇	◇
1	1	O	O	O	X	O	O	O	O	X	X	X	X	X	X	X	◇	X	X	X	O	O	X	X	◇

Table 15.6 Security policy using lock-bits

- LOCKF: Lock bit of Flash memory
- LOCKE: Lock bit of data EEPROM
- R: Read
- W: Write
- PE: Page erase
- BE: Bulk Erase
- O: Operation is possible.
- X: Operation is impossible.
- ◇: When LOCKE is programmed, each operation can be done after data EEPROM is erased with the bulk erase command.

16 Configure Option

16.1 Configure option Control Register

FUSE_CONF (Pseudo-Configure Data) : 2F5DH

7	6	5	4	3	2	1	0
BSIZE1	BSIZE0	SXINEN	XINENA	RSTDIS	LOCKB	LOCKE	LOCKF
R	R	R	R	R	R	R	R

Initial value : 00H

BSIZE	Select Specific Area for Write Protection NOTE) when LOCKB='1', It is applied
00	0100H~01FFH (default)
01	0100H~03FFH
10	0100H~07FFH
11	0100H~0FFFH
SXINEN	Enable External Sub Oscillator
0	Sub OSC disable (default)
1	Sub OSC Enable
XINENA	Enable External Main Oscillator
0	Main OSC disable (default)
1	Main OSC Enable
RSTDIS	Disable RESETB pin
0	External RESET enable
1	External RESET disable
LOCKB	Enable Specific Area Write Protection
0	Boot LOCK Disable
1	Boot LOCK Enable
LOCKE	Data (EEPROM) Read Protection
0	LOCK Disable
1	LOCK Enable
LOCKF	Code Read Protection
0	LOCK Disable
1	LOCK Enable

17 APPENDIX

A. Instruction Table

Instructions are either 1, 2 or 3 bytes long as listed in the 'Bytes' column below.

Each instruction takes either 1, 2 or 4 machine cycles to execute as listed in the following table. 1 machine cycle comprises 2 system clock cycles.

ARITHMETIC				
Mnemonic	Description	Bytes	Cycles	Hex code
ADD A,Rn	Add register to A	1	1	28-2F
ADD A,dir	Add direct byte to A	2	1	25
ADD A,@Ri	Add indirect memory to A	1	1	26-27
ADD A,#data	Add immediate to A	2	1	24
ADDC A,Rn	Add register to A with carry	1	1	38-3F
ADDC A,dir	Add direct byte to A with carry	2	1	35
ADDC A,@Ri	Add indirect memory to A with carry	1	1	36-37
ADDC A,#data	Add immediate to A with carry	2	1	34
SUBB A,Rn	Subtract register from A with borrow	1	1	98-9F
SUBB A,dir	Subtract direct byte from A with borrow	2	1	95
SUBB A,@Ri	Subtract indirect memory from A with borrow	1	1	96-97
SUBB A,#data	Subtract immediate from A with borrow	2	1	94
INC A	Increment A	1	1	04
INC Rn	Increment register	1	1	08-0F
INC dir	Increment direct byte	2	1	05
INC @Ri	Increment indirect memory	1	1	06-07
DEC A	Decrement A	1	1	14
DEC Rn	Decrement register	1	1	18-1F
DEC dir	Decrement direct byte	2	1	15
DEC @Ri	Decrement indirect memory	1	1	16-17
INC DPTR	Increment data pointer	1	2	A3
MUL AB	Multiply A by B	1	4	A4
DIV AB	Divide A by B	1	4	84
DA A	Decimal Adjust A	1	1	D4

LOGICAL				
Mnemonic	Description	Bytes	Cycles	Hex code
ANL A,Rn	AND register to A	1	1	58-5F
ANL A,dir	AND direct byte to A	2	1	55
ANL A,@Ri	AND indirect memory to A	1	1	56-57
ANL A,#data	AND immediate to A	2	1	54
ANL dir,A	AND A to direct byte	2	1	52
ANL dir,#data	AND immediate to direct byte	3	2	53
ORL A,Rn	OR register to A	1	1	48-4F
ORL A,dir	OR direct byte to A	2	1	45
ORL A,@Ri	OR indirect memory to A	1	1	46-47
ORL A,#data	OR immediate to A	2	1	44
ORL dir,A	OR A to direct byte	2	1	42
ORL dir,#data	OR immediate to direct byte	3	2	43
XRL A,Rn	Exclusive-OR register to A	1	1	68-6F
XRL A,dir	Exclusive-OR direct byte to A	2	1	65
XRL A, @Ri	Exclusive-OR indirect memory to A	1	1	66-67
XRL A,#data	Exclusive-OR immediate to A	2	1	64
XRL dir,A	Exclusive-OR A to direct byte	2	1	62
XRL dir,#data	Exclusive-OR immediate to direct byte	3	2	63
CLR A	Clear A	1	1	E4
CPL A	Complement A	1	1	F4
SWAP A	Swap Nibbles of A	1	1	C4
RL A	Rotate A left	1	1	23
RLC A	Rotate A left through carry	1	1	33
RR A	Rotate A right	1	1	03
RRC A	Rotate A right through carry	1	1	13

DATA TRANSFER				
Mnemonic	Description	Bytes	Cycles	Hex code
MOV A,Rn	Move register to A	1	1	E8-EF
MOV A,dir	Move direct byte to A	2	1	E5
MOV A,@Ri	Move indirect memory to A	1	1	E6-E7
MOV A,#data	Move immediate to A	2	1	74
MOV Rn,A	Move A to register	1	1	F8-FF
MOV Rn,dir	Move direct byte to register	2	2	A8-AF
MOV Rn,#data	Move immediate to register	2	1	78-7F
MOV dir,A	Move A to direct byte	2	1	F5
MOV dir,Rn	Move register to direct byte	2	2	88-8F
MOV dir,dir	Move direct byte to direct byte	3	2	85
MOV dir,@Ri	Move indirect memory to direct byte	2	2	86-87
MOV dir,#data	Move immediate to direct byte	3	2	75
MOV @Ri,A	Move A to indirect memory	1	1	F6-F7
MOV @Ri,dir	Move direct byte to indirect memory	2	2	A6-A7
MOV @Ri,#data	Move immediate to indirect memory	2	1	76-77
MOV DPTR,#data	Move immediate to data pointer	3	2	90
MOVC A,@A+DPTR	Move code byte relative DPTR to A	1	2	93
MOVC A,@A+PC	Move code byte relative PC to A	1	2	83
MOVX A,@Ri	Move external data(A8) to A	1	2	E2-E3
MOVX A,@DPTR	Move external data(A16) to A	1	2	E0
MOVX @Ri,A	Move A to external data(A8)	1	2	F2-F3
MOVX @DPTR,A	Move A to external data(A16)	1	2	F0
PUSH dir	Push direct byte onto stack	2	2	C0
POP dir	Pop direct byte from stack	2	2	D0
XCH A,Rn	Exchange A and register	1	1	C8-CF
XCH A,dir	Exchange A and direct byte	2	1	C5
XCH A,@Ri	Exchange A and indirect memory	1	1	C6-C7
XCHD A,@Ri	Exchange A and indirect memory nibble	1	1	D6-D7

BOOLEAN				
Mnemonic	Description	Bytes	Cycles	Hex code
CLR C	Clear carry	1	1	C3
CLR bit	Clear direct bit	2	1	C2
SETB C	Set carry	1	1	D3
SETB bit	Set direct bit	2	1	D2
CPL C	Complement carry	1	1	B3
CPL bit	Complement direct bit	2	1	B2
ANL C,bit	AND direct bit to carry	2	2	82
ANL C,/bit	AND direct bit inverse to carry	2	2	B0
ORL C,bit	OR direct bit to carry	2	2	72
ORL C,/bit	OR direct bit inverse to carry	2	2	A0
MOV C,bit	Move direct bit to carry	2	1	A2
MOV bit,C	Move carry to direct bit	2	2	92

BRANCHING				
Mnemonic	Description	Bytes	Cycles	Hex code
ACALL addr 11	Absolute jump to subroutine	2	2	11→F1
LCALL addr 16	Long jump to subroutine	3	2	12
RET	Return from subroutine	1	2	22
RETI	Return from interrupt	1	2	32
AJMP addr 11	Absolute jump unconditional	2	2	01→E1
LJMP addr 16	Long jump unconditional	3	2	02
SJMP rel	Short jump (relative address)	2	2	80
JC rel	Jump on carry = 1	2	2	40
JNC rel	Jump on carry = 0	2	2	50
JB bit,rel	Jump on direct bit = 1	3	2	20
JNB bit,rel	Jump on direct bit = 0	3	2	30
JBC bit,rel	Jump on direct bit = 1 and clear	3	2	10
JMP @A+DPTR	Jump indirect relative DPTR	1	2	73
JZ rel	Jump on accumulator = 0	2	2	60
JNZ rel	Jump on accumulator ≠0	2	2	70
CJNE A,dir,rel	Compare A,direct jne relative	3	2	B5
CJNE A,#d,rel	Compare A,immediate jne relative	3	2	B4
CJNE Rn,#d,rel	Compare register, immediate jne relative	3	2	B8-BF
CJNE @Ri,#d,rel	Compare indirect, immediate jne relative	3	2	B6-B7
DJNZ Rn,rel	Decrement register, jnz relative	2	2	D8-DF
DJNZ dir,rel	Decrement direct byte, jnz relative	3	2	D5

MISCELLANEOUS				
Mnemonic	Description	Bytes	Cycles	Hex code
NOP	No operation	1	1	00

ADDITIONAL INSTRUCTIONS (selected through EO[7:4])				
Mnemonic	Description	Bytes	Cycles	Hex code
MOVC @(DPTR++),A	M8051W/M8051EW-specific instruction supporting software download into program memory	1	2	A5
TRAP	Software break command	1	1	A5

In the above table, an entry such as E8-EF indicates a continuous block of hex opcodes used for 8 different registers, the register numbers of which are defined by the lowest three bits of the corresponding code. Non-continuous blocks of codes, shown as 11→F1 (for example), are used for absolute jumps and calls, with the top 3 bits of the code being used to store the top three bits of the destination address.

The CJNE instructions use the abbreviation #d for immediate data; other instructions use #data.

B. Instructions on how to use the input port

- Error occur status
 - Using compare jump instructions with input port, it could cause error due to the timing conflict inside the MCU.
 - Compare jump Instructions which cause potential error used with input port condition:

JB	bit, rel	; jump on direct bit=1
JNB	bit, rel	; jump on direct bit=0
JBC	bit, rel	; jump on direct bit=1 and clear
CJNE	A, dir, rel	; compare A, direct jne relative
DJNZ	dir, rel	; decrement direct byte, jnz relative
 - It is only related with Input port. Internal parameters, SFRs and output bit ports don't cause any error by using compare jump instructions.
 - If input signal is fixed, there is no error in using compare jump instructions.

- Error status example

```
while(1){
    if (P00==1){ P10=1; }
    else { P10=0; }
    P11^=1;
}
```

```

zzz:    JNB      080.0, xxx ; it possible to be
error
        SETB     088.0
        SJMP     yyy
xxx:    CLR      088.0
yyy:    MOV      C,088.1
        CPL      C
        MOV      088.1,C
        SJMP     zzz
```

```
unsigned char ret_bit_err(void)
{
    return !P00;
}
```

```

        MOV      R7, #000
        JB       080.0, xxx ; it possible to
be error
        MOV      R7, #001
xxx:    RET
```

- Preventative measures (2 cases)
 - Do not use input bit port for bit operation but for byte operation. Using byte operation instead of bit operation will not cause any error in using compare jump instructions for input port.

```
while(1){
    if ((P0&0x01)==0x01){ P10=1; }
    else { P10=0; }
    P11^=1;
}
```

```

zzz:    MOV      A, 080      ; read as byte
        JNB      0E0.0, xxx  ; compare
        SETB     088.0
        SJMP     yyy
xxx:    CLR      088.0
yyy:    MOV      C,088.1
        CPL      C
        MOV      088.1,C
        SJMP     zzz
```



```

bit tt;
while(1){
    tt=P00;
    if (tt==0){ P10=1;}
    else { P10=0;}
    P11^=1;
}

```

```

zzz:    MOV      C,080.0  ; input port use
internal parameter
        MOV      020.0, C      ; move
        JB       020.0, xxx    ; compare
        SETB     088.0
        SJMP     yyy
xxx:    CLR      088.0
yyy:    MOV      C,088.1
        CPL      C
        MOV      088.1,C
        SJMP     zzz

```

- If you use input bit port for compare jump instruction, you have to copy the input port as internal parameter or carry bit and then use compare jump instruction.

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